

centro de educación continua división de estudios superiores facultad de ingeniería, unam



A LOS ASISTENTES A LOS CURSOS DEL CENTRO DE EDUCACION CONTINUA

Las autoridades de la Facultad de Ingeniería, por conducto del Jefe del Centro de Educación Continua, otorgan una constancia de asistencia a quienes cumplan con los requisitos establecidos para cada curso. Las personas que deseen que aparezca su título profesional precediendo a su nombre en la constancia, deberán entregar copia del mismo o de su cédula a más tardar el SEGUNDO DIA de clases, en las oficinas del Centro con la señorita encargada de inscripciones.

El control de asistencia se llevará a cabo a través de la persona encar, gada de entregar las notas del curso. Las inasistencias serán computadas por las autoridades del Centro, con el fin de entregarle constancia solamente a los alumnos que tengan un mínimo del 80% de asistencia.

Se recomienda a los asistentes participar activamente con sus ideas y experiencias, pues los cursos que ofrece el Centro están planeados para que los profesores expongan una tesis, pero sobre todo, para que coordi nen las opiniones de todos los interesados constituyendo verdaderos seminarios.

Es muy importante que todos los asistentes llenen y entregen su hoja de inscripción al inicio del curso. Las personas comisionadas por alguna institución deberán pasar a inscribirse en las oficinas del Centro en la misma forma que los demás asistentes, entregando el oficio respectivo.

Con objeto de mejorar los servicios que el Centro de Educación Continua ofrece, al final del curso se hará una evaluación a tráves de un cues-tionario diseñado para emitir juicios anónimos por parte de los asisten tes. úd,

UNIVERSIDAD NACIONAL AUTONOMA DE MEXICO FACULTAD DE INGENIERIA DIVISION DE ESTUDIOS SUPERIORES CENTRO DE EDUCACION CONTINUA DIRECTORIO GENERAL	
REGISTRO DE ASISTENTES Y PROFESORES.	
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REG. FED. CAUS. 42 51 CED. PROF. 52 58	
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ASISTENTE PROFESOR 77	80 80
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DIRECTORIO DE PROFESORES DEL CURSO ANALISIS EXPERIMENTAL DE ESFUERZOS DEL 27 DE NOV. AL 8 DE DICIEMBRE, 1978.

DR. POPFIRIC BALLESTEROS BAROCIO JEFE DE LA SECCION DE MECANICA TEORIA Y APLICADA D. E. S. F. I. UNAM TEL. 550.52.15 EXT. 4498

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Fecha	Duración	Tema	Profesor
Nov. 27	9 a 10:30 a.m.	Introducción	Dr. Miklos Hetenyi
	ll a l2:30 h	Fundamentos de Mecánica	tt er er
	l4 a 15:30 h	Análisis de Modelos	Dr. Luis A. Ferrer Argoite
·	16 a 17:30 h	Análisis Dinámico	Dr. Mihir Sen
Nov. 28	9 a 10:30 a.m.	Fundamentos de Mecánica	Dr. Miklos Hetenyi
	ll a 12:30 h	Fotoelasticidad 2D y 3D	** ** **
	l4 a l4:30 h	Análisis de Modelos	Dr. Luis A. Ferrer Argoite
	16 a 17:30 h	Análisis Dinámico	Dr. Mihir Sen
Nov. 29	9 a 10:30 a.m.	Fundamentos de Mecánica	Dr. Miklos Hetenyi
	ll a 12:30 h	Fotœlasticidad 2D y 3D	Dr. Miklos Hetenyi
	14 a 15:30 h	Métodos Estadísticos	Dr. Luis A. Ferrer Argoite
	16 a 17:30 h	Método de Moire	Ing. Alfonso Olvera López
Nov. 30	9 a 10:30 h	Fundamentos de Mecánica	Dr. Miklos Hetenyi
	ll a 12:30 h	Fotœlasticidad 2D y 3D	Dr. " "
. ·	14 a 15:30 h	Fotoelaticidad Reflectiva	Dr. Salomón Redner
	l6 a 17:30 h	Método de Moire	ling. Alfonso Olvera López
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ANALISIS EXPERIMENTAL DE ESFUERZOS

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Fecha	Duración	Tema	Profesor -2-
Dic. l°	9 a 10:30 a.m.	Strain Gages	Dr. Miklos Hetenyi
	ll a 12:30 h	Fotoelasticidad 2D y 3D	rt tt tt
	14 a 15:30 h	Fotœlasticidad Reflectiva	Dr. Salomón Redner
	16 a 17:30 h	Método de Grid	Dr. Luis A. Ferrer Argoite
Dic.4	9 a 12:30		Dr. Miklos Hetenyi
	17 a 18:30 h 19 a 21 h	Lacas Frágiles Laboratorio	Dr. Salomón Redner Ing. Alfredo Olivares Ponce
Dic. 5	9 a 12:30 h .		Dr. Miklos Hetenyi
	17 a 18:30 h 19 a 21 h	Esfuerzos Residuales Laboratorio	Dr. Salomón Redner Ing. Alfredo Olivares Ponce
Dic. 6	9 a 12:30 h		Dr. Miklos Hetenyi
	17 a 18:30 h 19 a 21 h	Strain Gages Laboratorio	Ing. Alfredo Olivares Ponce
Dic. 7	9 a 12:30 h		Dr. Miklos Hetenyi
	17 a 18:30 h 19 a 21 h	Strain Gages Laboratorio	Ing. Alfredo Olivares Ponce Dr. Luis A. Ferrer Argoite
Dic. 8	9 a 12:30 h		Dr. Miklos Hetenyi
	17 a 18:30 h 19 a 21 h	Transductores Mesa Redonda	Ing. Alfredo Olivares Ponce Todos los Profesores
	. •	Clausura	

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ANALISIS EXPERIMENTAL DE ESFUERZOS

STRAIN GAGES

NOVIEMBRE, 1978.

Palacie de Minería

Calle de Tacuba 5, primer piso.

Móxico ? D. F.

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1:1 Generalidades

Con el enunciamiento por Robert Hooke en 1.678 de la leyprelaciona las tensiones y deformaciones en materiales sometidos a solicitaciones mecánicas y el posterior descubrimiento en 1.856 de Lord Kelvin referente a las variaciones que en su resistencia su fre un conductor eléctrico cuando se modifica su geometría, se esta blecieron los principios fundamentales de la extensometría eléctrica; si bién su nacimiento ha sido muy posterior, pudiendo decirse que fué a partir de la II guerra Mundial, cuando su aplicación emp<u>e</u> zó a vulgarizarse.

En su forma más elemental, una banda extensométrica (Strain-gage; jauge électrique d'extensometrie) está constituída -(fig. 1) por un hilo metólico muy fino en forma de "parrilla" mon-



tado sobre un soporte, de tal man<u>e</u> ra, que la mayor parte de su longi tud sea paralela a una dirección f<u>i</u> ja. Si deseamos conocer las deforma ciones de una estructura según una dirección, pagaremos el extensíme tro con sus hilos paralelos a dicha dirección y al deformarse_aquella, _producirá variaciones en la geometría del hilo del extensímetro que originarán una variación de su resisten# cia; por lo tanto disponiendo de ins trumentos capaces de medir variaciónes pequeñas de la resistencia original del extensímetro, podemos cono cer las deformaciones mecánicas de la estructura en la que se pegó.

La Resistencia de materiales nos enseña las leyes que ligan deformaciones y tensiones, siendo la extensometría la técnica que permitirá conocer el estado de tensiones de un cuerpo a partir de la medida del estado de deformaciones, sin necesidad de recurrir a ensayos destructivos, pudiendose efectuar un número ilimitado de mediciones, pués si bién el extensímetro una vez pegado es irrecuperable, sus cualidades con el tiempo perduran, dentro de los límites de utilización.

Por tanto, una banda extensométrica actua como elemento transductor, transformando la variación de una magnitud mecánica en la de una eléctrica, facultad ésta que se aprovecha para fabricar ca<u>p</u> tadores sensibles a ciertos parámetros mecánicos, pudiendo así evita<u>r</u> se el inconveniente de su no recuperación.

Actualmente el desarrollo de las técnicas extensométricas, ha alcanzado tal grado de perfección, que normalmente los probl<u>e</u> mas de medida de deformaciones y tensiones que puedan presentarse en ingeniería tienen solución, determinándose con exactitud la evaluación de fenómenos cuya influencia en la realización de proyectos es primo<u>r</u> dial, con la ambiciosa meta de fabricación con coeficientes de seguridad próximos a la unidad, sin perdida de garantias funcionales. Reducción de costos de fabricación, control de calidad, homologación de ma<u>r</u> cas, investigación, estudios y ensayos, mejores de fabricados, nuevos diseños, etc, etc, son logros, que incluso a corto plazo, se consiguen con equipos sencillos elementales y económicos.

1.2 PRINCIPIOS TEORICOS DEL EXTENSIMETRO OHMICO

Consideremos un extensimetro formado por un solo hilo conductor unido a una estructura, de tal forma, que las deformaciones que pueden producirse sean idénticas en ambos (fig 2).



Si el hilo sufre una deformación (alargamiento), la lon gitud l aumenta, la sección S disminuye y la resistividad varía dando lugar estos cambios a una variación del valor de R que podemos obtener diferenciando (1) y después deducir la relación entre la deformación elástica del hilo y la variación relativa o unitaria de resistencia, en efecto: $dR = \frac{s f dp + p df - pf ds}{s^2}$

[3]

 $\frac{dR}{R} = \frac{dl}{l} + \frac{dl}{l} - \frac{ds}{s}$

Nividiando [2] por [1]

-2-

Siel hilo es de forma cilindrica: $S = \frac{\pi D^{2}}{4}; \quad dS = \frac{\pi}{2} D dD \quad y \quad \frac{dS}{5} = \frac{2dD}{D}; \quad sustituyendo en[3]$ $\frac{dR}{R} = \frac{dl}{l} + \frac{dP}{P} - 2\frac{dD}{D} = - - - - - [4]$

La (4) podemos escribirla como:

$$\frac{\frac{dR}{R}}{\frac{dl}{l}} = 1 + \frac{\frac{dP}{P}}{\frac{dl}{l}} - 2 \frac{\frac{dD}{D}}{\frac{dl}{l}}$$

pero el último término del segundo miembro, es la expresión del co<u>e</u> ficiente de Poisson $\frac{dD}{D}$: $\frac{dl}{l} = -Jl$, luego sustituyendo tendemos el valor de la relación entre la variación de resistencia y la deform<u>a</u> ción unitaria.

$$\frac{dR}{R} = 1 + \frac{dP}{\frac{P}{P}} + 2\mu - - - - [5]$$

al segundo miembro de (5) se llama factor de banda o de sensibilidad K;

Bridgaman enunció que la variación relativa de resistividad de un con ductor es proporcional a la variación relativa de volúmen de dicho conductor

$$\frac{d\rho}{V} = C \frac{dV}{V} \quad (C = Constante \ de \ Bridgman) = [7]$$

Si $V = l, S$ y sustituyendo [7] en [5]
$$\frac{dR}{R} = [(1+2\mu)+C(1-2\mu)] \frac{dl}{L} = [----[8]$$

Hasta aquí, hemos considerado la sección del hilo circular, pero en

Hasta aquí, hemos considerado la sección del hilo circular, pero en las modernos b ndas impresas la sección es rectangular y la variación de resistencia $\frac{dR}{R}$, función de las deformaciones que experimenta la banda en las tres dimensiones se calculará.asi:



 $R = p - \frac{l}{2k}$

y las deformaciones según los ejes X,Y,Z son: [9]

$$E_{x} = \frac{dl}{l} \quad ; \quad E_{y} = \frac{db}{l} \quad ; \quad E_{z} = \frac{da}{a} = -\mu \frac{dl}{l} \quad \mu \in [0, \infty]^{p}$$

[10]

[10a]

diferenciando logarítmicamente la⁹tendremos

$$\frac{dR}{R} = \frac{dt'}{f} + \frac{dl}{l} + \frac{da}{a} - \frac{db}{b} + \frac{dl'}{l} + \frac{dl'}{a} + \frac{db}{b} + \frac{dl'}{l} + \frac{dl'}{a} + \frac{db'}{b} + \frac{dl'}{l} + \frac{dl'}{a} + \frac{db'}{b} = \frac{c(\ell_x - \mu \ell_x - \mu \ell_y + \ell_y) + \ell_x + \mu \ell_y - \ell_y}{c(\ell_x - \mu \ell_y) + \ell_x + \mu \ell_y - \ell_y} = \frac{c(\ell_x - \mu \ell_x - \mu \ell_y + \ell_y) + \ell_x + \mu \ell_y - \ell_y}{c(\ell_x - \mu \ell_y) + \ell_y + \ell_y}$$

y llamando
$$K_{l} = c(l - h) + 1 + \mu$$

queda

$$\frac{dR}{R} = \xi_{x} K_{1} + \xi_{j} K_{2}$$

 $K_2 = (C - 1) (1 - u)$

La (10) nos indica que una banda extensométrica es sensible a la deformación longitudinal según la dirección de los hilos activos, pero también a la deformación transversal, siendo esto último un inconveniente que puede introducir errores. Si el valor de la constante de Bridgman se consigue que valga la unidad, $K_2=0$, pero pró<u>c</u> ticamente es muy dificil de lograr, por lo que se tiende a buscar un compromiso que haga K_2 lo menor posible y por lo menos que permita c<u>o</u> nocer el error que su presencia introduce en la medida. Veamos como se logra.

La (10) puede escribirse:

$$\frac{IR}{E} = K_{f} \left(\mathcal{E}_{x} + K_{t} \mathcal{E}_{y} \right)$$

siendo $K_t = \frac{K_2}{K_1}$ = factor de sensibilidad transversal del extensimetro. Sustituyendo: $d\mathcal{R} = \frac{K_1}{K_1} - \frac{K_2}{K_1} - \frac{K_2}{K_2} - \frac{K_2}{K_1}$

$$\frac{dR}{R} = k_1 \left(\mathcal{E}_{\mathbf{x}} \cdot k_t \, \mu \, \mathcal{E}_{\mathbf{x}} \right) = k_1 \left(1 - \mu \, k_t \right) \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} - k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}} = K \mathcal{E}_{\mathbf{x}} + k_t \, \mu \, \mathcal{E}_{\mathbf{x}}$$

El factor de banda dado por el fabricante es $K=K_1(1-\mu K_t)$ para $\mu=0,285$

La expresión:

$$e = \frac{K_{t} \left(\frac{\varepsilon_{y}}{\varepsilon_{x}} + u \right)}{1 - u K_{t}} = \frac{100}{1 - u K_{t}}$$
[11a]

nos dá el error en % que sobre la medida de la deformación según \mathcal{E}_{x} introduce el factor de sensibilidad transversal. Vemos que en el caso en que la dirección de \mathcal{E}_{x} coincide con la dirección de tensiones unidireccionales (tracción o compresión simple) el error es cero, pues se cumple que $\mathcal{E}_y = -\mu \mathcal{E}_x$, (fig 2b).



Según la fig. 2c vamos a medir la d<u>e</u> formación lateral correspondiente a un estado unidireccional de tensiones, aquí por el giro dado al extensímetro, se cumple que :

 $E_{x} = -\mu E_{y} + \frac{E_{y}}{E_{x}} = -\frac{1}{\mu}$ Si consideramos $\mu = 0,3 \ y \ K_{t} = 3\%$ sus tituyendo en (11a), el error vale: $e = \frac{0,03 \left(-\frac{4}{0,3} + 0,3\right)}{1 + 0,3, 0,03} \times 100 = -9\%$

El error del-9% no puede despreciarse y aún cuando en el ejemplo se ha buscado un caso muy extremo, habrá que evaluar siempre la magnitud del error y considerar si debe o nó despreciarse.

El problema en el caso que se conozca la dirección pri<u>n</u> cipal de deformaciones (fig. 2b) no tiene importancia; pero como se verá posteriormente en el caso de rosetas de dos o tres direcciones el error por efecto de la sensibilidad lateral puede tener influencia, pués se estará siempre entre las dos posturas extremas presentadas en las fig. 2b y 2c.

1.3. OBJETO DE LAS MEDIDAS EXTENSOMETRICAS: Unidades

Los materiales empleados en la fabricación de máquinas o cualquier elemento sometido a solicitaciones externas, sufren en su estructura interna unas tensiones que deben equilibrar las cargas que soportan para que no aparezca la rotura, sobredimensionandose siempre los diseños para obtener un coeficiente de seguridad adecuado. Evide<u>n</u> temente el máximo conocimiento del estado de tensiones ayudará a mej<u>o</u> rar el diseño y a reducir el coeficiente de seguridad, pero la medida directa de ten iones no siempre es posible.

Demostraremos en este capítulo, que si conocemos el e<u>s</u> tado de deformaciones en un punto, podremos calcular el estado de te<u>n</u> siones del mismo y determinar el valor de tensiones críticas (tensiones normales máximas o combinación, en una determinada dirección de tensiones normales y cortantes, que puedan representar un fallo).

El estado de deformaciones se determinará a partir de las medidas, que en una, dos o tres direcciones, que se efectuen con extensimetros.

Salvo casos muy especiales, la aplicación de las bandas extensométricas será siempre en la superficie de los elementos de e<u>n</u> sayo, por lo que solo estudiaremos el estado plano o binaxial de deformaciones y tensiones en un punto.

El concepto de deformacion es análogo al de alargamien to unitario y lo representaremos por \mathcal{E} midiendose en microdeformacio nes $(\mu\delta)$

 $\varepsilon_{10}^{6} = \frac{d\ell}{k} \cdot 10^{6} = \mu \delta_{10} - microdeformación (adimensional)$

Diversa literatura suele expresar las deformaciones en micromilimetros/milimetro o micropulgada/pulgada, creando a veces alguna confusión, en realidad es decir lo mismo de una o de otra menera, ya que se trata de la misma unidad por lo que nosotros recomendamos referirse siempre a $\mu\delta$.

El módulo de elasticidad E y las tensiones ^{se} expresarán en da N/cm^2 , aunque en algunas tablas pueden aparecer estos valores en Kp/cm² o Kp/mm².

1.4 ESTADO BIAXIAL DE DEFORMACIONES



El rectángulo elemental de la fig. 3 de lados dx y dy tiene como posibles las deformaciones lineales según los ejes X e Y ya definidas y de valor:

$$E_x = \frac{\delta x}{dx}$$
 $E_y = \frac{\delta y}{dy}$

originadas cuando la dirección del alargamiento coincide con los ejes X e Y respectivamente y otro tipo de deformación llamada angular que aparece cuando hay un desplazamiento transversal de los lados dx y dy que motiva que la forma rectangular original se convierta en rombica. La d<u>e</u> formación angular \int_{XY} se define como la suma de los desplazamientos tran<u>s</u> versales divididos por las longitudes origincies que no le son paralelas es







decira Xxy= Sx + Sy = tg X2+tg Xi ~ Xi+ X2 La deformación angular se considera positiva si supone una disminución del ángulo recto original por una extensión.

En un punto arbitrario (fig.4) de la superficie de una pieza cargada podemos aíslar un elemento infinistesimal de material para estudiar sus deformaciones en el plano XY y para ello aplicaremos el principio de superposición, por el cual la d<u>e</u> formación total será la suma de las deformaciones parciales, es decir, la suma de la deformación lineal se gún los ejes X e Y respectivamente y la deformación angular Xxy.

Vamos a relacionar los valores de las deformaciones según los X-Y con otro conjunto de ejes X'-Y' que forman un ángulo θ . Al ángulo θ le considerare mos positivo en sentido contrario al de las agujas del reloj.

En la fig. 5 se observa la geometría del elemento infinitesimal referido a los nuevos ejes X'-Y', el alargamien to según el eje X' será: E_{x'}: OX

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 $\delta x' = F_{c'} dx' = BD + DE + FH$ $\frac{\overline{BD}}{\overline{DE}} = \{ dx' \cos \theta \cos \theta = E_x dx' \cos^2 \theta \\ \overline{DE} = E_y dy' xu \theta reu \theta = E_y dy' sen^2 \theta \\ \overline{FH} = dx' sen \theta j x j co \theta$ 512] Ex' = Ex cos2 + Ey sen2 + Jxy 2en & cos d. $\mathcal{E}_{y}' = \mathcal{E}_{x} \cos^{2}\left(\theta + \frac{\pi}{2}\right) + \mathcal{E}_{y} \operatorname{reu}^{2}\left(\theta + \frac{\pi}{2}\right) + \mathcal{J}_{xy} \operatorname{sen}\left(\theta + \frac{\pi}{2}\right) \cos\left(\theta + \frac{\pi}{2}\right)$ [13] La deformación angular viene expresada por: $\int_{0}^{\infty} = \delta_{1} + \delta_{2} = \frac{AI}{dx^{1}} + \frac{JK}{dx^{1}}$ $\overline{AI} = -HC + \overline{CE} - \overline{AB} - HC = -dx' f_{xy} \operatorname{sen}^{2} \Theta - \overline{RJ} = -dy \varepsilon_{x} \operatorname{sen} \Theta \operatorname{to} \Theta$ $\overline{JK} = -\overline{RJ} + \overline{NQ} + \overline{PL} \overline{CE} = \varepsilon_{y} d_{x}' \operatorname{sen} \Theta \operatorname{to} \Theta \overline{O} \overline{O} \overline{NQ} = dy \varepsilon_{y} \operatorname{sen} \Theta \operatorname{to} \Theta$ -AB = - Ex dx ren 8 cor 0) PL = dy Xxy cor 0

$$\chi_{\theta} = -2 (\mathcal{E}_{x} - \mathcal{E}_{y}) \operatorname{reu} \theta \cos \theta + \chi_{xy} (\cos 2\theta - \operatorname{sen}^{2} \theta) - - - [14]$$

Si expresamos la (12 y (14) en función del ángulo doble podemos escribirlas

Por ser funciones periódicas tendrán un máximo y un mínimo que calc<u>u</u> laremos derivando la (15) respecto a θ e igualando a cero.

de donde sustituyendo en (15) tenemos:

Los subíndices M-m indican los valores máximo y mímimo, en efecto hay dos valores de 2θ M-m que cumplen la ecuación (17) ya que to 2θ : Fg $(2\theta + \kappa)$ o sea que las direcciones de las deformaciones máxima y mínima son perpendiculares entre sí, verificándose además que la deformación angular es nula como se demuestra sustituyendo la (17) en la (16), la fig, 6 aclara lo expuesto.



demostrándose que su dirección forma 45º con respecto a las direcci<u>o</u> nes principales.

Si el éngulo $heta_{M}$ que el eje arbitrario X' forma con el eje X hacemos que sea nulo las expresiones (18) y (19) se pueden escribir:

$$\frac{\mathcal{E}_{x}(\mathbf{M},\mathbf{m})}{2} = \frac{\mathcal{E}_{1} + \mathcal{E}_{2}}{2} \pm \frac{\mathcal{E}_{1} - \mathcal{E}_{2}}{2}$$

$$\frac{\chi_{1n}}{2} = \pm \frac{\mathcal{E}_{1} - \mathcal{E}_{2}}{2}$$

-8-

siendo $\xi_1 \neq \xi_2$ las deformaciones según las direcciones principalês.

Para cualquier otra dirección que forme un ángulo 🗠 respecto a las principales, las fórmulas quedarán:

si llamamos:

1.5. ESTADO BIAXIAL DE TENSIONES



En una ba ra prismática sometida a una extensión pura, se llama tensión (esfuerzo o fatiga) a la fuerza que actua por unidad de superficie; $\sigma_x = \frac{F}{S} (S: sección segun r r')$ si consideramos otra sección S' (según p'-p) cuy normal forma un ángulo 8 con el eje de aplicación de fuerzas, la tensión según el eje X valdrá:

$$\nabla \nabla x = \frac{F}{S'} = \frac{F}{S} \cos \theta = \sigma_x \cos \theta$$

y descomponiéndola en las direcciones normal y tangencial respectivamente de p-p' tendremos que:

Estudiaremos el estado biaxial de tensiones en la superficie de un cuerpo que no esté sometido a presiones exteriores; de forma análoga a como se desa rolla el caso de deformaciones, para ello aislemos un elemento infinitesimal de lados paralelos a unos eje X - Y, las acciones que actuen sobre el elemento originan mas tensiones normales y cortantes que mantienen el equilibrio del sistema. -(fig. 8).



Las tensiones normales serán posit<u>i</u> vas en caso de tracción y negativas en caso de comprensión, así mismo las tensiones cortantes se consideran positivas cuando producen un par en sentido de las agujas del reloj y n<u>e</u> gativas en caso contrario.

En la fig. 9, vemos el elemento inf<u>i</u> nitesimal referenciado a unos ejes que forman un ángulo θ con los X-Y'; buscaremos el valor de las tensiones ligadas a la nueva orientación de ejes, para ello tengamos en cuenta que el equilibrio debe ser de fuerzas, en efecto:

ecuaciones que expresadas en función del ángulo doble nos dan:

$$\sigma_{\theta} = \frac{\sigma_x + \sigma_y}{2} + \frac{\sigma_x - \sigma_y}{2} \cos 2\theta + \tilde{c}_{xy} \cos 2\theta - - - [28]$$

$$\tilde{c}_{\theta} = -\left(\frac{\sigma_x - \sigma_y}{2}\right) \sin 2\theta + \tilde{c}_{xy} \cos 2\theta - - - - - [29]$$

Si derivamos la (28) respecto a ♀ e igualamos a cero, encontraremos los valores de ♀ que hacen máximo y mínimo a dicha ecuación:

$$\frac{d \sigma}{d \theta} = (\sigma_x - \sigma_y) \operatorname{ren} 2\theta + 2 C_{xy} \cos 2\theta = 0$$

$$\frac{d \sigma}{d \theta} = \frac{\operatorname{sen} 2\theta_{H-m}}{\cos 2\theta_{H-m}} = \frac{C_{xy}}{\sigma_x - \sigma_y}$$

Por consideraciones anólogas a las prechas en el estudio de la deformación biaxial, se ded cen que hay dos planos perpendiculares que corresponden a las dir cciones en que las tensiones normales son máxi ma y mínima respectivamente y en las cuales las tensiones cortantes son nulas. $\sigma_{\text{M-M}} = \frac{\sigma_{x} + \sigma_{y}}{2} \pm \sqrt{\left(\frac{\sigma_{x} - \sigma_{y}}{2}\right)^{2} + \left(Z_{xy}\right)^{2}} = -$

De la misma forma encontraremos que:

$$\mathcal{L}_{M-m} = \frac{+}{2} \left[\left(\frac{\sigma_x - \sigma_y}{2} \right)^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 - \frac{1}{2} \left[\left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 \right]^2 + \left(\mathcal{L}_{xy} \right)^2 + \left(\mathcal{L}_{xy$$

El valor máximo y mínimo de la tensión cortante se encuentra defasado 45º respecto a los valores principales de las tensiones normales. Haciendo que el ángulo $\hat{\theta}_{M=0}$ tenemos que:

$$\sigma_{\text{M-m}} = \frac{\sigma_1 + \sigma_2}{2} \pm \frac{\sigma_1 - \sigma_2}{2}$$

$$\sigma_{\text{M-m}} = \pm \frac{\sigma_1 + \sigma_2}{2}$$

siendo ∇_1 y ∇_2 el valor de las tensiones normales máxima y mínima; las tensiones en cualquier dirección que formen un ángulo con las principales, tienen de valor:

[30]

[31]

Llamando,

$$\delta = \frac{\sigma_1 + \sigma_2}{2} \quad y \quad P = \frac{\sigma_1 - \sigma_2}{2}$$

$$\sigma_a = \delta + \rho \cos 2\alpha \qquad [33]$$

$$C_a = \rho \sin 2\alpha \qquad [34]$$

1.6 RELACION ENTRE DEFORMACIONES Y TENSIONE

dy dy Suponemos el elemento de la fig. 10, <u>a</u> plicando el teorema de la superposición en contramos que; $E_x = \frac{\sigma_x}{E} - \mu \frac{\sigma_y}{E}$ figlo, $E_y = \frac{\sigma_y}{E} - \mu \frac{\sigma_y}{E}$

$$\sigma_{x} = \frac{E}{1 - \mu^{2}} (\epsilon_{x} + \mu \epsilon_{y}) - [35]$$

$$\sigma_{y} = \frac{E}{1 - \mu^{2}} (\epsilon_{y} + \mu \epsilon_{x}) - [36]$$

Experimentalmente se demuéstra que:

$$\chi = \frac{Z}{G} = \frac{E}{2(1+\mu)}$$
 - - - [37]

llamándose a G coeficiente de elasticidad a cortadura.

Recordando las relaciones:

$$d = \frac{\varepsilon_1 + \varepsilon_2}{2} \qquad \qquad \delta = \frac{\sigma_1 + \sigma_2}{2}$$

$$\Gamma = \frac{\varepsilon_1 - \varepsilon_2}{2} \qquad \qquad \rho = \frac{\sigma_1 - \sigma_2}{2}$$

se deduce que:

$$\mathcal{E}_{1} + \mathcal{E}_{2} = \frac{\sigma_{1}}{E} - \mu \frac{\sigma_{2}}{E} + \frac{\sigma_{2}}{E} - \mu \frac{\sigma_{1}}{E} = \sigma_{1} + \sigma_{2} \left(\frac{1 - \mu}{E} \right)$$

$$\delta = \frac{\sigma_{1} + \sigma_{2}}{2} = \frac{\mathcal{E}_{1} + \mathcal{E}_{2}}{2} \frac{E}{1 - \mu} = d \frac{E}{1 - \mu}$$

$$\mathcal{E}_{1} - \mathcal{E}_{2} = \sigma_{1} - \sigma_{2} \frac{1 + \mu}{E}$$

$$\mathcal{E}_{1} - \mathcal{E}_{2} = \sigma_{1} - \sigma_{2} \frac{1 + \mu}{E}$$

$$P = \frac{\sigma_1 - \sigma_2}{2} = \frac{\epsilon_1 - \epsilon_2}{2} - \frac{\epsilon_1}{1 + \mu} = r - \frac{\epsilon_1}{1 + \mu} = r - \frac{\epsilon_2}{1 + \mu} = r - \frac{\epsilon_2}{1 + \mu} = r - \frac{\epsilon_1}{1 + \mu} = r - \frac{\epsilon_2}{1 + \mu} = r - \frac{\epsilon_2}{1 + \mu} = r - \frac{\epsilon_1}{1 + \mu} = r - \frac{\epsilon_2}{1 + \mu} = r - \frac{\epsilon_1}{1 + \mu} = r - \frac{\epsilon_2}{1 + \mu} = r - \frac{\epsilon_$$

1.7. REPRESENTACION GRAFICA DEL ESTADO BIAXIAL DE TENSIONES Y DEFORMA CIONES; CIRCULOS DE MOHR

Una de las formas más sencillas y usuales de represent<u>a</u> ción del estado plano de deformaciones y tensiones es el círculo de Mohr. Recordemos que la deformación en una dirección cualquiera que forma un ángulo « respecto a las direcciones principales tiene por valor:

$$E_{\alpha} = \frac{\varepsilon_{1} + \varepsilon_{2}}{2} + \frac{\varepsilon_{1} - \varepsilon_{2}}{2} \cos 2\alpha = d + \epsilon \cos 2\alpha$$

$$\frac{\delta \alpha}{2} = \frac{\varepsilon_{1} - \varepsilon_{2}}{2} \operatorname{sen} 2\alpha = \epsilon \operatorname{sen} 2\alpha$$

Podemos representar prácticamente éstas ecuaciones según la fig. 11, pués se cumple que:





 $\mathcal{E}_{d} = \overline{OM'} = d + \Gamma \operatorname{out} \mathcal{E}_{d}$ $\frac{\delta \omega}{2} = \overline{MM'} = \Gamma \operatorname{sen} \mathcal{E}_{d}$

Observemos que el valor máximo y el mínimo

La fig. 12 nos indica el circulo-de. Mohr para el estado de tensiones y vemos su similitud con el de deformaciones.

$$\sigma_{d} = \overline{OH} = \delta + \rho \cos 2\alpha$$

$$T_{i} = HH' = \rho \sin 2\alpha \qquad -10$$

En el dominio elástico de los cuerpos isotrópicos, existe proporcionalidad entre deformaciones y tensiones, por lo que los circulos representativos de ambos valores son concéntricos. Los coeficientes de proporcionalidad han sido deducidos en el apartado 1.6 (fig. 13).



1.8 EJEMPLOS DE APLICACION DE LOS CIRCULOS DE MOHR.

Nº 1. Sobre el elemento de la fig. 14 actuan las tensiones que se indican. Calcular analítica y gráficamente el valor y dirección de los esfuerzos principales.



Casos típicos de aplicación del circulo de Mohr.



TORSION Y TRACCION







•



LIG18 CILINDRO BAJO PRESION



fig 19

ESFERA BAJO PRESION



Bandas de tres direcciones o rosetas (Rectangulares)

Consideremos el valor de las deformaciones (fig. 21) en direcciones A, B y C que forman los ángulos $\theta A, \theta B$ y θC respectivamente con el eje X de unos ejes arbitrarios X-Y, tendremos:

$$E_{A} = \frac{\varepsilon_{x} + \varepsilon_{y}}{2} + \frac{\varepsilon_{x} - \varepsilon_{y}}{2} \cos 2\theta_{A} + \frac{\delta_{x} + \varepsilon_{x}}{2} \sin 2\theta_{A}$$

$$E_{B} = \frac{\varepsilon_{x} + \varepsilon_{y}}{2} + \frac{\varepsilon_{x} - \varepsilon_{y}}{2} \cos 2\theta_{B} + \frac{\delta_{x} + \varepsilon_{x}}{2} \sin 2\theta_{B}$$

$$E_{c} = \frac{\varepsilon_{x} + \varepsilon_{y}}{2} + \frac{\varepsilon_{x} - \varepsilon_{y}}{2} \cos 2\theta_{c} + \frac{\delta_{x} + \varepsilon_{x}}{2} \sin 2\theta_{c}$$

Si hacemos que:

 $\theta_{A} = 0$; $\theta_{B} = \frac{\pi}{4}$; $\theta_{c} = \frac{\pi}{2}$ nos queda:

Sustituyendo las (41 y (42) en (18) y (19) y simplificando tenemos:

$$\mathcal{E}_{M} = \frac{\mathcal{E}_{A} + \mathcal{E}_{C}}{2} + \frac{1}{\sqrt{2}} \sqrt{(\mathcal{E}_{A} - \mathcal{E}_{B})^{2} + (\mathcal{E}_{B} - \mathcal{E}_{C})^{2}} \qquad [43].$$

$$\mathcal{E}_{m} = \frac{\mathcal{E}_{A} + \mathcal{E}_{C}}{2} - \frac{1}{\sqrt{2}} \sqrt{(\mathcal{E}_{A} - \mathcal{E}_{B})^{2} + (\mathcal{E}_{B} - \mathcal{E}_{C})^{2}} - [44]$$

$$\mathcal{E}_{M-m} = \pm \sqrt{2} \sqrt{(\mathcal{E}_{A} - \mathcal{E}_{B})^{2} + (\mathcal{E}_{B} - \mathcal{E}_{C})^{2}} - [45]$$

El ángulo β_{M} será el que forma la dirección principal máxima con la dirección A.

Los valores de las tensiones máxima y mínima

$$S_{\text{M·m}} = \frac{E}{2} \left[\frac{\varepsilon_{\text{A}} + \varepsilon_{\text{C}}}{1 - \mu} \pm \frac{\sqrt{2}}{1 + \mu} \sqrt{\left(\varepsilon_{\text{A}} - \varepsilon_{\text{B}}\right)^{2} + \left(\varepsilon_{\text{B}} - \varepsilon_{\text{C}}\right)^{2}} - \frac{\left[47\right]}{1 + \mu} \right]$$

Las fórmulas (47) y (48) dan directamente los valores de las tensi<u>o</u> nes principales a partir de los valores de las deformaciones en las direcciones A, B y C.



Las ecuaciones anteriores corresponden a una banda extensométrica roseta rectangular como la indicada en la fig. 22.

lo de Mohr.

Vamos'a ver gráficamente como se

determinan las deformaciones principales a partir de las deformaci<u>o</u> nes \mathcal{E}_{A} ; \mathcal{E}_{B} ; \mathcal{E}_{C} valiéndonos del círc<u>u</u>

Sobre el eje x (fig. 23) traslade-

mos los valores $\mathcal{E}_{A_{j}}\mathcal{E}_{B}$ y \mathcal{E}_{C} . En el círculo \mathcal{E}_{A} y \mathcal{E}_{C} tienen que estar - defasados 180°; por lo que el cen

tro del mismo será $c_1^{\ell} = \frac{\mathcal{E}_{A} + \mathcal{E}_{C}}{2}$ la di rección de \mathcal{E}_{B} estará en el cír

culo defasada 90º; por lo que debe

cumplirse la igualdad de los trián gulos 0'88' = $o'_{CC'}$ con lo que hemos



\$1022

determinado, $r_{=} \overline{Co'}$

En el círculo observamos que desde el punto A que corres ponde a \mathcal{E}_A tenemos que correr un ángulo positivo $\mathcal{E} \propto$ para llegar a $\mathcal{E}_i : \mathcal{E}_M$; por lo tanto y sobre la banda roseta desplazaremos un ángulo para la dirección de la deformación principal máxima. El ángulo \propto es el que forma la dirección principal máxima tomada como referencia y la dirección A, considerando como positivo el sentido contrario al gir o de las agujas del reloj.

Conocido el círculo de Mohr de deformaciones fácilmente se deduce el de tensiones (ver. 1.6) de la fig. 23 se deduce:



1.10 CALCULO TABULADO PARA ROSETAS RECTANGULARES

Sean \mathcal{E}_{A} ; \mathcal{E}_{B} ; \mathcal{E}_{C} las medidas de las bandas, A, B y C.

1) Cálculo de d: $d = \frac{E_{h} + E_{c}}{2} (con su signo)$ Ēa 2) Cálculo de r: Anotar los 3 valores con su signo -Restar $(-\xi_{R})$ a los3valores, se obtiene. Anotar el signo que corresponda al mayor valor de αόβ en valor absoluto 🛏 Sea, por ejemplo, & ese número. Dividir & y ß por 🗙 con su signo. Se obtiene -Y puede ser positivo o negativo, pero inferior a l en valor absoluto. Buscar en la tabla I el valor W que corresponde a Y Se tiene que: $r = |\alpha| W$ (Número positivo) Las deformaciones principales son: E,=d+r En= d-r Buscar en la tabla II, el ángulo que corresponde a Y con su signo.∝ está comprendido entre O y 45º. Llevar el ángulo 🔍 en sentido externo (que se aleje de la referencia O) sobre el eje marcado con el l. dirección obtenida es: La Máxima si anotamos el signo 🕂 🧲 Mínima si anotamos el signo 🗕 🛹

SQR **A** 13

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0,36 4 0,37 0,38 1 0,39	0,7515 0,7540 0,7564 0,7590	17 42 67 92	20 44 69 95	22 47 72 97	01 25 49 74	03 27 52 77	05 30 54 80	08 32 57 82	10 35 59 85	13 37 62 87
0,40 0,41 0,42 0,43	0,7616 0,7642 0,7669 0,7697	18 45 72	21 48 75	24 50 77	00 26 53 80	03 29 56 83	05 32 58 86	08 34 61 89	11 37 64 91	13 40 66 94
0,44 0,45 0,46	0,7725 0,7754 0,7783	00 28 57 86	03 31 60 89	06 34 63 92	08 37 66 95	11 40 69 98	14 42 71	17 45 74	20 48 77	22 · 51 80
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0,62	0,8320 0.8357 0,8395	24 61 99	27 65	31 69	35 72	.39 76	42 80	46 84	12 50 88	10 54 91

IABLAS PARA EL CALCULO CON ROSETAS DE 45º

TABLA Nº 1

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		8796	0521303	32 387	<u>1</u> <u>1</u> <u>1</u> <u>1</u> <u>1</u> <u>1</u> <u>1</u> <u>1</u> <u>1</u> <u>1</u>
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		8958 72 8958 72	70 81	85 -89 6	0 54 58 63 4 98 03 07
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TABLA Nº 1	0.81 0 0.82 0 0.83 0	.9100 04 .9144 49 .9189 94	09 13 53 58 58 24	18 62. 5 62. 5 67 7	6 31 35 40 11 76 80 85
(continuación)	0,84 0	.9235	44 - 48 - 48 - 48 - 48 - 48 - 48 - 48 -	107 - 12 - 1 53 - 57 - 6 99 - 6	773 21 126 30 32 87 F 71 76
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n an	<u></u>		2	4 5	5 7 8 9
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	ع: 0,6	7.0 6,8 9.2 9.0	88 85	6,2 6,0 5	3,8 5,6 5,4 52 7,9 7,7 7,4 72
TABLA Nº 2	-0.4 -0.3 -0.3	11.6 11.4 14.1 13.9 1681 166	11,1 10,9 13,6 13,4 163 160	10.6 10.4 10 113.1 12.9 12	9.9 97 94
-	- 0,1 - 0,0	19,7 19,7 22,5 22,2	19,1 18,8 21,9 21,7	18,5 18,2 17 21,4 21,0 20	7.2 13.0 14.7 14.4 7.9 17.7 17.4 17.1 0.8 20.5 20.2 19.9
	+ 0.0 + 0.1	22.5 25.3 25.6	23,1 23,3 25,9 26,2	23.6 24.0 24 26.5 26.8 27	1.2 24,5 24,8 25,1 7,1 27,3 27,6 27,9
	+ 0,2 + 0,3 + 0,3 + 0,3 + 0,3 + 0,3 + 0,2	28.2 28.4 30.9 31.1 33.4 35.6	28,7 29,0 131,4 31,6 33,9 34,7	29,2 29,5 29 34,9 - 32,1 - 32 34,4 - 34,6 - 34	1.8 30,0 30,3 30,6 2.4 332,7 32,9 33,2 4.9 35,1 35,3 35,6
· · · · · · · · · · · · · · · · · · ·	+ 0,5 ೪ಡ.೯್	35.8 36.0	36,2 36,5 38,4 38,8	36,7 36,9 37	37,3 37,6 37,8 39,59,49,9,84,657
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1.11 BANDAS DE TRES DIRECCIONES O RESITAS (EQUIANGULARES)

Las direcciones arbite rias de la medida de tres defo<u>r</u> maciones en un punto podemos hacer que estén defasados 120º con lo que la banda tiene la geometría indicada en la fig. 24 y por consideraciones análogas al caso de la reseta rectangular encontramos los resultados que se indican



siendo 🖯 el ángulo de la dirección principal máxima con la dirección A.

Gráficamente podemos encontrar la solución llevando sobre el eje X del diagrama de Mohr los valores de $\mathcal{E}_A, \mathcal{E}_B$ \mathcal{F}_C (fig. 25).



El centro del círculo sera d= $\frac{\mathcal{E}_A + \mathcal{E}_B + \mathcal{E}_c}{3}$; sobre las dos proyecciones que queden a la derecha o a la izquierda del centro O; se levanta MM[®] perpendicular en el punto medio de las dos proyecciones y desde O' se traza una recta que forma 60° con el eje X, el punto de intersección M nos dá el radio del círculo $\Gamma = 0^{\circ}M$. Aparen temente hay dos soluciones pero los puntos A[®]-B[®] y C[®] no guardan en el circulo el defase de 240° de acuerdo con la orientación de las - direcciones d. la bandu

De la fig. 25 deducimos:

$$d = \frac{\varepsilon_A + \varepsilon_z + \varepsilon_B}{3}$$

$$\varepsilon_1 : d + \tau$$

$$\varepsilon_2 = d - \tau$$

$$t_2 2x : \frac{\sqrt{2} (t_A - \varepsilon_1)}{2\varepsilon_A - \varepsilon_B - \varepsilon_C}$$

$$\tau = \frac{\varepsilon_A - d}{\cos \varepsilon_A}$$

$$\sigma_{1} = \frac{E}{1 - \mu^{2}} \left(\varepsilon_{1} + \mu \varepsilon_{2} \right)$$

$$\sigma_{1} = \frac{E}{1 - \mu^{2}} \left(\varepsilon_{2} + \mu \varepsilon_{1} \right)$$

1.12 CALCULO TABULADO PARA ROSETAS EQUIANGULARES

Sean $\mathcal{E}_{A}, \mathcal{E}_{B}$ \mathcal{E}_{C} las tres medidas con su signo 1) Cálculo de d: $d = \frac{\epsilon_A + \epsilon_{B+}\epsilon}{2}$ 2) Cálculo de r: Anotar las tres medidas según su dirección В

Q

X

β

Uno al menos de los valores medios, es algebraica mente igual o menor que los otros dos. Sea por ejemplo \mathcal{E}_c . Se suma (- \mathcal{E}_c) a los tres valores. Se obtiene así O y dos números positivos 🏾 🎽 β

Dividimosa continuación por el número mayor & o etasea por ejemploß

En la tabla III se obtiene un núm<u>e</u> ro U=f(x), tal que r= $\beta \cdot V$ $\mathcal{E}_{1} = d + r$ $\mathcal{E}_{2} = d - r$

3) Cálculo de 🏼

La tabla IV dá el ángulo en función de X. Este án gulo comprendido entre O y 30º se lleva sobre el esquema de direcciones haciendo girar un ángulo 🧳 la dirección marcada con l en el sentido que se aproxima a la dirección marcada con O. La dirección obtenida es la algebraicamente máxima.

: :	×	0	1	2	з	4	5	C	7	8	9 j		
:	0,00 0,01	0,6667 34	63 30	60 27	57 24	53 20	50 17	47 13	43 10	40 07	39 04	0,6634 01	0,83 0,83
:	0,02 0,03 0,04	0,6569 37	98 66 34	95 63 31	91 59 28	88 56 25	85 53 22	82 50 19	79 47 16	75 44 13	72 41 09	0 6! 69 37 06	0,97 0,96 0,95
•	0,05 0,06 0,07	0,6476 46 16	73 43 14	70 40	97 67 37 08	94 64 34 05	91 61 31 02	88 58 28	85 55 25	82 52 22	79 40 20	0,6476 46 17	0,94 0,93 0,92
:	0,09 0,10 0,11	0,6388 60 32	85 57 29	82 54 26	79 51 24	76 .48 21	74 46 18	99 71 43 16	96 68 40 13	94 65 37 10	91 62 35 08	0,6387 60 32 04	0,91 0,90 0,89 0,88
!	0,12 0,13 0,14 0,15	05 0,6278 52 27	02 76 50 25	99 73 47 22	97 70 45 20	94 68 42 17	92 65 40	89 63 37 12	86 60 35	84 58 32 07	81 55 30 04	0,6278 52 27 02	-0,87 0,86 0,85 0.85
: 	0,16 0,17 0,18 0,19	0,6178 55 32	00 76 53 30	98 74 50 28	95 71 48 26	93 69 46 23	90 67 44 21	88 64 41 19	86 62 39 17	83 60 37 14	81 57 34 12	0,6178 55 32 10	0,83 0,82 0,81 0,81
•	0,20 0,21 0,22 0,23	10 0,6089 68 48	08 86 66 46	06 84 64 44	04 82 62 42	01 80 60 40	99 78 58 38	97 76 56 36	95 74 54 34	93 72 52 32	91 70 50 30	0,6039 68 48 28	0,79 0,78 0,77 0,76
;	0,24 0,25 0,26 0,27	28 09 0,5991 74	26 07 89 72	24 05 88 70	22 03 86 69	20 02 84 67	19 00 82 65	17 98 80 64	15 96 79 62	1.3 95 77 60	1-1 93 75 59	09 0 5991 74 57	0,75 0,74 0,73 0,72
:	0,28 0,29 0,30 0,31	57 41 25 10	55 39 24 09	54 38 22 08	52 36 21 07	50 35 20 05	49 33 18 04	47 32 17 02	46 30 15 01	44 28 14	42 27 13	41 25 11	0,71 0.70 0,69
•	0,32 0,33 0,34 0,35 0,36	0,5897 64 71 59 48	96 82 70 58 47	94 81 69 57 46	93 80 68 56 45	92 79 66 55 44	90 77 65 54 43	89 76 64 53 42	88 75 63 52 41	99 86 74 62 51 40	98 85 72 60 50 39	0,5857 84 71 - 59 48 38	0.68 0.67 0.66 0.65 0.64 0.63
•	0.37 0,33 0,39 0,40 0,41	38 29 20 12 05	37 28 19 11 04	36 27 18 10 03	35 26 17 10 03	34 25 17 09 02	33 24 16 08 01	32 23 15 07 01	31 22 14 07 00	30 22 13 06	30 21 13 05	29 20 12 05	0,62 0,61 0,60 0,59
	0,42 0,43 0,44 0,45 0,46 0,47 0,48 0,49	0,5798 92 87 83 80 77 75 74	97 92 87 83 79 77 75 74	97 91 86 82 79 77 75 74	96 91 86 82 79 76 75 74	96 90 80 82 78 76 74 74	95 90 - 85 81 76 74 74	95 89 85 81 78 76 74 74	94 89 84 76 74 74	99 93 88 80 77 75 74 74	99 93 88 83 80 77 75 74 73	0,5798 92 87 83 80 77 75 74 0,5773	0.58 0,57 0,56 0,55 0,54 0,53 0,52 0,51 0,50
			9	8	7	6	5	4	3	2	1	0	x
		s.		•. •:					•		•	:	
	×	0 1		2	3		4	•5		6	7	8	9
	0,0 0,1 0.2 0,3 0,4 1	0,00 0.2 2,61 2,8 5,45 5,7 8,50 8,8 1,70 12,0	5 0 8 3 4 6 2 9 3 12	50 16 04 13 36	0,76 3,43 6,34 9,45 12,69	1 3 6 9 13	.01 ,72 ,64 ,77 ,02	1,28 3,99 6,99 10,09 13,39	5	1,53 4,28 7,26 0,41 3,68	1,80 4,55 7,55 10,73 , 14,01	2.07 4.87 7.92 11,06 14,34	2,33 5,15 8,18 11,38 14,67
	0.5 0.6 0.7 0.8 0.9 1.0	5.00 15.3 18.30 18.6 21.50 21.8 24.55 24.8 27.39 27.6 30.00	3 15 2 18 2 22 5 25 7 27	,66 .94 .08 .13 .93	15,99 19,27 22,43 25,42 28,20	16 19 22 25 23	.32 .59 .74 .72 .47	16,65 19,91 23,05 26,01 28,72		6,98 0,23 3,36 6,28 8,99	-17,31 20.59 23,60 26,57 29,24	17,64 20,87 23,96 26,84 29,50	17,97 21,18 24,26 27,12 29,75

TABLAS PARA EL CALCULO CON ROSETAS DE 120º

TABLA Nº 3

TABLA Nº 4

ABACO PARA EL CALCULO DT TENDIONES (Para 2 medidas según las direcciones (principales)



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Cuando la dirección de los ejes princi palès es conocida de antemano, como por ejemplo un cilindro bajo previón (fig. 26), con solo medir las deforep ciones en dos direcciones perpendiculares que coincidan con las direcciones principales, será suficiente para determinar el estado de tensiones en un punto



Se incluyen ábacos para el **cá**lculo rápido de tensiones a partir de las lecturas en microdeformaciones.

1.14 EXTENSIMETROS UNIDIRECCIONALES

Si se conoce la dirección principal de esfuerzos y esta es única, como en la tracción pura, la tensión es obtenida aplicando la ley de Hooke.

$$\sigma_1 = \varepsilon_1 \in \varepsilon_2 = \mu \varepsilon_1$$

$$\sigma_2 = 0$$

1.15 CORRECCIONES DEBIDAS AL EFECTO DE LA SENSIBILIDAD TRANSVERSAL

Como vimos en el apartado 1.2 el efecto de sensibilidad transversal en el extensímetro, puede tener influencia en los result<u>a</u> dos, sobre todo cuando se emplean bandas rosetas. A continuación se indican las correcciones que deben efectuarse sobre los valores de de formaciones principales, así como sobre la distancia del centro y radio del círculo de Mohr.

Sea $\mathcal{E}_{\mathcal{M}} \cdot \mathcal{E}_{\mathcal{m}}$ los valores de las deformaciones principales calculados y K₊ el factor de sensibilidad transversal, los ve<u>r</u> daderos valores

$$\begin{aligned} \varepsilon_{M}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 + \kappa^{2}} \left(\mathcal{E}_{M} - \mathcal{K}_{t} \varepsilon_{m} \right) \\ \varepsilon_{M}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 + \kappa^{2}} \left(\mathcal{E}_{m} - \mathcal{K}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{K}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{K}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{K}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{K}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \kappa^{2}_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{t} \varepsilon_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m} - \mathcal{E}_{m} \right) \\ \mathcal{E}_{m}^{\text{valores}} &= \frac{1 - \mu K_{t}}{1 - \mu K_{t}} \left(\mathcal{E}_{m$$


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PRUPIEDADES DE LLS NETALES DE USD MAS CONNELLATE

			14 A				-			
	Module dYoung E (1000 kg tranit)	Carflicient de Porsson ju (s.d.)	<u></u> Γ i μ	<u></u> Ε μ	<u>Ι</u> Ιμ ²	0 †	σo	· · / · ·	i RS isso Ist State RSa SikgtauP	Interenses 10 * prC
Acter de Construction Acter 45 SC 0.6 Acters resistants usure Acters resistants usure Acter inoxydalie 18-10 Invar	21,0 22,0 22,0 20,3 14,1	0,285 0,285 0,29 0,29 0,29 0,29	16,34 17,12 17,06 15,74 10,93	29,37 30,77 30,93 28,59 16,86	22,87 23.97 24.52 22,16 15,39	-	20 5 60 145 18 5 22 40 3 55	1 1 1 1 1	7 80 7,80 7,82 7,93	13 13 25 16,5 < 0,9
Fontes grises contantes . Fontes grises auto Fontes grises lingetières . Fonte graphile sphéroidal . Fontes blanches nun alliees Fontes malléables	9 a 12 10 a 13 5 a 8 16 a 18 16 a 20 17 a 19	0,29 0,29 0,29 0,29 0,29 0,29 0,17	7,0 à 9,3 7,7 à 10,0 3,9 à 6,2 12,4 à 14,0 12,4 à 15,5 14 à 16	12,7 à 16,9 14,1 à 18,5 7,0 à 11,2 22,2 à 25,4 22,2 à 28,2 20,5 à 22,9	9,8 5 12,1 10,9 5 14,2 5 4 5 7 17,5-5 19,6 17,5 5 21,8 17,5 5 19,5	7 & 9 10 & 15 17 & 35 16 & 38	18 à 25 -22 à 35 8 à 12 26 à 60 20 à 40 20 à 60	3,3 3,4 3,5 1,2 5	7,1 à 7,2 7,1 à 7,4 7,1 à 7,2 7,1 à 7,3 7,5 à 7,8 7,5 à 7,8 7,2 à 7,4	9 ð 11 9 ð 11 9 ú 11 11 ð 12 9 h 11 9 à 11
Titane Alliage titane 6A14V Alliage titane 1A6V Alumphium Alliage alu AU 4 G Alliage alu AU 2 GN Alliage alu AU 2 GN Alliage alu AU 5 GT Alliage alu AU 3 GT	10.55 10.9 10.5 7.05 7.5 7.5 7.0 7.0 7.2	0,34 0,34 0,34 0,34 0,34 0,34 0,34	7,87 8,13 7,83 5,26 5,63 5,60 5,22 5,37	15,98 16,52 15,91 10,68 11,15 11,36 10,61 10,91	11,93 12,33 11,88 7,98 £,41 8,48 7,92 P 14	10 à 25 60 12 12 10	20 à 47 90 20 37 22 à 26	1	4,51 4,42 2,8 2,8 2,8 2,8	8,9 8,0 23,5 22 à 24 23 23 5
Cuivre Laiton Bronze ordinaire Bronze au beryflium Beryflium Magnésium	10,0 9,2 10,6 13 30,0 4,60	0,33 0,33 0,31 0,34 0,05 0,34	7,51 6,92 8,09 9,70 2£,57 3,43	14,92 13,73 15,36 19,70 31,58 6,97	11,22 10,33 11,73 14,71 30,08 5,20	20	18 20 24 80 30	1,3 1,4 3 3 1	8,9 7,30 8,40 8,25 1,85 1,74	17 18 17,5 17 12,4 25,6
Marbre	2.6 1.4 a 2,1 6 0.29 0,30	0.3 0.3 0.2 4 0.3 0.4 0.4	2,00 1,1 à 1,6 5,0 à 4,6 0,207 0,214	3,71 2,0 à 3.0 7,5 à 8,6 0,483 0,500	2,86 1.5 à 2,3 6,2 à 6,6 0,345 0,357		50 30 3 à 8 8 5 à 8	15 11 10 1,2 1,2	2,8 1,9 1,8 1,15	8 14 80 à 90 90 à 130
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1.16 PROBLEMAS DE CALCULO EXTENSOMETRICO

Problema nº 1



Una barra de acero está sometida a una tracción pura, montándose una banda en el sentido de la tracción. Ca<u>l</u> cular las tensiones principales, si leemos 1275 u é y el acero de la barra tiene E= 21000 Kg/mm² y /u= 0,28

Problema nº 2



En un depósito calindrico de aluminio (E= 7200 Kp/mm²; /u= 0.33) se admite que las direcciones principales coinciden con los ejes vertical y horizontal y en tales direcciones se montan dos bandas extensométricas respectivamente. Las lecturas bajo carga son:

para $J_1 = \frac{1}{2} = \frac{1$

Calcular las tensiones en este punto.

Problema nº 3



En un eje cilíndrico de acero (E= 21000 Kp/mm²/u= 0,28) de 80 mm de diámetro se han montado dos bandas, J_1 y J_2 a 45º respecto a su eje. El eje no sufre flexión, pero si una compresión P y un cumento de torsión M.

En el curso de una primera experiencia, se obtienen como lecturas las siguientes:

$$\mathcal{E}_{i} = -\mathcal{E}_{i} = 1830 \, \mu \delta$$

¿Cuales son las tensiones en el punto? ¿Cual la fuerza de compresión y el par?

En una segunda experiencia se obtiene

 $\epsilon_1 = 2560/u\delta$ y $\epsilon_2 = -1080/u\delta$

¿Cuales son la fuerza P y momento M?

Los problemas siguientes, se refieren el cálculo de setas, en ellos deberemos calcular:

- Direcciones principales máximas y minimas

- Deformaciones y tensiones máxima y mínima.

Problema nº 4

Roseta de 45º $E = 7200 \text{ Kp/mm}^2$ /u = 0,34 Lecturas: $A = -3790 / u^{1}$ $B = -3220 / u^{1}$ $C = -4750 / u^{1}$

Problema nº 5

E =	7200 Kp/mm	2 /u= 0,34
Α=	+ 2080 /u :	
B=	- 1800 /u a	1
C=	- 1200 jù	5

Problema nº 6

E =	21000 Kp,	/ mm ²	/u= 0,29
Α=	+ 3580 ju à		/
B≂	+ 1930 א	,)	
C=	+ 1370 juč)	· · ·

Problema nº 7

 $E = 21000 \text{ Kp/mm}^2$ $\mu = 0,29$ $A = + 1,792 \mu \delta$ B= 817 ú Ó ې ۲ 898 C≈

Problema nº 8

E= 21000 Kp/mm² /u= 0,29 A= + 340 /u ξ B= + 520 /u ξ C= - 710 /u ξ

Dar directamente las tenciones, sin pasar por deformaciones.



Rosetas de 1:209 $E = 7200 \text{ Kp/mm}^2$ /u= 0,34 $A = + 2400 \text{ /u} \frac{1}{2}$ $B = + 2010 \text{ /u} \frac{1}{2}$ $C = + 1370 \text{ /u} \frac{1}{2}$

Problema nº 10

 $E = 7200 \text{ Kp/mm}^{2} / u = 0,34$ $A = + 4410 \mu \dot{c}$ $B = - 540 \mu \dot{c}$ $C = - 1920 \mu \dot{c}$

Problemas nº 11

E= 21000 Kp/mm² /u= 0.29 A= -120 μc B= +540 μc C= +310 μc

Problema nº 12

 $E = 7200 \text{ Kp/mm}^{2}$ $A = + 1795 \mu \delta$ $B = + 1803 \mu \delta$ $C = + 1812 \mu \delta$

_u= 0,34

II TECNICA DE UTILIZACION DE LAS BANDAS EXTENSOMETRICAS

2.1. FABRICACION DE BANDAS EXTENSOMETRICAS

Una banda extensométrica está formada por dos elementos fundamentales que son el soporte y el conductor eléctrico sensible a las deformaciones, habiendo evolucionado grandemente la constitución y técnicas de fabricación de dichos elementos.

En un principio, se emplearon con gran difusión soportes de papel y conductores de sección circular colocados según la fig. 1,





fig2

pero entre otros, presentaban los graves inconvenientes de la higroscopidad del papel, que hacía perder el aislamie<u>n</u> to de la banda y el elevado factor de sensibilidad transversal en las partes curvas del conductor, intentándose compensar éste último efecto dando forma de zig-zag u otros diseños ingeniosos (fig 2). Actualmente una banda de calidad se fabrica sobre soportes de resinas epóxicas y por el procedimiento de fot<u>o</u> grabado, se consiguen formas y dimensiones imposibles por los métodos clásicos (fig 3), ya que los modelos pueden hace<u>r</u>se a escalas muy aumentadas, constituyen-

éstas las llamadas bandas de trama pelicular o de film metálico.

Los principios en que se basa la extensometría, suponen que las isostáticas de la estructura bajo ensayo, pasan a través de la parte activa del extensimetro y se ha podido comprobar por fotoelasticidad, que en un extensimetro pegado a una estructura, solo en sus extremidades hay distorsión de aquellas, y nó en la zona central; por dicho motivo, dando a la banda la forma indicada en la fig. 4, conseguire



mos establecer en los extremos de los conductores activos una zona de anclaje en la que se inciden los isostáticas y por su mayor sección respecto a la parte activa la variación unitaria de resiste<u>n</u> cia es menor y despreciables los coeficientes de sensibilidad transversal y longitudinal. La posibilidad de disponer de superficies adecuadas par ra la soldadura de los cables y la transparencia de los soportes, que permiten una colocación óptima del extensímetro, añaden ventajas a éste.

Las aleaciones del metal conductor responden a las cara<u>c</u> terísticas específicas de cada tipo, siendo a veces riguroso secreto el proceso de fabricación, en el que se incluyen técnicas sofisticadas para conseguir mejoras en la utilización de extensímetros. A título de ejemplo, en la serie CEA de la casa Vishay-Micromesures, el tratamie<u>n</u> to dado a los extremos para soldadura de cables, hace posible que la unión soldada tenga mayor resistencia mecánica a la tracción que el cable que normalmente se útiliza, ventaja ésta que confiere seguridad







a una medida extensométrica.

Otras ventajas de las bandas de film metálico residen, en que dado su pequeño es pesor (4 micras), no introducen errores en la medida de deformaciones de secciones delgadas y se adaptan mejor sobre cualquier superficie (fig. 5).

Dejando al margen las bandas semiconductoras (de las que nos ocuparemos en otro capítulo) vemos en lo expuesto, que el verdadero sensor de las deformaciones es el conductor, siendo el soporte un medio de transición con la estructura, por lo que exige del pegado a la misma (bonded strain gauge) pero, en aplicaciones para fabricación de transductores, suele emplearse el conductor suelto montado sobre

zaffros aislantes, (fig.6) que se deforma bajo estímulos mecánicos, sin necesidad del soporte propiamente dicho (unbonded - Strain-gauges).

La banda puede ser posteriormente sometida a recubrimientos y opciones tales como inclusión de hilos de salida soldados, que en determinadas aplicaciones resultan de interés.

2.2 CARACTERISTICAS TECNICAS

22.1 Valor Shmico.

El valor de la resistencia óhmica de una banda viene condicionado por motivaciones de tipo eléctrico, y hay razones para que dicho valor sea elevado de una parte o pequeño de otra, por lo que debe establecerse un compromiso entre las posturas extremas.

Motivos que aconsejan un valor elevado de resistencias: 1. Señales elevadas para debiles deformaciones, en efecto, la señal es función de la tensión de excitación, por lo que conviene que ésta sea elevada, pero para que no circule una corriente excesiva, que – por efecto Joule produzca un calentamiento inadecuado, el valor ôhm<u>i</u> co será alto.

2. Evitar los errores producidos por las resistencias de contacto de los conmutadores y líneas de conexión a los instrumentos, pues siendo éstos valores pequeños su influencia será menor cuando mayor sea la resistencia de la banda.

Motivos que aconsejan valores pequeños de resistencias 1. Evitar la caída de tensión interna considerando a la banda como generador de tensión.

2. Conseguir mejor aislamiento eléctrico entre la banda y la estructura.

 Mayor robustez, pues resistencias elevadas obligan a conductores de muy pequeña sección y por tanto frágiles.

Por lo expuesto se ha establecido como valor normal y de uso más generalizado el de 120 ohmios, siendo también muy empleados los 350 (generalmente en transductores) 600 y 1000 ohmios.

Las tolerancias de fabricación son muy estrechas O,15% con el fín de poder equilibrar los circuitos de medida, pero no sería práctico un exceso de dicha tolerancia en límites que puedan confundirse con la variación lógica, que por efecto de montaje, sufriría la banda en su instalación. La exactitud de la medida no será afectada, por ligeras dispersiones del valor nominal.

También se construyen bandas con valores nominales que son fracciones de los indicados para los casos en que la medida requiere un circuito con dos, tres ó cuatro bandas en serie (se hacen de 30, y 60 óhmios u otros valores que no suelen ser standard).

2.2.2. FACTORES DE SENSIBILIDAD

En el estudio teórico de las bandas extensométricas -(1,2) vimos que hay dos factores K1 y K2 que relacionan la variación unitaria de resistencia del conductor con la deformación que sufre en sentido longitudinal y transversal respectivamente por efecto de las solicitaciones a que esté sometido el elemento donde se instala la banda.

La variación de la resistencia es motivada por el cambio de la geometría del conductor y de la conductividad, pero si bién el primer factor afecta prácticamente igual a todos los metales, el segundo es función de la aleación empleada en la fabricación del extensímetro y es por esta razón por lo que la forma y dimensiones de la banda no influyen sobre el factor de sensibilidad.

Los constructores de bandas, utilizan procesos de fabricación que mantienen el valor del factor de sentibilidad dentro de unas tolerancias estrechas en una serie, por lo que es importante en medidas con varios extensímetros procurar que no haya dispersión en dichos valores.

Por razones de la instrumentación asociado a las medidas extensométricas, se toma como valor nominol de la sensibilidad longitudinal de las bandas el de 2 y tolerancias admitidas como muy buenas son del <u>+</u> 0,5%. El factor de sensibilidad transversal se expresa en tanto por ciento del longitudinal y no debe ser superior al 1%.

El fabricante indica el valor de K obtenido en unas co<u>n</u> diciones determinadas de temperatura y sobre nedidas efectuadas con probetas de módulo de elasticidad y coeficiente de Poisson conocido, incluyendo curvas (fig. 7) donde se indica la variación del factor K respecto a variaciones de temperatura.

Para medir el factor K se utilizan balanzas de calibración basadas en producir una flexión circular a una probeta-en la que se montan bandas correspondientes a una misma serie.



2.2.3. RESPUESTA DE TEMPERATURA

Una banda extensométrica mide todas las deformaciones que experimente el elemento sobre el que se monta, pero sabemos que las deformaciones producidas por dilataciones térmicas homogéneas no



crean tensiones, por tanto (fig. 8) si consider<u>a</u> mos una viga empotrada en un extremo sin carga a<u>l</u> guna y hay variación de temperatura, aquella se dilatará y habrá una deformación que acusará la banda, pero por no originar tensiones, debe ser considerada como error.

El error por variación de temperatura se corrige, dentro de ciertos límites, fabricando el conductor de la banda con coeficientes térmico de variación de la resistividad de igual valor y signo contrario al del coeficiente de dilatación líneal del cuerpo sobre el que montan.

En efecto: Ro: Po 5 Rt= Po (1+Bt) - lo (1+at) $\Delta R = R_t - R_s = \frac{1}{s} [p_b + t + lop_b t] = 0$ Q = - B

Ascoeficiente dilatación lineal Ascoeficiente de variación térmico de resistividad

-5-

La relación 🏹 = 🛱 solo es lineal dentro de unos límites de temperatura para los cuales se dice que la banda está autocompensada, los f<u>a</u> bricantes indican la curva de respuesta en temperatura de las bandas expresadas como microdeformaciones aparentes (fig.9).

En la fig. 8a vemos que al dilatarse la viga, si la ban da es autocompensada, no experimentará variación alguna en su resistencia, por el contrario (fig.8b) si la viga está empotrada en sus ex tremos, se originan esfuerzos de compresión cuando dilate y la banda por tener el coeficiente $-\beta$ acusará un incremento negativo en la variación unitaria de resistencia, acusando precisamente la compresión habida.

Una banda solo puede ser compensada para materiales que tengan idéntico coeficiente de dilatación. Normalmente se compensan – para acera $(2*41.6^{\circ}/^{\circ}C)$ y aluminio $(2*23.6^{\circ}/^{\circ}C)$.

Veremos en el capítulo de técnicas de Medida, que los efectos de origen térmico pueden compensarse con disposiciones de mo<u>n</u> taje adecuados.



figlo

2.2.4. LINITES DE DEFORMACION: ESTATICA Y DINAMICA

La máxima deformación que puede soportar un extensímetro bajo carga estática se expresa en %, de la longitud de su rejilla o parte activa y depende de varios factores, entre ellos: a) Temperatura de utilización. El valor indicado por el fabricante se refiere a temperaturas ambientes (24°C) pero a temperaturas criogénicas, la deformación es solo una pequeña fracción de dicho valor.

b) Ductibilidad de la aleación que constituye el conductor sensible.

c) Malechilidad del soporte de la banda y del adhesivo.

d) Forma y dimensiones del extensímetro.

e) Calidad del montaje en la extructura

Los bondos impresos de trama películar, admiten mayor deformación estática que los de hilo.

El fenómeno de fatiga bajo cargos alterna, presenta aspectos que influyen en las medidas y deben tenerso en cuenta pues pue den introducir errores.

El conductor metálico del extensimetro cuando so monte sobre estructuras sometidas a tensiones alternas, sufre una fatiga cuyo efecto principal es producir una deriva del valor ámmico de la banda, por èste motivo se ensayan las bandas sometiéndolas a ciclos de amplitud constante (1839, 1230, 10) observando cuando la deriva del valor ámmico representa una deformación aparente de 100, us , volor éste admitido como límite (fig. 10).



Si en una medida dinámica queremos obtener con exactitud los valores de las componentes estáticas y dinámica (fig. 11) prestaremos especial atención en la elección del extensímetro adecuado y s<u>o</u> bre todo se cuidará que las soldaduras de los hilos de conexión de los



instrumentos a la banda sean puntuales para evitar concentración de esfuerzo en la banda y que el tamaño de la misma sea muy pequeño, ya que son los factores más infl<u>u</u> yentes para evitar llegar al límite de fatiga. En un fenómeno vibratorio la deriva no tiene gran importancia si lo que inter<u>e</u> sa conocer es solamente la amplitud de la oscilación.

2.2.5. LIMITE DE LA RESPUESTA EN FRECUENCIA

Una banda extensométrica por tener una longitud finita, actua como un integrador de todas las deformaciones que ocurren a lo largo de la parte activa, por esta razón si la longitud de onda del fenómeno vibratorio que se quiere medir coincide con la longitud acti-



va de la banda (fig. 12) no acusaremos deformación alguna pues la mitad sufrirá alargamiento y la otra mitad compresión.

Las deformaciones son fenómenos que se propagan a la misma velocidad que el sonido, por tanto conocido éste valor y el de la frecuencia del fenómeno, la longitud de onda $\lambda = \frac{U}{P}$ nos indica el valor límite en el cual una banda de longitud activa=lat no causaría deformación.

Para evitar la anomalía anterior se admite como valor normal de l_{α} el 10% de λ con lo que el % de perdida de sensibilidad es prácticamente nulo (fig. 13), -7Se fabrican bandas con longitudes activas de 0,4 mm por lo que se pueden medir en aceros (0=5000 m/sg) frecuencias de 10^6Hz aunque la limitación en éste caso está en los instrumentos de medida.

Otros factores influyen en la limitación de la respuesta en frecuencia de las bandas, pues si bien la debil masa de inercia de la misma favorece el seguir fielmente un fenómeno dinámico, la elas ticidad de adhesivos y soportes debe tenerse en cuenta, aunque su voloración es dificil de obtener de forma experimental, debiendo curjarse la elección de adhesivos en medidas críticas.

2.2.6. FENOMENOS DE FLUENCIA E HISTERESIS

Supongamos que una probeta sobre la que hay montada una banda extensométrica es sometida a esfuerzos de tracción simple (fig 14) las deformaciones de la probeta son entonces transmitidas al conductor a través activo del adhesivo y del soporte, creandose unas solicitaciones de cor



tadura principalmente en los extremos de la banda,que deben compensarse con la fuerza antagonista: que se origina en el co ductor activo.

La calidad del adhesivo y su elasticidad determinarán la magnitud de la relajación -

del mismo bajo las solicitaciones constantes a que esté sometido y porconsiguiente que permita al conductor activo un lento retorno a su estado original. El fenómeno descrito es el de fluencia de una banda y tiene importancia considerable en medidas estáticas no siendolo tanto en medidas dinámicas.

Por la propia naturaleza del fenómeno, se vé que la temp<u>e</u> ratura juega un papel importante en la fluencia, así como las dimensi<u>o</u> nes de la banda, participando en razón inversa al tamaño.

Es práctica muy aconsejable, someter las probetas a car gas y descargas sucesivas de magnitud lo mayor posible, antes de efec tuar las medidas.

Ligado al concepto anterior puede considerarse el fenőmeno de histeresis, el cual ocurre cuando queda una deformación residual después de someter a solicitaciones la probeta sobre la que está instalada la banda, siendo el principal motivo de este fenómeno que el transmita al conductor activo.

2.2.7. NIVELES OPTIMOS DE EXCITACION

La señal eléctrica que obtendremos de cualquier circuito de medida con bandas extensométricas, será proporcional a la tensión de excitación del mismo, lo cual hace presumir el empleo de niveles el<u>e</u> vados de excitación, sin embargo hay razones para limitar dichos niveles.

La corriente eléctrica que circula por el conductor de una banda excitada, origina por efecto Joule, una elevación de temperat<u>u</u> ra al disiparse el calor producido, por cuyo motivo pueden aparecer las perturbaciones siguientes:

a) Alterar el efecto de autocompensación, cuya estabilidad es mejor con niveles bajos de excitación.

b) Modificación del estado de tensiones de la estructura bajo ensayo,
 al absorber ésta el calor disipado por la banda, sobre todo en materia les plásticos.

d) Derivas del cero, sobre todo en circuitos con varios bandas y en las cuales la disipación de calor no será igual y simultánea.

Los parámetros de mayor incidencia en la determinación del nivel óptimo de excitación.de una banda son:

l.- Superficie de la rejilla, cuya influencia afecta al poder de disipación de calor.

2.- Resistencia óhmica de la banda, que limita el paso de corriente.3.- Coeficiente de conductibilidad térmica de la estructura.

4.— Tamaño de la probeta o estructura donde se monta la banda, que determina el poder de absorción de calor.

5.- Condiciones ambientales.

6.- Calidad del montaje de la banda, cuidándose de que no hayan burbujas de aire entre el soporte y la probeta.

En la tabla I se indica la potencia por cm² que pueden disipar las bandas según los materiales donde estén montadas y para precisiones bajas, elevadas o medias (datos cortesia de Vishay-Micromesures). POTENCIAS RECOMENDADAS EN WATS/CM²

PRECISION	REQUERIDA
-----------	-----------

DISIPACION DE		ESTATICAS	•	•	DINAMICAS	
CALOR	ELEVADA	MEDIA	BAJA	ELEVADA	MEDI A	BAJA
Excelente. Piezas grandes de alumi- nio o de cobre	0,30 6 0,75	0,75 & 1,5	1,5 & 3	0,75 á 3	1,5 á 3	3 6 8
Buena, Piezas - grandes de ace- ro.	0,15 & 0,30	0,30 6 0,75	0,75 á 1,5	0,75 á 1,5	1,5 á 3	3 á 8
Media. Piezas pe- queñas de acero - inoxidable o tit <u>a</u> nio.	0,08 & 0,15	0,15 & 0,30	0,30 á 0,75	0,30 á 1,5	0,75 á 1,5	1,5 á 3
<u>Mala.</u> Plásticos, resinas epoxy.	0,01 6 0,03	0,03 6 0,08	0,08 6 0,15	0,08 & 0,15	0,15 á 0,30	0,15 á 0,75
<u>Muy mala</u> . Polie <u>s</u> tireno, materiales acrílicos.	0,001 & 0,003	0,003 á 0,008	0,001 á 0,03	0,001 á 0,008	0,003 6 0,015	0,03 & 0,08

90

La tensión de excitación se deduce a la fórmula:

Potencia disipada: <u>Ve²</u>= We_d en donde Ve= Tensióm de excitación en Voltios R = Resistencia nominal de la banda La potencia por unidad de superficie es

 $\frac{W_d}{S} = W$

Siendo S la superficie de la rejilla

Si solo disponemos de una fuente de alimentación con sa lida fija de tensión y esta es elevada para excitar el circuito de medida se ponen en serie unas resistencias que produzcan una caida de tensión determinada, pero sin olvidar efectuar las correcciones adecuadas por la perdida de sensibilidad que introducen las mencionadas resi<u>s</u> tencias.

2.3. PRACTICA DE MONTAJE DE BANDAS

2.3.1. Preparación de superficies

La instalación de una banda extensométrica tiene como fundamento la perfecta unión entre la banda y el cuerpo de ensayo.

Para el extensometrista cada montaje de circuitos de medida supondrá un aumento de su experiencia y una garantía de que su labor es satisfactoria, solo cuando por un exceso de confianza omite alguna de las operaciones que se indican como preceptivas, el error aparece, pero desgraciadamente no se manifiesta inutilizando la medida, sino dando como ciertos unos resultados falsos, de ahí que será criterio firme el observar toda la meticulosidad humaname<u>n</u> te posible, con la certeza de que, si así se hace, se obtendrá resultados que justificarán el empeño puesto.

La banda puede elegirse, dentro de ciertas opciones que ofrece el fabricante, adaptada a las condiciones de utilización, pero no así la superficie donde deba instalarse, por lo que ésta ú<u>l</u> tima deberá ser preparada por el usuario, así como la soldadura de cables que configuran el circuito de medida.

2.5.1. Preparación de superficies

Toda superficie que debe recibir una banda se someterá generalmente a unos tratamientos mecánicos y químicos para conseguir el mayor rendimiento del adhesivo, sin que dichos tratamientos puedan suponer una modificación local de las características del cuerpo a ensayar. Dimensionalmente, se tratará una superficie doble (como mínimo) de la superficie total de la banda.

El proceso prévio será el de limpieza y desengrasado, para el que se utilizará preferentemente cloroetileno de calidad, p<u>a</u> ra metales y freón para plásticos, para ello se deposita el desengrasante sobre la superficie (se facilita esta operación si viene e<u>n</u> vasado en spray) y sin dejarlo evaporar se seca con una gasa limpia y de una sola pasada, repitiendose esta operación hasta que la gasa aparezca totalmente limpia.

Conviene indicar que siempre que haya que limpiar o se car una superficie debe hacerse con una gasa limpia (no necesariamen te esterilizada) o a veces con papel absorbente tipo Kleenex pero pun ca con algodones que dejarían hebras depositadas. Además la limpieza se hará en una sola pasada y jamás utilizando la misma gasa para dos pasadas sucesivas, las razones son obvias ya que si la gasa es repasada sobre la superficie, en vez de limpiar por arrastre, por efecto de estar impregnada de disolvente, la suciedad o grasa existente se disolvería más, entrando en las minusculas oclusiones que existan.

En montajes sobre metales, recordemos que al estar con<u>s</u> tituidos por cristales orientados al azar, un pulido superficial presentaría el aspecto de un espejo al quedar incluidas entre los cristales las pequeñísimas partículas arrancadas, por lo que la adhesión y cohesión en estas zonas seria muy dudosa, por tal motivo se combina el tratamiento mecánico por abrasión con un ataque por un ácido debil.

El proceso de abrasión dependerá del estado inicial de la superficie comenzando con papeles de carburo de silicio de grano 400, 200 o 150 respectivamente y que previamente se ha humedecido con el ácido, atacando en sentidos alternativos y que formen 90º entre ellos, con el fín de en cada pasada, eliminar las "crestas" que sobre el metal se van marcando; la coloración peculiar que adquiere la superficie y la desaparición de las marcas en un sentido cuando se at<u>a</u> que a 90º, indican que esta operación está concluida, debiendose proceder inmediatamente al secado con gasas.

Posteriormente y de inmediato, la superficie se humedece con un producto neutralizador (solución alcalina detergente) con el fín de que su pH sea adecuado para recibir el adhesivo.

En resumen haremos lo siguiente:

lº Limpieza grosera, quitar óxidos pinturas, etc, en una superficie doble que la de la banda.

2º Desengrasado absoluto y secado.

3º Abrasión progresiva combinada con ácido y secado.

4º Neutralización y secado.

Lógicamente el proceso anterior es indicado para ciertos metales, pero siempre habrá que seguir las indicaciones concretas del fabricante o de la propia experiencia. Si se trata de superficies porosas como el caso del ho<u>r</u> migón, habrá que impermenbilizar la zona de asentamiento de la banda, consiguiendose buenos resultados dando después de la limpieza, una c<u>a</u> pa previa de adhesivo.

En vidrio y plásticos será suficiente el empleo de freón y su limpieza con gasas.

2.3.2. Trazado de ejes de referencia



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Una mala alineación de los ejes de la banda con la dirección en la que deseamos medir las deformaciones introduce errores que son función: de la relación entre las deformaciones máximas y mínimas, del ángulo que forma la dirección en la que se desea medir y la dirección de la deformación principal máxima y del ángulo β o errorde montaje de la bandc (fig. 15).

Como por razones de montaje solo podemos influir sobre β , tendremos que esforzarnos en conseguir que este error sea mín<u>i</u> mo, para ello hay que determinar sobre la superficie de asentamiento de la banda, los ejes de la dirección en que deseamos medir, pero te<u>n</u> dremos que tener en cuenta que no podemos bajo ningún pretesto, alt<u>e</u> rar el estado de preparación de la superficie según se explicó en el apartado anterior.

Algunos montadores utilizan (nefastamente) puntas de acero de trazar, que al producir pequeñas incisiones en el material, alteran su extructura, por tanto, nosotros recomendamos siempre que sea posible no trazar sino grabar químicamente los citados ejes.

Con los instrumentos adecuados a la precisión de la m<u>e</u> dida (escuadras, goniómetros, compás, trazadores ópticos de precisión etc. etc) buscaremos unas referencias ortogonales en los límites de la zona que se ha limpiado procurando que no haya contacto de los útiles con la superficie limpia, para evitar su contaminación; situ<u>a</u> das las referencias tracemos con un bolígrafo de punta fina o con un lapiz de grafito duro (5 ó 6) los ejes completos sobre la superficie preparada. Posteriormente, un palillo cuyo extremo lleve una bolita



fig17

de algodón (los utilizados en Pediatría y de venta en farmacias son muy adecuados) se humedece con ácido y se pasa sobre los trazos del bolígrafo o lápiz, secando a continu<u>a</u> ción y se repite la operación pero humedecie<u>n</u> do un nuevo algodoncito con neutralizador; de esta forma la superficie mecánicamente no se ha modificado y sí veremos que han <u>sido gra-</u> <u>bados</u> los ejes de referencia, ya que la marca de grafito ha impedido la acción del ácido -

sobre la propia línea y a continuación el neutralizador ha limpiado el grafito que se depositó. Este procedimiento tiene una demostrada eficacia por innumerables experiencias y es práctica su aplicación en m<u>e</u> tales.

Otra solución consiste en marcar con lápiz los ejes, pero sin que estas lleguen a cortarse dejando siempre libre la superficie del soporte de la banda (fig. 17) pero se ve que conseguir este entraña una pericia grande y no queda exenta de problemas de contaminación de la superficie.

2.3.3. Pegado de extensímetros -

El adhesivo utilizado para el pegado de bandas deberá reunir unas características adecuadas a su uso y nunca se pecará por exceso en las exigencias que en su elección hagamos. Tienen preferencia todos aquellos que solidifican por polimerización, es decir que la totalidad de los átomos que forman los componentes (normalmente dos), constituyen el solido final, a diferencia de los pegamentos normales que solidifican por evaporación de un disolvente.

En general un buen adhesivo tendrá las siguientes características:

a) Permitir su aplicación en películas delgadas para no introducir errores por distanciamiento de la rejilla a la superficie.

b) Ser neutro a la superficie y al soporte de la banda.

c) Transmitir los esfuerzos a la banda sin fenómenos de fluencia.

d) Técnica de aplicación facil.

e) Utilización en un márgen lo más amplio posible respecto a condici<u>o</u> nes ambientales. Será dificil que un solo adhesivo cumpla en grado óptimo las condiciones anteriores, pero siempre será factible establecer un compromiso para aplicaciones concretas.

Hay pegamentos de aplicación sencilla y rápida cuyo uso es de interés en piezas grandes y usos generales donde la medida se haga a temperaturas ambientales normales (20º á 6CºC) un ejemplo de aplicación de las mismas se expone gráficamente en la fig. 18, referente al tipo M-200 de la firma Vishay-Micromesures.

Para aplicaciones que exijan una mejor precisión, como puede ser el caso de fabricación de captadores, se utilizarán adhesivos que deben someterse a un tratamiento térmico, operación que no d<u>e</u> ja de ser engorrosa. En cualquier caso, el fabricante dará normas cl<u>a</u> ras de aplicación. Para usos de condiciones extremas (1000ºC) se comprende que los adhesivos se descompondrían, para ello, existen bandas encapsuladas en una vaína metólica que son fijadas por soldadura elé<u>c</u> trica por puntos con utensilios adecuados.

Junto con la banda, es muy práctico pegar unos soportes de terminales impresos que ayudarán a la soldadura e instalación del cableado.



a) la banda y el terminal impreso se colocan sobre un cristal totalmente limpio y con papel transparente autoadhesivo, se cubren y se separan del cristal procurando no doblar la banda.



situa la cinta y banda so-- el punto de medida, fijando un extremo y levantando el otro.



c) con el pincel del acelerador se aplica éste sobre el reverso de la banda y terminal, procurando no contaminar la banda con adhesivo de la cinta. Dejar secar un minuto.



d) depositar una o dos gotas de adhesivo sobre la superficie de asentamiento.



e) se va bajando la cinta y con un dedo se hace ligera presión de izquierda a derecha y evita<u>n</u> do tocar directamente el adhes<u>i</u> vo.



f) una gasa se pasa varias veces para evitar se former burby
jas de aire.



g) a los 10 minutos como mínimo se puede retirar el papel tran<u>s</u> parente que ayudó a pegar la ba<u>n</u> da como se indica.

2.3.4. Soldadura de cables

La soldadura de las bandas a los hilos de unión de los instrumentos de lectura, requieren una especial atención y el montador necesitará adquirir cierta expeciencia para dominar esta operación.

En la composición de las soldaduras se emplean aleacio nes de plomo con estaño, plata o antimonio, que llevan o nó incorpor<u>a</u> da una resina y según las proporciones de dichas aleaciones resultan unas características determinadas de conductividad eléctrica, compo<u>r</u> tamiento a solicitaciones mecánicas, respuesta en temperatura etc. por todo ellonœs recomendable el uso de soldaduras comúnes en aplic<u>a</u> ciones de taller eléctrico o electrónico. Especial atención tiene el conocimiento de la temperatura de fusión que debe ser lo más inmedi<u>a</u> ta superior a la que estará sometida el circuito de medida, con el fín de no tener que aportar más calor del necesario al efectuar las soldaduras.

Según el tipo de soldadura elegido será conveniente o necesario utilizar un fundente, sobre todo para hilos muy delgados, pero será <u>totalmente</u> imprescindible limpiar con un decapante adecua do los puntos de soldadura con el fín de eliminar los residuos de fundente y resina que podrían ocasionar corrosiones y fenómenos par<u>á</u> sitos por efecto "pila" ya que evidentemente quedarían dos metales y un electrolito.

El soldador juega un papel muy importante, siendo rec<u>o</u> mendados aquellos de temperatura regulable; la punta del mismo nunca será cónica sino que tendrá una talla en forma de bisel. Para evitar que los cables puedan ejercer esfuerzos en la banda que pudiesen det<u>e</u> riorarla debe utilizarse siempre que sea posible un terminal impreso que servirá de apoyo al cable (que será de varios hilos) al que previamente se le separó un hilito y se estañó tal y como se indica en la fig. 19.



En general seguiremos el siguiente proceso: 1º Preparar el cable según la fig. 19 2º Proteger con papel autoadhesivo debil la banda, dejando al descubierto solamente los puntos de soldadura.

3º Depositar una gota de soldadura lo más p<u>e</u> queña posible sin aportar excesivo calor que podría desprender la banda del soporte. No debe durar esta oper<u>a</u> ción más de 2 segundos, si no se consiguen el primer intento, dejar enfriar y repetir.

4º Presentar el cable ya preparado y sin aporte de soldadura, solamente manteniendo caliente y muy limpio la punta del soldador, fijar los cables a los terminales y a la banda, tal y como se indica en la fig.20.

En la banda conviene que la gota de soldadura sea lo menor posible para evitar concentración de esfuerzos, de ahí que el procedimiento explicado favorezca ésta condición al ser más fino el hilo de unión del terminal a la banda, a la vez que se consiguen dar mayor seguridad al montaje, pues un fuerte tirón del cable rompería el termi nal pero no la banda.

Hemos ofrecido unas normas generales ya que el fabrican te indicará en cada caso las instrucciones concretas.

2.5.5. Comprobaciones

Una vez insralada una banda deberán efectuarse diversas comprobaciones siendo preceptivas:

- 1º Inspección ocular. Debe hacerse con una lupr de 20 aumentos o más para confirmar que se ha situado correctamente la banda a la vez que se observará que no han quedado bolsas de aire ni "lagunas" (zonas sin adhesivos) bajo el soporte de la misma.
- 2º Comprobación del aislamiento. Se utilizará un megohmetro cuya tensión no exceda los 50 V, si es de válvula mejor y jamás se hará uso de los medidores de aislamiento de tipo magneto que quemarían la banda.

El aislamiento deberá ser mejor que 100 megohms, ya que un aislamiento menor, equivale a introducir un error, por colocar en paralelo con la banda otra resistencia; se puede calcular dicho error, en efecto, consideremos un aislamiento de 2 Mohms.

3º Medida del valor óhmico de la banda. Utilizar un instrumento que aprecie decimas de ohmio como mínimo; esta comprobación tiene dos objetos; el primero saber que no está rota ni cortocircuitada la rejilla y el segundo conocer la dispersión del valor nominal, sobre todo en circuitos con varias bandas para controlar deseguilibrios excesivos.

2.5.6. Protecciones

Desde medidas efectuadas en laboratorio, hasta las difíciles en los conos de cohetes o cascos de barcos, encontraremos una serie de condiciones ambientales que juntamente con la duración de la medida exigirán proteger un elemento delicado con es la banda extensométrica de forma adecuada.

Las bandas, de por sí, son presentadas bajo opciones que aportan una determinada protección, así las hay encapsuladas sobre dos láminas, una inferior que constituye el soporte y otra superior de la misma naturaleza y que deja libre solo los terminales para la soldadura de cables, ésta protección evita la proyección del estaño en la soldadura y mejora enormemente el aislamiento. Otras opciones llevan unos hilos soldados, por lo que el soporte superior cubre totalmente a la banda (fig. 21).



En general la protección la consideramos b<u>a</u> jo el aspecto de aislamiento eléctrico y de fortaleza mecánica y previamente a la inst<u>a</u> lación de la banda tendremos que conocerla, para preparar la superficie adecuadamente antes del pegado de la misma Los criterios que debemos tener en cuenta para elegir los productos de protección e<u>s</u> tarán basados en:

a) Temperaturas extremas durante la medida, p.e. Probeta en laboratorio 22ºC <u>+</u> 3ºC; estructura expuesta al sol O-60ºC estructura de un avión en vuelo -50ºC + 120ºC.

b) Duración de las medidas, p.e. 1 hora en laboratorio; l año en un punto sumergido del casoo de un buque.

c) Ambiente, p,e, aire seco, aire humedo, agua, aceite, chorro de agua, gases corrosivos, hidrocarburos,

No debemos olvidar antes de la aplicación de los prote<u>c</u> tores, cercionarnos de que no hay restos de adhesivo alrededor de la zona a proteger, que se limpió bien la resina fundente de las soldaprotector se adhiera, que no hay humedad, etc. en una palabra, no desdeñar ningún esfuerzo que posteriormente pueda inutilizar varias horas de laboriosos trabajos.

Una práctica muy aconsejable, siempre que sea posible, será lo de conectar provisionalmente el instrumento de lectura al circuito antes de protegerlo y sometiendo aquel a alguna solicitación, observar que el funcionamiento es lógico.

Por último, no olvidar tomar datos de posición, fotos, numeración de cables, esquemas etc. antes de la protección, ya que po<u>s</u> teriormente sería imposible, al quedar el circuito tapado por los pr<u>o</u> tectores.

La aplicación del protector la haremos siguiendo siempre las indicaciones del fabricante pero como orientación tendremos prese<u>n</u> te:

1º Extender bién el producto sobre la superficie limpia y si hay que dar varias capas, que la última cubra por completo a las anteriores. Algunos productos vienen acompañados de un componente previo, que debe aplicarse sobre la superficie con pincel y dejar secar perfectamente para luego aplicar el protector y conseguir así la mejor adhesión. Vijilar que no queden bolsas de aire.

2º Cuidar que el espesor del protector sea el adecuado, muchos protectores son blandos y fácilmente las bolitas puntuales de las soldaduras, pueden atravesar el protector con pequeñas presiones, originando conta<u>c</u> tos de masa indeseados.

3º Protección del extremo de los cables de unión a instrumentos, pues de nada sirve esmerarse en la banda si dejamos opción a que por la vaina de los cables queden huecos por donde se perdería la protección.

La fig. 22	indica un acabado ti _l	po de protección.	
· · ·			
		STRUCTURA	
	BANDA	TERMINAL	lig22

2.6.1. Indicadores de propagación de fisuras

Dos son los motivos que pueden hacen recesario el uso de estos sensores: detectar la aparición de una fisura o determinar la velocidad de propagación de la misma, en ambos casos, si bien el sensor seró el mismo, variarán los instaumentos de lectura.



Estos indicadores están formados por una serie de hilos en paralelo (fig. 23) mon tados en un soporte similar al de los ex tensímetros, que se pega en el punto don de se produciró la fisura, y que cuando aparezca, romperó un determinado número de conductores, deduciéndose la longitud de la fisura por medida de la resistencia con un ohmetro; si por el contrario el mo mento de aparición de la fisura es regis trado de forma contínua por un oscilógrafo, deduciremos la velocidad con que se propaga (fig. 24).

La aleación de la que están constituidos es suficiente para soportar deformaciones superiores a <u>+</u> 2000_/uò más de 10⁸ ciclos



y son montados con técnicas similares a las utilizadas en los extensímetros,

Los efectos de temperatura tienen p**oc**a i<u>n</u> fluencia.

2.6.2. Indicadores de fatiga

Al contrario que las bandas extensométr<u>i</u> cas, que miden deformaciones por variacio nes instantáneas de su resistencia, los indicadores de fatiga (S/N) guardan "en memoria" todas las deformaciones experimentadas después de su instalación. La memoria aludida viene representada por una modificación permanente del valor no minal de su resistencia, que es función de la amplitud de las deformaciones y de

la frecuencia con que se producen.

- lº En una pieza sometida a cargas alternas, la carga de rotura disminuye.
- 2º El número de alternancias que hay que producir para la rotura es tanto menor, cuanto mayor es la amplitud de las mismas.
- 3º Existe un valor de deformación mógimo para el cual no se produce rotura sea cual sea el número de ciclos con que se aplique.

En la fig. 25 se expresa gráficamente lo expuesto.

Estudios realizados por Miner, permiten afirmar que el porcentaje de vida de una pieza sometida a tensiones variables, es el mismo si aumentando la amplitud de las tensiones disminuimos su fre-



cuencia o viceversa, siguiendo la proporción obtenida según los criterios de Wöheler.

En la fig. 26 vemos que el tanto por ciento de envejecimiento de una pieza es el mismo sometido a la te<u>n</u> sión ∇_4 y C₁, ciclos que si se somete a la tensión ∇_2 y C₂ ciclos.

Se considera que las tensiones apl<u>i</u> cadas escilan entre un valor o máximo y un mínimo O, si así no fuese, logicamente habrá que considerar los efectos de una componente contínua más la carga variable.

Si bién en su aspecto los indicadores de fatiga (fig. 27) son semeja<u>n</u> tes a las bandas extensométricas,

la constitución de su elemento sen-

sible es bién distinta, ya que la aleación de la rejilla persigue aumentar al máximo el efecto que en los extensímetros se trataba de el<u>i</u> minar; en efecto recordemos (2.2.4.) que en las bandas se establece como límite deformaciones dinámicas, aquel que produce una deriva de



100/u & , equivalente a un incremento de 0,024 ohms en una banda de 120 ohms, mientras que ahora preten demos que estos valores sean del orden de 7 a 10 ohm. Se constituyen en aleación de constantan con valor nominal de 100 ohm.

La variación de la resistencia del indicador de fatigas es producida por una distorsión de su red cristalina y por la aparición de micro fisuras de la aleación de que se compone su rejilla y ha podido demostrarse experimentalmente que en algunos metales, empleados en cons-

trucción normalmente, se produce el mismo fenómeno; de aní que estos sensores cuando son montados sobre piezas mecánicas puedan indicar con gran fidelidad el estado de envejecimiento de los materiales midiendo la desviación del valor nominal de la resistencia del sensor.

Si el envejecimiento de la aleación del sensor es distinto del material sobre el que se monta, la concordancia anterior se pierde y los resultados no tendrán valor alguno, ya que si, por ejemplo la deformación máxima capáz de desviar el valor de la resistencia del sensor, (3º ley de Wöhler) es superior a la deformación que producirá lo rotura de la pieza de ensayo, el indicador de fatiga jamás acusaría desviación de su resistencia; para evitarlo se fabrican sensores multiplicadores los cuales por diversos procedimientos de fabricación se consiguen adaptar la respuesta del sensor a los materiales en que se montar ligita)

La fig. 28 d**ó ubes respuesta de los sensores FWA de -**Vishay-Micromesures.



lig 27



Los indicadores de fatiga son verdaderos integradores de los efectos producidos por cargas alternas, sea cual sea su amplitud así pués, si después de 10.000 ciclos de <u>+</u> 2000/u & producen una desviación de la resistencia de 1,9 ohm y 100 ciclos de <u>+</u> 3000/u & 0,80hm, la indicación final será de 2,7 ohm.

Al montaje de estos indicadores habrá que tener en cuenta que su eje sensible coincida con el eje de esfuerzo principal máximo, determinado previamente por cualquier procedimiento (extensométrico, fotoelasticidad, etc).

2.6.3. Sensores de temperatura

Siguiendo el mismo procedimiento de fabricación de las bandas extensométricas, pero haciendo que la aleación de la rejilla sea de niquel, se obtienen sensores cuya variación de resistencia es altamente sensible a las variaciones de temperatura siendo este fen<u>ó</u> meno muy estable y repetitivo, de ahí que se utilice profusamente en la medida de temperaturas por contacto y utilizando las mismas técnicas de instalación que las expuestas para extensímetros. La curva $\Delta R-t^{\circ}$ (fig. 29), tiene una pendiente considerable por lo que se obtienen señales de alto nivel, pudiendose medir con gran precisión, exactitud y poder de resolución, temperaturas comprendidas entre -300 y + 500°F.



Generalmente son fabricados para qué a la temperatura ambiente (23,9°C su k resistencia nominal sea de 50 ohm y conociendo la curva , poder con<u>o</u> cer la temperatura midiendo por cualquier procedimiento las desviaciones de la resistencia.

Estos sensores a diferencia de los termopares que generan una f.e.m. son pasivos, necesitando de una fuente de alimentación, por eso (fig. 30) si es excitado con una fuente de intensidad constante lmA) la lectura directa de un milivoltímetro nos valdría para c<u>o</u>

nocer los <u>A</u> R directamente, no obstante como la respuesta no es lineal siempre tendríamos que tener tablas o curvas de respuesta para conocer el verdadero valor de la temperatura en ºC ó ºF. El inconveniente an-



fig 30

terior ha sido subsanado introduciendo circuitos linealizadores en los cuales, si bién se pierde sensibilidad, la re<u>s</u> puesta es lineal, por lo que los instrumentos de lectura pueden ir tarados directamente en escalas termométr<u>i</u> cas.

Con el fín de utilizar para la medida de temperaturas los mismos instrumentos que para medir deformaciones, los circuitos linealizadores se calculan de tal forma que el sensor constituye una rama de un puente de Whearstone -

(fig. 31), de tal forma, que al leer un número entero de microdeformaciones equivalga a la variación de lgrado centígrado o Farenheit, No<u>r</u> malmente se fabrican redes para:

10 ub <> 1°C <> 1°F 100 us c> 1°C c> 1°F



La aleación de niquel, muy sensible a las variaciones de temperatura, obligo a utilizar fuentes de alimentación de baja d.d.p. ya que al circular corriente por el sensor el calor generado por efecto Joule introduce pequeños errores. Por otra parte, si el punto de m<u>e</u> dida está sometido a deformaciones estas las acusará el sensor, pero dado su insensibilidad a este fen<u>ó</u> meno no tendrán gran influencia en la exactitud de la medida, de todas formas el fabricante da con los sensores las curvas de corrección

por este motivo.

La longitud de los cœbles puede ser origen de errores por perdida de sensibilidad, pero se compensan estos efectos modifican do el factor K de sensibilidad en el instrumento de lectura (esto se estudia en el próximo capítulo).

Para medida de muy bajas temperaturas (criogenia) se ut<u>i</u> lizan sensores (fig. 32) que llevan dos rejillas en serie en aleaciones de mangamina nikel, con lo **que se consigue linealizar** circuitos



desde -400ºF.

En el montaje de sensores de temp<u>e</u> ratura no habrá jamás de olvidar utilizar adhesivos soldaduras, cables protectores, etc. cuyo límite de utilización en temperatura sea superior a la que se desea medir.

2.6.4. Bandas semiconductoras

Todos los cuerpos tienen, más o m<u>e</u> nos acusada, la propiedad de sufrir variaciones en el valor de su re-

sistiviada cuando son sometidos a tensiones mecánicas, pero en los s<u>e</u> miconductores este efecto es mucho más notable y se aprovecha por ta<u>n</u> to, como elemento transductor para la medida de deformaciones. El fem<u>ó</u> meno expuesto de la piezaresistividad, no debe ser confundido con el de la piezoelectricidad, que presentan los cristales de cuarzo y otros, de crear cargas eléctricas entre sus caras cuando son deformados, con<u>s</u> tituyendo elementos activos, mientras a los que aquí nos referimos son elementos pasivos, esto se necesitarán una aportación de energía este<u>r</u> na (alimentación) para conocer sus variaciones de resistencia.

En un semiconductor la resistividad tiene por valor $\int_{c}^{2} \frac{1}{cNv} donde N$ representa el número de portadores de cargas eléctricas, v su velocidad media y e, es la carga del electrón.La variación de $\int_{c}^{2} donde n$ al aplicar cargas al semiconductor dependerá de la concentración especí fica de portadores y de la orientación cristalográfica respecto a las cargas aplicadas; si aplicamos cargas de tracción o compresión el cambio relativo de resistividad se expresa por:

 $\frac{\Delta P}{P} = \pi_{e} \sigma$

llamandose a Te coeficiente de resistividad longitudinal.

Recordemos que un semiconductor es un cristal de silicio o germanio (4 electrones de valencia) al que se le añaden impurezas t<u>i</u> po N (arsenico, 5 electrones de valencia) o Tipo P (galio, 3 electrones de valencia) y dependiendo de la proporción de los agentes contaminantes, podrán obtenerse infinidad de elementos de muy variadas caracterís ticas.

El factor de sensibilidad en los extensímetros de film metálico, hemos visto que tiene de valor 2, pero si empleamos bandas cuyo elemento sensible sea un semiconductor, se pueden obtenerse valores de entre 50 y 200 y dado que dimensionalmente pueden fabricarse iguales se establecen las ventajas de:

- 1º Obtener niveles de señal elevados que pueden evitar una posterior amplificación.
- 2º Mejorar la relación señal-ruido; sin embargo su precio es mucho más elevado y su sensibilidad a la temperatura mucho más acusada que en las bandas convencionales, lo que hace que su uso quede l<u>i</u> mitado a la medida de muy pequeños valores de deformaciones y a la fabricación de captadores.

El factor de sensibilidad es definida por: $K_{-} = \frac{\Delta R}{R} = 1 + 2M + R_0 E$

21_

_siendo E= Módulo de elasticidad: /u= Coeficiente de Poisson y T_l =coeficiente de resistividad longitudinal del semiconductor.

El término $n_i E$ es el equivalente el que por la constante de Bridgman se introduce en las bandas metálicas, con la salvedad de que es bastante más elevado.

La influencia de la temperatura en una banda semiconductora está intimamente ligada al número de átomos de impurezas que ll<u>e</u> ve, así para 10²⁰ atomos/cm³, el factor Ksc es constante prácticame<u>n</u> te a las variaciones de temperatura.

$$K_{sc} = \frac{\Delta R}{RE} = Constante$$

Si la proporción de impurezas es del orden de 10⁷ atomos/cm³ el factor de banda se verá afectado en la forma:

$$K_{sc} = \frac{T_{o}}{T} K_{sc}(o) + C \left(\frac{T_{o}}{T}\right)^{2} \varepsilon$$

donde T= Temperatura absoluta; Ksc(0) = Factor de sensibilidad a la temp<u>e</u> ratura To; Constante y E =deformación.

Los diferentes niveles de contaminación de los cristales de silicio se denominan por las letras, K, L, C, D, E, F, G y H y determinan las características piezoresistivas del sémiconductor. La resistividad según tipos, oscila entre 0,001 ohm/cm y lohm/cm, la fig.33, resume la respuesta de las distintas clases.

Para compensar los efectos de variación de temperatura, se emplea un circuito con banda compensadora (ver tema 3) o bién el f<u>a</u> bricante adapta el semiconductor para que dentro de ciertos límites de utilización y para determinados materiales, variaciones de temperatura no produzcan deformaciones aparentes.



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En general las técnicas de pe<u>ga</u> do, protección, etc, serán idé<u>n</u> ticas a las de los extensímetros metálicos. Añadiremos por último que los monocristales de silicio son perfectamente elásticos, lo que hace que el fenómeno de hi<u>s</u> teresis y fluencia quede prácticamente reducido al que introdu

2.6.5. Bandas para muy altas presiones y temperaturas

Las necesidades surgidas en la investigación de programas aeroespaciales de armamento, lineas submarinas, grandes obras de ingeniería civil, etc, donde es necesario medir deformaciones en condicicnes ambientales francamente adversas, ha motivado el desarrollo de ba<u>n</u> das especiales que pueden trabajarm bajo elevadísimas presiones y temp<u>e</u> raturas, con excelente exactitud.

A título anecdótico señalaremos, que gracias a estas ba<u>n</u> das especiales, se han podido medir deformaciones en el cono del fuselaje del avión cohete americano X-15. La tecnología que se expone -corresponde a la desarrollada por la firma Microdot Inc.

El principio en que se basan es el clásico por el cual la resistencia de un conductor eléctrico varía si se somete a tensiones mecánicas, sin embargo, respecto a las bandas convencionales, se diferencian en que carecen de soporte y su parte activa la constituye un conductor en forma de U introducido en una cápsula metálica de la que está aislado por polvo o presión de óxido de manganeso (fig. 34). Se efectua su fijación al punto de medición soldando por puntos la b<u>a</u>



se metálica del sensor. En la construcción del filamento se utilizan aleaciones de Niquel-Cromo para m<u>e</u> didas hasta temperaturas de 350°C y Platino-Tungsteno hasta 650°C. Polvo de MgO Los hilos terminales para unión de los cables a los instrumentos de lectura los constituyen los extremos del propio filamento y así se consigue una resistencia mečanica elevada; esta forma de terminales se realiza actuando por erosión -

química sobre el hilo constitutivo del sensor de un diámetro igual al del terminal hasta que la parte activa quede al diámetro inferior adecuado.

Las aleaciones Cr-Ni del filamento se someten a tratamie<u>n</u> tos térmicos, para que la variación de resistencia debida al coeficie<u>n</u>
te térmico de resistividad, sea de la misma magnitud y signo contrario que la originada por dilatación térmica, con lo que se consigue una autocompensación en un rango de utilización que especifica el fabrica<u>n</u> te.

Si la aleación es de Pl-W, un tratamiento térmico de la misma, no ofrecerá una garantia de conseguir una buena compensación del efecto de temperatura, por estar diseñados para trabajar a elevadas temperaturas, por tal motivo, se utilizan bandas con coeficiente de sensibilidad a las deformaciones nulo y que se montan en la rama adyacente a la que se monta la banda activa en un circuito de puente Wheatstone (fig. 35); se observa que al construir la banda compensadora arrollada en espiral, la sensibilidad a la deformación mecánica es nula, y además se puede fabricar dentro de la misma cápsula de la banda activa; las ventajas que se derivan son enormes, pues se reduce



el tiempo de montaje y se consigue además que los gradientes térmicos incidan con el mismo valor en ambas bandas.

Un pequeño inconveniente de la ale<u>a</u> ción PI-W se debe a las diferencias que pueden haber entre el coeficie<u>n</u> te térmico de resistividad y efecto de dilatación del material de ensayo, por eso se monta en serie una resistencia Rtc, que compensan esos errores. Siempre el fabricante incluye las especificaciones de cada tipo.

La preparación de superficies para montaje, no necesita de la meticulosidad de las bandas clasicas.

El óxido de manganeso es introducido, con suficiente compactidad, para que pueda transmitir las deformaciones de la extruc tura al filamento.

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TEMA III

3.1. Teoría del Puente Wheatstone



fig.1

La fig. l representa el esquema de un circuito en puente de Wheatstone que es el más universalmente utiliz<u>a</u> do para medidas extensométricas. Las bandas extensométricas podrán ocupar uno, dos o los cuatro brazos del pue<u>n</u> te, denominándose entonces circuitos de 1/4, 1/2, 1/1, de puente respect<u>i</u> vamente.

Se llaman ramas activas las ocupadas por bandas que se deforman por solicitaciones mecánicas y ramas pasivas aquellas que no intervienen en la medida.

La d.d.p. Vs en la diagonal de G tiene por valor $V_s = V_e \left(\frac{\Gamma_1}{\Gamma_1 + \Gamma_2} - \frac{\Gamma_4}{\Gamma_3 + \Gamma_4} \right)$ para pequeñas variaciones de $\Gamma_1; \Gamma_2; \Gamma_3 \neq \Gamma_4$ podemos derivar la [1] entonces:

$$\Delta V_{s} = V_{e} \left[\frac{\Delta r_{i} (r_{i} + r_{s}) - r_{i} (\Delta r_{i} + \Delta r_{z})}{(r_{i} + r_{s})^{2}} - \frac{\Delta r_{u} (r_{y} + r_{u}) - r_{u} (\Delta r_{y} + \Delta r_{u})}{(r_{y} + r_{u})^{2}} \right] =$$

$$= V_{e} \left[\frac{\Gamma_{1} \Gamma_{2}}{(\Gamma_{1} + \Gamma_{2})^{2}} \left(\frac{\Delta \Gamma_{1}}{\Gamma_{1}} - \frac{\Delta \Gamma_{2}}{\Gamma_{2}} \right) - \frac{\Gamma_{3} \Gamma_{4}}{(\Gamma_{3} + \Gamma_{4})^{2}} \left(\frac{\Delta \Gamma_{4}}{\Gamma_{4}} - \frac{\Delta \Gamma_{3}}{\Gamma_{3}} \right) \right]$$
Si el circuito está equilibrado $\frac{\Gamma_{1}}{\Gamma_{2}} = \frac{\Gamma_{4}}{\Gamma_{3}}$

$$\Delta V_{s} = V_{e} \left[\frac{\Gamma_{1} \Gamma_{2}}{(\Gamma_{1} + \Gamma_{2})^{2}} \left(\frac{\Delta \Gamma_{1}}{\Gamma_{1}} - \frac{\Delta \Gamma_{2}}{\Gamma_{2}} \right) - \frac{\frac{\Gamma_{3}}{\Gamma_{3}}}{(A + \frac{\Gamma_{4}}{\Gamma_{3}})^{2}} \left(\frac{\Delta \Gamma_{4}}{\Gamma_{4}} - \frac{\Delta \Gamma_{3}}{\Gamma_{3}} \right) \right]$$

$$\Delta V_{s} = V_{e} \left[\frac{\Gamma_{1} \Gamma_{2}}{(\Gamma_{1} + \Gamma_{2})^{2}} \left(\frac{\Delta \Gamma_{1}}{\Gamma_{1}} - \frac{\Delta \Gamma_{2}}{\Gamma_{2}} + \frac{\Delta \Gamma_{3}}{\Gamma_{3}} - \frac{\Delta \Gamma_{4}}{\Gamma_{4}} \right) \right] \dots$$

$$Si \quad \Gamma_{1} = \Gamma_{a}; \quad \Gamma_{3} = \Gamma_{4}$$

$$\Delta V_{s} = \frac{V_{e}}{4} \left(\frac{\Delta \Gamma_{i}}{\Gamma_{i}} - \frac{\Delta \Gamma_{2}}{\Gamma_{2}} + \frac{\Delta \Gamma_{3}}{\Gamma_{3}} - \frac{\Delta \Gamma_{0}}{\Gamma_{4}} \right) - \cdots - \cdots - [3]$$

de donde se deduce que la portación a la d, d.p. de salida V_s de dos ramas adyacentes que experirentan un Δr del mismo signo, tiene sentidos opuestos, propiedad importantísima que por algunos autores es den<u>o</u> minado"ley de signos".

Si la expresión $\frac{\Delta r}{r_1} - \frac{\Delta r}{r_2} + \frac{\Delta r_5}{r_3} - \frac{\Delta r_6}{r_4}$, la transformamos en ctra de forma $p \frac{\Delta r}{r}$ la [3] queda $V_s = \frac{V_c}{L_4} p \frac{\Delta R}{R} - [3a]$ en la que el factor de puente "p" incluirá la aportación a la señal de salida de todas y cada una de las ramas, siendo

 $p = \sum a_n b_n c_n = a_n b_n c_n = a_n b_n c_n + a_n b_n c_n - \dots - [4a]$



Los subíndices indican la posición relativa de las bandas del puente, respecto a un sentido arbitrario y a cada rama le asignaremos tres co<u>e</u> ficientes a, b,c, cuyo significado es el siguiente:

El coeficiente <u>a</u> es indicativo de si la rama es activa o pasiva, por lo que tiene de valor:

a= 1 para ramas activas a= 0 para ramas pasivas

El coeficiente <u>b</u> indicará si una rama activa del puente sufre deform<u>a</u> ciones por esfuerzos de tracción o de compresión, por tanto:

> b= +1 si $\Delta r > 0$ (tracción) b= -1 si $\Delta r < 0$ (compresión)

Si las ramas activas del puente no sufren deformaciones absolutas simultáneamente i Jales, referiremos la deformación de cada rama al valor máximo de 2, siendo esto expresado por el coeficiente c, que por tanto tendrá un valor comprendido

1≥c≥0

Por todo lo anterior, si consideramos el caso de la fig. 2 tendremos que:

°1=	$a_2 = a_3 = a_4 = 1$	por	ser todas las ramas activas
b ₁ =	b ₃ = + 1	por	corresponder a esfuerzos de tracción
^b 2=	b ₄ = -1	por	corresponder a esfuerzos de compresión
c ₁ =	$c_2 = c_3 = c_4 = 1$	por las	ser $\frac{\Delta R}{R}$ un valor absoluto el mismo en cuatro ramas del puente.

por lo que:

 $p = 1.1.1 - 1.(-1).1 + 1.1 - 1.(-1).1 = 4 \cdot V_s = \frac{V_e}{P} \frac{\Delta R}{R} = V_e \frac{\Delta r}{R} = - [5]$

Consideremos particularmente el caso del circuito de 1/4 de puente (fig. 3_d) en el se cumple:



 $\Delta V_{s} = V_{e} \left(\frac{\Gamma + \Delta \Gamma}{2\Gamma + \Delta \Gamma} - \frac{1}{2} \right) = \frac{\Delta \Gamma}{4(R + 0.5 \Delta R)} - \dots [6]$ expression que indica la no existencia de proporcionalidad lineal entre la señal de salida y la deformación; solamente cuando ésta sea muy pequeña, se podría despreciar el termino 0;5AR del denominador y quedar $V_{s} = \frac{V_{e}}{4} \frac{\Delta R}{R} - - - - - [7a]$

[76]

En el circuiro de 1/2 de puente (fig. 3b)::tenemos que:



p= a1b1c1 - a2b2c2
a1= a2 = 1
b1= 1
c1=c2= 1
p= 2

 $V_5 = \frac{Ve}{L} p \frac{\Delta R}{R} = \frac{Ve}{2} \frac{\Delta r}{r}$

que es un circuito lineal

3.1.1. Principios básicos en medidas extensométricas

Hemos visto como basándonos en el puente de Wheatstone, podemos transformar las variaciones que la resistencia que un extensímetro experimenta cuando se deforma, en una variación de diferencia de potencial eléctrico; pero en la materialización de las medidas deb<u>e</u> remos tener muy en cuanta ciertos principios con el fín de no cometer errores.

En primer lugar consideremos la fig. 4, en la que se representan dos



circuitos de medida en 1/4 de puente que son conmutadas al instrumento de lectura a través del conmutador C₁, si la resistencia de los contactos no es constante, cada vez que conmutemos, a la variación propia de la resistencia de la banda, añ<u>a</u> diremos la variación de la resistencia de contacto del conmutador, que introduce un error en la medida, lo que nos dice que dentro del circuito del puente a,b, c,d no deben producirse más variaciones

de resistencia que las producidas por las bandas.

Si existiesenotros conmutadores C₂ y C₃ que actuasen en el circuito externo del puente, no se introducirían errores, aún cua<u>n</u> do las resistencias de contacto fluctuasen entre una y otra actuación, pues en realidad buscamos la condición de equilibrio del puente que no se ve afectada por dichas variaciones.

Por tanto en toda medida extensométrica se cuidará rigurosamente, no perturbar las ramas del puente por cambio de cables, co<u>n</u> tactos defectuosos, resistencias de conmutadores (serán de excelente calidad) etc. etc. sin embargo pequeñas perturbaciones en las diagon<u>a</u> les no tendrán influencia.

Otra condición básica será la garantia de un perfecto aislamiento del circuito de medida, 🕱 ya que defectos del aislamiento (fig. 5) suponen, bien la puesta en cortocircuito de cierta longitud activa de la banda, o bien el acoplamiento en paralelo de una resistencia de elevado valor, y en cualquiera de los casos la medida sería







errónea.

3.1.2. Compensación del efecto de vari<u>a</u> ción de temperatura

Los materiales sobre los que se montan las bandas sufren deformaciones por efecto de las variaciones de temperatura (tema 2 apartado 2.2.3) que no crean tensiones y que por lo tanto son origen de errores; si la banda es autoco<u>m</u> pensada, se vió que, dentro de ciertos límites de temperatura, estos errores son despreciables, no obstante, si el circuito de medida es un puente de -Wheatstone, podremos corregir los erro res por variación de temperatura en cualquier rango utilizando una banda pasiva o de compensación.

En la fig. 6a la banda montada sobre probeta sufrirá deformaciones cuando hayan variaciones de temperatura, pero si (fig.6b) sobre un trocito de material idéntico al de la probeta montamos una banda compensadora, haciendo que en el puente de Wheatstone ocupe una rama adyacente respecto a la activa, ocurrirá que por variaciones de temperatura, las dos, activa y compensadora, se deformarán en la misma magnitud, pero su aportación a la señal de salida es nula por la ley de los signos y por tanto el circuito de medida solo será sensible a las solicitaciones que sufra la probeta o elemento de ensayo.

Este método presenta el inconveniente de necesitar dos bandas, pero tiene la gran ventaja de compensar los efectos de variación de temperatura en toda la gama de utilización de las bandas. Por otra parte en mediciones de varios puntos, puede emplearse una compe<u>n</u> sadora común en la mayoría de los casos; así mismo, se podrá buscar la disposición adecuada en ciertas medidas que necesitan dos o cuatro bandas activas, para que los efectos de temperatura queden compensados (Se verá con detalle en el apartado 3.1.6).

3.1.3. Configuración del cableado en diversos montajes



Sea <u>cualauiera el instrumento de medida utilizado, las</u> P 350 D bandas se montan de forma que constituyen 1,2 o las 4 ramas de un circuito de puente de Wheatsto ne, incluyendose dentro del instrumento las resistencias que completen el puente según la configuración. Estudiaremos la disposición de los hilos de unión del circuito de medida a los instrumentos según las diversas configuraciones.

> 1º Circuito de 1/4 de puente: En el caso de medidas en las que se pueda considerar la temperatura constante, el montaje de 2 hilos de la fig. 7 se puede utilizar sin más limitaciones que los erro res de linealidad, pero si la temperatura varía, aún dentro de los límites de autocompensación, (si la banda está autocompensada) nunca podremos corregir las perturbaciones que se originen en los hilos de unión, ya que éstos

no pueden autocompensarse; por esta razon se adapta el montaje de 3 hilos (fig. 7b) en los que se consigue una simetría del circuito re<u>s</u> pecto a dos ramas adyacentes y por la ley de signos, quedan compens<u>a</u> das las perturbaciones en la línea.

En la fig. 7c se resume lo expuesto, viendose que el tras lado del vertice A influye en que los conductores a y b actu@n en una sola rama (2 hilos). El conductor c por actuar en la diagonal del puente no influye (3.1.1.) en la medida.

En medidas de gran responsabilidad, se puede utilizar el circuito de 4 hilos (fig. 7d); se harán dos medidas, conectando a<u>l</u> ternativamente los hilos según el esquema y obteniendo la media aritmética de las dos lecturas. En realidad se han efectuado dos medidas con montaje de 3 hilos para eliminar posibles asimetrías del circuito

2º Circuito de medio puente.-

El circuito de 1/2 puente es el que se ha indicado para la compensación de los efectos de temperatura. En general se utiliza cuando se quieren eliminar, efectos que actuen ramas adyacentes del puente (fig. 8). Por su simetría, las perturbaciones en la línea quedan compensadas.



_ 3º Circuito de puente completo (1/1)



Si utilizamos las 4 ramas como activas, obtendremos la configuración de la fig. 9, en la cual por ser un circuito simétrico se compensan los efectos parásitos que perturban por igual a la línea.

fig8

3.1.4. Perdida de sensibilidad en las líneas de transmisión

Los hilos de unión del circuito de medida extensométrico a los instrumentos de lecturas añaden resistencias en serie a la banda que afectan al valor del factor de banda K y suponen una perdida de sensibilidad.

-6-



Rg. Valor Shmico nominal de la banda.

Rl= Valor óhmico de la línea de transmisión.

▲Rg. Variación del valor óhmico de la banda.

E Alargamiento unitario
K. Factor de banda aislada
Kv Factor de banda real
figio

en efecto, por definición, el valor del factor de banda teórico K vale (fig. 10) $K = \frac{\Delta R_g}{\epsilon} : \frac{\Delta R_F R_g}{\Delta L/0}$ [7]

pero el factor verdadero será: $\frac{\Delta R_3}{K_0} = \frac{R_3 + R_2}{R_3}$

Dado que el fabricante de bandas ignora cual será la resistencia de los hilos utilizados, habrá que introducir un fac tor de corrección de valor;

Fa

[10]

$$D = \frac{k_V}{K} = \frac{k_Y}{R_g + R_L} - - - [8]$$

D se llama coeficiente de desensibilización y será prácticamente l con lineas muy cortas, pero si éstas son superiores a unos 10 metros, es aconsejable h<u>a</u> cer la correción, para lo cual si no c<u>o</u> nocemos la resistencia del conductor deberá hallarse experimentalmente.

3.1.5. Relación entre deformación y señal de salida

El objeto principal de la Extensometría es el conocimiento del estado de deformaciones, pero en el estudio de los circuitos de medida hemos visto que las deformaciones del material donde se monta la banda, producen una variación de la resistencia de la misma y que al ser ésta parte activa de un puente de Wheatstone, or<u>i</u> gina una d.d.p. en una de sus diagonales proporcional a la deformación, es decir que será necesario establecer la relación entre el estímulo (deformación) y la respuesta (d.d.p. en el puente). Recordando [3a]: $V_{S} = \frac{V_e}{4} p \frac{\Delta R}{R}$, y la $[7\alpha]$ $K = \frac{\Delta R/R}{E}$

deducimos que: $\frac{V_s}{\epsilon} = \frac{V_e}{L} p K$.

Relación importante sobre todo cuando la lectura se efectua con instrumentos que no dan lecturas directas en microdeformaciones.

Ejemplo: El elemento de la fig. ll está sometido a un esfuerzo de tracción simple; si medimos al aplicar la carga, a la salida del puente una V_s= 1 mV, calcular la fuerza F.



 $V_{s} = \frac{V_{e}}{4} RK \epsilon = \frac{2}{4} 2\epsilon = 1000 \mu V (R=1)$ E= 1000 md

F= E E S: 1000. 20.10. 0.5. 10 = 10KN

3.1.6. Estudio de diversos circuitos de medida

Es muy frecuente, que en el punto objeto de medida incidan esfuerzos compuestos y sin embargo, solo nos interese conocer la influencia individual de dichos esfuerzos como veremos estudiando casos particulares.

Tracción o compresión simple

Si el elemento de ensayo está sometido simultáneamente a flexión, tracción compresión y variaciones de temperatura amplias, el circuito de la fig. 12 solo será sensible a los esfuerzos de trac ción ó compresión; en efecto, la variación de resistencia de cada una de las bandas es (llamando Ro= valor nominal de la banda; ΔR_T = incremento de Ro por la componente tangencial; ΔR_N = iden, normal y AR₊ efecto variación de temperatura

TRACCION O COMPRESION PURA









 $R_{A1} = R_{3} + \Delta R_{T} + \Delta R_{N} + \Delta R_{t}$ $R_{M} = R_{o} + \Delta R_{T} - \Delta R_{N} + \Delta R_{r}$ $R_{c2} = R_{o} + \Delta R_{F}$ Si aplicamos la [3] $R_{C'2} = R_0 + \Delta R_+$ $V_{S} = \frac{Ve}{4} \left(\frac{\Lambda R_{T}}{2R_{0}} + \frac{\Lambda R_{N}}{2R_{0}} + \frac{\Lambda R_{T}}{2R_{0}} + \frac{\Lambda R_{T}}{2R_{0}} - \frac{\Lambda R_{L}}{2R_{0}} \right) = \frac{Ve}{4} \frac{\Lambda R_{T}}{R_{0}} \left[11 \right]$ VS= Ve ART = Ve KET $\mathcal{E}_{T} = \frac{\Delta \hat{\ell}}{\hat{\ell}} = \frac{4 \sqrt{s}}{K \sqrt{s}}$ [12]

Lo anteriormente expuesto es válido siempre que por el eje de aplicación de cargas pase un plano de simetría de la pieza, y exige el montaje de dos bandas por rama del puente, siendo aquí de aplicación el utilizar valores fraccionados (ver 2.2.1.) p.e. 60 ohms, para que la impedancia del circuito sea 120 ohm, siendo esto último preceptivo si no se montan compensadoras y se utiliza montaja de 1/4 de puente.

Flexion simple





fig 13

Para medir una flexión simple (fig. 13) eliminando otras influencias, no es nec<u>e</u> sario montar bandas compensadoras, ya que el propio circuito compensa los efe<u>c</u> tos de variación de temperatura. Se cumple que:

$$R_{AI} = R_{o} + \Delta R_{T} + \Delta R_{N} + \Delta R_{E}$$

$$R_{A2} = R_{o} + \Delta R_{T} - \Delta R_{N} + \Delta R_{E} \quad aplicando [3]$$

$$k = \frac{Ve}{4} \left(\frac{\Delta R_{T}}{R_{o}} + \frac{\Delta R_{N}}{R_{o}} + \frac{\Delta R_{E}}{R_{o}} - \frac{\Delta R_{T}}{R_{o}} + \frac{\Delta R_{N}}{R_{o}} - \frac{\Delta R_{E}}{R_{o}} \right) =$$

$$= \frac{Ve}{2} \frac{\Delta R_{N}}{R_{o}} - - - - - [13]$$

$$V_{S} = \frac{Ve}{2} \frac{\Delta R_{N}}{R_{o}} = \frac{Ve}{2} K E_{N}$$

$$E_{N} = \frac{2Vs}{VeK} = \frac{4F_{N}E}{\pi Er^{3}} = \frac{3Er}{L^{3}}f - - - [14]$$

$$N = 0,56 - \frac{\Gamma}{12} - \frac{E}{P}$$

N= frecuencia natural f= flecha E= Modulo elasticidad **θ**= densidad



El efecto de la resistencia de calibración R_c , es equivalenté a una compresión sobre la rama que actua. Supongamos que deseamos calcular el valor de R_c para que tengamos un efecto equivalente a 500 μ en un circuito de bandas de $R_o = 120$ ohm, K = 2, excitado con $V_e = 2$ V; tenemos que:

El signo (-) indica que se trata de compresión. En la fig. 16 se supone que un solo brazo del puente es activo, en general y teniendo en cuenta el nº de brazos activos del circuito, encontramos la expresión general

en la que:

Rc= Resistencia de calibración

Ro= Valor nominal de la resistencia de una rama del puente.

[20]

- K= Factor longitudinal de sensibilidad de la banda.
- E= Alargamiento unitario equivalente que produce Rc.
- N= Nº de brazos activos del circuito del puente.

(El termino EK en el numerador se desprecia por ser muy pequeño).

Si el instrumento de lectura da indicaciones directas en microdeformaciones, lo explicado es suficiente, pero ocurre, sobre todo en medidas dinámicas, que tendremos que establecer una relación entre deformaciones y d.d.p. a la salida de los amplificadores que el<u>e</u> van de nivel las débiles señales del puente de medida; siendo regla práctica, buscar escalas enteras. Ejemplo.

En la fig. 17 se representa el circuito para medida de tracción simple en una barra circular de 500 mm² de sección, se desea que una carga 10 KN dé una indicación de 100 mV en el instrumento de lectura (1 da N/mV).



$$E = \frac{5}{E} = \frac{10 \cdot 10^2 \cdot 10^6}{500 \cdot 2 \cdot 1 \cdot 10^4} = 470 \text{ m}$$

$$V_{s} = \frac{V_{e}}{4} \epsilon K = \frac{1}{2} 476 = 238 \mu V$$

$$G = \frac{100 (mV)}{0238} = 420 (Ganancia amplificador)$$

 $R_{c}^{=} = \frac{2.120}{476.1052} = 252100 chm$

Luego si colocando una Rc= 252100 ohm, ajustamos la ganancia del amplificador para leer -100 mV, tendremos el circuito preparado para leer las fuerzas F con una escala de 1 da N/mV.

Observese que se ha empleado circuito de 1/4 de puente con 2 bandas de 120 ohm en serie para eliminar efectos de flexión y torsión.

La calibración de un circuito extensométrico por shunt de una resistencia es casi universalmente aceptada, no obstante presenta el inconveniente de insertar la señal de referencia en registros dinámicos, ya que dicha señal se superpone a la componente dinámica y la suma puede salirse del rango de medida por saturación de instrumento para paliar ésto, se puede utilizar una resistencia en serie tal y como



se indica en la fig. 18, asi abriendo el interruptor A dejamos sin excitación el circuito y nos marcará el cero -(correspondiente a carga nula) y si a continuación cerramos B, obtendremos una señal de referencia independiente del estado de carga del circuito.

Se demuestra que para producir la misma señal la relación entre los valores de la resistencias shunt y serie son Rc=2Rc.

Hasta aquí hemos supuesto siempre que el puente de Wheat<u>s</u> tone estaba completamente equilibrado para carga**s** nulas en el circuito de medida, pero debido a las pequeñas variaciones de resistencia que se originan **e**l montaje, (por soldaduras, variaciones de la propia resi<u>s</u> tencia de la banda al ser pegada, etc,) la señal de salida V_s tendrá un

-13-

pequeño valor que conviene anular para hacer lecturas directas.

El desequilibrio inicial del puente en medidas estáticas, con instrumentos que dan lectura directa en microdeformaciones, obliga a hacer una lectura inicial estando sin carga la pieza de ens<u>a</u> yo que será restada de las lecturas posteriores bajo carga. En el caso de medidas dinámicas, partir con un desequilibrio, equivale a introducir una componente de contínua constante.

Varios con los procedimientos que pueden utilizarse para corregir un desequilibrio inicial pero el más universal, consiste en colocar un potenciómetro de alto valor óhmico en la diagonal de alimentación del puente con el contacto móvil unido a través de una resistencia R_A al vértice intermedio tal y como se indica en la fig. 19.





La resistencia R_A limita *e*l tanto por ciento de desequilibrio capáz de corregir y el potenciómetro P dá el poder de resolución de dicha ajuste. En efecto, supongamos que en el circuito de la fig. 20 queremos calcular R_A para poder corregir desequilibrios de un 2% o lo que es lo mismo suponer que:

 $R_2 = R_3 = R_4 = 120$ ohm $R_1 = 117,6$ ohm

La resistencia total de la rama 2 tiene que ser igual a la de la rama 1 por tan R_2^{m} R_3^{m} R_3^{m} R_3^{m} $R_4^{m} = \frac{R_1 R_2}{R_2 - R_1} = \frac{5880 \text{ ohm}}{R_2 - R_1}$ Para el cólculo hemos supuesto que el cursor del poten-

Para el calculo hemos supuesto que el cursor del potenciómetro está en un extreno, por lo que si P es de valor elevado, al estar en paralelo con R, no le influye; para desequilibrios inferiores al 2% desplazando el cursor se consigue la posición en la que por G no circula corriente.

Otros procedimientos pueden consistir en añadir resistencias en serie en las ramas hasta conseguir el equilibrio, pero si bién este método es aconsejable para la construcción de captadores, no es práctico en medidas extensométricas salvo casos muy especiales. En instrumentación para medidas dinómicas, los desequiprios de los circuitos de medida se compensan introduciendo una con tratensión en la entrada de amplificación, con lo que se consigue no desensibilizar en absoluto el circuito e incluso producir "falsos ceros" cuando las condiciones de la medida lo aconsejen (fig. 21).



Sea cual sea el procedimiento con el que corrijamos el desequilibrio, los componentes utilizados serán de precisión y estabilidad idéntica a la exigida al circuito de medida. El potenciómetro P será de lO vueltas y provisto de duodial, que permitirá reestablecer las condiciones iniciales de equilibrado de manera fácil, aún cuando las condiciones originales hayan variado.

3.3. Captadores extensométricos

El conocimiento de las técnicas extensométricas abre la posibilidad de construir captadores que efectuen la transducción de – cierta energía mecánica en eléctrica, pero no obstante hay que advertir que los problemas que en éste cometido se presentan, son tal complejos, que solo verdaderos especialistas serán capaces de conseguir resultados aceptables, por lo que todo lo expuesto a continuación, debe cons<u>i</u> derarse solo a título informativo, para mejor comprender el funcionamien to de estos instrumentos indispensables en un laboratorio de ensayos – dinámicos.

Un captador estará formado por un dispositivo mecánico que sea sensible de forma mayoritaria a determinados parámetros fisicos (fuerza, presión, aceleración, etc) y prácticamente insensible al resto de fenómenos que incidan simultáneamente sobre él. Si sobre el elemento sensible del captador montamos bandas extensométricas, podr<u>e</u> mos medir las deformaciones de éstas relacionándolas con el parámetro que las originó, como es lógico, podremos conseguir la independencia del captador a solicitaciones no deseadas valiéndonos del adecuado d<u>i</u> seño mecánico y de la disposición de las bandas.

_95-

La elección de los materiales que constituyen la partemecánica del captador es de vital importancia y se tendrá muy en cue<u>n</u> ta que el módulo de elasticidad E, sea totalmente constante en el ma<u>r</u> gen de utilización y jamás sobrepasar la zona lineal de trabajo, exe<u>n</u> ta en lo posible, de fenómenos de histeresis y fluencia, siendo norm<u>a</u> tivomsobrepasar en las cargas 1/10 del límite elástico. El coeficiente de dilatación tiene menos importancia una vez que las dilataciones s<u>e</u> rán homogeneas y se utilizarán bandas autocompensadas.

A título de ejemplo en la fig. 22 se ofrecen esquematicamente algunos montajes para medidas de los parámetros que se indican. Nunca habrá limite en diseñar cualquier disposición mecánico que añada mejoras para determinados fines.

Hasta aquí nos referimos a bandas extensométricas pegadas (Bonded Strain-gages) pero en captadores se utiliza generalmente otro tipo de extensímetro en el cual, el elemento sensible es un hilo sin soporte y apoyado sobre unos zafiros (unbonded strain-gages), que si bién cumple todos los principios hasta ahora expuestos, es muy di<u>s</u> tinto. En efecto, consideremos la fig. 23 en la que las bandas extens<u>o</u> métricas tal y como las hemos concebido hasta ahora son sustituidas por hilos conductores A, B,C y D sometidos a una tensión previa; si la:





carcasa interna se mueve por cualquier solicitación mećanica (ej. aceleración) a derecha o izquierda respecto a la carcasa externa, los hilos A y D y los B y C sufren deformaciones de signos contrarios respectivamente. La conexión eléctrica del circuito para constituir el puente de Wheatstone se indica en la fig. 24.

A título de ejemplo la fig. 25 indica la disposición adoptada por B2H en sus captadores de aceleración.

Lio25

Desplazamiento





Aceleración-vibración



Los desplazamientos relativos entre A (fijo) y A' (móvil) producen una defo<u>r</u> mación en la lámina pro flexión, propo<u>r</u> cional al desplazamiento d.

Una barra cilíndrica en tracción y/o compresión (evitar pandeo).

Anillo dinamométrico en tracción.

La masa sismica M es sensible a las fuerzas de aceleración y habrá propo<u>r</u> cionalidad con la deformación que sufra a flexión la lámina M. Sí la frecuencia propia de la lámina es superior a la del movimiento la respuesta será a la aceleración y si inferior a la velocidad del desplazamiento de M.

Presión

La membrana M se deforma si en là camara C hay variaciones de presión.







Lámina cilindrica en flexión

- F fuerza aplicada
- d = 2.r. diametro
- brazo fuerza-banda 1
- brazo fuerza-encastramiento L
- primera frecuencia propia N
- flecha (desplazamiento de F) f
- deformación longitudinal εı
- deformación transversal ε,

Anillo dinamométrico

- е espesor
- anchura а
- R radio medio
- f flecha total
 - deformación longitudinal exterior

deformación longitudinal interior



 $\varepsilon_{e} = \frac{3 F R}{E a e^{2}} \left(1 - \frac{2}{\pi} \right)$

 $\varepsilon_{i} = \frac{-3 \text{ FR}}{\text{E a } c^{2}} \left(1 - \frac{2}{\pi}\right)$

 $f = 1,79 \frac{F R^3}{E a e^3}$

Arbol en torsión

M=FI momento aplicado

- longitud total del arbol L
- ángulo de giro en radiones α

La distancia de las bandas no afecta

- deformación de una de las bandas ε₁ ε2
- deformación de la otra banda

FORMULAS PARA EL (ALCULO DE TRANSDUCTORES

Lámina en Tracción

- F fuerza aplicada
- a 🗧 anchura
- espesor е

 ε_1 deformación longitudinal

 ϵ_2^{\dagger} deformación transversal

Toro circular en Tracción%compresión

- F fuerza repartida
- D diametro exterior
- d diámetro interior
- ϵ_1 deformación longitudinal ϵ_2 deformación transversal



- F fuerza aplicada

- $\begin{array}{l} \epsilon_1 & \text{deformación longitudinal} \\ \epsilon_2 & \text{deformación transversal} \end{array}$



- fuerza aplicada (en el vértice) F
- anchura base ·b
- L brazo fue f flecha brazo fuerza-encastramiento (altura)
- La distancia de las bandas no afecta
- $\begin{array}{l} \epsilon_1 & \text{deformación longitudinal} \\ \epsilon_2 & \text{deformación transversal} \end{array}$



 $\varepsilon_{1} = \frac{6 F L}{E b e^{2}} = \frac{e}{L^{2}} f$ $\varepsilon_{2} = \frac{-6 \mu F L}{E b e^{2}} = \frac{-\mu e}{L^{2}} f$ $f = \frac{6 F L^{3}}{E b e^{3}}$



 $\varepsilon_1 = \frac{F}{E a \cdot \theta}$

Temperaturas extremas de compensación.- Temperaturas inferior y superior, que no deben sobrepasarse, para que, empleando la compensación, las características del captador se mantengan dentro de los límites definidos para los mismos.

Temperaturas extremas de empleo.- Temperaturas inferior y superior que, en caso de sobrepasarse, determinan la pérdida definitiva de las características del captador.

Impedancia.- Sensibilidad a fenómenos para los cuales el captador no ha sido realizado, p.e.: Sensibilidad de un acelerómetro para aceleraciones perpendiculares a su eje primario (Cross Axis Sensitivity).

Desplazamiento (Deflection).- Distancia entre las dos posiciones de un punto después de cargado, comprendido dentro de la que existe a carga nula y nominal.

Ambiente (Stamdard Test Conditions).— Conjunto de aquellos valores característicos del medio ambiente que pueden influenciar las propie dades de un captador y que deben ser definidas en la calibración.

Frecuencia natural (Natural frequency).- Frecuencia de oscilaciones libres en ausencia de cargas.

Sobrecargas eléctricas admisibles.- Potencias límites para el circuito de alimentación y que no deben sobrepasarse, bajo el riesgo: a) De pérdida de características de captador.

b) Destrucción total del captador.

Eje primario (Primory Axis).- Eje según el cual las cargas deben ser aplicadas.

3.5. Determinación de las tensiones residuales

Introducción---

Con los extensimetros ohmicos lo único que puede eva luarse son cambios de deformación. Por consiguiente, si se desea determinar el estado de deformación existente en alguna pieza es necesario poder cambiar esa deformación una cantidad medible después de que se haya pegado la banda. A continuación, interpretar adecuadamen

te el cambio medido.

Las tensiones residuales determinadas por relajación son un ejemplo de este método. En él, una banda se fija a la pieza y se mide su resistencia eléctrica. Luego se perfora o corta un trozo de la pieza teniendo cuidado de que no se produzca calentamiento; y se vuelve a medir la resistencia de la banda.

Si se produce una variación correspondiente a una trac ción lo que habría es una compresión y recíprocamente.

2 R .

r= K

<u>Teoría. Para el caso de relación por taladro (fig.29)</u>

Si se hace un taladro de pequeño diámetro (2Ro) en una región con tensiones residuales, se produce una relajación de deformaci<u>o</u> nes. Las deformaciones suprimidas en el punto P a una distancia R del ce<u>n</u> tro del taladro cuando solo existe la tensión **S**₁ son:

$$E_{r} = -\Gamma_{1} \frac{(1+\mu)}{2E} \left(\frac{1}{r^{2}} - \frac{3}{44} \cos 2\alpha + \frac{1}{1+\mu} \frac{1}{r^{2}} \cos 2\alpha \right) \rightarrow \Gamma$$

$$E_{p} = -\Gamma_{1} \frac{1+\mu}{2E} \left(-\frac{1}{r^{2}} + \frac{3}{r^{4}} \cos 2\alpha - \frac{4\mu}{r^{4}} - \frac{1}{r^{2}} \cos 2\alpha \right)$$

$$\begin{aligned} & \mathcal{J}_{\Theta} = \frac{\sigma_{1}}{2 G} \left(\frac{3}{\Gamma^{4}} - \frac{2}{\Gamma^{2}} \right) \operatorname{ser} 2 \alpha \\ & \mathcal{E}_{\Gamma} - \mathcal{E}_{\Theta} = -\sigma_{1} \frac{1 + \mu}{2 E} \left(\frac{2}{\Gamma^{2}} - \frac{6}{\Gamma^{4}} \cos 2\alpha + \frac{\mu}{\Gamma^{2}} \cos 2\alpha \right) \end{aligned}$$

 $\mathcal{E}_{r}: (A + B \cos 2\alpha) \mathcal{T}_{r}$ Y si existen simultáneamente $\mathcal{T}_{r} \mathcal{Y} \mathcal{T}_{z}$ será

$\mathcal{E}_r = (A + B \cos 2\alpha) \mathcal{T}_r + [A + B \cos 2(\alpha + 90^\circ)] \mathcal{T}_2.$

Los coeficientes A y B pueden calcularse fácilmente a partir de las constantes $\mu \gamma E$ E del material en cuestión y para cual quier distancia R.

06.

También se pueden determinar experimentalmente los coe ficientes A y B haciendo ensayos sin tensiones residuales sino com reales $\mathcal{G}_{\mu} \neq \mathcal{G}_{\sigma}$ conocidos, por ejemplo $\mathcal{G}_{\mu} = \mathcal{G}_{\mu} \neq \mathcal{G}_{\mu} = 0$

Caso de la roseta (fig. 30)

Con tres bandas pega das a una distancia R y en las direcciones <u>a b</u> y <u>c</u> a 45º pueden me. dirse tres deformaciones $\mathcal{E}_{\boldsymbol{\xi}}, \mathcal{E}_{\boldsymbol{\xi}} \mathcal{Y} \mathcal{E}_{\boldsymbol{\zeta}}$ que llevadas a la ecuación anterior (2) nos permiten despejar (; ;); y tg2B

$$S_1 = \frac{(A+B\cos 2\beta)\varepsilon_a - (A-B\cos 2\beta)\varepsilon_c}{4AB\cos 2\beta}$$

$$\sigma_{2} = \frac{(A+B\cos 2\beta)\mathcal{E}_{c} - (A-B\cos 2\beta)\mathcal{E}_{a}}{4AB\cos 2\beta}$$

$$t_{g} 2\beta = \frac{\mathcal{E}_{a} - 2\mathcal{E}_{b} + \mathcal{E}_{c}}{\mathcal{E}_{a} - \mathcal{E}_{c}}$$



fig.30

Estas expresiones son buenas si las direcciones a 🖇 C corresponden aproximadamente con las principales. En casp de que no sea así y las <u>a</u> y <u>b</u> dén las deformaciones más distintas son más satisfactorias las ecuaciones siguientes:

$$\sigma_{1}: \frac{(A+B \operatorname{sen} 2\beta)\varepsilon_{a} - (A-B \operatorname{cos} 2\beta)\varepsilon_{b}}{2AB(\operatorname{sen} 2\beta + \cos 2\beta)}$$

$$\sigma_{2}: \frac{(A+B \operatorname{cos} 2\beta)\varepsilon_{b} - (A-B \operatorname{sen} 2\beta)\varepsilon_{a}}{2AB(\operatorname{sen} 2\beta + \cos 2\beta)\varepsilon_{a}}$$

$$\operatorname{cas experimentales}$$

Técni

Como en todo lo experimental, las herramientas apropia das, la instrumentación y la cuidadosa aplicación de los procedimien tos son esenciales para obtener resultados ciertos.

Taladrado

Con brocas cilíndricas, no cónicas. La parte cortante sólo en el frente. El diámetro del cilindro se reduce a una distancia de O,16 otin a un diámetro menor en un 12% del de la punta para dejar sitio entre la broca y el agujero para la salida de virutas.

-26-

Bandas especiales

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Rosetas de bandas especialmente bién espaciadas en el círculo y con el centro de este bién definido. (#3.31)

Puente de médida

Puente portable de baterías con potenciómetros de equ<u>i</u> librado.

Centrado del taladro

Soporte centrador de un microscopio sustituible por una taladradora. (fig.32)



fig31



fig 32

TEMA IV

4.1. Instrumentos para medidas estáticas.-

Aceptando como universal el circuito de puente de -Wheatstone en medidas extensométricas, dos son los procedimientos que se pueden emplear para medir el desequilibrio que en una diagonal se produce cuando las bandas se deforman.

El "Método de oposición" introduce en la diagonal del puente (fig. l) una tensión opuesta a la de desequilibrio, siendo el instrumento G el que controla la posición de equilibrio. Si el poten-



ciómetro P está graduado en la escala deseada (microdeformaciones) e incluso va dotado de un indicador num<u>é</u> rico y dispositivos de preequilibrado, podremos hacer las lecturas directas. Se comprende que para no intr<u>o</u> ducir error las tensiones -

 $E_1 y E_2$ deben estar estabilizadas en alto grado o bién que sus variaciones sean totalmente proporcionales, pero según el esquema de la fig. 1, eso es muy dificil de conseguir, de ahí, que se utilice la disposición indicada en la fig. 2 en las que la solución si bién es satisfactoria en un aspecto, crea problemas en otros, en efecto, si alimentamos los puentes en corriente contínua, y dada su polaridad, los instrumentos nos indicarán las deformaciones producidas por esfuerzos de tracción o compresión según las desviaciones de la aguja sea en uno u otro sen tido respectivamente, pero al ser excitados en corriente alterna es ne cesario introducir un circuito llamado detector de fase que discrimine cuando las deformaciones son de tracción o de compresión en efecto: - (fig. 3)



si el puente está en equilibrio:

v_B - v_A = v_S = O

si hay tracción en una rama:

si hay compresión en una rama

$$v_{B} - v_{A} = v'_{S}$$
 (compresión)



Por otra parte, para conseguir la oposición entre las tensiones E_1 y E_2 es necesario que estén defasadas 180º y para logra<u>r</u> lo hay que introducir ajustes capacitivos, lo cual representa otro i<u>n</u> conveniente; por tal motivo la casa Vishay-Micromesures, en su puente P-350, emplea como portadora una onda cuadrada, en vez de senoidal, y la oposición de fase se consigue de forma automática sin necesidad de ajustes capacitivos, ventaja que le confiere una gran aceptación por extensometristas experimentados.

En el "Método de cero" (fig. 4) el equilibrio del puente



se consigue introduciendo resistencias en las ramas del puente hasta conseguir el equilibrio inicial; los potenciómetros P_1 y P_2 se desplazan conjuntamente en sentido inverso hasta anular tensión de desequil<u>i</u> brio entre A y B. graduando adecuadamente los mandos de P_1 y P_2 podremos hacer lecturas directas. El mando de P_1 y P_2 puede hacerse a través de un servomecanísmo y constituir casí una unidad de lectura autom<u>á</u> tica. Otro procedimiento, que actualmente está siendo cada vez mas empleado, consiste en leer directamente la señal de salida del puente por medio de un voltímetro digital de precisión y exactitud ele vada. Este procedimiento exige a su vez que la fuente de excitación sea muy estable (fig. 5)



4.1.1. Cajas de conmutación manual

Normalmente, las medidas extensométricas, habrá que efe<u>c</u> tuarlas en varios puntos, si estos son muy numerosos (se estima que s<u>u</u> periores a 25) una unidad automática será conveniente, pero para una cantidad inferior se utilizan unidades de conmutación manual con resultados prácticos satisfactorios; ya que el mayor tiempo de lectura que será necesario emplear justifica su uso por razones meramente económicas, pues lógicamente los equipos manuales son de bajo precio.

El problema que se plantea es conmutar diversos circuitos de medida a un solo instrumento de lectura de lo que se deduce que el conmutador será de una calidad que garantice un mínimo de error en la medida (Ver 3.1.1.). Por otra parte la unidad de conmutación debe ofrecer la posibilidad de un equilibrado previo de los circuitos de dida, para que cuando ensayemos bajo carga la pieza en estudio, las lecturas puedan ser directas.

En la fig. 6 se indica la disposición adoptada por Vishay-Micromesures en su unidad S-Bl en la que se consigue una adaptación completa de los circuitos de 1/1; 1/2 ó 1/4 de puente, asociada al in<u>s</u> trumento P-350 o cualquier otro similar.

El potenciómetro P de equilibrado, será de precisión y de 10 vueltas para conseguir una buena resolución, si a su vez va provisto de un mando con contador numérico de vueltas (Duodial) podremos reestablecer las condiciones previas del equilibrado, aún cuando se hubiese utilizado en otros circuitos distintos la unidad de conmutación en el curso de experiencias diversas.





4.1.2. Instrumentos de calibración

Los instrumentos de lectura son contrastados por el fabricante en sus factorias, pero el uso y la degeneración de sus componentes con el tiempo, hace necesario una contrastación periódica de los mismos, para ello pueden seguirse varios procedimientos uno de los cu<u>a</u> les se explicó en el apartado 3.2. y consistía en colocar resistencias en paralelo en una rama del puente, que produjesen un desequilibrio – equivalente al que experimentase el mismo circuito sometido a solicit<u>a</u> ciones concretas. Este método si bién es recomendado para calibrar los circuitos de medida no es idóneo para contrastar el instrumento de lectura, ya que nunca sabremos si al colocar la resistencia en paralelo – observamos alguna anomalía, si el error es del circuito o del instrumento, por tal motivo se recomiendan dos procedimientos: lº Simulador de deformaciones y 2º Patrón primario de deformaciones.

Simulador de deformaciones. Consiste en una caja de decadas de alta precisión y estabilidad que comprende 5 décadas que pu<u>e</u> den obtener valores en proos de O,Ol; O,l; l; lO y 100 ohm. con precisión total de <u>+</u> O,O2% sobre cualquier lectura. Su estabilidad es superior a <u>+</u> 50 ppm por año. A estas características responde la unidad - VE-40 de Vishay-Ellis.

Para calibrar un instrumento de lectura en extensometría, suponfremos que el simulador de deformaciones constituye la banda propiamente dicha y para ello ajustaremos un valor igual al de extensímetro p.e. 120. Efectuaremos posteriormente su conexión al instrumento en montaje de 1/4 de puente en la configuración de 3 hilos (fig. 7).



Recordando que: AR= K.R.

tenemos que para $\mathcal{E} = 1500 \, \mu \delta$ **∆**R= 0,36 ohm E = 2000 / u O AR = 0,48 E= 2500 / u & ∆R=0,60

Si K=2 y R= 120 ohm.

Por tanto si el instrumento de lectura está bien tarado, leemos los valores indicados de microdeformaciones, si en el simulador vamos paulatinamente fijando los valores de 120,36; 120,48 ohm etc. Te ner presente que así simulamos tracciones, si disminuimos el valor 120 ohm, en la misma proporción leeríamos compresiones.

Patrón de deformaciones

Una viga de sección rectangular b...c. toma forma de arco de anillo circular, al ser sometida a flexión pura. El valor absoluto de la deformación longitudinal que sufren sus caras horizontales es $\frac{6 Pa}{k c^2 F}$ La flecha del arco de circunferencia así producido es

La relación entre flecha y deformación es

-4 C

lo que nos dice que podemos conocer la deformación en fun ρ ρ a a łig 8

ción de la flecha y de cons tantes geométricas, indepen 📲 dientemente de las cargas y del módulo de elasticidad del material.

El Patrón de Deformaciones permite fijar la flecha con lo que se puede calcular la deformación & correspondiente. Si además se mide la deformación & por medio de extensómetros óhmicos, se puede calcular un coeficiente de corrección para este método o comprobar sistemas extensométricos.

4.2. Sistemas automáticos de adquisición de datos.

Estos sistemas son necesarios cuando por el número de puntos de registro, el tiempo requerido para un barrido manual fuese tal que las condiciones del ensayo variasen dentro de él, y por cons<u>i</u> guiente no fuesen datos adquiridos en igualdad condiciones los de una misma lectura; o bién cuando la magnitud y frecuencia de medidas múltiples haga tedioso y propenso a errores de anotación las lecturas manuales.

El avance tecnológico de la electrónica ha facilitado el diseño de equipos muy sofisticados, y a veces, no justifican las pequeñas ventajas que introducen el elevado precio que adquieren. Por tal motivo juzgamos oportuno describir el conjunto para aue el usuario futuro, tenga elementos de juicio para configurar el Sistema idóneo a sus necesidades, pero no entraremos en la descripción de circuitos, que se escapan del alcance de este artículo.

4.2.1. Diagrama bloque

Circuito Acandiciona Unidod de Amplificodo de barrida dør medida Ezcila. Control de Bión Sarrida Registro Nisuali zacióz Umbresora to magnifica herbona ØÆ

Circuito de medida.

Será cualquier circuito extensométrico, ya descrito, -bién en el aspecto de bandas extensométricas, o bién bajo el concepto de captador. Generalmente podrá ser cualquier elemento transductor de energía mecánica en electrica.

Excitación.-

Por ser circuitos pasivos, tendremos que apostar energía, generalmente para excitar un circuito de puente de Wheatstone.

Acondicionador.-

Debe permitir equilibrar el circuito de medida e introducir señales de calibración.

Unidad de barrido.-

Esta unidad está destinada a conectar cada uno de los circuitos de medida a la unidad central de lectura, con una secuencia predeterminada. Sus características principales son: velocidad de conmutación; fiabilidad de los contactos, número de polos conmutados,etc.

Amplificacdor.-

Aumenta el nivel de tensión de las señales débiles que se crean en los circuitos de medida.

Control de barrido y registro.-

Lo forman circuitos electrónicos, más o menos complejos. que permiten programar las secuencias de las lecturas y de la impresión.

4.3. Sistemas analógicos de registro contínuo

Podríamos definir un sistema como el conjunto de instrumentos, debidamente acoplados, para la adquisición de datos en forma predeterminada, de las magnitudes físicas a medir.

4.3.1. Diagrama bloque



Diagrama bloque de un sistema elemental

El esquema de la figura responde a los elementos funcionales del sistema, que son:

- a) Captador: Es un elemento capáz de convertir una magnitud física en eléctrica. Se basa en fenómenos resistivos, capacitivos, inductivos, piezoeléctricos, termoeléctricos, semi-conductores, etc, etc,
- b) Unidad de excitación: Si el captador no autogenera su propia señal (p.e.: termopares) es necesario alimentarlo con una fuente de energía adicional.
- c) Unidad de adaptación y calibración: Permite corregir y compensar los desequilibrios en los circuitos e introducirles una señal que permita la calibración de los mismos.
- d) Amplificador: Las señales emitidas por los captadores pueden ser tan débiles que no sean capaces de excitar los instrumentos de le<u>c</u> tura ó registro. Es necesario entonces el empleo de unidades inte<u>r</u> medias que aumenten el nivel de la señal de salida.
- e) Registrador ó unidades de lectura: Pueden ser cualquiera de los in<u>s</u> trumentos clásicos destinados a registros analógicos ó digitales ó bién osciloscopios, molivoltímetros, etc,

f) Red de amortiguamiento: Sirve para adaptar las impedancias de entrada y salida de los diferentes amplificadores e instrumentos de lectura ó registro. En el caso de galvanómetros, tiene una influen cia decisiva referente a la respuesta en presencia de los mismos.

4.3.2. Descripción

A Captadores

Un captador ó transductor es aquel elemento que, bajo estímulos físicos, da origen a señales eléctricas. La mayoría de los captadores pr<u>o</u> porcionan salidas analógicas en forma de d.d.p. eléctrico. Muy ideal<u>i</u> zado, podemos suponerlo tal y como se muestra e quemáticamente:

Si una viga elástica y empotenda recibe en su extremo libre un golpe, se producirá un movimiento oscilatorio amortiguado, pues bién, el transductor nos dará una d.d.p. analógica del estímulo recibido.

Los captadores los clasificaremos bajo diversos aspectos:

- a) Estímulo físico, al que son sensibles: captadores de aceleraciones, vibraciones, presiones, fuerzas, desplazamientos, torsión, calor,etc
- b) Principio de la transducción: Resistivos (P. de Wheatstone y poten ciómétricos) inductivos, piezoeléctricos, fotoeléctricos, capacitivos, semiconductores, etc.
- c) Alimentación de su circuito interno: Autoexcitados, excitados, en c.c. y excitados en c.a (portadora).

Captadores más usuales son:

1º Acelerómetros.- Supongamos una masa sísmica M montada en una caja



dor comò el representado esquemáticamente, Si la caja es solidaria con un elemento sometido a vibraciones, se creará un movimiento relativo entre masa M y caja y entre caja y un punto fijo del espacio. Si llama mos "X" e "Y" a los desplazamientos de M respecto a caja y descaja respecto al punto fijo, respectivamente, tendremos que ante cualquier ex citación aparecerá dentro de la caja una energía de valor: dE: (x"+y") dy

con un muelle y sistema amontigua

 $E = \int_{a}^{b} M(X'' + y'') dy = \int_{a}^{b} N(X'' + y'') y' dt$ Energía que se manifiesta en tres formas: cinética, de-

formadora del muelle y disipada en forma de calor por el sistema amo<u>r</u> tiguador. Por tanto:

$$E = \frac{1}{2} M(x'+Y')^2 + \frac{1}{2} K x^2 + \int_0^1 C x'^2 dt (z)$$

siendo K= característica del muelle

C= constante de amortiguamiento

Si el muelle es totalmente elástico se cumple que $\frac{K}{M} = 4 \pi^2 fn^2$, y si el amortiguamiento es el ideal $\frac{S}{M} = 4 \pi f_n$ de ^Mdonde igualando (1) y (2), simplificando y sustituyendo, obtenemos que:

 $X'' + 4\pi f_n X' + 4\pi^2 f_n^2 X = -y''$ (3)

El desplazamiento "Y" varía con el tiempo y no tiene por qué ser periódico. Su armónico principal sería de la forma y" = Ae^{jwt} siendo A la amplitud y w= 2 m f; de esta forma la solución de X sería: X = Be^{jwt} en donde B es función compleja de w; sustituyendo en (3) queda simplificado que:

 $-B^{4}n^{2}f^{2} + jB(2nf) + B(2nfn)^{2} = -A$

donde los dos primeros términos pueden despreciarse si $f_n > f$ es decir, si la frecuencia natural del resorte es mayor que la frecuen cia_del_movimiento-de-la-caja, entonces:-B- $(2\pi fn)^2 = -A$ $\times (2\pi fn)^2 = -y"$ $\times = -y"$

> Vemos, por tanto, que el desplazamien to de la masa es proporcuonal a Ta aceleración a que se somete la caja, siempre que $f_n > f(\approx f \text{ es el } 60\% \text{ de } f_n)^s$ Si unimos la masa sísmica adecuadamen te a un circuito de bandas extensométricas, tal como el mostrado en la f<u>i</u>, gura, los movimientos de la masa se convertirán en deformaciones de las bandas y si éstas forman los cuatro brazos activos de un puente de Wheat<u>s</u> tone, el desequilibrio que producen origina una d.d.p. proporcional a la


Los acelerómetros se construyen de forma que sean sensibles en una so la dirección y con la propiedad que giros de \pm 90° respecto a su posi ción de equilibrio equivalen a producir los mismos efectos que si se someten a una aceleración de \pm l g, repectívamente (g= 9,8 m/seg⁻²).

El tipo descrito corresponde a un acelerómetro resistivo, que son más utilizados, ya que con un margen de frecuencia, relat<u>i</u> vamente amplio, permiten medir desde f = O Hz. Son, además, de muy f<u>á</u> cil acoplo en el sistema por su baja impedancia de salida y proporcionan señales altas, no existiendo problemas de ruido ó descompensación especiales cuando haya que utilizarlos a distancias relativamente gra<u>n</u> des.



Acelerómetro piezoeléctrico.

Si a un cristal piezoeléctrico le aplicamos entre sus caras una fue<u>r</u> za F, se genera en las mismas una carga q, Incorporándole íntimame<u>n</u> te una masa al cristal, tenemos un acelerómetro, en efecto: q dF = dMa.

donde la d.d.p. V_s originada entre caras del cristal vale:

 $V_{s} = \frac{q}{c} = \frac{A}{c} = \frac{dF}{c} = \frac{dMa}{c} = Ka$

es decir, la d.d.p. V es proporcional a las aceleraciones que es s<u>o</u> metida la masa M.

Los acelerómetros piezoeléctricos no necesitan aliment<u>a</u> ción, ya que son autoexcitados. Tienen una respuesta en frecuencia a<u>l</u> ta, aunque no responden bién a frecuencias próximas a O Hz. Necesitan un adaptador de impedancias para su concle en el sistema debido a su muy alta impedancia de salida y pueden dar problemas cuando haya que emplear cableado a distancia.

> 2º) Captadores de vibraciones.- Para los acelerómetros resistivos deciamos que la frecuencia del mov<u>i</u> miento debía ser menor que la fr<u>e</u> cuencia natural del resorte, pues bién, si hacemos ahora que f fn, tendremos un captador de vibración.



En efecto, si lo caja se mueve por encima de la frecuencia de resonancia del muelle, la masa sísmica pe<u>r</u> manece "quieta" en el espacio y la corriente que se origina en las b<u>o</u> binas es proporcional a la velocidad de los desplazamientos de la caja.

Estos captadores tienen la ventaja de que son autoexcitados.

32) Captadores de presión.- El fundamento es el mismo que en los acel<u>e</u> rómetros resistivos, salvo que la masa sísmica es sustituida por un diafragma, que es el elemento se<u>n</u> sible a las presiones.

Pueden hacerse medidas absolutas y diferenciales.

DIFFERENCE VOLTAGE 42) Captadores basados en transformadores lineales.- Ha sido muy desarro llada la técnica del transformador diferencial lineal para su uso en transductores. Básicamente, está constituido por devanado primario y dos devanados secundarios idénti cos y montados en oposición; los tres devanados constituyen la parte estática del captador y un núcleo magnético forma la parte dinámica.

> Al excitar el primario con una corriente alterna constante, si el núcleo se encuentra en su posición media, no habrá d.d.p. en los terminales del secundario, pero para cualquier desplazamiento del núcle aparecerá una d.d.p. entre termin<u>o</u> les del secundario proporcional al

desplazamiento.

Vemos que un transductor básado en el anterior principio, puede conve<u>r</u> tir cualquier magnitud mecánica (de<u>s</u> plazamiènto, presión, fuerza, vibr<u>a</u> ción, etc) en magnitud eléctrica.

Las ventajas de estos transductores son:

Salida exactamente proporcional al desplazamiento del núcleo.

Alta sensibilidad y nivél elevádó a la salida.

Característica linéal de la respues∸ ta en toda su escala.

Variación de la d.d.p, de salida desde cero, sin necesidad de equilibrar el circuito.

Estabilidad del cero.

Permiten la suma ó producto de varios desplazamientos montándolos en serie ó tandem, respectívamente,

Por el contrario, presentan el inconveniente de que nec<u>e</u> sitan demodular y filtrar la salida y de que su excitación no puede ser en corriente continua.

Para paliar el anterior inconveniente, la firma Schaevitz, ha desarrollado un modelo que puede ser excitado en c.c.; su esquema es el indicado y toda la electrónica la constituye un circuito integra do de estado sólido, de dimensiones reducidísimas, incluido dentró del propio captador. El resultado es francamente favorable.





CORE DISPLACEMENT



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Servoacelerómetros



Constituyen un avance enorme en la medida de aceleraciones por las -elevadas prestaciones que ofrecen. Su principio está basado en la res tauración del equilibrio de una ma sa sismica pendular cuando éste es desplazado de su posición de reposo por una fuerza aceleradora. En efecto, de la ecuación Mr= (Momento de tensión)= I (Momento de iner

cia) (aceleración) deducimos que una aceleración angular aplicada al acelerómetro y actuando sobre una masa equilibrada montada en un eje giratorio, origina un par de tensión sobre dicho eje; de la misma forma, si la masa no está equilibrada (pendular) y es sometida a una aceleración lineal producirá en el eje de rotación un momento de tensión.

El fenómeno de la transducción aceleración-señal, se consigue disponiendo de un sensor de posición, capaz de detectar los movimientos de la masa sismica pendular el cual da una señal eléctrica a dichos movimientos y que es amplificada hasta conseguir el nivel adecuado para alimentar la bobina montada dentro de un campo magnético que originará el par antagonista al de torsión que creó la fuerza aceleradora. El circuito es cerrado, de ahi que la señal se obtiene como caida de tensión en R_{r} .

La señal de estos acelerómetros es de <u>+</u> 5 VDC y en la mayoría de aplicaciones no necesitarán posterior amplificación para su registro. Son alimentados normalmente a + 15 VDC.

B <u>Módulos de excitación</u>

Módulo de excitación es un elemento capáz de suministrar la energía adecuada al captador para obtener señales eléctricas propo<u>r</u> cionales a los estímulos físicos a los que se someta. Podremos utilizar, desde una simple pila seca, hasta una sofisticada fuente de alimentación, siendo la calidad del captador y las características del sistema quienes impondrán el tipo adecuado de módulo.

Nos referiremos siempre a módulos de excitación en c.c. ya que la utilización de excitación en c.a. (portador:) cada vez está más en desuso y, cuando se utiliza, son los propios amplificadores los que llevan incorporados un oscilador que proporciona la excitación con d.d.p. de O-10 V en frecuencias de 2 a 8 KHz, normalmente.

Un buén módulo de excitación debe suministrar una d.d.p. constante; se comprende ésto, ya que cualquier variación en la d.d.p. de la excitación introducirá errores en la señal de salida del captador, que es proporcional a la excitación y a la variación del estímulo físico.

En general, la elección de un módulo de excitación se hará considerando dos aspectos:

- 1º) Características del captador.- Impondrán el valor de la d.d.p., in tensidad de corriente y potencia; deberán considerarse los casos en que sean varios los captadores alimentados en paralelo por un solo módulo.
- 2º) Especificaciones propias del módulo de excitación.- Serán indice de la calidad del mismo. Deben considerarse como importantes:

Posibilidad de ajuste sobretensiones (cortocircuitos, electromagné tica, térmica, electrónica, etc).

Limitador electrónico de la corriente de salida. Reversibilidad de la polaridad. Rizo residual de la tensión de salida. Aislamiento de bornes de salida a masa ó tierra. Corrientes de fugos. Rechazo de interferencias. Voltímetro incorporado de control. Deriva de la salida respecto a tiempo y temperatura. Márgenes de la temperatura de utilización. Posibilidad de alimentación por c.a. ó por baterías. Incorporación de acumuladores autorrecargables. Conectores, caja de montaje, pero, etc.etc.

C. Unidades de adaptación

Una unidad de adaptación incorpora en el sistema los el<u>e</u> mentos necesarios para equilibrar el circuito de medida, es decir, para que una carga nula en el captador dé como señal de salida cero, compe<u>n</u> sando las asimetrías propias del captador, ó producidas por cables, conexionado, etc. Si los captadores son resistivos, la come en sación será solo con potenciómetros, siendo necesario un ajuste capacitivo en el caso de captadores inductivos ó cuando se emplee el sistema de exc<u>i</u> tación por "onda portadora". Opcionalmente, pueden incluir un sistema de calibración y elementos pasivos (resistencias) para completar circu<u>i</u> tos de medida de captadores, generalmente cuando se utilizan puentes de Wheatstone.

Normalmente, las especificaciones de una unidad de adap tación son referidas a circuitos con 350 ohmios y excitados con 10 V, pero no hay razón para ampliar estas especificaciones a otros valores, por ejemplo, si una unidad de adaptación permite compensar desequilibrios de \pm 4 mV en un circuito de 350 ohmios con 10 V de excitación, -Utilizando un circuito de 1.000 ohmios y la misma excitación, la cobe<u>r</u> tura de ajuste sería:

 $\frac{1.000}{350} \times (\pm 4) = \pm 11,4 \text{ mV}.$

El poder de resolución debe ser del orden de 5 microvoltios para una buena unidad.

Es frecuente utilizar una resistencia fija de precisión para calibrar un circuito, conmutándola en paralelo con una rama del puente de Wheatstone. La señal así obtenida es equivalente a la que produciría el captador sometido a cierto estímulo físico. La carta que acompaña a los captadores indica el valor de la resistencia, que producirá una señal equivalente a la del captador con el 80% de su carga nominal. Con el fín de evitar la utilización de numerosas resis tencias de calibración, se montan unas bornas exteriores que permiten conectar una caja de décadas y, de esta firma, seleccionar el valor adecuado para cada captador ó circuito de medida.

En medidas de Extensionetría se presenta, con frecuencia, la necesidad de utilizar 1,2 ó 4 brazos activos de un circuito de puente Wheatstone. Para estos casos ó similares, las unidades de adaptación suelen llevar incorporadas las resistencias que completan los brazos pasivos del circuito, facilitando el montaje con una economía notable al disminuir el número de extendímetros por circuito de medida.

Se tendrá muy en consideración que no exista un punto común (masa), pues provocaría un cortocircuito en una rama del puente.

D <u>Amplificadores</u>

El amplificador es una unidad intermedia entre el circu<u>i</u> to de medida y el registrador y su utilización será justificada por dos razones: una cuando la señal del captador sea insuficiente para excitar los instrumentos de lectura ó registro y otra en el caso de fenómenos cuya presencia sea superior a los 350 Hz, ya que los galvanómetros capaces de dar respuestas a estas frecuencias son de baja se<u>n</u> sibilidad.

La tecnología electrónica de un amplificador para sist<u>e</u> mas de medida ha evolucionado grandemente en los últimos años y del primitivo tipo de onda portadora (carrier), se ha pasado a las actuales de tipo diferencial, con circuitos transistorizados sencillos, e<u>s</u> tando desarrollándose actualmente técnicas más avanzadas con empleo de circuitos integrados y del amplificador operacional.

Describir circuitos electrónicos de un amplificador no es objeto de este artéiulo, pues no olvidemos que, desde el punto de vista de instrumentación, su uso, y no su constitución, es necesario conocer. Sí es preciso, sin embargo, interpretar correctamente las especificaciones que de ellos se dan, para poder elegir y utilizar siempre el modelo mós idóneo para un determinado sistema.

Especificaciones de un amplificador.

Configuración (Configuration).- Indica generalmente la disposición de la entrada y salida, diciéndose que es verdaderamente "di ferencial" cuando están totalmente aisladas y "single e<u>n</u> ded" cuando hay una entrada y salida común. La salida de un amplificador puede tener un punto a tierra ó estar t<u>o</u> totalmente aislada. En este caso se dice que tiene "salidas flotantes".

- Ganancia en tensión (Voltage Gain).- Normalmente será por pasos fijos (10, 20, 50, 100, 200, 500, etc) y ajuste fino entre pasos. Es importante el grado de exactitud entre pasos.
- Respuesta en frecuencia (Frequency Response).- Nos indicará el % de v<u>a</u> riación de la ganancia en un determinado ancho de banda.
- Tiempo de recuperación contra sobrecargas (Overload Recovery Time).-Si a un amplificador lo sometemos a una sobrecarga de lO veces el valor final de escala, nos indicará el tiempo que transcurre desde que cesa la sobrecarga hasta que se alcan za el 90% del valor total de escala.
- Linearidad (Linearity).- Idealmente, un amplificador deberá dar salidas totalmente proporcionales a las señales de entrada. El error de proporcionalidad expresado en % del valor máximo de la señal de salida lo da esta especificación.
- Derivas (Drifts).-Se entiende por derivas las variaciones de la señal de salida con señal de entrada nula y puede referirse al tiempo y/ó temperatura. Las variaciones de la salida por este motivo deben mantenerse en el entorno dado en esta especificación.
- Ruido (Noise).— El ruido inherente a circuitos electrónicos (agitación térmica) limita el poder de resolución, que no podrá ser mayor que la especificación dada para ruido.
- Modo común de rechazo (Common Mode Refection).- Es Índice del poder de rechazar señales indeseadas. Se expresa, en dB, como la r<u>e</u> lación entre el voltaje en modo común (CMV) y la señal que dicho CMV originaría en la entrada.

 $CMR (dB) = 20 \log CMV$

- Sensibilidad (Sensitivity).- Relaciona los miveles de la señal de entrada y los máximos de la señal de salida.
- Máxima impedancia del circuito de medida (Máximum Source Impedance).-Es el límite superior del valor de la impedancia del circu<u>i</u> to de medida.

Impedancia de entrada (Input Impedance).- Es la medida a la entrada del amplificador.

Impedancia de salida (Output Impedance).- Es la medida a la salida del amplificador.

Capacidad (Capability).- Máximos valores en tensión y corriente capaces de obtenerse a la salida.

Ajuste Zero Offset.- Indica la capacidad del amplificador de obtener una salida nula con las entradas conectadas a un circu<u>i</u> to de impedancia cero.

Mínima impedancia de carga (Minimum Load Impedance).- Mínima carga que debe conectarse a la salida del amplificador pata obtener la máxima salida.

Como conclusión, diremos que las especificaciones del amplificador d<u>e</u> berán cumplir, como mínimo, las propias exigidas al sistema en conjunto. Características superiores solo producirían un encarecimiento innecesario.

E <u>Registradores</u>

El registrador es el instrumento que recibe las informaciones transmitidas por los captadores a través de los módulos interme dios para ser grabadas de forma que permitan el cálculo ó procesamie<u>n</u> to de datos.

La elección del registrador, al igual que los demás comp<u>o</u> nentes del sistema, estará condicionada por el parámetro a medir.

Si los fenómenos a registrar son de muy bajas frecuencias un registrador potenciométrico será suficiente. Por el contrario, si las frecuencias son de algunos herzios, tendremos que utilizar un registrador oscilográfico de haz luminoso, microfilm, placas osciloscópicas ó cinta magnética. En general, varios serán los factores que i<u>n</u> tervendrán en la elección y convendrá considerar:

Fidelidad, ó sea, distorsión que experimenta la señal en la grabación.

Valor mínimo de señal que puede ser grabado y posteriormente interpretado dentro de los límites de exactitud y precisión exigidos en la medida.

Banda de frecuencias con respuesta plana.

Número de canales simultáneos de registro.

Tratamiento posterior de la información.

En medidas dinámicas son muy utilizados los registradores oscilográficos de haz luminoso y los registradores magnéticos de cinta.

Registradores oscilográficos de haz luminoso.

La señal eléctrica procedente del captador excita un ga<u>l</u> vanómetro que refleja el haz procedente de una fuente luminosa capáz de impresionar un papel fotosensible, grabando en forma analógica la magnitud física objeto de la medida.

Cuatro son los elementos fundamentales de un oscilógráfo: mecanismo de transórte de papel, fuente luminosa de alta intensidad, sistema óptico y galvanómetros. El mecanismo de transporte de papel d<u>e</u> be permitir varias velocidades de registro y asegurar la constancia de cada una de ellas. Una de las limitaciones de registrar fenómenos de frecuencias elevadas la impondrá la capacidad de transporte del papel para conseguir la velocidad adecuada que permita una grabación legible, con un consumo mínimo de papel.

La fuente luminosa está también intimamente ligada a la frecuencia de los fenómenos a registrar y se comprende que, para frecuencias elevadas, el tiempo de exposición del haz luminoso sobre el papel será muy breve, de ahí que la intensidad del mismo tendrá que ser grande. Se utilizan focos de lámparas de tungsteno, arco, halógenos vapor de mercurio, etc. El límite está en frecuencias de unos 25 KHz.

El sistema óptico de su oscilógrafo está formado por una serie de espejos y lentes que conducen el haz luminoso hasta el papel fotosensible, consiguiendo que la grabación sea legible. La calidad de sus componentes, su facilidad de ajuste, así como la precisión de su montaje, serán el índice de la bondad de este sistema.

El galvanómetro es el elemento fundamental de un registro dor y su misión es convertir una determinada energía eléctrica en movi miento de rotación.



Los galvanómetros tipo D'Arsonval son los más utilizados y están constituidos por una pequeña bob<u>i</u> na con una suspensión torsional sometida a un campo magnético con<u>s</u> tante; la suspensión es portadora de un espejo que recibe un haz de luz y lo refleja sobre papel fot<u>o</u> sensible; el paso de una corriente por la bobina crea un campo electromagnético, cuya resultante con el campo magnético del imán perm<u>a</u> nente originará el giro de la bobina y, por tanto, el del espejo de la suspensión.

El valor T del par de torsión de la suspensión tiene por valor T= NBi. .a.cos () siendo:

- N = Número de espiras
- B = Densidad de flujo
- i = Corriente en la bobina
- a = Ancho de la bobina
- 👌 = Angulo de deflexión

La deflexión del haz luminoso es proporcional al número de espiras de la bobina e inversamente proporcional a la constante de torsión K de la suspensión; un incremento del número de espiras y un decrecimiento de la constante K, aumentará la sensibilidad, pero tambi también el periodo de la oscilación, disminuyendo, por tanto, la frecuencia natural. De aquí se deduce que un galvanómetro con amplia re<u>s</u> puesta en frecuencia implicará sacrificio en la sensibilidad.

Un galvanómetro balístico se usa para medir la cantidad de carga desplazada por una corriente de corta duración. Supongamos (fig. a) que se cierra el interruptor e inmediatamente se abre, por G

> circulará una corriente de desca<u>r</u> ga que origina un giro de la suspe<u>n</u> sión. Este giro de la bobina en un campo magnético induce una f.e.m. pero, como el circuito está abierto no circula corriente por G y éste oscila indefinidamente existiendo





como único amortiguamiento, la fri<u>c</u> ción de la suspensión.

En la(fig. b) la corriente debida a la f.e.m., inducida por el giro, se cierra por el shunt y esta corriente origina un par de torsión que se opone al movimiento producido por la descarga del condensador. El valor de la resistencia shunt limita el valor de la corriente antdgonista, existiendo un valor para el -

cual G retorna a cero sin entrar en oscilación. Este valor de shunt se denomina resistencia externa crítica de amortiguamiento (Critical External Damping Resistance, CSDR).

Galvanómetros utilizados para frecuencias bajas neces<u>i</u> tan el amortiguamiento indicado en el párrafo anterior. Por el contrario, para altas frecuencias el amortiguamiento se consigue intr<u>o</u> duciendo la bobina en un tubo capilar con un fluido (Silicona).

Terminología de galvanómetros

- Frecuencia natural (Natural Frequency).— Es la frecuencia a la que un galvanômetro sin amortiguamiento responde con la máxima amplitud.
- Sensibilidad en c.c. sin amortiguamiento (Undamped d-c- Sensitivity).-Deflexión por unidad de corriente del punto luminoso sobre un plano situado perpendicularmente a un brazo óptico determinado.

Sensibilidad en tensión (Voltage Sensitivity).- Relación de la deflexión con un determinado brazo óptico a la d.d.p. aplicada al circuito del galvanómetro, teniendo éste una resistencia interna equivalente a la resistencia de amortiguamiento.

Ejemplos

Sensibilidad de corriente sin amortiguamiento = _____ Ia

Sensibilidad de corriente= -

Sensibilidad de tensión

<u>a</u> Vo

22





CIRCUITO DE TENSION

CIRCUITO DE CORRIENTE

Resistencia de amortiguamiento (Damped Resistance).- Valor de resisten cia requerido para el 0,64 del amortiguamiento crítico.

Desequilibrip (Galvanometer Unbalance).- Máxima deflex.én que se prod<u>u</u> ce en un galvamómetro al someterse a una aceleración de l g. en cualquier plano.

- Linearidad (Linearity).- Grado de concurrencia entre una posición del punto luminoso y valor teórico dividido por deflexión específica al valor total de escala, expresado en %.
- Error tangenciañ (Tangential Error).- Error causado al registrar en una superficie plana, en vez de una circular de radio igual al brazo óptico.
- Respuesta en frecuencia (Frequency Response).- Frecuencia a la cual la respuesta es plana.

Corriente de seguridad (Safe Current).- Máxima corriente que puede pasar permanentemente por el galvanómetro sin dañarlo.

Resistencia interna (Internal Resistance).- Resistencia interna de la suspensión y bobina media con corriente contínua.

Cálculo de redes de amortiguamiento.



Al conectar un galvanómetro a un amplificador ó circuito de medida se presenta elproblema de acoplamiento de impedancias, ya que el amplific<u>a</u> dor tendró un valor óptimo R_L y, a su vez, para un amortiguamiento determinado, el galvanómetro requerirá una cierta R_D . En todos los galvanómetros CEC el valor R_D indicado en sus especificaciones se refiere al 64% de su amortiguamiento crítico, equivalente a una respuesta plana hasta el 60% de su frecuencia natural.

Fijándonos en el esquema, siempre habrá unos valores $R_1 - R_2 - R_3$, que permitan un acoplo y las ecuaciones que establecen di chos valores son:

Donde

 $R = SD/I_{o}$

R_L = Optima impedancia de carga para el amplificador (
R_S = Resistencia de salida del amplificador.
R_D = Resistencia de amortiguamiento requerida por el galvanómetro.
S = Sensibilidad del galvanómetro (mA/cm).
R_g = Resistencia interna del galvanómetro
D = Deflexión deseada (cm).
I_o = Corriente de salida del amplificador para el total de escala.
K = Constante.

En galvanómetros amortiguados electromagnéticamente, el valor h = amortiguamiento total, es la suma de dos valores, uno constante, (amortiguamiento viscoso = h_v) y otro variable (amortiguamiento magnético = h_m). Las especificaciones CEC-indican-estos valores para cada tipo. En ellos se cumple:

$$h = h_{m} + h_{v}$$

$$\frac{h_{m1}}{h_{m2}} = \frac{R_{D1} + R_{g}}{R_{D2} + R_{g}}$$

$$R_{D2} = \frac{h_{m} (R_{D1} + R_{g}) - h_{m2} R_{g}}{h_{m2}}$$

Donde

- h_{ml} = Componente magnética de amortiguamiento para el 64% de amortigua miento crítico.
- h_{m2} = Componente magnética de amortiguamiento para el nuevo amortiguamiento deseado.
- R_{D1} = Resistencia del amortiguamiento (64%)
- RD2 = Nueva resistencia de amortiguamienti.

Eligiendo un determinado valor de h, (CEC incluye las curvas de respuesta de un galvanómetro para diversos h), podremos uti lizar los galvanómetros como verdaderos filtros.

F REGISTRADORES ANALOGICOS DE CINTA MAGNETICA

Hace aproximadamente 30 años, Marvin Camras presentó al Navy's Bureau of Ships un instrumento que podría ser utilizado por la industria naval. Era el primer registrador en cinta magnética basado en los mismos principios que hoy se siguen utilizando.

Consideraciones teóricas

Una cinta de material ferro-magnético es el soporte de este registro. La señal eléctrica de entrada se aplica a las bobinas del circuito magnético de registro por el que pasa la cinta, el cual es sometido a una inducción proporcional al valor de entrada.

La inducción remanente forma el dato memorizado en la cinta que, al pasar por un circuito de lectura crea, por variación del flujo, una f.e.m. inducida.

Ventajas del registro magnético

Veamos primero las ventajas del registro en cinto magn<u>é</u> tica respecto a otros sistemas tradicionales, principalmente gráficos, que han hecho esta técnica indispensable en ciertos campos de aplicación y una de las más utilizadas y de más posibilidades.

- 1º) Permite registrar un vasto campo de frecuencias, desde c.c. hasta varios MHz.
- 2º) Un amplio margen dinámico ó campo de medida superior a 50 dB. Se conoce por campo de medida la razón, medida generalmente en dB, entre la máxima señal medible sin distorsión ó señal fondo de escala y la mínima señal distinguible del ruido. En otros términos, es una relación señal/ruido referida al valor fondo de escala.

Considerando la señal a medir, un campo de medida superior a 50 dB indica una resolución del orden del 0,3% del valor máximo medible.

3º) En caso de sobrecarga, los posibles desperfectos som minimos si los comparamos con los que se pueden suceder a galvanómetros ú otros sistemas mecánicos. 42) La información se recoge y reproduce en su forma el Elló permite utilizar el registrador, no solo como instrucción de medida, sino también para recrear el fenómeno original, utilizando en su salida un transductor inverso al utilizado en la entrada. Esta capa cidad única le hace insustituible en experiencias simuladas.

La memorización de la señal en su forma eléctrica posibilita los trabajos de adquisicón de datos en el laboratorio cuando las condiciones de medida no permitem hacerlo in situ.

- 5º) La cinta magnética puede borrarse y utilizarse de nuevo, lo que representa una gran economía frente a otros métodos.
- 6º) El fenómeno registrado puede reproducirse milea de veces, lo que asegura la obtención de la máxima información para el análisis de datos.
- 7º) La densidad de información obtenible en un registrador de cinta magnética no es posible con otros métodos. Cientos de canales pu<u>e</u> den registrarse mediante técnicas de multiplexing.
- 8º) Otra característica, y no la menos importante, es su facilidad p<u>a</u> ra varíar la base de tiempo, reproduciendo el fenómeno a distinta velocidad de la del registro.

Descripción de un registrador magnético

Con objeto de conocer alguno de los principios del diseño de estos r<u>e</u> gistradores, pensados para utilización instrumental, estableceremos cuatro grupos básicos en su construcción:

- 1º) Electrónica de registro y reproducción, que codifica la señal, pr<u>e</u> parándola en forma adecuada para registro óptimo y la descodifica para recuperar la señal en su forma eléctrica original.
- 2º) Cabezas magnéticas que durante el registro convierten la señal eléctrica en diversos estados de magnetización de la cinta y du– rante la reproducción realiza el proceso inverso.
- 3º) Sistemas de arrastre cuya función es mover la cinta con la máxima suavidad y a velocidad constante. La precisión de este movimiento condiciona grandemente la calidad y coste del registrador.
- 4º) Cinta magnética constituida por un soporte delgado, magméticamente neutro, (plástico, poliester, generalmente) lo más resistente pos<u>i</u>

ble a la tracción mecánica sob e la que se ha depositado una suspensión de óxido férrico.



Sistema de registro en Modulación de recuencia

Para compensar los inconvenientes implícitos del registro directo; se utiliza la modulació de la señal en frecuencia y así la inestabilidad de amplitud no prod (e trastornos en cuando que la i<u>n</u> formación va contenida en la frecuen ia. La imposibilidad de registrar señales de frecuencias muy bajas no xiste, ya que señales en continua son, en realidad, representadas por recuencias más ó menos altas. En todo sistema FM, el demodulador debe ir seguido por un filtro pasabajo, cuya frecuencia de corte debe se cerca de 1/5 de la portadora.



La tecnica FM lleva la señal a través de un amplificador de c.c. a un oscilador controlado por voltaje La amplitud de la señal se convierte así en una desviación de frecuencia y la frecuencia de la señal en una velocidad de desviación. Esta portadora de frecuencia ondulada se registra en la saturación. El amplificador de reproducción de\$modula y filtra la señal para recoger el dato.

Una primera desventaja, inmediatamente observable, comp<u>a</u> rando los diagramas bloque, es su más compleja electrónica. Asímismo, el sistema de transporte debe ser más perfeccionado y preciso, ya que si la velocidad no es rigurosamente constante, se traduce, no en un error de la base de tiempos, sino en una modulación indeseada ó ruido. Igualmente, la respuesta de frecuencia es inferior que en el registro directo.

Sus ventajas más destacables son:

- a) Posibilidad de registrar señales en continua.
- b) Insensibilidad a las variaciones de amplitud, así como al ruido originado en la cinta. La relación señal/ruido es superior en algunas decenas de dB a la obtenible en el sistema directo.

Especificaciones de un registrador magnético

Respuesta en frecuencia

Viene determinada por la longitud del entrehierro de las cabezas reproductoras, la velocidad de transporte y el método de re gistro.

El límite superior de frecuencia lo alcanza cuando la longitud de onda registrada (velocidad cinta/frecuencia) equivale al entrehierro. Los registradores de instrumentación actuales operan a velocidades comprendidas entre 1 7/8 y 240 in/fec. Las versiones modernas pueden establecerse en dos categórías de bandas intermedia y de bandas anchas.

Relación señal-ruido

Es una indicación del margen dinámico de señales de e<u>n</u> trada que pueden registrarse, reproducirse y separarse del ruido del sistema.

Se expresa en dB y en una función primaria de la electrónica de reproducción y del ruido de la cinta.

Distorsión armónica

Es la medida de la no linearidad del sistema. Se expr<u>e</u> sa como porcentaje de uno 6 todos los armónicos respecto a la frecue<u>n</u> cia fundamental sinusoidal.

Flutter

En los registradores de cinta de instrumentación se co<u>n</u> sidera flutter como cualquier forma de variación de velocidad superior a O,2 Hz. Un cierto flutter existe siempre debido a imperfecciones en el sistema de transporte δ en el recubrimiento de la cinta. Esto produce perturbaciones en la base de tiempo e introduce ruido en el modo FM.

Se expresa en términos de %, pico a pico. Cuando se comparen especificaciones de flutter en diferentes equipos debe hace<u>r</u> se en el mismo ancho de banda y velocidad de cinta; normalmente a mayor velocidad, el flutter es menor.

El flutter puede reducirse significativamente acoplando un servosistema con control de alta frecuencia a un transporte de baja inercia.

Error de base de tiempos

Cuando se utilizan sistemas de banda ancha, el error de tiempo absoluto es normalmente más significativo que el error de tiempo porcentual. En tales casos, se especifica el TBE, que es la v<u>a</u> riación del flutter con el tiempo.

En la comparación de dos registradores de TBE inferior nos asegura una reducción proporcional del flutter. Un flutter a baja frecuencia produce proporcionalmente un mayor TBE.

Dynamic Skew

Se define como el error de desplazamiento de tiempo intercanales (ITDE) y es un desplazamiento variable de tiempo entre las pistas de una misma cabeza causado por tensiones no uniformes de ci<u>n</u> ta ó irregularidades en su dimensionado. Se expresa en /seg. de aesplazamiento. Para que sean significativos, deben mencionarse la velocidad de cinta y el número de canales sobre los que se ha medido. Una especificación típica es \pm 0,25 /seg. entre pistas adyacentes de la misma cabeza a 120 ips.







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*=&(APPROX.)

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ANALISIS EXPERIMENTAL DE ESFUERZOS

FOTOELASTICIDAD REFLECTIVA

NOVIEMBRE, 1978.

Polacie de Minería

Colle de Tacuba 5,

primer piso.

Méxicol, D.F.

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SECTION 9 - REFERENCES

INTRODUCTION

Today, the use of experimental stress analysis techniques has been considerably expanded in such fields as:

- establishment of design criteria
- improvement of product reliability
 - reduction of weight and cost

The necessity for these techniques has been created by current technical advances, radical designs and an increasingly competitive market.

These pressures have forced an increased work load on the engineer who by necessity is now looking for tools and methods which will help him reduce his testing time and costs as well as providing him with more data.

Photoelastic coatings, the most recent development in stress analysis techniques, has proved to be an extremely versatile yet simple tool. It is, therefore, becoming widely used both in field and laboratory testing. It combines the best features of strain gages and classical photoelasticity by providing:

- a visible picture of the surface stress distribution of the component
- stress distribution which is accurately readable at any point for both direction and magnitude

While the photoelastic model is still the only method for three-dimensional analysis, the surface coating technique eliminates the difficulties in casting complicated models yet permits the measurement of surface strains in the elastic or plastic ranges on structures, joints, weldments, etc., previously inaccessible to photoelasticity.

Polarized Light - Fundamentals

Light or luminous rays are electromagnetic vibrations similar to radio waves. An incandescent source emits radiant energy which propagates in all directions and contains a whole "spectrum" of vibrations of different frequencies or wave lengths. A portion of this spectrum is useful within limits of human perception (wave lengths between 4000 and 8000 Angstrom* units).

*Angstrom unit = 10 - 8 cm.

- l ·

The vibration associated with light is perpendicular to the direction of propagation. A light source emits a train of waves containing vibrations in all perpendicular planes. However, by the introduction of a polarizing filter (P), only one component of these vibrations will be transmitted (that which is parallel to the privileged axis of the filter). Such an organized beam is called polarized light or "plane polarized" because the vibration is contained in one plane. If another polarized filter (A) is placed in its way, complete extinction of the beam can be obtained when the axes of the two filters are perpendicular to one another (See Figure 1).

Extinction Direction of propagation Directions of vibration FIGURE 1

Light propagates in a vacuum or in air at a speed (C) of 3 x 10^{10} cm/sec. In other transparent bodies, the speed V is lower and the ratio C/V is called the index of refraction. In a homogenous body this index is constant regardless of the direction of propagation or plane of vibration. However, in crystals the index depends upon the orientation of vibration with respect to its axis.

Certain materials, notably plastics, behave homogenously when unstressed but become heterogenous when stressed. The change in index of refraction is a function of the stress applied similar to the resistivity and the resistance change in an electrical strain gage. When a polarized beam (P) propagates through a transparent plastic of thickness, t, where x and y are the directions of principal strains at the point under consideration, the light vector splits and two polarized beams are propagated in planes "x" and "y". (Figure 2)

Х



а

REF

PLANE POLARISCOPE

FIGURE 2

Δ

a)Sin

 $(B-\alpha)$

cos

- 3 -
If the strain intensity along "x" and "y" is ε_x and ε_y and the speed of the light vibrating in these directions is V_x and V_y respectively, the time necessary to cross the plate for each of them will be t/V, and the relative retardation between these two beams is:

$$\delta = C \left(\frac{t}{V_x} - \frac{t}{V_y}\right) = t \left(n_x - n_y\right)$$

Brewster's Law established that: "The relative change in index of refraction is proportional to the difference of principal strains", or:

$$(n_{X} - n_{V}) = K (\epsilon_{X} - \epsilon_{V})$$

The constant K is called the "strain-optical coefficient" and characterizes a physical property of the material. It is a dimensionless constant usually established by calibration and may be considered similar to the "gage factor" of resistance strain gages. Combining the expressions above, we have:

 δ = tK ($\epsilon_x - \epsilon_v$) in transmission

 $\delta = 2tK(\epsilon_x - \epsilon_y)$ in reflection polariscope (light passes through the plastic twice)

Consequently, the basic relation for strain measurement using the photoelastic coating technique is:

$$\varepsilon_{\mathbf{X}} - \varepsilon_{\mathbf{Y}} = \frac{\delta}{2tK}$$

Due to the relative retardation δ , the two waves are no longer simultaneous when emerging from the plastic. The analyzer A will transmit only one component of each of these waves (that is parallel to A) as shown on Figure 2. These waves will interfere and the resulting light intensity will be a function of:

- the retardation δ
- the angle between the analyzer and direction of principal stresses $(\beta \alpha)$

In the case of a Plane Polariscope, the intensity of light emerging will be (Lever B on instrument set at "D" position):

$$I = a^{2} \sin^{2} 2(\beta - \alpha) \sin^{2} \frac{\pi \delta}{\lambda}$$

.- 4

Adding quarter-wave plates in the path of light propagation, transforms the instrument into a "Circular Polariscope" (lever B on instrument set on "M" position). The emerging light intensity is now independent of the direction of principal stresses:



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The expressions shown above basically describe the function of a polariscope.

In a "Plane Polariscope", directions of the principal stresses are measured. The light intensity becomes zero when $\beta - \alpha = 0$ (see Figure 2), or when the crossed polarizer-analyzer is parallel to the direction of principal stresses.

In the "Circular Polariscope", the light intensity becomes zero when $\delta = 0$, $\delta = 1\lambda$, $\delta = 2\lambda$..., or in general:

 $\delta = N\lambda$

Where N is 1, 2, 3, etc.

This number N is also called fringe order and basically it expresses the size of δ . The wave length is selected:

$$\lambda = 22.7 \times 10^{-6}$$
 in.

The retardation, or photoelastic signal is simply described by N. As an example, if N = 2:

(δ) Retardation = 2 fringes

or $\delta = 2\lambda$

or $\delta = 2 \times 22.7 \times 10^{-6}$ in.

Once $\delta = N\lambda$ is known, the strains are:

$$\varepsilon_{\mathbf{x}} - \varepsilon_{\mathbf{y}} = \frac{\delta}{2\pi K} = N \frac{\lambda}{2\pi K} = N \mathbf{x} \mathbf{f}$$

where f contains all constants and N is the result of measurements.

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SECTION 1

BASIC ANALYZER

DESCRIPTION AND ASSEMBLY

1.0 DESCRIPTION

The Basic Analyzer, Model 031, consists of two ballbearing mounted Polarizer-Quarter Wave Plate Assemblies attached to a common frame, and mechanically connected so that they rotate in unison (See Figure 4). The assembly (1) is equipped to receive the special light source (3), and the assembly (2) is provided with measurement scales. The instrument is also equipped to accept many new accessories which greatly increases the versatility of the instrument and permits any photoelastic coating task to be accurately performed.





FIGURE 4



The Basic Analyzer measures three major pieces of data:

- 1. The directions of the principal strains or stress
- 2. The magnitude and sign of the tangential stress at free boundaries, or in any region of uniaxial stress condition
- 3. The magnitude of the difference of the principal strains or stress in bi-axial state

The instrument may be hand-held or mounted on a tripod. The hand-held feature is used to inspect areas for possible detailed analysis by quickly scanning the entire test part. The portable operation is also used when a large number of point by point measurements are to be made on a structure, and for analyzing hard-to-see areas where a tripod would be awkward. In other cases, when attention is concentrated on only a few areas, or when a laboratory test is being conducted on small parts, the instrument will usually be mounted on the tripod.

1.1 ASSEMBLY

To prepare the polariscope for operation by hand or on its tripod, proceed as follows:

- 1.) Remove the polariscope, light housing, and handle from the instrument case.
- Dust off the meter unit, using a soft tissue or cloth wet with alcohol.
- 3.) Mount the light housing on the meter by engaging the holes in the mounting brackets to the pins fixed to the polarizer frame. Adjust the angle to a slightly convergent position for normal incidence measurements (See Figure 5).
- 4.) Place the bulb in the rear position. The normal life of the lamp (type DFA TRU-FOCUS Base 150W, l20V, Tl2) is 15 hours.
- 5.) Extend the legs of the tripod to the desired length and lock them tightly if the instrument is to be used on its tripod.
- 6.) Mount the handles locking the tripod platform. Note: The handles are not identical; the longer one is used to control the forward tilt, the shorter to control lateral tilt.
- Place the analyzer directly on the tripod platform and mount in place using the 1/4"-20 thread screw provided.
- 8.) Attach the meter to the grip-handle for hand-held operation.

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SECTION 2

MEASUREMENT OF DIRECTIONS OF PRINCIPAL STRAINS

2.0 INTRODUCTION

The principal strain directions are always measured with reference to an established line, axis, or plane. Therefore, the initial step for the determination of the direction of principal strains (or stresses) will be to select a convenient reference. In most cases, the reference direction is suggested immediately, like an axis of symmetry of the test part or structure; in other cases, a vertical or horizontal line will suffice.

2.1 MEASUREMENT OF DIRECTIONS AT A POINT

When the directions of the principal strains ε_x and ε_y are to be measured at a point, the following procedure - shall be followed:

- Assemble the instrument, as discussed in Section 1.2.
 Connect the light source to a 110 volt outlet and
- switch the light on.
- 3.) Direct the light beam toward the point of interest on the part or structure being studied. The suggested distance between the instrument and the observed areas is between 1 1/2 feet and 8 feet.
- 4.) Orient the instrument so that one of its axis is parallel or perpendicular to the selected reference direction. Consequently, with the direction arrow reading 0°, the axes of polarization will be parallel or perpendicular to the reference.
- 5.) With the direction and compensation scale on the meter set at zero (Figure 5), check the unloaded part for an initial pattern which may be due to improper application of the plastic, or stresses created during the test assembly operation. If a colored pattern appears, a zero reading should be obtained before loading (Section 5, Part 5.1). In most cases, however, the plastic on the unloaded part will appear black or dark bluish, and a zero reading will not be necessary.
- 6.) Proceed with the loading of the part (if possible, incremental loading is recommended).

- 7.) Move knob "B" from "M" (magnitude) to "D" (direction) position (See Figure 5). This aligns the axes of the quarter-wave plates parallel to the direction of the polarizer and analyzer, and the meter is transformed from a "circular" to a "plane" polariscope (quarter-wave plates are optically removed from field).
- 8.) If measurable strains do exist, a pattern of color and black lines (or areas) will be observed. The bands of equal color (isochromatic fringes), will be discussed in measurements of magnitudes of strains (Section 3). The black lines or areas, are of primary interest to us in this discussion and they indicate:

1. Areas of zero shear strain $\epsilon_x - \epsilon_y = 0$ ($\delta = 0$) 2. Areas of equal direction of principal strains

Along such a black line, the direction of principal strains (or stresses) is the same as the axis of polarizer-analyzer. In order to differentiate between these two cases, loosen the lock located on handle "H", rotate the polarizer-analyzer assembly and observe any black areas or lines in the field. Upon rotation, any areas or lines that remain black and stay in a fixed position are those places where the difference of the principal strains is zero. The black lines which move as the rotation is progressing are termed "Isoclinics", and are used to determine the direction of the principal strains ε_x and ε_y . At every point on a isoclinic line, the directions of the principal strains are the same. These directions are shown by the angular position of the polarizer and analyzer (arrow "A" on Figure 5).

- 9.) With a grease pencil, mark a cross on the plastic coating defining the point of interest on the test part, and identify the marked point with a letter or number.
- 10.) By means of handle "H", rotate the polarizer-analyzer until a black line (Isoclinic) crosses over the marked point. Now, the axes of the polarizer and analyzer are parallel and perpendicular to the direction of the principal strains ε_x and ε_y at the point, and their position with respect to the selected reference is shown on the meter (Figure 6). The arrow on the meter shows the rotation in degrees of the polarizer-analyzer assembly with respect to the reference line on the part, and indicates the direction of the principal strains.

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When bringing the isoclinic to the point of measurement, the polarizer-analyzer rotation may be either clockwise or counter clockwise. Therefore, in order to record the data without ambiguity, the angular rotation must be accompained with the correct sign. The clockwise rotation is considered positive and counter clockwise negative.

2.2 MEASUREMENT OF DIRECTIONS OVER LARGE AREAS

In many cases it is necessary to know the directions of the principal strains over the entire area coated, instead of at individually selected points. The initial procedure is to repeat steps 1 through 8, as previously described, for determining the principal strain directions at a point. After completing step 8, proceed as follows:

9.) By means of handle "H", rotate the polarizeranalyzer assembly to the angular positions 0°, 15°, 30°, 45°, 60°, 75°, and 90°, as indicated by arrow "A" on the meter (Figure 5). At each angular position, the black isoclinics will be observed in a different location (except for the 90° position which will be the same as that observed at 0°).

10.) With a grease pencil, trace the isoclinic lines directly on the part at each angular position, and assign to each line its corresponding direction as indicated by arrow "A" on the meter.

- 11.) After the isoclinics have been traced onto the plastic, transfer their positions onto onion-skin paper. The isoclinic recording can also be accomplished by photography, which is a faster and accurate technique. The photographic procedure follows:
 - a. Install the camera and obtain a photograph for each isoclinic at every angular position. Before taking each photograph, mark in a convenient location in the field of view, the corresponding angle for identification. Also, be careful not to alter the position of the camera from frame to frame. A color film that directly yields slides should be used.
 b. Next, project the slides of the isoclinics (0°, 15°, 30°, etc.) one by one on a plain sheet of paper, and then carefully trace the isoclinics on the paper as each slide appears.

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12.) Following the tracing of the family of isoclinics on paper, the isostatic flow lines can be sketched, these lines reveal the directions of the principal strains ϵ_X and ϵ_Y at every location of the coated part. Figure 7 illustrates the photographs of the isoclinics in a ring subjected to diametral compression, and Figure 8 shows how these isoclinics, from a segment of the ring, were transferred on paper from which the isostatics or principal strain directions were constructed.

If the isoclinics are sharp and narrow, it means the directions of ε_X and ε_Y are varying rapidly from one location to another. If the isoclinics are broad black bands or areas, the directions ε_X and ε_Y are varying slowly and the boundary surrounding the whole isoclinic should be marked (not merely the center). In the case of the tensile specimen of constant cross section an isoclinic will be seen over the entire area when the axes of polar-ization coincide with the axes of the specimen, since_the_direction_of_ ε_X is the same at every point.

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Isoclinic 0⁰



60⁰





45⁰



75⁰

FIGURE 7

- 15 -



SECTION 3

MEASUREMENTS IN NORMAL INCIDENCE-INTERPRETATION OF STRESS DISTRIBUTION

3.0 INTRODUCTION

Experimental stress analysis is not always reduced to measuring the magnitude of stress. In fact, the ability to see and interpret the complete stress field is one of the important time and money saving advantages of the photoelastic coating technique. If the part being stress analyzed is being done so because of actual service failures, the display of the complete stress distribution on the part will usually offer suggestions on how to modify designs to prevent failures. Similarly, the analysis of the complete stress distribution in prototype parts could prevent potential design errors, which if not corrected, may result in expensive repairs during service operation.

The photoelastic pattern also yields valuable design information, on how to modify the part to make it lighter, and at the same time less stressed. In addition, the visual stress display shows the relative importance of various load modes applied. Often such design information is revealed not by highly stressed areas, but by low stressed areas where material could be removed. After learning how to interpret the overall stress distribution, measurement of the magnitude of the stress is then accomplished at the points of interest by the methods described herein.

3.1 BASIC DATA ON PHOTOELASTIC MEASUREMENTS

When a coated specimen is subjected to stresses, the surface strains are the same in plastic as in the coated parts:

 ϵ_x , ϵ_y are principal strains in plastic (and metal) β is the direction between ϵ_y and selected reference The stresses in the part are established from strain in the elastic range by Hooke's Laws:

$$\sigma_{\mathbf{X}} = \frac{\mathbf{E}}{1-\mu^{2}} \quad (\varepsilon_{\mathbf{X}} + \mu \varepsilon_{\mathbf{Y}})$$
$$\sigma_{\mathbf{Y}} = \frac{\mathbf{E}}{1-\mu^{2}} \quad (\varepsilon_{\mathbf{Y}} + \mu \varepsilon_{\mathbf{X}})$$

$$\sigma_{\mathbf{x}} - \sigma_{\mathbf{y}} = \frac{\mathbf{E}}{\mathbf{1} + \mu} \quad (\varepsilon_{\mathbf{x}} - \varepsilon_{\mathbf{y}})$$

At every point we receive the photoelastic signal, which is the retardation between two light beams, one polarized ε_x , the other along ε_v :

$$\delta = N\lambda = 2tK (\epsilon_x - \epsilon_y)$$

where δ is the retardation (in.)

and

 λ is the wave length (in white light $\lambda = 22.7 \times 10^{-6}$ in.) N is called "fringe order" which we are measuring

The measured number N is then used for all the data reduct-

$$\varepsilon_{x} - \varepsilon_{y} = N \frac{\lambda}{2tK} = N x f$$

The "fringe value" f is obtained from the plastic applied.

$$f = \frac{\lambda}{2tK} = \frac{11.35 \times 10^{-6}}{t K}$$

where t is the thickness of coating (inches) K is the sensitivity of plastic, supplied by the manufacturer (for K of various plastic,

see Bulletin P-1120)

The difference of principal stresses in the structure is:

$$\sigma_{\mathbf{X}} - \sigma_{\mathbf{Y}} = (\varepsilon_{\mathbf{X}} - \varepsilon_{\mathbf{Y}}) \frac{\mathbf{E}}{1+\mu} = \mathrm{Nf} \frac{\mathbf{E}}{1+\mu}$$

Note that in NORMAL INCIDENCE measurements, the quantity measured is the DIFFERENCE OF PRINCIPAL STRESSES $\sigma_x - \sigma_y$.

In many practical applications (edges, uniaxial field, corners, long beams), one of the principal stresses is zero. In all those cases we have:

$$\sigma = N \frac{fE}{I+\mu}$$

In the case of a biaxial stress field two measurements are needed to determine the individual principal stresses σ_x and σ_v (See Section 4 on Oblique Incidence Measurements).

3.2 INTERPRETATION OF PHOTOELASTIC PATTERN-IDENTIFICATION OF FRINGES

The photoelastic pattern appears as a colorful map of lines of equal color (isochromatic lines or finges). Every equal color line represents a constant level line of N (or $\delta = N \ge 22.7 \ge 10^{-6}$ in.). The first logical step in analysis is to assign to those level lines their order (example N = 1, 2, 3, etc.) to identify fringe orders.

The following experiment will greatly simplify the understanding of identification of fringes:

EXPERIMENT FOR ILLUSTRATION OF PHOTOELASTIC READING AND INTERPRETATION OF STRESS DISTRIBUTION

Prepare an aluminum cantilever beam 1/8" x 1" x 10" long for analysis by coating the beam on one side with Photolastic Plastic Type PS-2 (1/8" thick). Next, clamp the beam, coated side up, to the edge of a bench or table. On the other end, hang a 5 pound weight using a wire or cable (See Figure 9). Set-up the instrument so that the polarizer-analyzer assembly is looking down on the coated beam (the handle "H" being aligned with the long axis of the beam). Now set all dials of the analyzer on zero and move knob "B" to position "M" (magnitude) setting (See Figure 5). Make sure the beam is illuminated by the light coming from the instrument.

The retardation is increasing proportional to the stress. Every time the retardation is:

 $\delta = 1, 2\lambda, 3\lambda \cdot \cdot \cdot 4 \times \lambda,$

a particular wave disappears and the complementary color is seen. As an example, when $\delta = 25 \times 10^{-6}$ in. ($\delta = \lambda$ red), red disappears and green is observed.



The following table explains the sequence of color observed:

RETARDATION 10 ⁻⁶ IN.	COLOR OBSERVED	N
0	Black	0
12	Yellow	
- 18	Red	
22.7	*lst Fringe	1
25	Blue-Green	
35	Yellow	
, 40	Red	
45.4	*2nd Fringe	2
50	Green	
57	Yellow	
63	Red	1
68.1	*3rd Fringe	3
73	Green	

Observe the colored pattern appearing on the cantilever beam and compare the color sequence to that described above and shown in Figure 9. Note how the bands of color change progressively from the loaded end of the beam (zero stress) to the clamped end (high stress). The color sequence observed is black, yellow, red, blue, yellow, red, green, yellow, red, green. The color transition from the red to the blue (lst Fringe) and from the red to green (2nd and 3rd Fringes) is sharply marked.

Now starting from the black area where $\varepsilon_x - \varepsilon_y = 0$ (loaded edge of the beam), trace a line with a grease pencil at the 1st, 2nd, and 3rd fringe locations. Note that the first fringe falls between red and blue, but in the subsequent higher order fringes, the blue color disappears and is replaced by green. Repeat the exercise several times tracing the line so that it is between the red and blue or red and green color.

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The fringes are related to increasing strain as follows:

Along the black fringe	N=0	$\varepsilon_{x} - \varepsilon_{y} = 0$	$\varepsilon_{\mathbf{x}}^{-\varepsilon} \mathbf{y}^{=0}$
Along the first fringe (RED-BLUE)	N=l	$\varepsilon_x - \varepsilon_y = f\mu''/''$	$\epsilon_x - \epsilon_y = 757 \mu'' / ''$
Along the second fringe (lst RED-GREEN)	N=2	$\varepsilon_{x}^{-}\varepsilon_{y}^{=} 2f\mu''/$	$\varepsilon_{x} - \varepsilon_{y} = 1514 \mu'' / ''$
Along the third fringe (2nd RED-GREEN)	N=3	$\varepsilon_x - \varepsilon_y = 3f\mu''/''$	ε _x -ε _y =2271μ"/"

EXAMPLE: t = .100 f = 757 μ "/"

One can now see the significance of being able to recognize fringe orders. Once we master this first and very important step, the initial study of the overall strain distribution_on_a_test_structure-is-straightforward. The fringes are continuous bands (occasionally dots) ending at boundaries or making continuous loops. They do not intersect at any point. They follow in continuous sequence (if the 1st and 3rd orders are observed, the 2nd must be in between). Once one fringe is recognized (usually "0" or 1st), follow toward increasing strain level (yellow-red-green), and locate the 2nd then the 3rd, etc. Always remember the sequence for increasing strain: -yellow-red-green-yellow-red-green . . . If the colors go green-red-yellow-green-red-yellow, then the strain is decreasing. In case doubt remains concerning the correct identification of the integral order fringes, use of the Models 032 and/or 232 Compensator (Section 3.4) provide a means for positive identification.

If the fringes are observed as tightly grouped loops confined to a single area (such as would be found at a notch or sometimes around holes), it means that the strain varies rapidly from one point to another resulting in a stress concentration. On the other hand, a single uniform color may cover a vary large portion of the test part, or in the case of a tensile specimen ideally aligned, the entire surface of the part will exhibit a solid color. This type of situation tells us that the strain is behaving uniformly over the entire area, neither increasing or decreasing from one point to another.

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In summary, the stress distribution can easily be studied by simply being able to recognize fringes, their absolute order, and location with respect to one another on the structure or test part being analyzed.

3.3 MEASUREMENTS AT A POINT

It has been shown that in the first step of measurement one is observing the whole area and assigning to every fringe its order (N = 1, 2, 3, etc.). At every point of a fringe, N is then known and therefore:

$$\varepsilon_x - \varepsilon_y = f \times N$$

In general, the point of interest on the structure will fall between fringes, and it will be necessary to establish "fractional order" or fraction of a fringe. The technique used is called "compensation". Two basic methods are used:

- 1) TARDY COMPENSATION using the rotatable analyzer built into the 031 Instrument.
- ABSOLUTE COMPENSATION or null balance, using Compensator Models 232 or 332.

3.3.1 TARDY COMPENSATION

The Tardy Compensation is a relatively fast and simple method. However, the method requires an experienced operator to be fool-proof, and if the rules that are given below are not followed exactly, serious mistakes are made. The principal of the method is shown on Figure 10.

WHEN THE POLARIZER AND ANALYZER ARE ALIGNED WITH THE DIRECTION OF PRINCIPAL STRESSES, AND THE QUARTER-WAVE PLATES ARE AT 45° ("M" POSITION), A ROTATION α OF THE ANALYZER WILL MOVE A FRINGE TO A POSITION WHERE THE FRACTIONAL ORDER IS $\frac{\alpha}{180}$ (TARDY COMPENSATION).

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FIGURE 10

3.3.2 OPERATIONAL PROCEDURE: HOW TO MEASURE FRACTIONAL FRINGE ORDERS USING TARDY METHOD

Prepare a cantilever beam test specimen (See Section 3.2). Load the beam with a 5 pound weight, and set-up the instrument to observe the beam as described previously. This specimen will now be used to illustrate all the operational steps necessary to measure fractional fringe orders using Tardy Compensation:

- Switch the instrument to the "D" position by means of lever "B" (Plane Polariscope set-up).
- 2. Unlock the knob "H" and rotate the Polarizer-Analyzer Assembly until an isoclinic comes to the point of measurement. As explained before, the isoclinic is a black line or area, and its thickness depends only on the variation of direction. In the cantilever beam experiment the isoclinic will cover the whole beam, since directions are uniform.

When step 3 is completed, the handle "H" is aligned with direction X of principal stress σ_X . The stress σ_Y is perpendicular to it. The arrow A reads the Angle β between the reference selected and direction X.

NOTE: 90° rotation of polarizer will once again bring the isoclinic to the point.

One can, therefore, choose either one of the principal stresses as direction X.

- Switch 4. Once step 3 is completed, tighten the knob H. the lever B to "M" position (CIRCULAR POLARISCOPE). The isoclinic fringes are now eliminated, and a colorful pattern appears. Recognize fringes and assign to every fringe its order. Trace with a grease pencil fringes 0, 1, 2, 3, etc. In many practical applications, the recognition of fringes is simple. Sometimes the Compensator Model 032 or 232 should be used, as explained later. Choose on the cantilever beam a point between fringe 1 and 2. In most cases, the point will be between n (lower order) and n + 1(higher order). Mark the point by tracing a thin cross (+) directly on the plastic using a scriber or grease pencil.
- 5. Rotate the analyzer clockwise by means of knob C. The fringes will move. Observe the motion of fringes carefully. The clockwise rotation of the analyzer rotation is graduated on the scale 0 to 100. Rotate until a fringe arrives at the selected point of measurement (red on one side, green on the other side, see Figure 11). Read directly the fraction r as shown on the compensation scale (in hundreds of a fringe).
- If lower order fringe moves to the point (fringe n), the total reading will be:

N = [n + firaction] = [n + r] and N > 0

If higher order fringe moves to the point (fringe n + 1) the total reading will be:

N = -[(n + 1)] - fraction] = -[n + 1 - r] and N < 0

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In either case:

$$\sigma_{\mathbf{X}} - \sigma_{\mathbf{Y}} = \mathrm{Nf} \frac{\mathrm{E}}{\mathrm{l} + \mathrm{\mu}}$$

 $\varepsilon_{\mathbf{x}} - \varepsilon_{\mathbf{y}} = \mathbf{N} \mathbf{x} \mathbf{f}$

(On the cantilever beam the "first" or lower order fringe n will move to the point and therefore the total reading will be N = n + ra positive number.)

NOTE:

IT IS VERY IMPORTANT TO RECOGNIZE AND UNDERSTAND THE SIGN CONVENTION USED WHEN OBTAINING NORMAL INCIDENCE MEASUREMENTS AS DESCRIBED ABOVE. THE MOST IMPORTANT POINT TO REMEMBER IS THAT $\varepsilon_{\rm X}$ IS NOT NECESSARILY THE GREATER PRINCIPAL STRAIN OR LARGER THAN $\varepsilon_{\rm V}$.

ACCORDING TO THE SIGN CONVENTION ESTABLISHED, AFTER BRINGING AN ISOCLINIC TO THE POINT OF INTEREST, THE HANDLE "H" IS DEFINED TO BE ALIGNED WITH ϵ_x WITHOUT REGARD TO THE FACT THAT ϵ_x MAY NOT BE THE GREATER PRINCIPAL STRAIN. REMEMBER IN NORMAL INCIDENCE READINGS, WE ARE PRIMARILY CONCERNED WITH THE SIGN OF THE DIFFERENCE OF $\epsilon_x - \epsilon_y$, AND NOT WHETHER ϵ_x IS GREATER THAN ϵ_y OR VICE-VERSA. THE SEPARATE VALUES AND SIGN OF THE INDIVIDUAL PRINCIPAL STRAINS ϵ_x AND ϵ_y WILL BE DISCUSSED UNDER OBLIQUE INCIDENCE MEASUREMENTS IN SECTION 4.

A typical example of the sign convention used can be demonstrated with the cantilever beam. First, align the handle "H" with the long axis of the beam. Now rotate the compensator in a clockwise direction and bring the lower order fringe to the point. (With our set-up, we will observe the 1st fringe moving to the point.) Since we already know that $\sigma_{\mathbf{X}}$ is the longitudinal stress at the point ($\sigma_{\mathbf{X}}$ is tensile) and the transverse stress is zero, we will read ($\sigma_{\mathbf{X}} - \sigma_{\mathbf{Y}}$) or $(\sigma_x - 0)$, a positive number. Now if we rotate handle "H" 90° so that it is perpendicular to the beam, and if we again rotate the compensator clockwise, the higher order or 2nd fringe will move towards the point. In this situation, we are reading $(\sigma_X - \sigma_y)$ or - $(0 - \sigma_v)$, a negative number. Obviously, both measurements have the same magnitude but opposite sign.

To summarize, the procedure for measuring the difference of the principal strains at a point by the Tardy Compensation Method follows:

- Trace a cross at the point or identify the point by some other means, or to the direction of the stress.
 Determine the position of fringes n and n + 1
- around the point.
- 3. Bring a isoclinic to the point and establish $\varepsilon_{\mathbf{X}}$ as being parallel to the position of the handle "H". Read the direction β (in degrees) of $\varepsilon_{\mathbf{X}}$ to the selected reference.
- Rotate the compensator clockwise to bring a fringe to the point and read the fraction "r" on the scale.
- 5. If the lower order fringe (n) moves toward the point, the total reading will be:

$$N = n + r$$
 (positive)

If the higher order fringe (n + 1) moves toward the point, the total reading will be:

N = - [(n + 1) - r] (negative)_

and

$$\varepsilon_{x} - \varepsilon_{y} = N \times f$$

$$\sigma_x - \sigma_y = Nf \frac{E}{1+u}$$

3.3.3 MEASUREMENTS IN UNIAXIAL STRESS FIELD AND ANALYSIS OF THE PRINCIPAL STRESS ACTING TANGENT TO A POINT ALONG A FREE BOUNDARY USING TARDY COMPENSATION

The sign and magnitude of the principal stresses in uniaxial field and also at a free edge or boundary can be determined directly under normal incidence since one of the stresses acting is zero.

The procedure is as follows:

- Bring an isoclinic to the point of interest. The handle "H" must then be parallel to the boundary at the point.
- 2. Move knob "B" back to the "M" position.
- Identify fringes (n) and (n + 1) on either side of the point.

Rotate the compensator in a clockwise direction. If the lower fringe order (n) moves toward the point of measurement, the sign of the stress is positive and the total reading will be N = n + r. If the higher order fringe (n + 1) moves toward the point, the sign of the stress is negative and the total reading will be N = -[(n + 1) - r]. In either case, the stress will be:

$$\sigma_{\mathbf{x}} = \mathrm{Nf} \frac{\mathrm{E}}{1+\mu} (+ \text{ tension})$$

Remember, direct measurement of the individual principal stresses in biaxial state of stresses can only be obtained by the addition of oblique incidence measurements (See Section 4).

ABSOLUTE COMPENSATION - MEASUREMENTS USING NULL 3.4 BALANCE METHOD

The principal of Null Balance Method is considerably simpler, than the Tardy Method. To measure a photoelastic signal at a point, we simply add to the light path an identical calibrated signal equal in size but opposite in sign (See Figure 12). By doing this, the photoelastic signal at the point is completely cancelled to read zero. This method

Null Balance Detect Signal To Be Measured (N) Zero COMPENSATOR ADDS (-N) Signal Т FIGURE 12

completely eliminates the need to recognize fringes or assign orders. When the calibrated compensator adds the opposite sign equal signal, the total is zero, and BLACK is restored at the point.

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3.4.1 LINEAR COMPENSATOR, MODEL 032

The Compensator Model 032 consist of a wedge sliding in a fixed frame which is attached to the instrument as shown on Figure 13. The frame contains a window through which the part is observed. As the compensator slides in its frame, the fringes move on the specimen and numbers appear in the window. From a calibration chart (Figure 14), the signal N that the compensator adds is established. Since every point of the compensator exhibits a different N (N is varying linearly from one end to another) a "parallax" effect exists and for this reason, the linear compensator is used mostly for identification of fringes only as an auxiliary tool to the Tardy Method.



MODEL 032 LINEAR COMPENSATOR		
CALIBI	ATION CHART	
Reading on Scale	<u>Fringe</u> Order (N)	
.50	1	
1.20 -	2	
1.90	3	
2.60	4	

FIGURE 14

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To use the Linear Compensator for identifying an unknown fringe order at a point, proceed as follows:

- 1. Engage the compensator in its mount provided on the analyzer frame (See Figure 13).
- Determine the direction of the principal strains at the point of interest as described in Section 2, Part 2.1.
- 3. After bringing the isoclinic to the point, lock the handle "H" in position and move the knob "B" back to the "M" (magnitude) position. Note that the handle now is aligned with x direction and the compensator with y direction.
- 4. Now observe the fringe at the point through the normal field of view. Next, observe the point through the compensator opening, and push the compensator in its slide (from right to left) until a black fringe appears at or near the point. Read the scale on the compensator and establish N from the compensator calibration chart.
- 5. The compensator fringes are positive. If $\sigma_x - \sigma_y$ is also positive, the compensator will add instead of subtract and no balance is possible. In this case, turn the handle "H" 90°, and repeat operation. Note that compensator will perform only when:

$\sigma_x - \sigma_y < 0$

3.4.2 UNIFORM FIELD COMPENSATOR, MODEL 232

The basic principal of the compensation is the same as described above, e.g. NULL BALANCE Method. The uniform field of the Model 232 Compensator eliminates parallax errors and provides better resolution than other compensation methods:

-It eliminates the need of recognizing fringes as in the TARDY Method

-It eliminates parallax errors

-It provides a numerical readout on a counter, from which the total reading N is determined, eliminating all possible mistakes of other methods. To measure N using the Model 232 Compensator, proceed as follows:

- 1) Attach the compensator to the polariscope on mount provided and tighten the attachment knob (See Figure 15). Make sure the analyzer ring is set on zero on the fractional order scale.
- Switch the lever "B" 2) to "D" position. Release the knob "H" and rotate the polarizer-analyzer assembly until an isoclinic crosses the point where the measurement is to be made. Read the direction angle β . The handle_"H" points nowin x direction $(\sigma_{\mathbf{X}})$ and the long axis of the compensator is in y direction.

3)

Switch the lever "B" back to "M" position. are now eliminated and colors are seen. Looking through the compensator window onto the part, observe the pattern. Turn the knob towards you, driving the compensator, and observe the fringes moving. Continue turning until a black fringe covers the point of measurement. The "Null Balance" is achieved and the N of compensator is equal and opposite sign to N on the specimen (See Figure 16).





Isoclinics



FIGURE 16

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 $(\epsilon_{\rm X} - \epsilon_{\rm V}) = - Nf$

 $(\sigma_x - \sigma_y) = -N \frac{fE}{1+u}$



Remember that the compensator fringes are positive, and if $\varepsilon_x - \varepsilon_y$ is also positive, the compensator will add instead of subtract, and NULL BALANCE will not be possible. In this case, turn the handle "H" 90° and repeat the operation.

EXAMPLE:

Set the cantilever beam up for analysis as previously described and align the handle "H" parallel to the long axis of the beam. In this position $\varepsilon_{\mathbf{x}} - \varepsilon_{\mathbf{y}}$ will be a positive number. Next, load the beam and observe the fringe pattern (at a selected point) through the normal field of view. Now, rotate the compensator knob until another fringe crosses The pattern through the the point. compensator will now be observed as one fringe order higher than that observed without the compensator. Next, rotate the handle "H" (counter-clockwise) so its position will be perpendicular to the beam ($\varepsilon_x - \varepsilon_y$ will now be a negative number). Now, by rotating the compensator knob and viewing the same point through it, a black fringe will be observed moving toward the point. Thus, in the first case, we added fringes to the initial pattern, and in the latter case, we subtracted fringes from the initial pattern.

NOTE:

- As the counter reading is increasing, N in compensation increases.
 - Looking at a point where $(\sigma_x \sigma_y) > 0$, we will be adding N and the sequence of the colors will be:

Yellow-Red-Green-Yellow . .

Looking at a point where $\sigma_x - \sigma_y < 0$, the sequence of colors will be:

Yellow-Green-Red-Yellow-Black

The resolution of the Model 232 Compensator is approximately 1/50 of a fringe (± 1 digit).
 The 232 can also be used in conjunction with the Tardy Method to improve the resolution of the Tardy Method in difficult to read areas. In case of N < 1, set the 232 Compensator on N = 1. It will than add 1 fringe to the field and improve the resolution.

The newest compensator developed by Photolastic (Model 332) provides a direct digital readout of the strain in micro-inches per inch when the NULL BALANCE is achieved at the point of measurement (See Figure 18). This unit is also available with a printer system (Model 432) which "prints out" the Point Number (2 digits). Strain direction angle (2 digits), and the strain magnitude (4 digits).



FIGURE 18

SECTION 4

MEASUREMENTS IN OBLIQUE INCIDENCE

4.0 INTRODUCTION

In the previous sections covered in this manual, it has been shown how to obtain the magnitude of the difference of principal strains and their directions with respect to some reference axis using normal incidence light.

In certain cases, however, a more complete analysis is required that necessitates separation of the two principal strains, and obtaining the individual values of each. To accomplish this a second reading is required, and that reading must be taken with oblique incidence light.

By oblique incidence, we mean that the light from the polarizer traverses the photoelastic coating at an angle and the birefringence measured depends on the secondary principal strain in the plane perpendicular to the light path. Thus, an oblique incidence reading combined with a normal incidence reading provides us with the necessary information for determining the separate values and directions of the principal strains ε_x and ε_y .

4.1 DESCRIPTION OF OBLIQUE INCIDENCE ADAPTER MODEL 033 AND ASSEMBLY TO BASIC ANALYZER

The Oblique Incidence Adapter for use with the Photolastic Analyzer has a fixed mirror angle which provides for simplified data reduction.

In addition, the unit's special design permits accessability in corners and fillets of the test part where separation of the principal strains is most desirable. The unit also telescopes for varying point to instrument distance. It is easily attached to the analyzer by a simple locking device as shown in Figure 19.



4.2 BASIC EQUATIONS

Figure 20 shows the path of light emerging from the polarizer, reflected by the oblique incidence mirror, traversing the photoelastic coating, reflected back to the mirror, and finally back to the analyzer. By referring to detail A of Figure 20, we can see that there is an angle θ between the normal of the surface of the test piece and the light ray. Thus, the measured fringe order at this point will depend on the angle θ , and on the strains existing at the point as expressed by the formula:

$$N_{\theta} = \frac{1}{f} (A \varepsilon_{x} - B \varepsilon_{y})$$

If angle e is small, then A = B = 1, and the equation reduces to that used for normal incidence measurements:

$$N_{normal} = \frac{1}{f} (\varepsilon_x - \varepsilon_y)$$

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When two readings are obtained, one in normal incidence and the other in oblique incidence, the values of the two principal strains are given by:

 $\varepsilon_x = f (1.5 N_{\theta} - N_{normal})$

$$\varepsilon_{v} = f(1.5 N_{\theta} - 2N_{normal})$$

Where the numerical values of 1, 1.5, and 2 are coefficients derived from the development of equations for oblique incidence measurements (See Technical Paper "New Oblique Incidence Method for Direct Photoelastic Measurement of Principal Strains" by S. S. Redner, "Experimental Mechanics", March 1963).

The preceeding formula utilizing the coefficients 1, 1.5 and 2 is accurate for most of the commonly used photoelastic coatings which have a Poisson's Ratio of approximately .36. However, for some plastics, such as high elongation coatings, the Poisson's Ratio will be slightly different and correction factors will have to be applied for more precise results.

For this purpose, we will rewrite the equations to read:

$$\varepsilon_{\mathbf{x}} = \mathbf{f} (CN_{\theta} - DN_{normal})$$

 $\varepsilon_{\mathbf{y}} = \mathbf{f} (CN_{\theta} - EN_{normal})$

where C, D, and E represent the coefficients for photoelastic coatings that have a Poisson's Ratio different from most ordinary applications. Most of the available photoelastic plastics have a Poisson's Ratio between the limits of 0.34 and 0.50, and the graph shown in Figure 21, gives the numerical substitution for C, D, and E in the formula over these limits. However, as previously mentioned, under most circumstances the photoelastic coating used will more than likely have a (μ) value close to .36, and the basic equation for determing the values of $\varepsilon_{\rm X}$ and $\varepsilon_{\rm Y}$ will be valid.

Once the principal strains have been determined, the principal stresses can be found by:

$$\sigma_{\mathbf{X}} = \frac{\mathbf{E}}{1-\mu^2} \quad (\varepsilon_{\mathbf{X}} + \mu \varepsilon_{\mathbf{Y}})$$
$$\sigma_{\mathbf{Y}} = \frac{\mathbf{E}}{1-\mu^2} \quad (\varepsilon_{\mathbf{Y}} + \mu \varepsilon_{\mathbf{X}})$$

where E and μ are the modulus of elasticity and Poisson's Ratio of the test piece.

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4.3 MEASUREMENTS

The basic difference between the technique of measurements in normal and oblique incidence is that with oblique incidence the axis of polarizer and analyzer must be maintained as follows:

- 1) parallel to the axis of symmetry of the mirrors of the oblique incidence adapter
- 2) parallel to the directions of the principal strains at the point of measurement

To satisfy the first condition, the handle "H" must always be maintained in the vertical position (direction reading on dial = 0°). The second condition, alignment of the polarizer-analyzer assembly with the directions of the principal strains, is accomplished by rotating the whole instrument in its own plane until an isoclinic appears at the point of measurement.

With the above two conditions defined, we can now proceed with making oblique incidence measurements according to the following step by step procedure:

- 1. Check the cleanliness of the oblique incidence adapter mirrors and attach to the basic analyzer.
- Rotate the polarizer-analyzer assembly by means of handle "H" so that the arrow indicating direction reads 0° on the dial.
- 3. Switch on the light source and observe the test part in normal incidence. Mark with a grease pencil the points of interest at which oblique incidence measurements are to be made, and assign identification marks to each point.
- Rotate knob "B" to the "D" direction position.
 Now rotate the whole instrument in its plane until an isoclinic appears at the marked point. The axes of polarizer and analyzer will now be parallel to the direction of the principal strains at the considered point. (Note: These axes will also be identical to the axes of symmetry of the instrument.) In the case of the cantilever beam, the set-up will be as shown

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in Figure 22.



FIGURE 22

- 6. When step 5 has been completed, the handle "H" will be parallel to one of the principal strains (ε_x) . Next rotate knob "B" back to the "M" (magnitude) position and obtain a reading in normal incidence at the selected point by either the Tardy Compensation Method or Null Balance principal as explained in Section 3,
- 7. Without changing the rotational position of the instrument, adjust the oblique incidence adapter so that the pointer located between and in front of the mirrors almost touches the point of measurement. Now, observe the point through the mirrors and measure the fringe order in the exact same way as for normal incidence (the same rule for determination of the sign applies).

The determination of the value N and its sign is slightly more difficult under oblique incidence since the observed area is considerably smaller. Continued practice on the cantilever beam will aid in making oblique incidence measurements on more complicated parts. The use of the digital compensator and Null Balance principle for determing N in oblique incidence is by far the most positive method to use and is strongly recommended.

8. Once the readings in normal incidence N_n and in oblique incidence N_{θ} have been obtained, the principal strain values can be calculated by the following formulas:

$$\epsilon_{x} = f (1.5N_{\theta} - N_{n})$$

 $\epsilon_{y} = f (1.5N_{\theta} - 2N_{n})$

where $\varepsilon_{\mathbf{X}}$ is the strain in the direction of handle "H"

ε_y is the strain perpendicular to handle "H" f is the fringe value expressed in microinches per inch per fringe

 N_n and N_θ are the fringe orders measured in normal and oblique incidence.

The principal stresses can be found in the elastic range by:

$$\sigma_{\mathbf{X}} = \frac{E}{1-\mu^{2}} (\varepsilon_{\mathbf{X}} + \mu \varepsilon_{\mathbf{Y}})$$

$$\sigma_{\mathbf{Y}} = \frac{E}{1-\mu^{2}} (\varepsilon_{\mathbf{Y}} + \mu \varepsilon_{\mathbf{X}})$$

where E and μ = modulus of elasticity and Poisson's Ratio of the test part.

For steel where $E = 30 \times 10^6$ psi, and $\mu = 0.30$, the equations reduce to:

$$\sigma_{x} = 66.0 \text{ f} (N_{\theta} - 0.82 N_{n})$$

 $\sigma_{y} = 66.0 \text{ f} (N_{\theta} - 1.18 N_{n})$ in psi

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For aluminum where $E = 10 \times 10^6$ psi, and $\mu = 0.33$, the equations reduce to:

$$\sigma_{\rm X} = 22.4 \text{ f} (N_{\theta} - .83 N_{\rm n})$$

 $\sigma_{\rm V} = 22.4 \text{ f} (N_{\theta} - 1.17 N_{\rm n})$ } in psi

4.4 USE OF NOMOGRAPH

A.rapid numerical solution of the equations:

$$\epsilon_x = f (1.5N_{\theta} - N_n)$$

 $\epsilon_y = f (1.5N_{\theta} - 2N_n)$

may be obtained by using a nomograph (Figure 23). In order to obtain the best resolution two scales are provided. Use of the nomograph simply involves drawing a straight line connecting the N_n and N_θ readings. The intersection of this line with the ε_x and ε_y scales will give a number which multiplied by the fringe value (f) gives the strains directly

Note: On the nomograph, if

 $0 < N_{\theta}$, $N_n < 1.5$ use left scales 1.5 < N_{θ} , $N_n < 3.5$ use right scales 3.5 < N_{θ} , $N_n < 15$ use left scales

IMPORTANT:

T: When using the nomograph, be careful to watch sign of N_{θ} and N_{n} whether positive or negative.



SECTION 5

CORRECTION FACTORS

5.0 INTRODUCTION

If the photoelastic coating exhibits an initial color pattern prior to loading (Parasitic Birefringence), a correction must be made in all subsequent readings taken during the test. Also, when a part is coated with a layer of photoelastic plastic and is subjected to load, the plastic coating carries a fraction of the load, and the strain on the part is thereby reduced. In most cases, the reinforcing effect of the coating on the test part is negligible. (As on structural parts like I, H, U, tubular and other beam members, thick walled parts, castings, etc.) However, in the case of plane stress problems and plates subjected to bending, a correction in the reading is required so that the experimental results can be given in terms of the uncoated part.

In other cases, when the temperature is changing during a test, a system of stresses will develop in the photoelastic coating due to the difference in the coefficient of thermal expansion between the test part and coating. If this happens, a correction factor must also be used to compensate for the effect of temperature change on the readings.

5.1 METHOD OF CORRECTION FOR PARASITIC BIREFRINGENCE

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Under normal circumstances, residual birefringence in the coating can only be produced by severe mishandling of the plastic during or after application, and in such cases, it is usually more convenient to strip off the coating and apply a new one, rather than attempting to make corrections for the existing residual stresses.

It is necessary, however, to point our a few cases where residual birefringence will unavoidably occur and where readings will have to be made by applying the formulas given on page 47.

- A.) RESIDUAL BIREFRINGENCE DUE TO THE TEST TEMPERATURE VARYING FROM THE BONDING TEMPERATURE. This parasitic birefringence due to temperature will generally occur around the edges of the plastic and will extend inside the coating by as much as five times the thickness of the coating.
- B.) PARASITIC BIREFRINGENCE DUE TO CONTRACTION OF THE CEMENT Sometimes the cement is not fully polymerized; during a month or so it may continue to polymerize slightly, and therefore contract. This effect will also produce birefringence around the edges of the plastic.
- C.) EDGES NOT PROTECTED AGAINST HUMIDITY If the edges of plastic are not protected against humidity with a layer of cement, some moisture may be absorbed through the machined edges of the plastic and produce a swelling, which in turn will produce parasitic birefringence around the edges of the plastic, similar to cases (A) and (B).

For cases (A), (B), and (C), since birefringence is located around the edges of the plastic and since a free boundary is an isostatic, the procedure for correcting for parasitic birefringence consists simply of subtracting the reading under no load from the reading under load. It is assumed here that the shape of the plastic matches the free boundaries of the part.

There are cases where permanent birefringence will occur due to mishandling of the plastic or to yielding of the part after it has been coated. In these cases, the directions of principal strains of the parasitic birefringence may not necessarily coincide with the directions of principal strains due to load; hence, simple subtraction is not permissible. It is important to underline that subtraction of the two states of stress is only permissible when the directions of the principal stresses coincide for both states of stress. If they do not, the formulas outlined below must be used. In order to determine if the directions of the residual birefringence does or does not coincide with the directions under load, proceed as follows;

a) Trace or observe the isoclinics of the parasitic birefringence. (No load applied).

b) Load the part and observe the isoclinics once again. If the isoclinics under load and under no load conditions are identical (they do not move when load is applied), both states of stress (parasitic and due to load) can be subtracted one from the other. In case these isoclinics do move, use formulas (1) and (2) below:

(1)
$$N_{c} = \sqrt{N_{f}^{2} + N_{i}^{2}} - 2N_{f}N_{i} \cos 2(\theta_{f} - \theta_{i})$$

where:

Nc

 $(\theta_{f} - \theta_{i})$

Nf

Ni

is the corrected fringe order due to the applied load only is the fringe order measured due to a combination of applied load and initial birefringence is the fringe order measured for no load (para-

sitic fringe order) is the principal stress rotation when going from the unload to the loaded condition; it is the

change in the isoclinic parameters

The angle θ of the correct isoclinic parameter due to load alone expressed by Formula (2).

(2) $\tan 2\theta = \frac{N_f \sin 2 \theta_f - N_i \sin 2 \theta_i}{N_f - \cos 2 - \theta_f - N_i \cos 2 \theta_i}$

 θ is the measured angle between the major principal stress σ , and the reference direction X (see Figure 24).

When N_C is found from Formula (1), it is then multiplied by the fringe constant and the correct value of the principal strain difference is obtained.

Figure 25 shows an example of how a plot of load versus birefringence reading may look in case parasitic birefringence directions are not aligned with applied principal stress directions. To obtain correct values from such a plot, one may be justified for all practical purposes, in extrapolating the linear part of the curve. Obviously, if the magnitude of the parasitic birefringence is very high and if the misalignment is large, load-versusreading plot will never have a linear part, and extrapolation will not be possible. In such a case the use of Formula (1) will solve the problem.



Fringe order of parasitic birefringence EXAMPLE: $N_{i} = 1.37$ Fringe order of birefringence measured when part is loaded $N_C = 3.42$ Change in isoclinic parameter, or $\theta_f - \theta_i =$ $15^{\circ} (\theta_{f} = 45^{\circ} \& \theta_{i} = 30^{\circ})$

The correct fringe order due to load is:

$$N = \sqrt{3.42^2 + 1.37^2 - 2 \times 3.42 \times 1.37 \times \cos(2\times 15)} = 2.33$$

If the readings N_f and N_i were subtracted directly, N_c . would be 2.05 and a 10% error would be introduced.

To obtain the isoclinic parameter (θ) with respect to a reference axis, X (Figure 23), Formula (2) is used: for the example cited, one would find

 $\tan 2\theta = \frac{3.42 - 1.37 \times .867}{-0. = -1.37 \times .5} = -3.26$

Remember that $\tan 2\theta = \tan (2\theta - 180)$. Therefore, there are two solutions for θ : $\theta_1 = -36.5^\circ$ and $\theta_2 =$ +53.5°. One of them corresponds to σ_1 and the other to 02.

CORRECTION FACTORS FOR PLANE STRESS PROBLEMS

In the case of plane stress problems where the bending action is negligible (such as pressure vessels, plates and panels loaded in their plane), there is some reinforcing effect although it is very small. In these situations the correction factor C1 by which the initial readings should be divided to obtain the corrected strain value is:

 $\frac{1}{C_1} = 1 + \frac{t \text{ plastic } X E \text{ plastic}}{t \text{ structure } X E \text{ structure}}$

where t = thickness of the plastic and test part E = modulus of elasticity of the plastic and test part.

In Figure 26 the correction factor C1 can be directly picked off the chart for various materials with respect to the thickness of the test part and the coating.

5.3 CORRECTION FACTORS FOR COATED PLATES SUBJECTED TO BENDING

When thin beams or plates are subjected to bending, the plastic coating reinforces the part and the measured strain must be corrected for this reinforcing effect. The correction factor C₂ applied must take into consideration three different effects as follows:

- a) The neutral axis of the coated structure shifts.
- b) The coating increases the stiffness of the plate. c) The reading is an average strain through the coating thickness, and corresponds to the middle plane
 - of the coating, which is located further from the neutral plane than the surface of the structure.

All of the above effects were taken into consideration when the correction factor chart (Figure 26) was constructed. Thus C₂ (correction factor for bending) can also be picked off the chart and the corrected strain reading can be obtained as follows:

Enter the ratio thickness of coating on the horizontal thickness of structure

axis of the chart, and read the correction factor C_2 for the considered type of structure on the vertical axis.

Once the correction is known, we have:

$$\varepsilon_{\mathbf{x}} - \varepsilon_{\mathbf{y}} = \frac{\mathbf{N} \mathbf{x} \mathbf{f}}{\mathbf{C}_2}$$

It is easily seen that uncorrected readings will usually be too high (C2 larger than 1), Consequently, during the selection of the plastic, the thickness should be calculated to put C₂ in one of the following ranges: (Figure 26)

Area A: thickness of plastic small in comparison to the structure Area B: correction C₂ reaches maximum and higher

sensitivity is obtained.

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CORRECTION FACTORS

C _ PLATES IN BENDING

C, - PLANE STRESS PROBLEMS



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FIGURE²⁶

- Area C: the correction factor is 1 and the selection is most useful in cases of very thin plates, and in cases where there is a combination of plane stress and bending.
- Area D: where the ratio of plane stress to bending is unknown, the plastic should be selected so that the correction factor is the same for both cases.

Typical Cases

Example 1: Thin member in bending

Consider the aluminum cantilever beam described in the example of measurements 1/8" thick, 1" wide, and coated with 1/8" thick plastic.

Here: t structure = .125" t plastic = .125" and the ratio: $\frac{t_p}{t_s} = 1.0$

We read from the chart on the curve for aluminum: $C_2 = 1.25$. Suppose the reading at the point is N = 1.40 fringes and the fringe value f of the plastic is 725 µin/in/fringe. The corrected results are:

$$\epsilon_{x} - \epsilon_{y} = \frac{N \times f}{C} = \frac{1.40 \times 725}{1.25} = 810 \ \mu in/in$$

Example 2: Biaxial stress field

A very large diameter cylindrical envelope forming a pressure vessel is subjected to internal pressure. The state of stress is very nearly a plane stress condition and the correction factor is then given by the dotted lines of Figure 26.

Assuming:	^t plastic	=	0.125	
•	t steel .	=	0.625	
	t plastic t steel	=	0.20	

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From the chart the correction factor $C_2 = 1$. Thus the reinforcing effect is negligible and can be disregarded.

Example 3

In a test the state of stress in a thin aluminum membrane is to be determined (combination of membrane stress and bending). The thickness of the plate is .060". We wish to select the plastic thickness to obtain C = 1 (no corrections to be considered).

$$t metal = .060$$

For C = 1 we have for aluminum $\frac{t_p}{t_p} = 1.6$

$$t_{\rm p} = t_{\rm m} \times 1.6 = .096"$$

5-4 CORRECTION FACTORS DUE TO TEMPERATURE _CHANGE.

When the temperature is changing during a test, a system of stresses will develop in the plastic due to the difference in coefficient of linear expansions between the structure and plastic. The treatment of the thermal stress problem has been fully discussed in a recent paper*. In a practical application the following procedure is suggested:

A) In regions not located on boundaries (distance from edges of the plastic is greater than four (4) times the plastic thickness), normal incidence reading is not affected by the change of temperature, and the pattern observed is directly due to the thermal stresses to be measured.

In oblique incidence a "zero shift" will result due to change of temperature only. This "zero shift" is proportional to temperature and is given by:

 $N_{TO} = \frac{1}{f} \frac{1 + \mu}{1 - \mu} \frac{\sin^2 \theta}{\cos \theta} (\alpha_s - \alpha_c) \Delta T = \frac{.66}{f} (\alpha_s - \alpha_c) \Delta T$

*"Photoelastic Coating Analysis in Thermal Fields" by F. Zandman, S. Redner, and D. Post.

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Where: N_{TO} fringes observed, due to the change of temperature only.

- Poisson's Ratio of plastic
- $\alpha_s \alpha_c$ Differential coefficient of thermal expansion between structure and coating.
 - θ Angle of oblique incidence
 - ∆T Change of temperature

Then, if N_{mo} is the measured fringe order in oblique incidence, the corrected value is given by:

$$N_{o} = N_{mo} - N_{To}$$

B) On the edges

The oblique incidence readings are not required on edges. In normal incidence however, fringes will appear on the edges due to a change in temperature. The most convenient procedure for analysis in this case is to prepare a dummy specimen not subjected to the same stresses in the part, but to the same changes of temperature as the investigated part, and then to take comparative readings. (Comparing the total fringe order on the coated part with that of the dummys). The same dummy specimen may also be used for oblique incidence zero shift measurements, as described above. In many cases the part itself will be used as a dummy and after the change in temperature, new "zero" readings can be obtained on the edges.

Example 4:

The temperature is rising from 72°F to 212°F. Using PS-2, .080" thick plastic on aluminum, what is the "zero" shift in oblique incidence?

We have: $\Delta T = 212 - 72 = 140^{\circ}F$

 $\alpha_{\rm S} - \alpha_{\rm C} = 24 \ \mu in/in/{}^{\circ}F$

f = 1170 µin/in/fringe

$$N_{TO} = \frac{.66}{1170} \times 24 \times 140 = 1.9$$
 fringes

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The same may be established on a dummy specimen. Continuing: If $N_{\rm T}$ is due to temperature only (as established on the dummy) and $N_{\rm m}$ is the measured fringe order, the corrected result is:

$$N = N_m - N_T$$

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SECTION 6

CALIBRATION OF PLASTICS

6.0 INTRODUCTION

If the K factor on a sheet of photoelastic plastic is not given by the manufacturer, or if the coating has been made from liquid plastic, it will be necessary to experimentally determine the K factor so that the fringe value f of the plastic can be computed.

6.1 USE OF THE CALIBRATOR MODEL 010

The Calibrator Model 010 is a precision instrument providing an accurate means of determining the strainoptical coefficient K, and the sensitivity of the photoelastic plastic. If used exactly in accordance with the instructions contained in Photolastic, Inc. Bulletin IB-I-100, the K factor will be measured within \pm .001.

6.2 CALIBRATION OF PLASTIC USING A CANTILEVER BEAM

The cantilever beam provides a very reliable way to calibrate the plastic. Suppose an aluminum beam 1/4" thick and 1" wide is set up as described in Section 3. The small strip of plastic approximately 3" x 1" to be calibrated, is bonded to the beam, its center (point of our measurements) located 6" from the loaded end. With no load on the beam, the reading at the point is zero. After a 20 lb. weight is applied, the reading is N = 1.54 fringes. In order to establish the "f" and "k" of the plastic, first the stress on the uncoated beam is calculated:

The stress is: $\sigma = \frac{6PL}{bh^2} = \frac{6 \times 20 \text{ lbs. x } 6''}{1'' \times (1/4)^2} = 11,500 \text{ psi}$

The difference of principal strains on the surface of uncoated beam is:

$$\epsilon_{x} - \epsilon_{y} = \frac{1 + \mu}{E} (\sigma_{x} - \sigma_{y}) = \frac{1.33}{10.3 \times 10^{6}} \times 11,500 = 1490 \ \mu in/in$$

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In the middle plane of the plastic the strains are: $(\epsilon_x - \epsilon_y)$ plastic = $(\epsilon_x - \epsilon_y)$ uncoated structures x C₂ from chart: (Ex: $t_p = 0.080$ $t_s = 0.250$)

$$\binom{t_p}{t_s} = .32$$
 $C_2 = 1.21$

and

 $(\varepsilon_{x} - \varepsilon_{y}) \text{ plastic} = 1490 \text{ x } 1.21 = 1800 \text{ µin/in}$ The fringe value f = $\frac{(\varepsilon_{x} - \varepsilon_{y}) \text{ plastic}}{N} = \frac{1800}{1.54} = 1170 \text{ µin/in}.$

and the "K" factor is:

$$K = \frac{11.35}{t \times f} = \frac{11.35}{.080 \times 1170} = .122$$

SECTION 7

DESCRIPTION AND USE OF ACCESSORIES

7.0 INTRODUCTION

The Basic Photolastic Analyzer is designed to accept a wide variety of accessories available to increase its usefulness. This makes it a truly one instrument system that permits any photoelastic coating task to be accurately performed. The complete line of accessories and their description and use follows.

7.1 TELEMICROSCOPE ATTACHMENT MODEL 037 AND 137

The Telemicroscope attachment constitutes a new development for field and laboratory analysis. Taking advantage of the basic analyzer's existing optical system, it simply mounts on the tripod, and provides high magnification which allows analysis of high strain gradient areas with microscopic accuracy, and examination of a distant object. It is also desirable to use when making measurements by either the "TARDY" or "NULL BALANCE" compensation methods since the point of measurement will be greatly magnified and much easier to observe. The telemicroscope is furnished with either an F/5.6 95-205mm Zoom Lens (Model 037), or an F/3.5 43-86mm Zoom Lens (Model 137).

The telemicroscope (Model 137) is shown mounted to the Photolastic Analyzer in Figure 27. The front "zoom" lens permits observation of a relatively wide area for locating the point of interest, and then zooms to high magnification for the desired detail by projecting the image at the focal point of the rear mounted microscope.



Description of the Optical System

The telemicroscope assembly consists of the following: (Refer to Figure 28)

- A.) <u>Mounting Frame</u> attachable to the tripod by means of the platform (A). The basic analyzer is also attached to this platform.
- B.) Lens and Microscope Supports mounted on a common axis (B), articulated in the platform (A), and allowing the telemicroscope to swing in or out of the observers field.
- C.) Front Lens Adapter allows the mounting of Nikon lenses to a 16mm movie camera.
- D.) Front Lens normally the zoom lens is installed here providing a variable focal length system of lenses. The front lens is interchangeable, and any desired lens could be installed as the front lens.



TELEMICROSCOPE SET UP.

- 1.) 50mm focal distance (normally supplied with the Model 035 Camera).
- 2.) Zoom lens of larger focal distance provided with the telemicroscope itself.
- E.) <u>Microscope</u> mounted on an adjustable rack to permit easy focusing. Both the objective lens and eye-piece lenses are interchangeable. Normally a 6x objective lens and a 10x eyepiece are supplied, providing a total magnification of 60x.

Assembly to the Basic Analyzer

To mount the telemicroscope to the basic analyzer, refer to Figure 28 and proceed as follows:

- 1.) Mount the base plate (A) to the tripod.
- 2.) Mount the analyzer on the base plate.
- 3.) Select the desired lens and mount the lens in the front lens adapter (C). This is accomplished by gently engaging the bayonnet in the mount, and then rotating the lens until the stop pin engages in the groove. (Dots on the lens and on the mount should be aligned to engage the bayonnet.)
- 4.) Release the stop button (F) and swing the optical system until its axis coincides with the axis of the instrument.
- 5.) Set the distance scale of the lens (approximately at the distance of the investigated part).
- 6.) Focus the microscope until a sharp image is observed. The instrument is now ready for operation.

In case the digital or linear compensator (G) is used in conjunction with the system, mount the compensator first, and then follow steps 1, 2, 3, and 4 in sequence as above.

then:

- 5.) Focus the microscope first on the compensator plane.
- 6.) Adjust the focusing ring of the front lens until a sharp image is obtained.

Selection of the Lens

For most applications only a moderate magnification is required, and the lens of maximum aperature would be selected to obtain a maximum amount of light. The f/l.4 lens 50mm focal length is satisfactory in most cases. However, in case higher magnification is required, the zoom lens should be installed. The aperture of a high focal distance lens is smaller and for best results, the measurement should be made in dark areas or areas with a minimum amount of surrounding light.

7.2 CAMERA MODEL 035 AND 135

The camera provided with this equipment is one of the finest single lens reflex camera manufactured. It has many features and accessories that make it especially well-suited for work in the photoelastic coating field and for general industrial work. The camera is provided with a special bracket for easy mounting directly behind the basic analyzer (Figure 29).



A single lens reflex unit with shutter speeds of 1 to 1/1000 second, it automatically sets the lens opening at the preset setting during exposure, but allows viewing with maximum opening. The automatic mirror swings in and out of the field during exposure. The unit is also equipped with instant action preview control, and a split image range finder with interchangeable focusing screens. The camera itself can also be fitted with a wide variety of accessories. The Model 035 comes complete with a 50mm fl.4 Auto-Nikkor Lens. In addition, the Model 135 offers a leather case, cable release, grey card set, light meter, and circular polarized analyzer filter for taking pictures when not attached to the instrument.

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The general instructions for operation are enclosed with the camera. These cover:

•Loading •Lens Setting

•Focusing •Shutter Setting and Self-timer

•Unloading •Changing Lenses

These instructions naturally cover the normal operation of the camera but because of its rather specialized use in the field of photoelastic coatings, specific information of photographic recording of the observed patterns is presented in Section 8 of this manual.

7.3 CAMERA ADAPTER MODEL 038 AND 138 FOR TELEMICROSCOPE

This accessory is for recording on film the observations made with the telemicroscope. Both the Model 038 and 138 Camera Adapters are self-contained units with internal lenses that attach directly to the microscope tube and camera body (in place of the camera lens). The Model 038 provides viewing through the camera while the Model 138features a lateral eyepiece allowing observation and measurements while the camera remains attached. Normally supplied to fit the Nikon F Camera, they can also be supplied for other makes as well. Figure 28 shows how the Model 038 Camera Adapter (H) mounts to the telemicroscope. The Model 138 (Figure 30) mounts in a similar manner.



7.4 MONOCHROMATOR MODEL 036

The use of monochromatic viewing in photoelastic coatings falls into two distinct categories. These are:

- 1.) Black and white photography
- Identification of fringes when the colors washout at higher fringe orders

A truly monochromatic light source provides a very low light intensity only usable in a dark room. Semimonochromatic lights used with standard photographic filters cause a shift in the fringe positions from color to black and white. The most efficient and economical solution is to use standard high intensity light and filter the desired band of wave lengths.

The Photolastic Monochromator is a narrow band interferential filter. It provides a band pass of 100A° at the wave length of the tint of passage producing a black fringe at every location where the tint of passage is observed in white light. It can be used in-hand or attached to the lens of the camera.

7.5 STROBOSCOPIC LIGHT MODELS 034 AND 134

When stress analysis studies under dynamic conditions (such as those found on centrigues or shakers) is required, replacement of the Basic Analyzer Light Source with a strobe accessory will provide the same sensitivity of measurement plus the advantages of a strobe light.

Both units are especially designed and manufactured for Photolastic, Inc., and they incorporate a combination of several features to increase their effectiveness in photoelastic observations. The lamps are attached to the polariscope so that its use as a portable analyzer will not be impaired (within the limits of the lamp's calbe). To maintain a light weight, the oscillator on Model 134 has its own control box separate from both lamp and power supply. This feature permits a flashing rate control up to 2C feet from the lamp.

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Each model consists of lamp, power supply, and oscillator with connecting cables. Figure 31 shows how the Model 134 Strobe Light attaches to the basic analyzer. The Model 034 mounts in a similar manner. A complete set of operating instructions is supplied with each model.



7.6 MODEL 332 and 432 DIGITAL STRAIN READOUT

Photolastic has brought automation to photoelastic stress analysis with the Model 332 or Model 432 Digital Strain Readout.

Easily attached to the basic analyzer, Model 332 (Figure 32) assures easy, fast, accurate strain measurements directly displayed-in microinches/in.-as a 4-digit readout. Model 432 provides a printout of the 4-digit strain measurement, plus a 2-digit printout of Point Number, and a 2-digit printout of the Principal Strain Direction Angle.

Because it eliminates the need to recognize fringes (or their absolute order), and the need to identify and then calculate fractional orders, it reduces human error to virtually zero. . . even with inexperienced operators.

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Both Models consist of a Babinet-Soleil uniform field compensator electrically coupled to the digital strain readout.

The measuring method uses the "Null Balance" principle. Displacing the compensator wedge within the strain field adds-to the unknown quantity-an amount equal to the unknown quantity, but opposite in sign. We merely add an exact amount sufficient to achieve Zero Balance (the procedure is described in Section 3, part 3.4.2).

The electrical output from the compensator is then computed into Digital Strain Readout, displayed by the instrument.

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Separate instruction manuals are available which describes in detail the set-up of electrical connections, adjustments, and operational procedure of these units.

SECTION 8

PHOTOGRAPHIC RECORDING OF FRINGE PATTERNS

8.0 GENERAL RULES

Photographic recording of the observed fringe patterns provides the simplest and most accurate method of recording data without transcription errors or forgotten details. In order to obtain satisfactory results when photographing the photoelastic patterns, the following general rules should be observed:

(1.) Select the area to be photographed. The size of this area will determine the position of the camera and the proper lens. With a lens of focal length "f" the size of the area covered "L" from a distance "D" on a 35mm frame is:

$$L = \frac{D - f}{f} \times 35 mm$$

If the distance D is much larger than f, the following approximation may be used:

$$L = \frac{35mm}{fmm} \times D$$

It is apparent that to cover small areas a lens of large focal distance must be used.

- 2.) Be sure the area of interest is well and uniformly illuminated. For overall views (test set-ups, etc.) only use several lights.
- 3.) Avoid parasitic reflections of windows, overhead lights, and direct reflections off polished metallic surfaces, etc.
- 4.) Attach the camera rigidly to the tripod. Use the cable plunger to make certain the camera does not move during the exposure.
- 5.) To obtain good depth of field, use as small a diaphragm opening as possible (f/22). The larger openings (f/1.4 and f/2.0) should be used only on relatively flat areas when uniform focusing can be achieved. Care should always be taken when focus-ing (use the split image feature of the camera on a vertical line or fringe). If no vertical reference is naturally available, make one artifically with masking tape, removing the tape before exposure.

6.) Avoid parasitic reflections and other "hot" spots that may appear in the field of view. Preferably, place the camera in a normal incidence position with respect to the part and to the illuminator, which should be slightly inclined (See Figure 33).



8.1 PHOTOGRAPHY OF ISOCHROMATICS

Use Ektachrome-X when slides are required, and Kodacolor-X (or the equivalent) when prints are to be made. The exposure guide (see Table I below), is based on average conditions. For best results, obtain actual lightmeter readings. The light level depends on:

- -Actual voltage on the lamp
- -Reflectivity of the cement
- -Angle of illumination
- -Distance from the light source to the part

Since most of these effects are difficult to evaluate, it is suggested to take three frames of each position adding one "underexposed" and one "overexposed".

For exposure use Table I which follows:

TABLE I

Distance - Analy- zer to Test Part		2 ft. •		4 ft.				
ASA Film Speed		20	64-80	200	20	64-80	2 <u>00</u>	3000
Diaphragm Opening f/x	f/16	2	1/2	1/4	-4	1	1/2	1/30
	f/8	1/2	1/4	1/15	1	1/4	1/8	1/125
	f/"4	1/8	1/30	1/60	1/4	1/15	1/30	1/500
	f/2	1/30	1/125	1/125	1/15	1/60	1/125	

Time-Exposure Data

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8.2 PHOTOGRAPHY OF ISOCLINICS

A very convenient method of recording isoclinics is to use color transparency film such as Kodachrome-X (or equivalent). While the analyzer-polarizer assembly is rotated successively to different positions (0°, 15°, 30°, 45°, etc.), obtain photographs without changing the position of the camera. The resulting slides can then be projected later on white paper for tracing the isoclinics and isostatics.

In this case, the slides should be <u>overexposed</u>. This will show sharper isoclinics. When black and white film is used, the isoclinics should be recorded at a low strain level to avoid confusion with isochromatic fringes.

8.3 PHOTOGRAPHIC RECORDING THROUGH THE TELEMICROSCOPE

Photographic recording of the observed patterns viewed through the telemicroscope may be obtained by installation of the camera adapter Model 038 or 138 on the microscope.

- 1.) Set up the telemicroscope as for visual observation. Next, tighten all tripod handles to obtain maximum rigidity of the system.
- 2.) Mount the 50mm lens in the front of the telemicroscope, and focus on the area of interest.
- 3.) Engage the camera adapter to the camera. This adapter is mounted in exactly the same manner as the camera lens.
- 4.) Unscrew the eyepiece holder (I) from the camera adapter. Now introduce the eyepiece (J) in the camera adapter and tighten the eyepiece retainer back. (See Figure 28).
 - Note: When the eyepiece is removed from the microscope, care should be taken to avoid any motion that would destroy the focus obtained.
- 5.) Now gently introduce the camera adapter (with the camera attached) to the microscope until the eye-piece hits the stop. Tighten the adapter on the microscope tube using the knob (K). The set-up is now ready to take photographs with no addition-al focusing required.

Note: It is possible to check the focusing using "through-the-lens" viewing of the camera although the light intensity will be lower.

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SECTION 9

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ANALISIS EXPERIMENTAL DE ESFUERZOS

A ...

ARTICULOS TECNICOS

NOVIEMBRE, 1978.

Palacio do Minoría

Celle de Tacuba 5,

primer plso.

México 1, D. F.

A P P L I C A T I O N S

The Transfer-grid Method, a Practical Moiré Stress-analysis Tool

Grids are applied to any part within minutes by a transfer technique which does not require any special skills. An optical instrument for moiré-fringe production, remote from the part (no contact master) is described

by Felix Zandman.

ABSTRACT A practical and simple moiré stress-analysis technique is described. The grid is applied to any part by a transfer method, like a decal, not necessitating mechanical engraving or photoetching nor any special environmental care. The moiré fringes are observed remotely from the part without master contact. This is done through the use of a projection device and a master held in a plane where the projected image of the working grid is formed. Limitations of the method, as well as its applications, are discussed.

Introduction

The moiré stress-analysis technique* has been limited in its usefulness until recently, principally because of the difficulties involved in the application of grids to the test part. The only methods available were by engine ruling, photoengraving or photoetching which are very expensive and tedious, demanding high degrees of skill and consuming a considerable amount of time.

Still another difficulty was apparent in the necessity of using masters directly in contact with the active grid to produce the fringe pattern. In many instances contact is prohibited, difficult or impossible.

This paper describes a recently developed, simple and inexpensive method of grid application. It also describes an instrument for producing moiré fringes without contacting the part with a master.

Producing and Applying the Grid

During the development of this new technique,

the following parameters were established and considered:

- (a) Produce a grid which can be stored, handled, shipped and applied without producing grid distortions.
- (b) Grid application should be permissible under normal lighting conditions by personnel familiar with usual stress-analysis techniques.
- (c) Grid should be applicable to flat or cylindrical surfaces of any material.
- (d) Grid and application method should be economical.
- (e) Grid should be capable of withstanding high temperatures and extreme elongations.

To accomplish the above objectives, the following concept resulted; produce a transferrable grid or dot system of a highly reflective thin metal film which is supported by a rigid, easily stripped carrier. This was achieved by taking a stainlesssteel plate of 0.005-in. thickness and covering it with a layer of nickel in such a way that the peel strength of nickel to stainless steel is very low. A layer of photoresist is then applied to the nickel and a print of the desired grid or dot system is made. After development, the areas in the unexposed portion of the image are etched. The etching process is stopped as soon as the pattern is formed.

An alternate method involves evaporating or plating nickel through a mask onto the stainlesssteel backing. Material other than nickel can also be used; we have found, however, that nickel produces good results in terms of reflectivity, temperature, peel strength and process handling.

At this point, the transferrable grid on its backing plate can be stored, shipped and eventually applied

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^{*} For those interested in a description of the principles of moiré, several excellent papers by A. J. Durelli of The Catholic University, Washington, D. C. are recommended.
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to the part without concern for distortion.

The method of applying (transferring) the grid consists of:

- (a) Cleaning the surface to which the application is to be made. (This is similar to surface preparation used for strain gages or photoelastic coatings.)
- (b) Applying cement to part. (A black adhesive is used for reflection techniques on opaque parts, a transparent adhesive for transmission techniques on transparent parts.)
- (c) Application of the grid-plate sandwich to the cement-coated part, making certain that the grid is in contact with the cement. If the part is mildly curved, the plate can be made to conform to the curvature. (For sharp curvatures, the grid is first stripped off the backing plate with cellophane tape; now the tape, which is very flexible, is the carrier and it conforms more easily. This method can produce some grid distortions.)
- (d) The cement is then allowed to cure. (Twenty-four hours at room temperature or a few hours at elevated temperatures.)
- (e) After the cement is fully cured, the backing plate (or tape) is peeled off and the part is now ready for testing.

The sequence of grid application described above is schematically shown in Fig. 1.

Types of Grids

Employing this technique for manufacturing grids, practically any pattern can be produced such as lines, grids, dots, circles, triangles, etc. For practical production and stocking reasons, the available commercial patterns[†] have been limited to lines, grids or dots of 200, 500, 1,000, and 2,000 lines-per-inch density. These are normally made in $4 - \times 4$ -in. and 1×1 -in. sizes.

In addition, individual gages made of concentric circles of 500 lines-per-radial-inch density are produced with a gage diameter of 0.2 in.

Moiré Fringes Without Master Contact

The principle of producing moiré fringes without resorting to direct contact between the master and the active grid is accomplished by projecting the image of the working grid onto a plane remote from the part and then placing a suitable master grid in the same image plane of the working grid. Moiréfringes will then be produced in the remote plane. ^{1, 2}

The instrument developed to accomplish this[†] consists of a very accurate optical system containing high-resolution, color-corrected, non-distorting lenses. The basic magnification is 1:1, thus providing the same result as two grids of the same line pitch in contact (matched grids). Magnification adjustability provides the same results as two mis-

† Photolastic, Inc., 176 Lincoln Highway, Malvern, Pa.







Fig. 2—General view of the moiré instrument (to the right) and a straining frame (to the left)

matched grids (fringes at zero strain) thereby permitting analysis of low strains or measurement over short gage lengths. In addition, photographic film can be used in place of the master in the image plane and, hence, moiré fringes will be produced through double exposure (before and after load application.)

Photographs of the fringes or direct measurement can be made directly from the screen of the instrument (location of the master grid) where the moiré fringes appear. Figures 2 and 3 show the instrument described above.

Limitations of the Transfer-grid Method

Grid Limitations

- 1. At high temperatures, the epoxy or other adhesive can be destroyed.
- 2. When applying grids to small radius or complex curvatures, they will usually distort, which will necessitate zero readings. This complicates data reduction.
- 3. Limited area of a single-transfer pattern.

Instrument Limitations

1. The distance between the instrument and the test part must be rigidly fixed; if not, magnification changes will occur and fringes not related to strain might appear. Fig. 2—View of the rear of the moiré instrument where the fringe pattern appears



Fig. 4—Moiré pattern visible through a remote observation instrument. Moiré grid located inside the transparent model and master grid of the instrument located at 4 ft from the model

- 2. Full-field analysis can be accomplished on flat surfaces only. On curved surfaces, measurements are made point by point or line by line.
- 3. Refocusing of instrument might be required if load-induced warping of the plane containing the grid leads to spurious fringes or out-offocus areas.
- 4. A 2000-line-per-inch grid appears as the practical limit for conventional lenses because of

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their limited resolution power for large-field observations. Microscope lenses can be used for very high line densities (5 to 10,000 lines per inch); however, then the field of observation becomes very small.

Applications

The main areas where the moiré method of stress analysis can be used uniquely or to more advantage than other methods appear to be:

- 1. High-temperature applications such as welding, heat treatment, creep.
- 2. Analysis of interiors of tridimensional models through insertion of grids inside of models and producing moiré fringes with the instrument described above; no contact with grid is required.
- 3. Strain measurements on soft materials or wherever reinforcement caused by the strainmeasuring device is a problem.
- 4. Long-term measurements wherever stability of the strain-measuring device is a problem.
- 5. In combination with photoelasticity for twoor three-dimensional problems (stress freezing or not), providing a means of separation of principal strains without resorting to graphical integration, as follows:
 - (a) Two-dimensional photoelastic model with grid on one of its surfaces. Separate values of principal strains are obtained at any point through the use of moiré or combination of moiré and photoelasticity.
 - (b) Grid applied inside a three-dimensional photoelastic model. After model "freezing," the slice containing the grid is cut out and analyzed photoelastically and moiré-wise at any desired point. Threè principal strains in sign, magnitude and orientation are obtainable without graphical integration.
 - (c) A slice is cut out from a three-dimensional "frozen" model. A photoelastic analysis is made of the slice. A transfer grid is then applied to the slice and the slice annealed so as to remove from it its birefringence. Because of strain relaxation, the grid is now distorted and can be analyzed. The photoelastic and moiré information are sufficient to obtain the three principal strains as in 5(b) above.

- 6. The method, being very basic, can be used efficiently as a teaching tool in classes of elasticity and stress analysis.
- 7. An extremely important advantage of the moiré method exists for those problems in which displacements are the desired quantities. Example: A simple example will illustrate one of the above-mentioned applications. A section of a rail made of a transparent material was analyzed in its plane directly under a point-acting load (three-dimensional problem.) The model was cut along the plane to be analyzed. A transfer grid was applied to the plane. The model was recemented and a point-like load applied directly above the plane containing the grid. The moiré instrument was then focused on the interior grid and the resulting moiré fringes analyzed without resorting to stress "freezing." Figure 4 shows a portion of the model and the moiré fringes as visible through the instrument.

Conclusion

4

The technique of grid transfer and moiré-fringe production without master contact appears to be a realistic, economical and practical approach for industrial and laboratory problems. Technicians without special skills can apply grids to any part within minutes and at a reasonable cost.

The future of the method as an industrial tool will depend very much on the level of education of the users, as for any new technique, and upon future developments still needed in high-temperature cements, fringe readout systems for data-reduction simplification, and grids of larger dimensions.

Acknowledgments

Most of the work contained in this paper was inspired by the excellent pioneering work done in this field by P. Dantu of the Laboratoire Central des Ponts et Chaussees, Paris, France. The particular technique of grid transfer, as well as the instrument described in the paper, was developed in a team effort by D. Post, S. S. Redner, M. Wishner, and the author.

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Homegrown Strain-gage Transducers

Simple compensation procedures can be used to correct errors in strain-gage transducer bridges

by James Dorsey

ABSTRACT—Small errors commonly encountered in experimental stress analysis are often unacceptably large when building strain-gage transducers—even crude ones. Fortunately, the procedures necessary to remove the errors are simple. The steps are discussed in detail and examples given. These compensation techniques can also be useful in strain-measuring applications under certain circumstances. Also discussed briefly is the effect of instrument circuits on transducer performance.

Symbols

- R = resistance
- ΔR = change in resistance
- GF = gage factor
 - $\epsilon = \text{strain in in./in. (m/m)}$
- R_B = resistance of transducer strain gages
- V = Wheatstone-bridge supply voltage

S.G. = strain gage

- $V_0 = \text{transducer output}$
- R_m = Resistance of span-shift compensation resistor
- ΔE = temperature-induced change in spring-element modulus of elasticity
- ΔK = temperature-induced change in gage factor of strain gages
- α_m = temperature coefficient of resistance of span-shift compensation resistor

Introduction

Most strain gages are used in testing to learn about the strain on a surface. But another large quantity is employed on devices called transducers. In the latter applications, users want to measure a physical quantity such as load or pressure and do it by means of an electrical output.

Resistance strain gages are convenient for these devices because they easily convert strains to electrical signals. Although this qualifies them, or the complete devices, to be called transducers, it is more useful for this paper if transducers are defined as devices (a) that use strain gages, and (b) that can be precalibrated before use. Strain sensitivity (or transfer coefficient) of the gages will be learned by actually applying known physical quantities to the device.

The study of transducers is very complex and cannot be completely covered here. Material properties, element (spring) design, case construction, sealing, use of flexures, etc. are all important considerations. But perhaps the

Paper was presented at 1976 SESA Spring Meeting held in Silver Spring, MD on May 9-14. least understood area involves compensation techniques needed for initial bridge unbalance and for several errors caused by temperature changes. This paper discusses bridge errors and their corrections, a subject often neglected because cost or time involved is thought to be great. In fact, simple adjustable resistors can be used to quickly and easily achieve good results. In any case, accuracy improvement is often so dramatic that, on a unit-cost basis, nothing else done to improve the transducer can possibly be as effective. As a corollary : failure to make simple corrections for problems caused by temperature changes can result in very large errors (as is also true in experimental stress analysis).

Finally, many of the techniques described find application in experimental stress analysis use of multiplestrain-gage circuits. Bridge compensation has been used both to produce more accurate data and to save installations in which unmatched gages were inadvertently used.

Errors

Unfortunately there are many ways in which the strain gages and their installations can deviate from the ideal. However, most of the serious errors are easily corrected. The four most important are normally considered when transducers will experience temperature excursions or must be interchangeable.

Zero Shift with Temperature Changes

Strain gages respond to temperature. Changes in resistance result from the temperature coefficient of resistance of the grid and the expansion coefficients of the grid and the spring element. Although the temperature coefficient of resistance of most foil strain gages can be adjusted to minimize the changes caused by temperature, zero output cannot be achieved over any appreciable temperature range.

The resulting error is particularly bad because it is, in no way, related to the size of the measurement. In other words, even if the quantity to be measured is zero, a large output can result if temperature changes.

Theoretically, use of a fully active half- or full-bridge will eliminate zero shift by subtraction. In practice, no two strain gages are ever identical and there are variations in installation and in the spring element. (Zero shift will also occur when adjacent bridge arms are mounted on surfaces with different radii.)

Bridge Balance

In general applications, it is convenient to use transducers whose output is zero (or close to zero) when input is zero. Even if the strain gages are well balanced and uniformly installed, compensation for zero shift with

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C-PATTERN

A-PATTERN





E-PATTERN

Fig. 1—Bondable resistors

temperature change will often unbalance the bridge zero.

Span Vs. Temperature

D-PATTERN

Output (span) of an uncompensated transducer will normally change as temperature changes. Differences in span occur with temperature change because both gage factor of the strain gages and modulus of the elasticity of the spring element are functions of temperature.

Normally these two effects combine to cause increasing span as temperature rises.

Span Adjust

The output of a transducer can be set to a specific desired level. Although adjustment of span does not directly_affect_accuracy,_it_is_usually-desirable_because-it is an advantage to have the transducer/instrument system output displayed in convenient units (e.g., 137 lb—or kilograms—load reads 137 or 1370 counts on the indicator) and also, if transducers are interchanged, output for a given Q would be the same.

Impedance Match

In some applications, it is helpful if the transducer's input or output impedance is within a specified range.

Other Errors

There are many other types of transducer errors. (Creep and nonlinearity are important examples.) Most can be avoided or, to some extent, corrected. However, correction is often difficult and costly and, in any event, the errors are almost always very small.

For these reasons, no attempt will be made to deal here with subjects other than the first five given above.

Compensation Procedures

When compensating strain-gage transducers, it is possible either to calculate the resistors needed or to determine their values experimentally. If more than one transducer of a given type is to be built, it is sometimes possible to use constant values for span and impedance resistors. Step-by-step procedures follow. Where practical to calculate the resistor value rather than determine it experimentally, both techniques are discussed.

For building one (or a small number of transducers), it is often convenient to use compensation resistors that are adjustable. Figure 1 shows four types of bondable resistors that will be used in the examples which follow. The A-pattern represents any fixed resistor. C-pattern is a fixed grid with an added adjustable section. D and E are , single and double ladders, respectively. Patterns C, D and E are designed to allow user adjustments of varying amounts. Using a sharpened dental probe or other convenient tool, steps in the ladder-like arms are cut through to lengthen the conducting path and so raise its resistance. Parallel steps may be cut to increase resistance by very small amounts. In Fig. 1 (D-pattern), cutting step X would increase resistance about 2.8 percent of the maximum value. Cutting steps such as Y and Z would increase it only about 0.2 percent and 0.1 percent, respectively. Cutting steps in the C-pattern are designed to be 20 percent, 10 percent and 1 percent of the uncut resistance. There are four 20 percent, four 10 percent, and twenty 1 percent steps. However, like the D- and Epatterns, smaller changes can be obtained by cutting from the top or in the middle. The C-pattern is used if the minimum required value will be about half of the fully cut maximum. When it is not known if any resistance will be needed, D- and E-patterns are better because their uncut resistance is very low.

If possible, all temperature-sensitive (copper, Balco[®], nickel) compensation resistors (to be described in following sections) should be_located on_the transducer element where the strain will be low but as close to the strain gages as possible. Doing so will assure the best temperature tracking without danger of fatigue damage. Also, connecting wires *inside* the bridge should be balanced in length and in good thermal contact with the spring element.

Zero Shift with Temperature Change

When gaging the spring element, it is not known if there will be a zero shift with temperature large enough to require compensation or which arm will require the added resistor.

Pattern E resistors are a convenient means to solve the problem because they are very low in uncut resistance



Fig. 2-Bridge circuit with all compensation resistors

TABLE 1-LOAD CELLS AND PRESSURE TRANSDUCERS

		Load Cells	•
	General Purpose	Improved Accuracy	High Accuracy
Calibration Inaccuracy	0.5% FS*	0.25% FS	0.1% FS
Temp. Effect on Zero	± 0.005% /°F FS (± 0.009% /°C FS)	±0.0025%/°FFS (±0.0045%/°CFS)	±0.0015%/°FFS (±0.0027%/°CFS)
Zero-balance Error	±5% FS	±21⁄2% FS	±1% FS
Temp. Effect on Span	± 0.01%/°F OL*	±0.005%/°FOL	±0.008%/°FOL
	(± 0.018% /°C OL)	(±0.009%/°COL)	(±0:0015%/°COL)
Nonlinearity	0.25% FS	. 0.1% FS	0.05% FS
Hysleresis	0.1% FS	0.05% FS	0.02% FS
Non-repeatability	0.1% FS	0.05% FS	0.02% FS
System Inaccuracy†	1% FS	1∕2 % FS	0.15% FS
		Pressure Transducers	
Calibration Inaccuracy	0.5% FS	0.25% FS	0.15% FS
Temp, Effect on Zero	±1%/100°F FS	± ½%/100°F FS	± ¼ %/100°F FS
	(± 1.8% /100°C FS)	(±0.9%/100°C FS)	(±0.45%/100°C FS)
Zero-balance Error	±8% FS	± 21/2 % FS	±1% FS
Temp. Effect on Span	± 1%/100°F OP* (± 1.8%/100°C OP)	± ¾ % /100°F OP (± 1.35% /100°C OP)	± ½ % /100°F OP (±0.9% /100°C OP)
Nonlinearity	0.5% FS	0.25% FS	0.1% FS
Hysteresis	0.75% FS	0.25% FS	0.1% FS
Non-repeatability	0.15% FS	0.1% FS	0.05% FS
System Inaccuracy	2%	1%	1/2 %

*FS is 'Full Scale', OL is 'Of Load', OP is 'Of Pressure'. †Combined effects but not including temperature.

and are designed to be wired in each of two adjacent bridge arms. The copper-foil version can be bonded at the same time as the gages and wired into the bridge at the start. For best performance, the double ladder is most often in a bridge output corner.

Assume that four strain gages (should be same type and lot) are bonded to a spring element and wired in a fullbridge. Output of the bridge will generally not be zero, but is usually close enough so that a reading can be obtained on the transducer-indicator instrument.

If the gages and element are then warmed, output will usually change. (Even in cases where the spring element is part of a large structure such as a bridge or a commercial aircraft, it is usually possible to get readings at two temperatures at different times of the day.)

Theoretically, it is possible to make a very careful measurement of the temperature effect and to calculate the needed compensation resistor. For example: if the bridge output is equivalent to 35μ in./in. (μ m/m) for a temperature rise of 100°F (55°C) and 350 ohm gages with a gage factor of 2 used:

$$\Delta R = GF \times \epsilon \times R_R \tag{1}$$

$$\Delta R = 2 \times 35 \times 10^{-6} \times 350 = 0.0245 \, \Omega / 100^{\circ} F =$$

0.0245 Ω/55°C

Copper wire increases resistance approximately 22 percent/ $100^{\circ}F$ (22 percent/ $55^{\circ}C$), so a length of wire whose resistance is 0.11 ohms is required to compensate for temperature-induced zero shift of the transducer

bridge. [The resistance of a 1.25-in. length of AWG-40 copper wire (0.08-mm diameter \times 32 mm long) would be about 0.11 ohms.]

In practice, this calculation is an unproductive exercise. The resistance of copper required is normally extremely small. Selecting such a resistor and soldering it into the bridge arm to achieve compensation is impractical if not all but impossible.

Using a double copper ladder in one corner of the bridge (Fig. 2) assures that the adjustable resistor will be available in the required bridge arm; and also if overcompensation occurs accidentally, it is easy to increase the copper conductive path in the adjacent arm.

When the spring element is gaged and the bridge wired with the double copper ladder in place, it can be put in an oven or otherwise warmed. Bridge-output change will indicate which of the two adjacent arms surrounding the copper ladder needs added temperature sensitivity. By experience and trial and error, the ladder in that arm can be increased in resistance until the temperature-caused zero shift is within acceptable limits.

A word about 'acceptable limits': many of the compensation techniques described can be tuned to as fine a level as is desired. The limits are economic considerations and the fact that compensation is usually not linear. Output can be trimmed to zero at pairs of temperature, such as $77^{\circ}F$ and $105^{\circ}F$ ($25^{\circ}C$ and $40^{\circ}C$), but normally is not zero at other temperatures.

Although it is possible to reduce such nonlinearities, the procedure is time-consuming, costly and rarely completely effective. The simple one-resistor compensations discussed here will rotate the curve but not linearize it. Typical magnitudes of correction in Table 1 are chord slope

values between temperature points selected by the transducer designer.

Bridge Zero

Bridge zero is adjusted by the same techniques as for zero shift with temperature except a low-temperature coefficient resistor is used. If the initial unbalance is the equivalent of 100 μ in./in. in our example, then from eq (1):

$R = 2 \times 100 \times 10^{-6} \times 350 = 0.07$ ohms

[The resistance of a 1.6-in. length of AWG-40 constantan wire (0.08-mm diameter \times 40 mm long) will be approximately 0.07 ohms.] Balance wire can be added after bridge zero is checked or a double ladder can be installed opposite the copper ladder. If the strain gages are made of constantan, then usually an E-pattern resistor made of constantan would be employed, and a Karmatype-alloy resistor would be used for Karma-type gages. The adjustment technique is the same.

The double ladders are connected as shown in Fig. 2.

Span Vs. Temperature

Adjustment of span changes with varying temperature is usually the most difficult compensation to achieve because the quantity to be measured must be applied to the spring element as the temperature is changing.

Nickel temperature sensors have often been used as the compensating element but recently there has been more interest in Balco[®], a very stable nickel-iron alloy with a <u>high-temperature_coefficient_of_resistance.-Balco-has-a-</u>number of advantages when compared with nickel. It is



FIG._3—Temperature vs. resistance for Balco and nickel

less expensive, easier to manufacture, and has about $2\frac{1}{2}$ times the resistivity of nickel. Temperature coefficient-of-resistance curves for Balco and nickel are shown in Fig. 3. At temperatures above -100° F (-75° C), the only disadvantage to Balco is a slightly lower temperature coefficient of resistance.

If the transducer is put through a temperature cycle and the span change recorded, it is possible to calculate the resistance of the Balco gage required. Or, using approximate values for materials and gage behavior, the following equation will produce a nominal value for this resistor:

$$R_m = \frac{-(\Delta E - \Delta K)R_B}{\alpha_m + (\Delta E - \Delta K)}$$
(2)

ΔK (Approximate)

- = +0.5%/100°F (+0.9%/100°C) for constantan = -0.57%/100°F (-1.03%/100°C) for K-alloy - 06 compensation
- = -0.83% / 100°F (-1.49% / 100°C) for K-alloy 13 compensation

\propto_m (Approximate)

(for nickel) =	$+0.31\% / {}^{\circ}F (+0.56\% / {}^{\circ}C) OR =$
	0.0031 Ω/Ω/°F (0.0056 Ω/Ω/°C)
(for Balco) =	+0.25%/°F(+0.45%/°C)OR =
	$0.0025 \ \Omega/\Omega/^{\circ}F (0.0045 \ \Omega/\Omega/^{\circ}C)$

Figure 4 is a plot of values obtained with eq (2) and is a good guide to the resistance of the Balco sensors needed. Approximate values for ΔE are also shown for typical transducer element materials. Precise compensation usually does not result from using these resistances because values of R_m from the plots are approximate and will be altered when the calibration resistor is inserted.

A better practice is to pick a value from Fig. 4 and then use a C-pattern resistor that is below the value uncut and above it when fully cut. By successive tests, the value of the resistor-can then be adjusted to give best results. It is usually possible to adjust span shift vs. temperature to less than 0.0025 percent of signal/°F (0.0045 percent/°C).

Span Adjust

Span is adjusted by using a temperature-insensitive resistor in series with the voltage supply. A good selection is the D-pattern. By measuring the impedance of the bridge circuit (including the Balco resistor just discussed) and knowing the desired reduction in bridge output, a constantan or Karma D-pattern resistor is easily selected and adjusted by the same method that was used with the Balco.

As with the double ladders within the bridge itself, it is often possible to select suitable span and span vs. temperature adjustable resistors before beginning the gaging and to install them at the same time as the gages.

Impedance Match

If bridge-input impedance match is required, it is usually a fairly high resistance not available in bondable grids. The resistor should be stable with temperature and is installed as shown by the dotted lines in Fig. 2.

Output impedance match is tricky, likely to destroy compensation already achieved, and can only be adjusted to a lower value (by shunting). Since output impedance is



Fig. 4-Calculated-span-shift compensation resistors

close to gage resistance, adjustment is not recommended. Better practice is to use gages with the impedance desired.

General

The completely compensated transducer bridge is shown in Fig. 2. It is actually best to 'split' the Balco and constantan resistors in the voltage circuit so that approximately half of each resistor is in the plus and minus supply arms, respectively. Although two adjustable resistors could be used for each, it is often acceptable and simpler to use a fixed resistor of about the right value in one lead and an adjustable resistor in the other. For example: if Fig. 4 indicates that 28 ohms of Balco is required, a 14-ohm fixed resistor could be put in one lead and a 10- to 24-ohm Balco C-pattern in the other.

When all of the resistors are installed in the beginning, it should not be necessary to repeat the adjustment steps. If, however, tests of the transducer are not satisfactory, a repeat may be needed to 'fine tune' the compensations.

One other problem is sometimes encountered. When the spring element is installed in its case, loads applied by the case itself may change various compensations. Corrections for these difficulties are not recommended because they are complex (usually involving compensation resistor shunts located in a terminal box outside the case). Redesign of the case to avoid trouble is usually possible.

Specifications

Table 1 shows typical specifications for several 'grades' of load and pressure transducers. The compensation techniques above routinely achieve the 'general purpose' specifications. In many applications 'improved accuracy' is not difficult to obtain if there are no adverse effects caused by the case or other environmental protection. 'High accuracy' requires more sophisticated techniques.

In some of the specifications (including system inaccuracy), pressure transducers show worse performance

than load cells. There are several reasons, including a greater interaction between the pressure cell diaphragm and its support structure and less freedom of springelement design in the pressure transducer.

Comments on Instrumentation

Constant Current

The techniques above were discussed for a constant voltage or mV/V device. Constant-current power supplies (or instruments with resistors in series with the voltage supply) will cause little change in zero shift vs. temperature and transducer zero compensations, but completely remove the effect of span adjust and span vs. temperature resistors. (If the current is truly constant, then resistors in series with the power supply do not affect current in the bridge and so compensation does not result from their insertion.)

Transducers can be compensated for constant-current operation by means of shunts rather than series resistors. The procedure is more complex and not recommended for 'homegrown' transducers.

Most transducer manufacturers will provide transducers ⁴ for use with either-type power supply, often at no difference in cost. Before either buying or building, the type of instrument to be used must be fixed and its operating principles determined. If not done, expensive compensation may either be seriously downgraded or, worse, not work at all.

Instrument Zeroing Circuits

Many instruments used with strain gages and straingage transducers have an adjustment that allows the user to balance the reading to zero when the transducer is at zero input. In some cases, these instruments can be set at zero with a fairly large tare input (fixed input of no interest such as the weight of an empty tank).

The zero-balance circuit shown in Fig. 5 is common and, unfortunately, is harmful to the compensation techniques just described. Essentially, the circuit shown shunts two arms of the bridge. For most instruments with this type of balance control, all of the compensations discussed are affected except bridge zero (which it is designed to override). The amount of downgrading depends on the resistors in the instrument but is often enough to put the transducer well outside stated specifications.



Fig. 5-Undesirable transducer-balance control





The preferred transducer-instrument circuit is shown in Fig. 6.

Instrument Zero

When building a transducer, it is desirable to know the true instrument zero to assure that the transducer bridge is accurately zeroed. A simple and foolproof method of getting the value is to substitute the circuit shown in Fig. 7 for the complete transducer circuit (gages and compensating resistors). The four resistors in Fig. 7 are all the same and about half the strain-gage resistance. This 'inside out' or star bridge has two important features. The instrument automatically senses zero bridge output and, input and output impedances are about the same as with the transducer in place. (Use of a star bridge is also recommended in strain-gage applications where very small changes in strain are important. Unless the instrument zero is precisely known each time a reading is taken, very large errors can be encountered-in-these test programs.)

Combining Transducers

If the quantity to be measured requires a combined reading from more than one transducer, special care



Fig. 7-Star bridge

must be exercised in the circuit used. A typical case would be the use of three or four load cells supporting a tank or a weighing platform. Since the load may be off center, the reading must be either the sum or average of transducers not all seeing the same load.

If inputs and/or outputs of the transducers are paralleled, difficulties are encountered much like those described above under "Instrument Zeroing Circuits"; or worse. The circuit selected for combining transducers must be carefully chosen to prevent interactions. Figure 8 shows a popular arrangement.

General Circuit Considerations

All of the above individual circuit topics relate to some form of problem that occurs because the transducer is built to operate with a relatively 'pure' instrument but often encounters a somewhat less ideal circuit. While some liberties can be taken if a transducer is to be constructed for use only with one particular instrument, this is not the usual case.

It is advisable to investigate the design of instruments to be used with transducers and be sure they will not adversely affect transducer compensation and performance.

Conclusions

In general, building transducers will not be less expensive than buying them. Rather, the decision to build is usually based on one or more of the following :

- 1. No commercial transducer is available.
- 2. A portion of a large structure is the required spring element.
- 3. Many will be used and must be part of an assembly to be manufactured.

Often, readily available commercial transducers will satisfy needs; but in cases where they will not, the techniques needed to compensate for most common strain-gage-bridge errors are straightforward and easy to master. Provided that instrumentation for use with the transducer is wisely selected, quite accurate 'homegrown' transducers are not difficult to construct.



Fig. 8—Circuit for combining transducers

SESSION IV

TRANSDUCER DESIGN

1. Materials

(a) Steels (E = 30×10^6 psi)

SAE 4340, 410SS, RDS Tool Steel, Armco 17-4PH SS Electric furnace or vacuum melt Hardness: R_c 43 to 48 (BHN 400 to 450) T.T.S. = 225 to 250 KSI O.T.S. = 200 to 225 KSI Y.S. = 175 to 200 KSI (2000 $\mu\epsilon$ offset) P.L. = 150 to 175 KSI (20 $\mu\epsilon$ offset) E.S. = 85 to 95 KSI (N = 107 cycles) K_f = 3.00 (threads) Elongation = 10 to 15% Design limits:

με (static) = 150,000/30 = 5000 (overloads)
με (fatigue) = 90,000/30 = 3000 (reversed cycles)
με (threaded) = 3000/3 = 1000 (nominal)

(b) Aluminum Alloys (E = 10.5×10^6 psi)

2024 T-81, 2014 T-6, 7075 T-6, X-2020 Hardness: BHN 130 to 140 T.T.S. = 80 to 87 KSI O.T.S. = 70 to 80 KSI Y.S. = 50 to 60 KSI (2000 $\mu\epsilon$ offset) P.L. = 40 to 50 KSI (20 $\mu\epsilon$ offset) E.S. = 20 KSI (N = 107 cycles) K_f = 2.00 (threads) Elongation = 5 to 15% Design limits:

µɛ (static) = 40,000/10.5 = 3800 (overloads) µɛ (fatigue) = 20,000/10.5 = 1900 (reversed cycles) µɛ (threaded) = 1900/2 = 950 (nominal)

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(2) (c) Beryllium-Copper (E = 18.5×10^6 psi) Berylco 25 HT Maximum Hardness (2 hours @ 600°F) T.T.S. = 200 to 205 KSI 0.T.S. = 200 KSI Y.S. = 175 KSI (2000 με offset) P.L. = 130 KSI (20 με offset) E.S. = $40 \text{ KSI} \cdot (N = 107 \text{ cycles})$ $K_{f} = 5$ (estimated for threads) Elongation = 1 to 3%Design limits: $\mu\epsilon$ (static) = 130,000/18.5 = 7000 (overloads) $\mu\epsilon$ (fatigue) = 40,000/18.5 = 2150 (reversed cycles) $\mu\epsilon$ (threaded) = 2150/5 = 430 (nominal) 2. Design Principles for Spring Element (a) Integral spring (no bits & pieces) (b) Maximum strain at gage locations (use flexures) (c) Uniform strain over grid area of gage (d) Minimum strain at gage tabs (e) Gage area consistent with output (MV/V) (f) Provide adequate heat-sink for power dissipation (g) Gage area accessible for proper installation (h) Rated strain consistent with gage endurance (i) "Caution" with threads: Preload if possible Avoid "last-engaged-thread" Use low nominal stress (j) Achieve maximum natural frequency: Maximum overall stiffness Minimum overall weight (k) Simple structure - easy to machine - low cost 3. Examples (sketches of good designs)



SENSITIVITY SHIFT DUE TO TEMPERATURE CHANGE 3. MODULUS OF ELASTICITY (E) OF TRANSDUCER ELEMENT (A) TYPICAL VALUES - CHANGE PER 100°F 1.5% RDS Tool Steel. 1.4% 301 SS 7% 17-4PH SS 1 Z 2024 Al. % 6061 Al. 6-8 % AZ91 Mag. d R 2-3 HK31 Mag. % 8 Mn Ti. feel heat treat - 3,1% 3.6% 6 AL4V T1. annella -3,549 2.1% Inconel X 2.5% Beryllium Copper GAGE FACTOR OF STRAIN GAGE ALLOY (B)TYPICAL VALUES - CHANGE PER 100°F 6.F. 2.4 mon +0.5% Constantan DETION B-53 K 06 -1,792 K Alloy Compensation 03 -1.7% -0.45 -0.55 -2,25% 09 -0.72 09 13 -0.85 Iso Elastic -0-75 (c) COMBINED EFFECT GAGE & SPECIMEN Titanium & Aluminum + Constantan 6 OUTPUT (%) Aluminum + K-13 Ц Tool Steel + Constantan 2 Tool Steel + K-06 100 75 503 175 200 CHANGE TOF -2 -4 -6

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TYPICAL MODULUS RESISTOR VALUE

BRIDGE RESISTANCE CONSTANTAN

•	120 OHM	350 OHM
Tool Steel	м 7.7	M 22:5
Aluminum and Titanium	14.3	41.6
Beryllium Cu.	12.0	35.0



Typical Adjustable Nickel Resistor AR Series

4. Bridge Balance



TYPICAL ADJUSTABLE CONSTANTAN BRIDGE

BALANCE RESISTOR

BR SERIES"



5. BRIDGE CALIBRATION



6. IDEAL COMPENSATION TO MAINTAIN BRIDGE SYMMETRY



'AR' OR 'BR' SERIES ADJUSTABLE CONSTANTAN RESISTOR MAY BE USED DEPENDING ON VALUE REQUIRED

GENERAL INSTRUCTIONS FOR THE SELECTION AND USE OF TENS-LAC® BRITTLE LACQUER AND UNDERCOATING

INTRODUCTION TO BRITTLE LACQUER

Brittle Lacquers crack at certain strain levels. These cracks occur perpendicular to the maximum tensile strains and are present at locations where the strain level has exceeded a certain "threshold" value. For Tens-Lac® Brittle Lacquer this threshold is nominally 500 micro-strain $(\mu\epsilon)$. In areas where the threshold is not exceeded, the lacquer will not crack. Since cracks occur where the strain is greatest, stress concentrations can be quickly identified. The cracks also show the direction of maximum strain at a point which allows for accurate alignment of strain gages in order to obtain precise measurements. Test parts are frequently loaded incrementally, and after each load increment, the coating is examined for cracks. Areas where cracks occur can be outlined with a felt-tipped pen, and the applied load noted. The accuracy of brittle lacquer measurements depends on the application of the coating as well as variations in temperature and humidity. If care is taken in the preparation, application, and testing procedure, Tens-Lac[®] Brittle Lacquer, when properly calibrated, can yield quantitative results accurate to +100 $\mu\epsilon$. Under optimum conditions, accuracy on the order of +50 $\mu\epsilon$ is possible.

SURFACE PREPARATION

It is essential that Tens-Lac® be applied in an oil/water-free environment. The test part must be completely free of oil, dirt, rust, and loose paint. However, a smooth painted film which is not readily softened by the methylene-chloride solvent in Tens-Lac® Brittle Lacquer can be left on the test part. Extremely rough castings, and highly porous surfaces with numerous indentations, can be filled with an eqoxy. Any raised imperfections (e.g., excessive weld splatter scale, should be ground smooth by using a file or rotary grinding wheel. Remove all dirt, grease, etc. using solvents which leave no residue such as Tens-Lac® Brittle Lacquer T-1 solvent.

THE UNDERCOAT

Tens-Lac® Brittle Lacquer Undercoat U-10, which consists of a mixture of aluminum powder and a carrier solvent, is sprayed on the surface of the test part before applying Tens-Lac® Brittle Lacquer. Undercoating with U-10 enhances the visibility of crack patterns. Even if the surface is bright or shiny, U-10 is recommended so as to produce uniform reflectivity. Undercoat also makes it easier to judge the thickness of Tens-Lac® Brittle Lacquer during application.

APPLICATION OF U-10-A UNDERCOAT (AEROSOLS)

One U-10-A aerosol can will cover approximately 8 to 10 square feet. Shake the can vigorously for several minutes to get the aluminum powder in suspension. Periodic shaking of the aerosol can while spraying is also required. Depress the spray head fully while the aerosol is aimed off the part, then move parallel to the surface at a distance of three to six inches $(7\frac{1}{2}$ to 15 cm). Do not release the spray head until the aerosol is again beyond the surface of the part. A thin, uniform coating is produced and controlled by the speed of each pass, and the distance from the spray head to the test part. The coating should have a wet appearance immediately after spraying, but will dry to a flat finish in 15 - 30 minutes.

After drying, it is recommended that the surface be brushed gently with a clean tissue or cloth to remove any dust which may adhere to the U-10 undercoat. Undesirable undercoat dust contributes to excessive bubbles in the Tens-Lac® Brittle Lacquer coating.

Spray head clogging is unlikely. If clogging occurs, a 90^o rotation of the spray head will usually alleviate the problem. An extra spray head is supplied with each can (found inside the lid). Remove the old spray head and wash out the nozzle hole in the U-10 aerosol can with alcohol. Install the new spray head before the alcohol dries. A lubricant, such as vegetable oil, may be used to ease insertion of the new spray head. If oil is used, be sure to clean out the new spray head by spraying the aerosol for two to five seconds into a waste container. Spray heads for Tens-Lac® Brittle Lacquer and U-10 Undercoat are different and not interchangeable.

APPLICATIONS OF U-10-B UNDERCOAT (BULK SYSTEMS)

The U-10-B is applied to the surface of the test part using a hand held spray gun connected to a remote air supply. The air supply must be completely free of oil and water. It is strongly recommended that separate guns be used when applying Tens-Lac® Brittle Lacquer and Undercoat as this minimizes the possibility of contaminating the Tens-Lac® Brittle Lacquer. Fluid carrying hoses should be Photolastic's type XFH, other hoses can deteriorate when exposed to the methylene-chloride carrier solvent. The canister of the spray gun must be agitated periodically to prevent the aluminum particles from settling.

Spray gun pressure can vary with the type of gun used. Excessive pressure will cause the undercoat to be deposited too dry and dusty. With the pressure properly adjusted, the undercoat should initially appear wet, but not run on a vertical surface. Allow 30 minutes for the undercoat to dry before applying Tens-Lac® Brittle Lacquer.

Immediately after application of the undercoat, clean the spray gun, hoses, and fluid cup, by spraying T-2 solvent followed by T-1 solvent through the system.

SELECTING THE PROPER TENS-LAC® BRITTLE LACQUER

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Selecting the proper lacquer is done with the selection chart (see Fig. 1). Your anticipation of the temperature and the relative humidity at the time of testing will determine the proper lacquer.

For example, if the anticipated test temperature will be 70°F (21.1°C) and the relative humidity will be 50%, the proper coating indicated by the selection chart would be TL-500-75. At test conditions of 70°F (21.1°C) and 30% relative humidity, the proper coating could be either TL-500-75 or TL-500-70. The higher number (TL-500-75) would have better sensitivity (lower threshold) while the TL-500-70 would crack at higher strain levels. The lacquer will normally begin to crack when a nominal strain level of 500µε is reached. However, an increase in temperature or relative humidity will also increase the threshold of the brittle coating causing a loss of sensitivity. At thresholds greater than 700µε, the resultant cracks will not always remain open after removing the load, and it may be necessary to observe the crack patterns on the test part while under load. The threshold of Tens-Lac® Brittle Lacquer can be lowered by decreasing the temperature. However, there is a practical lower threshold limit of 300µε. Below this level Tens-Lac® Brittle Lacquer enters a high state of internal tension and random cracking called "crazing" occurs (see Fig. 2). These random cracks make testing very difficult, and it may be best to respray the part.



Figure 2

3

Figure 1

GENERAL SPRAY TECHNIQUES FOR TENS-LAC® BRITTLE LACQUER

The development of good spray techniques is essential in order to obtain perceptable crack patterns. An important point is to avoid producing an excess of bubbles. Spraying too far from the part (depositing dust), or spraying too thick a coat (trapping solvents), can produce too many bubbles. If too many bubbles are present in the coating, the crack patterns will be difficult to detect. Tens-Lac® Brittle Lacquer should be applied in relatively thin, wet layers, allowing approximately two minutes between coats. This method permits the carrier solvents to evaporate. Thin coatings are produced by moving quickly over the part. Wet coatings are produced by decreasing the distance from spray head to the test part. Sufficient layers of 8 to 12 coats will produce the desired thickness of .003" to .006" (0.08 to 0.15mm). A uniform thickness is seen by noting the variations in color of the coating. Lighter colored areas indicate a thinner coating where more material needs to be added. It is advisable to practice the spraying technique on some calibration bars before doing an actual test. A micrometer can be used to relate the thickness of a coating to the shade of green.

The best lacquer surface is not a flat one, but one that is glossy with an "orange peel" appearance. "Orange peel" surfaces crack in a more repeatable and predictable manner than flat coatings. Spraying in highly humid areas (over 50% R.H.) may produce a "blush" effect caused by water condensing on the cooled surface. Each new coat will dissolve the previous blush. Wait 15 minutes before applying the last coat.

SPRAY TECHNIQUES (AEROSOL)

It is not necessary to shake Tens-Lac® Brittle Lacquer in the aerosol cans. However, if the spray head becomes clogged, an extra nozzle is supplied with each can (found inside the lid). Remove the old nozzle and install the new nozzle following the same procedure as mentioned earlier for the Undercoat U-10 aerosol cans.

Remember, spray heads for Tens-Lac[®] Brittle Lacquer and U-10 are different and not interchangeable.

The average distance for spraying Tens-Lac® Brittle Lacquer aerosols is about 5 inches (13 cm). The surface temperature of the test part will drop slightly due to evaporation of the solvents and from the propellant in the aerosol can. Thus, the test part needs sufficient time to recover before the next coat is applied (typically 2 min.). This is especially true of thin metal and plastic parts.

SPRAYING TECHNIQUES (BULK SPRAY)*

It is important to have an air supply free of oil and water for any bulk spray system. If a remote feed is used, the fluid hose should be Photolastic's XFH Fluid Hose. Other fluid hoses can contaminate the Tens-Lac® Brittle Lacquer and change its properties. The air pressure needed to spray Tens-Lac® Brittle Lacquer can vary with different guns. If the pressure is too low, the Tens-Lac® Brittle Lacquer may be heavy and run. If the air pressure is too high, the Tens-Lac® Brittle Lacquer may be deposited as dust and the cracks can be difficult to detect. Properly adjusted air pressure should deposit the Tens-Lac® Brittle Lacquer to appear initially wet, but not run on a vertical surface. After spraying, the gun and system components should be thoroughly cleaned by using T-1.

DRYING CONDITIONS FOR TENS-LAC® BRITTLE LACQUER

Parts should be sprayed at ambient conditions, and dried 20-24 hours at 5^{OF} or 10^{OF} (2.8°C to 5.6°C) above the grade of material selected. After drying, the part should be cooled slowly to the environmental test conditions. Rapid cooling will result in "crazing" of the brittle coating. For parts to be tested below 70°F (21.1°C), spray and dry the

*The Photolastic Model TBS-3 System is recommended

coating at $70^{\circ}F$ (21.1°C) or above for 20-24 hours, and then reduce the temperature slowly to test conditions. Temperature equilibrium must be reached before proceeding with the test.

ALTERNATE DRYING: ELEVATED TEMPERATURE

In some cases, testing requirements dictate that the part be tested in the shortest possible time. Preferably the same day as the Tens-Lac® Brittle Lacquer is applied. For these applications it is suggested that the Tens-Lac® Brittle Lacquer coated part and calibration beams be force dryed at an elevated temperature. Allow $\frac{1}{2}$ to 1 hour of normal drying time at room temperature. Place and cure the coated part and calibration beams in an oven set at 100°F (37.8°C) for several hours (3-5). Cool the coated part and calibration beams to the test temperature. When the coated part and beams are at the test temperature proceed with the calibration of the bars and testing of the coated part. The threshold of the Tens-Lac® Brittle Lacquer might be slightly higher due to the elevated temperature cure.

TESTING CONSIDERATIONS

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Always prepare an ample supply of calibration beams (typically four or more). The beams should be sprayed with undercoat and Tens-Lac® Brittle Lacquer in exactly the same manner and at the same time as the test part. During the cure, it is very important that the calibration bars and test part experience-identical temperature and humidity conditions. Whenever possible, the bars should be placed directly on the test part during the cure cycle. Further, it is desirable to load the calibration beams over the same length of time that it takes to load the test part. This compensates for creep, or stress relaxation in the Tens-Lac® Brittle Lacquer which can in turn influence the threshold sensitivity.

Cracks are more easily observed when the part is under load and viewed using a portable light source such as a flashlight. Direct the light at an angle of approximately 30 degrees with the coated surface.

It is convenient to outline the crack patterns using a felt tipped pen. The outlines are easier to photograph than the cracks themselves.

For examining the crack patterns during successive loads or incremental loading, reduce the load to zero between each load increment. Zero load should be maintained for twice the duration of the previous load increment before re-loading to the next level.

COMPRESSION TESTING

While brittle coatings are used mainly for locating tensile strains, it is possible to locate areas of compressive strains. This is achieved by loading the test specimen first and then applying and drying Tens-Lac® Brittle Lacquer. After the proper drying time has elasped, the specimen can be unloaded, and the coating will crack showing areas of compression. This occurs when the unloaded compression strains show up as tension strains in the coating. Special calibration procedures are not required.

Another method of measuring compression is to coat and load the specimen in the normal manner, but maintain the load for 3 to 5 hours. During

this period the Tens-Lac® Brittle Lacquer relaxes, and when the load is finally removed, the released compression strains appear as tension in the cracked coating. In these instances it is reasonable to calibrate in a like manner. The sprayed calibration beams should be installed in the Tens-Lac® Brittle Lacquer C-220 Calibrator with the sprayed side down. A small clamp, dead weight, etc. will hold the beam in its full deflected position while the lacquer relaxes. The calibration beam should be released at the same time the test part is unloaded.

INSTRUCTIONS FOR TENS-LAC® BRITTLE LACQUER CALIBRATOR C-220

The Calibrator is a convenient, lightweight device for determining the threshold of your Tens-Lac® Brittle Lacquer.

- 1. Spray a calibration bar on one side except for an area of Γ'' to $1-\frac{1}{2}''$ at one end. Spray it with the same number of coats, at the same time, and same place as the test part is sprayed. Keep the calibration bars with the test part so the bars experience the same cure history as the part. This is very important.
- 2. At the time of test, put the uncoated end of the bar into the calibrator as shown in Figure 3.
- 3. Set the strain range selected by turning it until a knob aligns with the strain scale for the range desired. The 300 to 1500 microinches/ inch range will be used most often. Even high threshold coatings (above 1500 microinches/inch) should be_checked_on_the 300 to 1500 scale first.
- 4. Depress the bar until it touches the range selector stop. Important: Place your thumb directly over the stop - not at the end of beam.
- 5. The first full crack on the bar that is toward the low end of the strain scale (toward you) is the threshold of the lacquer tested. Match this crack with the correct strain scale. Cracks are most ----easily-observed WHILE UNDER LOAD AND by having the light come from behind you as you look at the bar at a shallow angle.
- 6. Each calibrator has been adjusted and individually calibrated at the factory to produce the correct strain fields in a one-eighth inch thick bar. Therefore do not remove the lacquer from the calibrator bars by sanding or mechanical abrasion. Under the proper ventilation conditions remove the lacquer with Tens-Lac® thinner and the Under-coating with T-2.

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Figure 3			
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ANALISIS EXPERIMENTAL DE ESFUERZOS

Chapter XXIII

ROSETTE ANALYS13

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Palacie de Minería

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Chapter XXIII

ROSETTE ANALYSIS

Outline

1. Reason for Rosette Analysis

2. Stress Fields

- (a) Special Case of Uniaxial Stress
- (b) Special Case of Siaxial Stress
- (c) The General Case

3. Rosette Geometry

- (a) Basic Arrangements Involving 3 Observations of Strain
- (b) Modified Arrangements Involving 4 Observations of Strain

4. Analytical Solutions

- (a) Rectangular Rosette with 3 Observations
- (b) Equiangular or Delta Rosette
- (c) Rectangular Rosette with 4 Observations
- (d) Tee-Delta Rosette

5. Graphical Solutions

- (a) The General Case
- (b) Rectangular Rosette
- (c) Equiangular Rosette
- (c) Nomograph Methods

6. Machine Solutions

7. Corrections for Transverse Sensitivity of SR-4 Gages

- (a) For Rosettes Made Up of Single Component Gages
- (b) For Manufactured Rocettes Containing Three Elements in a Single Unit

8. List of References

9. Laboratory Experiment No, 26 Rosette Analysis

Chapter XXIII

1. Reason for Rosette Analysis

At any point on a free (unloaded) surface of a solid it is necessary to know three independent quantities in order to specify the state of stress completely. These quantities are the magnitudes of the two principal stresses, σ_1 and σ_2 , and their directions, ρ or ($\rho + 90^{\circ}$), with respect to some reference.

For isotropic elastic materials these values can be calculated from strains measured on the surface at the point in question*, and since three independent quantities are to be determined, in general, it will be necessary to make three independent measurements of strain. There are, however, some special situations in which one or two observations of strain will suffice to provide the information necessary for completely establishing the state of stress.

2. Stress Fields

(a) Special Case of Uniaxial Stress (Simple Tension or Compression)

In the case of simple tension or compression, one knows that the directions of the principal stress axes will be parallel and perpendicular to the direction of the applied force, or load, and that the megnitude of the principal stress whose direction is at right angles to the load will be zero,

This means that two of the three quantities are known from the prevaling physical conditions. On this account, it will therefore be necessary to make only a single observation of the strain along the direction of the load in order to determine the one remaining unknown quantity. For an elastic body, the stress may be calculated as follows:

* It will be well to draw attention to the fact that, although one refers to the stress condition at a point, the manner of measuring the strain gives the average over a small distance. Therefore, from the practical point of view, the results of a set of rosette observations will approximate the average conditions over a small area. This is not objectionable as long as the length over which the strain is measured is short enough so that there is relatively little change from one end to the other. The gage length will therefore depend upon the strain gradient and may run from small (1/32" or 1/16") values to as much as 6 or 8 inches or even more.

$\mathcal{O} = \mathbf{E} \mathbf{x} \mathbf{\mathcal{E}}$

where

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- σ = the stress intensity*
- E = the Modulus of Elasticity of the Material
- E = the measured strain (+ for tension and for compression)

(b) Special Case of Biaxial Stress (Principal Stress Directions are Known)

In a few special cases, in which the directions of the principal stress axes (angle ϕ) can be established by auxiliary means such as conditions of symmetry, or through a previous application of Stresscoat, there are only two unknowns, \mathcal{T}_1 and \mathcal{T}_2 , the principal stress magnitudes, to be determined. These can be found by measuring the corresponding principal strains, \mathcal{E}_1 and \mathcal{E}_2 , in the directions of the principal stress axes, and calculating the values from equations (2) and (3), which have been developed on the assumption that the material is clastic and isotropic.

$$\Gamma_1 = \frac{E_1}{1 - \mu^2} \times (\epsilon_1 + \mu \epsilon_2)$$

$$\sigma_2 = \frac{E}{1-\mu^2} \times (\mu \epsilon_1 + \epsilon_2)$$

where

ି ଫ.	, =	the algebraically larger principal stress intensity
d'		the algebraically smaller principal stress intensity
Ě	ູ່ສ	the algebraically larger principal strain
€:	2 =	the algebraically smaller principal strain
E	ິສ	the Modulus of Elasticity of the Material
N	A A	Foisson's Ratio

For later use it will be more convenient to express the values of the principal stresses in the form

$$\mathcal{O}_{1} = E \left\{ \frac{A}{1-\mu} + \frac{B}{1+\mu} \right\}
 (2a)$$

$$\mathcal{O}_{2} = E \left\{ \frac{A}{1-\mu} - \frac{B}{1+\mu} \right\}
 (3a)$$

$$\sigma_2 = E \left\{ \frac{A}{1-\mu} - \frac{B}{1+\mu} \right\}$$
(3a)

* If the stress is tension, \mathcal{O} represents \mathcal{O}_1 , the algebraically larger principal stress and $\mathcal{O}_2 = 0$, whereas if the stress is compression $\mathcal{O}_1 = 0$ and \mathcal{O} corresponds to \mathcal{O}_2 , the algebraically smaller principal stress,

(1)

(2)

(3)

Chapter XXIII

and

ROSETTE ANALYSIS

where
$$A = \frac{\mathcal{E}_1 + \mathcal{E}_2}{2} =$$

the hydrostatic component of strain and corresponds to the center of Mohr's Circle

the shear component of strain and corresponds to the radius of Mohr's Circle,

(c) The General Case

In many instances, neither the magnitudes of the principal stresses nor the directions of their axes will be known. This means that for a complete description of the state of stress, at any particular point, three independent quantities must be found. In consequence, it will be necessary to make three measurements of linear strain in different directions, and, from these three observations, to compute the two principal stress magnitudes and the directions of the axes.



Figure 1

For example, Fig. 1 illustrates a pair of reference axes, OX and OY (90° apart), and three other axes, OA, OB, and OC, making angles Θ_a , Θ_b , and Θ_c , respectively with the reference axis OX. The axes OA, OB, and OC, form what is described as a "Rosette" and, if corresponding linear strains ϵ_a , ϵ_b , and ϵ_c , are measured in their respective directions, one can calculate the linear and shearing strains, ϵ_x , ϵ_y , and δ_{xy} , corresponding to the OX and OY axes of reference.

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The values of \mathcal{E}_{x} , \mathcal{E}_{y} , and \mathcal{E}_{xy} , are calculated in terms of the measured strains, \mathcal{E}_{a} , \mathcal{E}_{b} , and \mathcal{E}_{c} , from the simultaneous solution of the equations (4), (5), and (6).

$$\begin{aligned} & \mathcal{E}_{a} = \mathcal{E}_{x} \cos^{2} \Theta_{a} + \mathcal{E}_{y} \sin^{2} \Theta_{a} + \mathcal{E}_{xy} \sin \Theta_{a} \cos \Theta_{a} \quad (4) \\ & \mathcal{E}_{b} = \mathcal{E}_{x} \cos^{2} \Theta_{b} + \mathcal{E}_{y} \sin^{2} \Theta_{b} + \mathcal{E}_{xy} \sin \Theta_{b} \cos \Theta_{b} \quad (5) \\ & \mathcal{E}_{a} = \mathcal{E}_{y} \cos^{2} \Theta_{a} + \mathcal{E}_{y} \sin^{2} \Theta_{c} + \mathcal{E}_{xy} \sin \Theta_{c} \cos \Theta_{c} \quad (6) \end{aligned}$$

where

When \mathcal{E} , \mathcal{E} , and \mathcal{E} , have been determined by the simultaneous solution of equations (4), (5), and (6), the principal strains may be found from the expressions

В

$$\mathcal{E}_{1} = \frac{\mathcal{E}_{x} + \mathcal{E}_{y}}{2} + \frac{1}{2} \sqrt{(\mathcal{E}_{x} - \mathcal{E}_{y})^{2} + \mathcal{E}_{xy}^{2}}$$
 (7)

and

$$\epsilon_{2} = \frac{\epsilon_{x} + \epsilon_{y}}{2} - \frac{1}{2} \sqrt{(\epsilon_{x} - \epsilon_{y})^{2} + \delta_{xy}^{2}}$$
(8)

(7a)

The magnitudes of the principal stresses are then determined from equations (2) and (3) or (2a) and (3a) and the directions from the ratio of the quantities under the radical in (7) or (8) above, since,

$$\tan 2 \mathcal{O} = \frac{\delta_{xy}}{\mathcal{C}_x - \mathcal{C}_y}$$
(9)

where

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the angle of one of the principal axes with respect to the axis of reference. (The distinction between the two principal axes will be considered later.)

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3. Rosette Geometry

Theoretically the relative directions of strain measurement (Angles Θ_a , Θ_b , and Θ_c) are of no particular importance, however, from the practical consideration of solving the equations one finds that certain preferred orientations permit of much simpler reduction of the strains into terms of stress.

At the present time there are four generally accepted arrangements of the gage axes for strain rosettes. Basically there are just two arrangements, the rectangular, and equiengular, but each of these has a modification involving a redundant fourth observation of strain.

(a) Basic Arrangements Involving Three Observations of Strain

1. The Rectangular Rosette in which the three gage axes are laid out at 45 and 90 to each other as shown in Fig. 2.



Figure 2

2. The Equiangular or Delta Rosette in which the three gage axes are laid out parallel to the sides of an equilateral triangle. This type of rosette has the most desirable orientations of the directions of strain observation but the equations for computing the stress values are not quite so simple as those of the rectangular rosette, which for this reason, is preferred by many investigators. Chapter XXIII

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Figure 3

(b) Modified Arrangements Involving Four Observations of Strain

1. The Rectangular or Fan Type Rosette with the four gage axes 45° apart as indicated in Fig. 4. Although the fourth observation is theoretically unnecessary, nevertheless, it provides a convenient means of checking the observations since the sum of the strains in any two cirections at right angles should be a constant for a given set of conditions, that is.



Figure 4

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2. The Tee-Delta $(T-\Delta)$ Rosette is essentially the same as the equiangular arrangement with the addition of a fourth observation which is made at right angles to the direction of one of the other three. It is claimed that this form of rosette has all the desirable characteristics of the equiangular type plus the advantage of a little more precise determination of the hydrostatic component of strain at the reference point, if this coincides with the intersection of two perpendicular gage axes.



Figure 5

4. Analytical Solutions

(a) The Rectangular Rosette (With Three Observations of Strain)

If the OA axis of the rosette (Fig. 1) is taken as the reference, and considered as coincident with OX, then, for the arrangement of the strain gage axcs in the rectangular rosette (Fig. 2),

$$\Theta = 0$$
 $\Theta_{\rm r} = 45^{\circ}$ $\Theta_{\rm r} = 90^{\circ}$

and

$$\begin{array}{cccc} \cos \Theta_{a} &=& 1 \\ \sin \Theta_{a} &=& 0 \end{array} \quad \begin{array}{cccc} \cos \Theta_{b} &=& \frac{1}{\sqrt{2}} \\ \sin \Theta_{b} &=& \frac{1}{\sqrt{2}} \end{array} \quad \begin{array}{cccc} \cos \Theta_{c} &=& 0 \\ \sin \Theta_{b} &=& \frac{1}{\sqrt{2}} \\ \sin \Theta_{c} &=& 1 \end{array}$$

By substituting these particular values of the trigonometric functions into equations (4), (5), and (6), one obtains the relations

$$\mathcal{E}_{a} = \mathcal{E}_{x}^{(1)^{2}} + \mathcal{E}_{y}^{(0)^{2}} + \mathcal{Y}_{xy}^{(0)(1)}$$
(10)

$$\boldsymbol{\epsilon}_{\mathrm{b}} = \boldsymbol{\epsilon}_{\mathrm{x}\sqrt{2}}^{\left(\frac{1}{2}\right)^{2}} + \boldsymbol{\epsilon}_{\mathrm{y}\sqrt{2}}^{\left(\frac{1}{2}\right)^{2}} + \boldsymbol{\delta}_{\mathrm{x}\mathrm{y}\sqrt{2}}^{\left(\frac{1}{2}\right)}^{\left(\frac{1}{2}\right)}$$
(11)

 $\boldsymbol{\varepsilon}_{c} = \boldsymbol{\varepsilon}_{x}^{(0)^{2}} + \boldsymbol{\varepsilon}_{y}^{(1)^{2}} + \boldsymbol{\delta}_{xy}^{(1)}(0)$ (12)

from which it is seen that

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$$\mathcal{E}_{x} = \mathcal{E}_{a} \qquad (13) \qquad \mathcal{E}_{y} = \mathcal{E}_{c} \qquad (14)$$

$$\mathcal{E}_{b} = \frac{\mathcal{E}_{x}}{2} + \frac{\mathcal{E}_{y}}{2} + \frac{\mathcal{Y}_{xy}}{2}$$

$$= \frac{\mathcal{E}_{a}}{2} + \frac{\mathcal{E}_{c}}{2} + \frac{\mathcal{Y}_{xy}}{2}$$

$$\mathcal{Y}_{xy} = 2\mathcal{E}_{b} - (\mathcal{E}_{a} + \mathcal{E}_{c}) \qquad (15)$$

or

and

By substituting (13), (14), and (15), into equations (7) and (8) one obtains the values of the principal strains directly in terms of the observations on the rosette as

$$\boldsymbol{\varepsilon}_{1} = \frac{\boldsymbol{\varepsilon}_{a} + \boldsymbol{\varepsilon}_{c}}{2} + \frac{1}{2} \sqrt{\left(\boldsymbol{\varepsilon}_{a} - \boldsymbol{\varepsilon}_{c}\right)^{2} + \left[2\boldsymbol{\varepsilon}_{b} - \left(\boldsymbol{\varepsilon}_{a} + \boldsymbol{\varepsilon}_{c}\right)\right]^{2}}$$
(16)

$$\mathcal{E}_{2} = \frac{\mathcal{E}_{a} + \mathcal{E}_{c}}{2} - \frac{1}{2} \sqrt{(\mathcal{E}_{a} - \mathcal{E}_{c})^{2} + [2\mathcal{E}_{b} - (\mathcal{E}_{a} + \mathcal{E}_{c})]^{2}}_{(17)}$$

$$= A - B \qquad (17a)$$

These values of ϵ_1 and ϵ_2 may now be employed in equations (2) and (3) in order to determine the principal stresses, σ_1 and σ_2 . However, in most cases, one does not need to know the numerical values of the principal strains; therefore, a little time and effort can be saved by using equations (2a), (3a), (16a) and (17a) since for this type of rosette

$$A = \frac{\epsilon_a + \epsilon_c}{2}$$
(18)

and

$$B = \frac{1}{2} \sqrt{(\epsilon_{a} - \epsilon_{c})^{2} + [2\epsilon_{b} - (\epsilon_{a} + \epsilon_{c})]^{2}}$$
(19)

from which the values of the principal stresses can be expressed directly in terms of the strain observations on the rosette, as follows:

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$$\mathcal{O}_{1}^{\circ} = E \left\{ \frac{\mathcal{E}_{a}^{\circ} + \mathcal{E}_{c}^{\circ}}{2(1 - \mu)} + \frac{1}{2(1 + \mu)} \sqrt{(\mathcal{E}_{a}^{\circ} - \mathcal{E}_{c}^{\circ})^{2} + [2\mathcal{E}_{b}^{\circ} - (\mathcal{E}_{a}^{\circ} + \mathcal{E}_{c}^{\circ})]^{2}} \right\}$$

$$\mathcal{O}_{2}^{\circ} = E \left\{ \frac{\mathcal{E}_{a}^{\circ} + \mathcal{E}_{c}^{\circ}}{2(1 - \mu)} - \frac{1}{2(1 + \mu)} \sqrt{(\mathcal{E}_{a}^{\circ} - \mathcal{E}_{c}^{\circ})^{2} + [2\mathcal{E}_{b}^{\circ} - (\mathcal{E}_{a}^{\circ} + \mathcal{E}_{c}^{\circ})]^{2}} \right\}$$

$$(20)$$

$$(21)$$

Mathematically, equations (20) and (21) are not in the simplest form, but the form given lends itself better to the determination of the directions of the principal stress axes.

Determination of the Directions of the Principal Stress Axes

By substituting equations (13), (14), and (15) into equation (9) one obtains the expression

$$\tan 2 \varphi = \frac{2 \varepsilon_{b} - (\varepsilon_{a} + \varepsilon_{c})}{\varepsilon_{a} - \varepsilon_{c}}$$
(22)

which yields two values of q. One value corresponds to each principal stress axis but which of the two axes corresponds to σ_{τ_1} , the algebraically larger principal stress?

In the literature, no uniform convention has been adopted by the various writers on the subject and in consequence there is an apparent confusion which necessitates the exercise of extreme care in-making one's interpretation of the physical significance of the values computed for the angle Q.

Fortunately a check can always be made by eketching Mohr's diagram from which the following rules can be established

Definition:

Let φ_1 = the angle measured (positive in the anti-clockwise direction) from the positive OA axis of the strain rosette to the positive Ol axis which corresponds to the direction of σ_1 ,

Rules (to be proved later)

1. When
$$\epsilon_{b} > \frac{\epsilon_{a} + \epsilon}{2}$$

 Φ_1 , lies between 0 and +90°



Figure 6

Mohr's Circle for the Rectangular Rosette (with three observations of strain)

Proof of Rules

An inspection of the diagram, Fig. 6, shows that the strains $\boldsymbol{\epsilon}_{a}$, E b, and E c, are represented by points A, B, and C, on the circumference of the circle and at the ends of the radial lines which are 90° = $(2 \times 45^{\circ})$ apart taken in the same sequence as the rosette axes which are 45° apart.

If the point A lies anywhere along the semi-circumference below. the abcissa, then the angle $2 \, \phi_1$, will be positive, and have values between 0 and 180°, so that Q_1 will be between 0 and 90°. If the point A happens to lie on the semi-circumference above the abcissa, then the angle $2 \, \mathcal{G}_1$ will lie between 0 and -180° and \mathcal{Q}_1 will be between 0 and -90° .

How can one tell whether point A is above or below the abcissa on the Mohr diagram?

A study of Fig. 6 shows that point A will lie below the abcissa whenever point B is to the right of the center of the circle, that is, when ϵ_{b} $\frac{\epsilon_{a} + \epsilon_{c}}{\epsilon_{a}}$. Point A will be above the abcissa when $\epsilon_{b} \langle \frac{\epsilon_{a} + \epsilon_{c}}{2} \rangle$ and will lie on the abcissa when $\epsilon_{b} = \frac{\epsilon_{a} + \epsilon_{c}}{2}$.

Therefore the following rules can be set down:





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(b) \mathfrak{S}_1 will lie between 0 and -90° when $\mathfrak{E}_b < \frac{\mathfrak{E}_a + \mathfrak{E}_c}{2}$

45⁰

45⁰

А

600

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Rosette Diagram



(c)	when	€ _b =	$\frac{\epsilon_a + \epsilon_c}{2}$
_	\$ ₁ =	0 1f	$\epsilon_{a} > \epsilon_{c}$
į	₽ ₁ =	90 [°] if	$\epsilon_{a} < \epsilon_{c}$







Figure 9 (a)




(b) The Equiangular or Delta (Δ) Rosette

Following the previous procedure, in which the OA axis of the rosette is taken coincident with the OX axis of reference, for this arrangement gives

 $\Theta_a = 0$ $\Theta_b = 120^\circ$ $\Theta_c = 240^\circ$

$\cos \theta_a = 1$	$\cos \Theta_{\rm b} = -1/2$	$\cos \Theta_{c} = -1/2$
$\sin \Theta_a = 0$	$\sin \Theta_{\rm b} = \sqrt{3}/2$	$\sin \theta_{\rm c} = \sqrt{3}/2$

Upon substitution of these values in equations (4), (5), and (6), there results

$$\mathcal{E}_{g} = \mathcal{E}_{x}(1)^{2} + \mathcal{E}_{y}(0)^{2} + \mathcal{F}_{xy}(0)(1)$$
 (23)

$$\mathcal{E}_{b} = \mathcal{E}_{x}(-\frac{1}{2})^{2} + \mathcal{E}_{y}(\frac{\sqrt{3}}{2})^{2} + \mathcal{V}_{xy}(\frac{\sqrt{3}}{2})(-\frac{1}{2})$$
 (24)

$$\mathcal{E}_{o} = \mathcal{E}_{x} \left(-\frac{1}{2}\right)^{2} + \mathcal{E}_{y} \left(-\frac{\sqrt{3}}{2}\right)^{2} + \mathcal{V}_{xy} \left(-\frac{\sqrt{3}}{2}\right) \left(-\frac{1}{2}\right)$$
 (25)

which reduce to

and

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$$\mathcal{E}_{\mathbf{x}} = \mathcal{E}_{\mathbf{a}}$$
 (26)

$$\epsilon_{b} = \frac{\epsilon_{x}}{4} + \frac{3}{4}\epsilon_{y} - \frac{\sqrt{3}}{4}\delta_{xy} \qquad (27)$$

$$\epsilon_{c} = \frac{\epsilon_{x}}{4} + \frac{3}{4}\epsilon_{y} + \frac{\sqrt{3}}{4}\delta_{xy}$$
 (28)

Adding (27) and (28) gives

$$\boldsymbol{\epsilon}_{b} + \boldsymbol{\epsilon}_{c} = \frac{\boldsymbol{\epsilon}_{x}}{2} + \frac{3}{2}\boldsymbol{\epsilon}_{y} \qquad (29)$$

Introduction of $\boldsymbol{\epsilon}_{a}$ for $\boldsymbol{\epsilon}_{x}$ according to equation (26) above results in

 $\epsilon_{b} + \epsilon_{c} = \frac{\epsilon_{a}}{2} + \frac{3}{2} \epsilon_{y}$

from which

$$\begin{aligned} \varepsilon_{y} &= \frac{1}{3} \quad (2\varepsilon_{b} + 2\varepsilon_{c} - \varepsilon_{a}) \end{aligned} \tag{30} \\ \text{By subtracting equation (27) from (28)} \\ \varepsilon_{c} &- \varepsilon_{b} = \frac{\sqrt{3}}{2} \quad \delta_{xy} \\ \text{or} \quad \delta_{xy} &= \frac{2}{\sqrt{3}} \times (\varepsilon_{c} - \varepsilon_{b}) \end{aligned} \tag{31}$$

We may now proceed to the evaluation of the principal strains in terms of the rosette observations by setting up the expressions for A and B.

$$A = \frac{\mathcal{E}_{x} + \mathcal{E}_{y}}{\frac{2}{3}} = \frac{\mathcal{E}_{a} + \frac{1}{3} (2\mathcal{E}_{b} + 2\mathcal{E}_{c} - \mathcal{E}_{a})}{2}$$

$$(32)$$

$$B = \frac{1}{2} \sqrt{(\epsilon_{x} - \epsilon_{y})^{2} + \delta_{xy}^{2}}$$

= $\frac{1}{2} \sqrt{\{\epsilon_{a} - \frac{1}{3}(2\epsilon_{b} + 2\epsilon_{c} - \epsilon_{a})\}^{2} + \{\frac{2}{\sqrt{3}}(\epsilon_{c} - \epsilon_{b})\}^{2}}$
= $\sqrt{\{\epsilon_{a} - \frac{1}{3}(\epsilon_{a} + \epsilon_{b} + \epsilon_{c})\}^{2} + \{\frac{1}{\sqrt{3}}(\epsilon_{c} - \epsilon_{b})\}^{2}}$
(33)*

* A more concise mathematical form has been given by Mindlin, but the above saves a few steps in the numerical solution.

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$$\mathcal{E}_{1} = A + B \qquad (7a) \qquad \mathcal{E}_{2} = A - B \qquad (8a)$$

$$\mathcal{E}_{1} = \frac{\mathcal{E}_{a} + \mathcal{E}_{b} + \mathcal{E}_{c}}{2} + \sqrt{\left\{\mathcal{E}_{c} - \frac{1}{2}\left(\mathcal{E}_{c} + \mathcal{E}_{c} + \mathcal{E}_{c}\right)\right\}^{2} + \left\{\mathcal{E}_{c} - \mathcal{E}_{b}\right\}^{2}} \qquad (34)$$

$$\epsilon_{1} = \frac{\varepsilon_{a} + \varepsilon_{b} + \varepsilon_{c}}{3} - \sqrt{\left\{\epsilon_{a} - \frac{1}{3}\left(\epsilon_{a} + \epsilon_{b} + \epsilon_{c}\right)\right\}^{2} + \left\{\frac{\epsilon_{c} - \epsilon_{b}}{3}\right\}^{2}} (35)$$

By substituting the values of A and B, equations (32) and (33), into equations (2a) and (3a), the principal stresses in terms of the equiangular rosette observations are found to be

The angular orientation of the principal stress axes may now be found by taking the ratio of the quantities under the radical in equation (36) or (37). That is equivalent to substituting the values from equations (26), (30), and (31) into equation (9), which will yield

$$\tan 2 \phi = \frac{\sqrt{3} (\hat{e}_c - \hat{e}_b)}{2\hat{e}_a - \hat{e}_b - \hat{e}_c}$$
(38)

Since the solution of equation (38) yields two values for the angle ϕ , one must establish some means of determining which of them corresponds to the angle ϕ_1 . The following rules, to be proved later, will answer the question,

1. When $\mathcal{E}_{c} \geq \mathcal{E}_{b}$ 2. When $\mathcal{E}_{b} \geq \mathcal{E}_{c}$ 3. When $\mathcal{E}_{b} = \mathcal{E}_{c}$ (a) If $\mathcal{E}_{a} \geq \mathcal{E}_{b} = \mathcal{E}_{c}$ (b) If $\mathcal{E}_{a} \leq \mathcal{E}_{b} = \mathcal{E}_{c}$ (c) If $\mathcal{E}_{a} = \mathcal{E}_{c}$ (c) If $\mathcal{E}_{a} \leq \mathcal{E}_{b} = \mathcal{E}_{c}$ (c) If $\mathcal{E}_{a} = \mathcal{E}_{c}$ (c) If

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Proof of the Rules

Since the gage axes of the equiangular rosette are inclined at 120° (or 60°) relative to each other, the points which represent the corresponding strains on the circumference of Mohr's circle will be located at the vertices of an equilateral triangle ACB as indicated in Fig. 11(c).*

C'





Gage Axes and Mohr Diagram Equiangular Rosette Figure 11

A study of the diagram reveals that as the strains \mathcal{E}_a , \mathcal{E}_b , and \mathcal{E}_c , vary, the triangle ACB will rotate about its centroid, which is located at the center of the circle;

*The Reader's attention is drawn particularly to the observation that if one starts at point A and follows around the circumference of Mohr's circle in the anticlockwise direction, the next station reached will be point C. On first thought, this might appear to be an error, since in going around the rosette axes in the same direction, axis B follows axis A as shown in Fig, 11(a). The apparent discrepancy is caused by the fact that the angular displacements are doubled in Mohr's diagram. If one extends the axis OC into the position OC' shown in Fig. 11(b), then the reason for the relative positions of the points A, B, and C on the circumference of Mohr's circle should be clear.

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If the point A happens to fall at the extreme left of the circumference of the circle, Fig. 12(a), then, since the centroid of ACB lies on the abcissa, CB is at right angles to OA which means that $\mathcal{E}_c = \mathcal{E}_c$. Also, because A is at the extreme left of the circle $\mathcal{E}_a = \mathcal{E}_2$, the algebraically smaller principal strain. From the diagram it is seen that $2\Phi_1 = \pm 180^\circ$ and therefore $\Phi_1 = \pm 90^\circ$, which substantiates rule 3(b).



Equiangular Rosette - Special case in which

 $\epsilon_{b} = \epsilon_{c} > \epsilon_{a} = \epsilon_{2}$ and $\varphi_{1} = \pm 90^{\circ}$

Figure 12

If the relative values of \mathcal{E}_a , \mathcal{E}_b , and \mathcal{E}_c are now changed so that the triangle ACB rotates in an anticlockwise direction from the position in Fig. 12(a), \mathcal{E}_b will become smaller than \mathcal{E}_c , and point A will move on to the lower half of the circumference of the circle. Under these conditions the angle $2\mathcal{P}_1$ will be between 0 and $+ 180^\circ$ and \mathcal{P}_1 between 0 and $+90^\circ$ as shown in Fig. 13 and stated in rule 1.



When the trianble ACB has finally rotated through 180° the point A will have moved along the entire lower semi-circumference of the circle and taken up the position shown in Figure 14(a), such that $2 \mathcal{O}_1 = 0$, $\mathcal{O}_1 = 0$, $\mathcal{E}_a = \mathcal{E}_1$, and since A is again on the abcissa $\mathcal{E}_c = \mathcal{E}_b$. This time $\mathcal{E}_a > \mathcal{E}_c = \mathcal{E}_b$ and rule 3(a) is satisfied.



(a) Mohr Diagram (b) Rosette & Principal Strain Axes Equiangular Rosette - Special case in which

$$a \rangle \epsilon_b = \epsilon_c \quad \epsilon_a = \epsilon_1 \quad \beta_1 = 0$$

Ê

Figure 14

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When the strains are further altered so that the continued rotation of the triangle causes the point A to move on to the semi-circumference above the abcissa, then according to definition, $2 \Phi_1$ becomes negative and will lie between 0 and -180° , and ε_b will be larger than ε_c until A returns to the position corresponding to ε_2 where equality is again established between ε_b and ε_c . This establishes rule 2 and is indicated in Fig. 15,



(a) Mohr Diagram (b) Rosette and Principal Strain Axes Equiangular Rosette - Special Case in which $\epsilon_{\rm b} > \epsilon_{\rm c}$

> $2 \varphi_1$ lies between 0 and -180° - 90 $\langle \varphi_1 \langle 0$ Figure 15



In this rosette arrangement the fourth observation of strain is redundant but it does provide a check since, within the limits of making the strain readings,

$$\mathcal{E}_{a} + \mathcal{E}_{c} = \mathcal{E}_{b} + \mathcal{E}_{d} \quad (39)$$

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In this case, it will be simpler to state the expressions for the principal strains, principal stresses, and the angle \mathfrak{P}_1 and then to prove them graphically with Mohr's diagram.

Here
$$\mathcal{E}_{1} = A + B$$
 (16a)

$$= \frac{\mathcal{E}_{a} + \mathcal{E}_{b} + \mathcal{E}_{c} + \mathcal{E}_{d}}{4} + \frac{1}{2}\sqrt{(\mathcal{E}_{a} - \mathcal{E}_{c})^{2} + (\mathcal{E}_{b} - \mathcal{E}_{d})^{2}}$$
(40)
(17a)

$$= \frac{\mathcal{E}_{a} + \mathcal{E}_{b} + \mathcal{E}_{c} + \mathcal{E}_{d}}{4} - \frac{1}{2}\sqrt{(\mathcal{E}_{a} - \mathcal{E}_{c})^{2} + (\mathcal{E}_{b} - \mathcal{E}_{d})^{2}}$$
(41)

From which one sees that

$$\frac{\varepsilon_{a} + \varepsilon_{b} + \varepsilon_{c} + \varepsilon_{d}}{4}$$
(42)

(43)

and

As previously, the direction of the principal axes may be found from the ratio of the quantities under the radical such that

 $B = \frac{1}{2} \sqrt{(\epsilon_{a} - \epsilon_{c})^{2} + (\epsilon_{b} - \epsilon_{d})^{2}}$

$$\tan 2 \phi = \frac{\epsilon_b - \epsilon_d}{\epsilon_a - \epsilon_c}$$
(44)

Insertion of the values of A and B into equations (2a) and (3a) produces the expressions for the principal stresses as

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The above rules and equations (39) to (46) may be proved by recourse to Fig. 18 which shows Mohr's diagram for this type of rosette. Since the directions of strain measurement in the rosette are inclined successively at 45° , therefore the radial lines to the points A, B, C and D, which represent the strains on Mohr's circle, will be inclined successively at $2 \times 45^{\circ} = 90^{\circ}$. Therefore, A, B, C and D will be located at the corners of a square inscribed in the circle.

Since the intersection of the diagonals of the square will coincide with the center of the circle and because the position of the center of square corresponds to the average of the four corners, therefore

$$A = \frac{\mathcal{E}_a + \mathcal{E}_b + \mathcal{E}_c + \mathcal{E}_d}{4}$$

(42)



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Let us now determine B, the radius of the circle in terms of \mathcal{E}_{a} , \mathcal{E}_{b} , \mathcal{E}_{c} , and \mathcal{E}_{d} , the horizontal distances from the ordinate through 0 to the corners of the square. This will require the following construction. Let P be the center of the circle and drop perpendiculars Am and Bn respectively from A and B on to the abcissa at m and n. Then from the right angled triangles APm and BPn

$$AP = BP \qquad (radius of the circle)$$

$$\frac{/PmA}{/PmA} = \frac{/PnB}{90^{\circ}}$$
and since $\frac{/BPA}{Pm} = 90^{\circ}$

$$\frac{/BPn}{/BPn} = \frac{/PAm}{(90^{\circ} - 2 \oint_{1})}$$
Therefore \triangle^{B} APm and BPn are equal, so that
$$Am = Pn = \frac{\mathcal{E}_{b} - \mathcal{E}_{d}}{2}$$
and since $Pm = \frac{\mathcal{E}_{a} - \mathcal{E}_{c}}{2}$
the hypotenuse = radius of the circle
$$= \sqrt{\left(\frac{\mathcal{E}_{a} - \mathcal{E}_{c}}{2}\right)^{2} + \left(\frac{\mathcal{E}_{b} - \mathcal{E}_{d}}{2}\right)^{2}}$$

$$= 1/2 \sqrt{(\mathcal{E}_{a} - \mathcal{E}_{c})^{2} (\mathcal{E}_{b} - \mathcal{E}_{d})^{2}} = B \qquad (43)$$
also
$$\tan 2 \oint_{1} = \frac{Am}{Pm} = \frac{\mathcal{E}_{b}^{-} \mathcal{E}_{d}}{\mathcal{E}_{a}^{-} \mathcal{E}_{c}} = \frac{\mathcal{E}_{b}^{-} \mathcal{E}_{d}}{\mathcal{E}_{a} - \mathcal{E}_{c}} \qquad (44)$$

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The T - \triangle Rosette (d)





If one considers this rosette arrangement as containing a delta resette with the addition of a fourth gage whose axis D is at right angles to the axis A, then, although the fourth observation is redundant, a variety of solutions can be obtained utilizing all four strain readings.

Meier gives a solution based on the method of least squares but its complexity is rather a disadvantage. The following simple solution is therefore presented since its reduction of observed strains into terms of stress will be very much easier.

Since the average of any two strains measured at right angles gives the position of the center of Mohr's circle, therefore, for the $T - \Delta$ Rosette the quantity

$$A = \frac{\epsilon_a + \epsilon_d}{2}$$
 (45)

Also, from the 🛆 Rosette

$$A = \frac{\mathcal{E}_a + \mathcal{E}_b + \mathcal{E}_c}{3}$$
(32)

Therefore for the $T - \Delta$ Rosette

$$A = \frac{\mathcal{E}_a + \mathcal{E}_d}{2} = \frac{\mathcal{E}_a + \mathcal{E}_b + \mathcal{E}_c}{3}$$
(46)

Furthermore, from the Δ Rosette

$$B = \sqrt{\left\{ \mathcal{E}_{a} - \frac{\mathcal{E}_{a} + \mathcal{E}_{b} + \mathcal{E}_{c}}{3} \right\}^{2} + \left\{ \frac{1}{\sqrt{3}} \left(\mathcal{E}_{c} - \mathcal{E}_{b} \right) \right\}^{2}}$$
(33)

Improvements in Rosette Computer, J. H. Meier, SESA Proc. Vol. III, No. 2, p. 1.

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so that in the case of the T - \triangle Rosette, if one substitutes $\frac{\epsilon_a + \epsilon_d}{2}$ for $\frac{\epsilon_a + \epsilon_b + \epsilon_c}{3}$, then

$$\epsilon_{a} - \frac{\epsilon_{a} + \epsilon_{b} + \epsilon_{c}}{3} = \epsilon_{a} - \frac{\epsilon_{a} + \epsilon_{d}}{2} = \frac{\epsilon_{a} - \epsilon_{d}}{2}$$
 (47)

and

 $B = \sqrt{\left(\frac{\epsilon_{a} - \epsilon_{d}}{2}\right)^{2} + \left(\frac{\epsilon_{c} - \epsilon_{b}}{\sqrt{3}}\right)^{2}}$ (48)

Again, from the Ro

Rosette since

$$\tan 2 \varphi = \frac{\frac{1}{\sqrt{3}} (\varepsilon_{c} - \varepsilon_{b})}{\varepsilon_{a} - \frac{\varepsilon_{a} + \varepsilon_{b} + \varepsilon_{c}}{3}}$$

by substitution of equation (47) in (49) one obtains the ratio of the quantities under the radical of equation (48) such that

$$\tan 2 \Phi = \frac{\frac{1}{\sqrt{3}} (\mathcal{E}_{c} - \mathcal{E}_{b})}{\frac{1}{2} (\mathcal{E}_{a} - \mathcal{E}_{d})}$$
(50)

The rules for assigning the two values of \mathcal{P} , given by equation (50), to the correct principal axes will be exactly the same as in the case of the equiangular rosette.

For the T - A Rosette one may now express the values of the principal straips as follows,

 $\begin{aligned} \boldsymbol{\mathcal{E}}_{1} &= \mathbf{A} + \mathbf{B} \\ &= \frac{\boldsymbol{\mathcal{E}}_{a} + \boldsymbol{\mathcal{E}}_{d}}{2} + \sqrt{\left(\frac{\boldsymbol{\mathcal{E}}_{a} - \boldsymbol{\mathcal{E}}_{d}}{2}\right)^{2} + \left(\frac{\boldsymbol{\mathcal{E}}_{c} - \boldsymbol{\mathcal{E}}_{b}}{\sqrt{3}}\right)^{2}} \end{aligned} \tag{16a}$

$$\epsilon_2 = A - B \qquad (17a)$$

$$= \frac{\mathscr{E}_{a} + \mathscr{E}_{d}}{2} - \sqrt{\left(\frac{\mathscr{E}_{a} - \mathscr{E}_{d}}{2}\right)^{2}} + \left(\frac{\mathscr{E}_{c} - \mathscr{E}_{b}}{\sqrt{3}}\right)^{2}$$
(52)

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The principal stresses will be

and

 $O_{2}^{*} = E\left\{\frac{A}{1-\mu} - \frac{B}{1+\mu}\right\}$ (3a)

$$= E\left\{\frac{\varepsilon_{a} + \varepsilon_{d}}{2(1-\mu)} - \frac{1}{1+\mu}\sqrt{\left(\frac{\varepsilon_{a} - \varepsilon_{d}}{2}\right)^{2} + \left(\frac{\varepsilon_{c} - \varepsilon_{b}}{\sqrt{3}}\right)^{2}}\right\}$$
(54)



SUMMARY

Directions of principal axes are given by equation. Tan $2\phi = \frac{2nd}{1st}$ guantity under radical, for all of above relations.

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5. Graphical Solutions

In addition to the various analytical solutions for the strain rosette equations there are also many graphical (and semi-graphical) procedures for determining the principal stress magnitudes and directions. The choice between analytical and graphical procedures is usually dependent upon personal preference but in the event of two people checking each other it is highly desirable to have one perform the computations analytically and to have the other do the checking by a totally different graphical method, or vice-versa.

For the purpose of these notes, the discussion of graphical methods of solving the rosette equations will be confined to three procedures which have been found convenient and useful. All apply to rosettes with three observations of strain. The first corresponds to the general case, in which the axes of measurement may be inclined to each other in any manner, the second to the rectangular rosette, and the third to the equiangular arrangement.

(a) The General Case

The following method, which has been put forward by Mcclintock (Special Reference No. 3), applies to the general case in which the rosette axes may have any arbitrarily chosen angles, θ_{ab} and θ_{bc} , between them, as indicated in Figure 21.





The object is to establish Mohr's Circle for strain. The procodure is very simple and by some is preferred for the rectangular and equiangular rosettes even though each of these arrangements has methods peculiarly well adapted to itself. The following four steps are employed for finding the strain circle.

- 1. The rosette axes are rearranged (by extending them if necessary) so that they are:
 - (a) Arranged in sequence, in order of ascending or descending strain magnitudes (Algebraic order).

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(b) The included angle between the axes of minimum and maximum strain must be less than 180

Some examples of this rearrangement are shown in Fig. 22. Space Diagrams of Physical Layout



Rearrangement of Axes in Sequence of Strain Magnitude (Algebraic) $\mathcal{A} =$ Angle between axes of Maximum and Intermediate strain $\mathcal{B} =$ Angle between axes of Intermediate and Minimum strain

Int. Int. Int. Max, Min. Min. Max. Max, в Min Case (a) Case (b) = **0** θ ab $186-(\Theta_{ab}+\Theta_{bc})$ bc Case (c) Notes In Case (c) the axis of e_{ab.} max. strain falls to left $180-(\Theta_{ab}+\Theta_{bc})$ of intermediate axis Figure 22(b)

2. Lay out a sheet of paper with a strain scale near one edge and parallel to the direction of the abcissa (which will be established later). Then draw in ordinates at locations corresponding to:

> 1. Zero strain 2. $\mathcal{E}_{a}, \mathcal{E}_{b}, \mathcal{E}_{c}$

This is indicated diagramatically in Fig. 23.

Figure 23

Scale

n

Strain

- Note: In Fig. 23 the strain values have been indicated as positive but they might all be negative or some positive and negative.
 - It will also be noted that the measured strains, \mathcal{E}_{a} , \mathcal{E}_{b} , & \mathcal{E}_{c} , may have any relation with one another, In Fig. 23 the values have been plotted in sequence according to magnitude.
- When the diagram corresponding to Fig. 23 has been drawn, choose any point, D, on the ordinate corresponding to the intermediate strain value.

From point D draw straight lines DE and DF, making angles \mathcal{A} and \mathcal{B} , respectively, with the ordinate of intermediate strain, to meet the ordinates of \mathcal{C}_{Max} , and \mathcal{C}_{Min} , at E and F respectively.

One will notice that there are two possibilities for drawing the lines DE and DF since the angles \checkmark and β can be measured from either the upwards or the downwards direction of the ordinate of intermediate strain.

The following rule governs this choice: If, in the diagram (Fig. 22(b)) showing the strain axes in sequence, the axis of Max, strain falls to the right of the intermediate. axis, d and β are measured from the upwards direction, as indicated for Cases (a) & (b). But if the axis of maximum strain is inclined towards the left, as in Case (c), then d and β , should be measured from the downwards direction. This is suggested by the dotted axis extensions indicated for Case (c) in Fig. 22(b) and shown in detail in Fig. 24.

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. 3.



4. The final step is now to draw a circle through the points D, E, & F, This will be Mohr's circle for strain. The abcissa, which can now be drawn in, will pass through the center of the circle and the extreme right and left hand positions of the circumference will represent the principal strains \mathfrak{S}_1 and \mathfrak{S}_2 , as shown in Fig. 25,



Figure 25(a) Mohr's Strain Circle for Case (a) $\mathcal{E}_a > \mathcal{E}_b > \mathcal{E}_c$

> (See also Figs, 25(b) and 25(c))

Strain Scale

The points A, B, & C, which represent the strains along the rosette axes, can now be located on the circumference of the circle according to the following two requirements:

The magnitudes of the strains ϵ_{a} , ϵ_{b} , ϵ_{c} . 1,

2, The sequence of order as we go along the circumference of the circle, This must correspond to the sequence in the physical layout of the rosette. For example, if the rosette axes follow the sequence A, B, & C, when one proceeds in the anticlockwise direction, the same order must prevail as one goes around Mohr's circle in the same sense.

Although there are two possible positions for each of points A, B, & C, which will satisfy requirement 1 above, the second requirement eliminates half of them, This means that there is only one arrangement for the points A, B, & C on the circumference of the circle.

Angle of Reference, \mathfrak{P}_1 . As soon as the point A has been located on the circumference of the circle, the radius to this point will establish the angle $2 \mathcal{P}_1$, as shown in Fig. 25. From this we can determine the angle Ψ_1 , and locate the axis of ϵ_1 , the algebraically larger principal strain, relative to the A axis of the rosette.

Principal Stress Determination, Once the magnitudes of the principal strains, ε_1 and ε_2 , have been determined, then the principal stress values can be computed from equations (2) & (3).

$$\mathcal{O}_{1} = \frac{E}{1 - \mu^{2}} \times (\mathcal{E}_{1} + \mu \mathcal{E}_{2})$$
(2)

and

G

$${}_{2} = \frac{E}{1 - \mu^{2}} \times (\mathcal{E}_{2} + \mu \mathcal{E}_{1})$$
(3)

Or, it may be more convenient to prepare a chart, of the type shown in Fig. 27, from which the values of $\mathbf{0}^{*}$, and **O**, may be read directly.

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 $\beta = 180^{\circ} - (\Theta_{ab} + \Theta_{bc})$ $_{2\beta} = 360^{\circ} - 2\Theta_{ab} - 2\Theta_{bc}$ + 20_{bc} 2d= $2\beta + 2\lambda = 360 - 2\Theta_{ab}$

Strain Scale

Figure 25(b) Mohr's Circle for Strain Case (b) $\epsilon_b > \epsilon_c > \epsilon_a$



 $2\beta = 360^{\circ} - 2\partial_{ab} - 2\partial_{bc}$ $2\beta + 2\alpha = 360^{\circ} - 2\Theta_{bc}$

for Strain

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(b) The Rectangular Rosette

The method described in the following paragraphs was developed by R. Baumberger* while he was associated with the firm of Ruge-de-Forest. It requires 7 steps which lead directly to the determination of the principal strains and the directions of the principal axes. The calculation of the principal stresses from the principal strains must be carried out as an additional step.

The procedure actually involves a simple means of drawing Mohr's strain circle from which the principal strains and the angle of reference can be read off directly. The use of specially prepared graph paper, with the reference lines printed on it, will eliminate the two initial steps for the person making the graphical calculation so that the complete solution can be achieved in six steps.

The fundamental procedure (without the use of specially prepared graph paper) is as follows:

1. On a piece of paper lay out two perpendicular axes of reference (B-B, and K-K, as shown in Fig. 26-1. Generally it will be well to have the origin of reference (0, the intersection of the axes) about the middle of the paper but for certain special situations it may be more convenient to have it farther to the right or to the left.



Figure 26-1

2. Parallel to B-B draw two lines, A-A and C-C, such that they are on opposite sides of the abcissa and at equal distances from it. That is, make OR = OT as shown in Fig. 26-2.

For Baumberger's original note see SESA Proceedings,
 Vol, 1, No. 1, 1943, pages 145 and 1465



Figure 26-2

3. Let one now define the lines A-A, B-B, and C-C, as:

A-A = Axis of ϵ B-E = Axis of ϵ C-C = Axis of ϵ

and proceed to lay off along these lines (using K-K as zero for reference) distances which are respectively proportional to the strains $\boldsymbol{\varepsilon}_{a}$, $\boldsymbol{\varepsilon}_{b}$, and $\boldsymbol{\varepsilon}_{c}$, which have been observed in the directions of the rosetto axcs, A, B, and C.

Positive (Tensile) strains are represented by distances to the right of K-K and negative (compressive) strains by distances to the left of K-K.

A typical layout for three positive strains is indicated in Fig. 26-3, in which a, b, and c, are points representing strains on the axes of the diagram,



4. Now draw a straight line through a and c. The intersection of this line with B-B determines the center of Mohr's strain circle, as indicated by point P in Fig. 26-4.



5. Through "a" draw a line which will be perpendicular to <u>B-B</u> and which will intersect this axis at m, as shown in Fig. 26-5. The point A, which represents \mathcal{E}_{a} on the circumference of Mohr's circle, must lie somewhere along this line.



Figure 26-5

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6. From the point m, on the line am, lay off a distance MA such that MA = Pb. If b is to the right of P this should lie below the abcissa - as per Fig. 26-6 - but if b is to the left of P than A will be above the axis B-B.



figure 26-6

7. With center P and radius PA now draw a circle as shown in Fig, 26-7. This is Mohr's circle for strain corresponding to the rectangular rosette observations $\boldsymbol{\epsilon}_{a}, \boldsymbol{\epsilon}_{b}$, and $\boldsymbol{\epsilon}_{c}$. The right hand extremity corresponds to $\boldsymbol{\epsilon}_{1}$, the extreme left to $\boldsymbol{\epsilon}_{2}$, and the angle $2 \mathfrak{S}_{1}$, between the radius PA and the abcissa determines the directions of the principal axes relative to the A axis of the rosette,



Figure 26-7

8. The principal stresses may now be calculated from the principal strains by means of equations (2) & (3) or read directly from a chart of the type shown in Figure 27.



Figure 27

 $\mathcal{T}_{max.} = \frac{E}{2(1+\mu)} (E_1 - E_2)$

$$\sigma_1 = \frac{E}{I - \mu^2} \left(\epsilon_1 + \mu \epsilon_2 \right)$$

 $\sigma_2^{*} = \frac{E}{I - \mu^2} \left(\epsilon_2 + \mu \epsilon_1 \right)$

Conversion Chart from Principal Strains to Principal Stresses and Maximum Shear Stress (By J. H. Meier)

Chart Based on E = 30,000,000 psi. and $\mu = .30$

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Convenience of Specially Prepared Graph Paper

In the event that solutions are required for many sets of rosette observations much time and effort can be saved by employing graph paper upon which the axes of reference have already been printed. This takes care of the first two steps for the person carrying out the computation and permits him to complete the remaining six operations with only a triangle, compass and protractor. If the protractor has a straight edge of sufficient length the triangle will not even be needed.

A preprinted form of typical character is shown in Fig. 28 and in Fig. 29 its application to the solution of a set of observations is indicated.

Proof of Baumberger's Method

Since B-B is midway between A-A and C-C, the point P will fall at a distance from the origin equal to the average of the distances a and c from k-k.

Therefore

OF represents
$$\frac{\epsilon_a + \epsilon_c}{2}$$

This means that the point P corresponds to the center of Mohr's strain circle for this type of rosette (See equation 18).

One must now establish the radius of Mohr's strain circle. From equation (19) it is seen that the radius of the circle is represented in the expression.

$$\frac{1}{2}\sqrt{\left(\boldsymbol{\epsilon}_{a}-\boldsymbol{\epsilon}_{c}\right)^{2}+\left[2\boldsymbol{\epsilon}_{b}-\left(\boldsymbol{\epsilon}_{a}+\boldsymbol{\epsilon}_{c}\right)\right]^{2}}$$

By taking the factor 1/2 inside the radical, this becomes

$$C_{1} = \frac{\sqrt{\left(\frac{\epsilon_{a} - \epsilon_{c}}{2}\right)^{2}} + \left(\epsilon_{b} - \frac{\epsilon_{a} + \epsilon_{c}}{2}\right)^{2}}{\frac{1}{1 - 1}}$$

(19a)

(19)

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I<u>II</u> 111 Figure 28 3 3 -+-23 EEEE H 3 <u>o</u> σ. 11 156 E± A X18 X Axis П.L. -11 ΞŦ h.: ÷:H: r: -..... n Ed 7 -----<u>tri</u> . . . L. 12ED tr! E 긢 14 E Ē 32 1.1. E T. 퍮 H 71 1t ΞЩ: G. l i E 11-1-1 IJ, BNU/111 詽 Ľ., rin: ţ. ΕŦ j‡rLī Ξ. H 궤 ΞŦ 171117 H ++++ :1 11111111 E: HELLI + ŦŦ -Elfr TE 田出 Tr 陆 ti. 111; EEF :11 EELE £υ E Hi i j ļ 111 **T**!!! 出日 <u>ाम</u>ाः Hidden LINE HHH 111 111111 urt. :47 2117 1:EE 1:12 £1. . i i i 111



Examination of Figs, 26-4 to 26-6 now reveals the following:

1. The horizontal distance between points a and c represents $\boldsymbol{\epsilon}_{a} - \boldsymbol{\epsilon}_{c}$, and since P is half way between these points, Pm, the horizontal projection of Pa, represents $\boldsymbol{\epsilon}_{a} - \boldsymbol{\epsilon}_{c}$

which is the first term under the radical of equation (19a).

2, The distance between points P and b, on the axis of $\boldsymbol{\epsilon}_{\mathrm{b}}$, corresponds to

$$\left(\boldsymbol{\epsilon}_{\mathrm{b}} - \frac{\boldsymbol{\epsilon}_{\mathrm{a}} + \boldsymbol{\epsilon}_{\mathrm{c}}}{2}\right)$$

which is the second quantity under the radical in equation (19a).

3. Now if these distances, which represent the two quantities under the radical of equation (19a), can be made to form the perpendicular sides of a right angled triangle, then the hypotenuse of the triangle will represent equation (19a) which is the radius of the strain circle.

This result is accomplished by erecting mA (=Pb) perpendicular to the axis B-B at the point m, as illustrated in Fig. 26-6.

4. One will also observe that the ratio of the quantities under the radical of equation (13a) gives a measure of the angle of reference, that is,

n
$$2 \hat{\varphi}_1 = \frac{2\hat{\epsilon}_b - (\hat{\epsilon}_a + \hat{\epsilon}_c)}{\hat{\epsilon}_a - \hat{\epsilon}_c}$$

ta

(22)

(22a)

$$\frac{\mathcal{E}_{b} - \frac{\mathcal{E}_{a} + \mathcal{E}_{c}}{2}}{\frac{\mathcal{E}_{a} - \mathcal{E}_{c}}{2}}$$

This means that the inclination of the radius PA (hypotenuse of right angle triangle PmA) with respect to the axis B-B will represent the angle $2 \oint_{1}$, as shown in Fig. 26-7.

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(c) The Equiangular or Delta Rosette

A simple and direct method of evaluating the magnitudes and directions of the principal stresses from observations of strains in a delta rosette has been devised by Bossart & Brewer (Special Reference No. 4).

This method possesses the following important characteristics:

- 1. The values of the principal stresses (rather than principal strains) are determined directly.
- 2. In its basic form the method is applicable only to those instances in which Poisson's Ratio (μ) = 1/3.
- 3. By very slight modification the procedure can be extended to cover those cases in which $\mu \neq 1/3$.

When $\mu = 1/3$ it can be shown that for the delta rosette the following relations exist in regard to the apparent stresses.

(Apparent Stress = Modulus of Elasticity x Observed Strain)

- 1. The center of Mohr's circle for stress corresponds to the algebraic sum of the half apparent stresses determined in the directions of the three axes of the delta rosette.
- 2. The radius of Mohr's circle for stress corresponds to the vector sum of the half apparent stresses.

The procedure is as follows:

1. Compute the half apparent stresses from the observed strains -

$$\frac{Sa}{2} = \frac{E \times C}{2}$$
(55)

$$\frac{S_{\rm b}}{2} = \frac{E \times \mathcal{E}_{\rm b}}{2} \tag{56}$$

$$\frac{S_c}{2} = \frac{E \times C_c}{2}$$
(57)

Where $S_a = Apparent$ stress in direction of the A axis $S_b = Apparent$ stress in direction of the B axis $S_c = Apparent$ stress in direction of the C axis

2. Determine the center of Mohr's circle (the hydrostatic component of stress, \mathbf{O}_{H}) by laying out, in order along the abcissa, arrows proportional in length to the half apparent stresses, as shown in Fig. 30.

Positive values are drawn to the right and negative values to the left.

3. From point P, the center of Mohr's circle, as determined in item 2, determine the vector sum of the half apparent stresses by laying out another arrow repressing $S_{\rm R}/2$ along the abcissa (+ to right, - to left) and continuing with arrows representing Sb/2 and S_C/2 with inclinations and senses as indicated in Fig. 20.

The tip of the third arrow will fall at point A (which represents σ_A on the Mohr stress circle), the distance PA will be the radius of the circle (sometimes called the shear component of stress and designated by the symbol, σ_s) and the angle measured from PA to the abcissa will be twice the reference angle φ_1 .

- 4. With center P and radius PA draw a circle. This is Mohr's stress circle whose intersections with abcissa determine the principal stress values, σ_1 and σ_2 , as shown in the diagram.
- Note: Those who are interested in the proof of the method will find it given in the paper entitled "A Graphical Method of Rosette Analysis" by K. J. Bossart & G. A. Brewer, SESA Proceedings, Vol. IV, No. 1, pp. 2 & 3.

Modification for Use When Poisson's Ratio is not 1/3

$\mu \neq 1/3$

When Poisson's Ratio is other than 1/3, the procedure indicated above should be followed to the end of item 3. However, OP and PA will now no longer represent the hydrostatic and shear components of stress, \mathcal{O}_{H} and \mathcal{O}_{S} , directly.

Fortunately, these quantities, $\boldsymbol{\sigma}_{\mathrm{H}}$ and $\boldsymbol{\sigma}_{\mathrm{S}}$, can be found by multiplying the algebraic and vector sums of the half apparent stresses by the appropriate factors as follows:

 $O'_{\rm H} = (\text{Stress represented by OP}) \times \frac{2}{3(1-\mu)}$

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(58)

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$$\mathcal{O}_{S}^{\bullet} = (\text{Stress represented by PA}) \times \frac{4}{3(1+\mu)}$$
(59)

$$\mathbf{O}_{1}^{\circ} = \mathbf{O}_{H}^{\circ} + \mathbf{O}_{S}^{\circ} \tag{60}$$

$$\mathbf{G}_{2}^{\prime} = \mathbf{G}_{H}^{\prime} - \mathbf{G}_{S}^{\prime} \tag{61}$$



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(d) Nomograph Methods

In addition to the above two graphical solutions there are various other graphical and semi-graphical procedures which can be employed for evaluating strain rosette observations. Some of the nomographic charts which have been developed will be found most helpful, particularly those developed by Hewson. See reference No. 4 under graphical methods in attached list of references.

6. Machine Solutions

In situations involving the solution of large numbers of rosette equations the employment of machines may be very advantageous both for economy of time and cost.

Some of the elaborate calculating machines, such as the Differential Analyser, can be used for this purpose if they are available, but except in unusual situations the use of such versatile machines is not warranted, particularly when one considers the cost involved.

A number of special purpose computers (See references at end) have been developed to evaluate rosette data. Some are electronic and others have mechanical and electrical components. The earlier machines depended upon manual introduction of strain data whereas newer devices can be connected directly to strain gages for their input, and to electric typewriters for tabulation of the computed results, provided of course, that the strain observations are not made faster than the typewriters can handle the results.

At the present time it appears as though the ultimate aim would be to develop a combined computer-plotter-tabulator for direct connection to the strain gages. Such an instrument, directly connected to the strain gages, would be capable of receiving the gage signals, computing the results, providing temporary or permanent storage of information, selecting data on the basis of, location of observation, stress level, frequency, or time of event, then tabulating and plotting the results.

For those who are faced with the problem reduction of a fairly sizeable amount of rosette data, but not enough to warrant the purchase of a special computer, attention is drawn to the methods worked out by Bassett, Cromwell, & Wooster, (SESA Proceedings, Vol. III, No. 2, p. 76) for the employment of standard office calculators.

7. Corrections for Transverse Sensitivity of SR-4 Gages

(a) For rosettes made up of single component games which have been calibrated in a uni-axial stress field on material for which Poisson's Ratio = M_m .

One will observe that any two dimensional strain distribution may be considered as being made up of hydrostatic component and a pure

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shear component. Allowance for the lateral effects in SR-4 gages may therefore be made by multiplying

the hydrostatic component by
$$\left[\frac{1 - \mathcal{M}_{m}K}{1 + K}\right]$$
 (62)

and the pure shear component by $\left[\frac{1-\mu_{m}K}{1-K}\right]$ (63)

where K = the transverse sensitivity coefficient for the gages in the rosette (assumes that the gages are alike)

and μ_m = Poisson's Ratio of the material upon which calibration was made, (0.285)

Equations (2a) and (3a) which represent the principal stress (intensities can therefore be modified to the form given in expressions (64) & (65) if one wishes to take account of the transverse effect, which is usually rather small.

$$\mathbf{O}_{1}^{o} = E\left\{\frac{A}{1-\mu} \left[\frac{1-\mu_{m}K}{1+K}\right] + \frac{B}{1+\mu} \left[\frac{1-\mu_{m}K}{1-K}\right]\right\} (64)$$

$$\mathbf{O}_{2}^{o} = E\left\{\frac{A}{1-\mu_{K}} \left[\frac{1-\mu_{m}K}{1+K}\right] - \frac{B}{1+\mu} \left[\frac{1-\mu_{m}K}{1-K}\right]\right\} (65)$$

(b) For Manufactured Rosettes Consisting of Three or Four Independent Strain Gages Mounted Together on a Common Carrier

In the case of SR-4 resette gages manufactured as complete units incorporating three or four separate elements, two gage factors, a and b, are furnished with the gages.

The factor a = the axial strain sensitivity factor. This is comparable to the Gage Factor for a single gage, however, due to the method of calibration the numerical value is slightiy different.*

The factor b = the auxiliary strain sensitivity factor. By means of this coefficient one can correct the indicated strains to the proper values.

Practical Reduction Formulas for Use on Bonded Wire Strain Gages,
 R. Baumberger and F. Hines, SESA Proceedings, Vol. II, No. 1, p. 116.

In the literature it has been stated that neglect of the factor b (which is related to the transverse sensitivity coefficient, K) will not introduce an error of more than 3% in the numerically larger principal strain.*

Let \mathcal{E}^1_{a} , \mathcal{E}^1_{b} , \mathcal{E}^1_{c} , and \mathcal{E}^1_{d} , represent the apparent strains in the directions of the rosette axes. They are obtained from the relation

$$\mathbf{e}^{1} = \frac{\frac{\mathbf{a} \cdot \mathbf{R}}{\mathbf{R}}}{\mathbf{a}}$$
(66)

The values of the apparent strains are not quite equal to the true values, however, they may be corrected to the true values, $\boldsymbol{\varepsilon}_{a}$, $\boldsymbol{\varepsilon}_{b}$, $\boldsymbol{\varepsilon}_{c}$, and $\boldsymbol{\varepsilon}_{d}$, as follows:

I. Rectangular Rosette with Three Observations



from which the principal strains may be calculated as

 $\hat{\mathcal{E}}_{a}^{1}$

$$\mathbf{\hat{e}}_{1} \text{ or } \mathbf{\hat{e}}_{2} = (1 - \frac{1}{b}) \frac{\mathbf{\hat{e}}_{a}^{1} + \mathbf{\hat{e}}_{c}^{1}}{2} \pm (1 + \frac{1}{b}) \frac{1}{2} \sqrt{(\mathbf{\hat{e}}_{a}^{1} - \mathbf{\hat{e}}_{c}^{1})^{2} + [2\mathbf{\hat{e}}_{b}^{1} - (\mathbf{\hat{e}}_{a}^{1} + \mathbf{\hat{e}}_{c}^{1})]^{2}}$$
and $\tan 2\mathbf{\hat{e}}_{a} = \frac{2\mathbf{\hat{e}}_{b}^{1} - (\mathbf{\hat{e}}_{a}^{1} + \mathbf{\hat{e}}_{c}^{1})}{(71)}$

$$(70)$$

and tan $2\phi =$

II. The Equiangular Rosette

$$\mathcal{E}_{a} = \mathcal{E}_{a}^{1} - \frac{1}{b} \quad (\mathcal{E}_{b}^{1} + \mathcal{E}_{c}^{1})$$
(72)

$$\mathcal{E}_{b} = \mathcal{E}_{b}^{1} - \frac{1}{b} \quad (\mathcal{E}_{a}^{1} + \mathcal{E}_{c}^{1}) \quad (73)$$

$$\frac{120^{-1}}{A} = \frac{120^{-1}}{C} = \frac{1}{c} = \frac{1}{b} = \frac{1}{c} = \frac{1}{b} = \frac{1}{c} =$$

Practical Reduction Formulas for Use on Bonded Wire Strain Gages,
 R. Baumberger and F. Hines, SESA Proceedings, Vol. II, No. 1, p. 116.

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and the principal strains are

$$\begin{aligned} \mathcal{E}_{1} \text{ or } \mathcal{E}_{2} &= (1 - \frac{2}{b}) \frac{\mathcal{E}_{a}^{1} + \mathcal{E}_{b}^{1} + \mathcal{E}_{c}^{1}}{3} \pm (1 + \frac{1}{b}) \sqrt{\left(\mathcal{E}_{a}^{1} - \frac{\mathcal{E}_{a}^{1} + \mathcal{E}_{b}^{1} + \mathcal{E}_{c}^{1}\right)^{2}} + \left(\frac{\mathcal{E}_{c}^{1} - \mathcal{E}_{b}^{1}}{\sqrt{3}}\right)^{2}} \\ \tan 2 \quad \mathcal{O}_{1} &= \frac{\sqrt{3} \left(\mathcal{E}_{c}^{1} - \mathcal{E}_{b}^{1}\right)}{2 \mathcal{E}_{a}^{1} - \mathcal{E}_{b}^{1} - \mathcal{E}_{c}^{1}} \end{aligned}$$
(75)

III. Rectangular Rosette with Four Observations

Since this form of rosette is not regularly made as a single unit it will be necessary to make it up from four independent units and to correct the A^1 and B^1 quantities accordingly, or else to make some other special arrangement.

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IV. The $T - \triangle$ Rosette



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$-\frac{1}{b}\left(\epsilon_{a}^{1}+\epsilon_{d}^{1}\right)$	(78
$-\frac{1}{b}\left(\boldsymbol{\varepsilon}_{a}^{1}+\boldsymbol{\varepsilon}_{d}^{1}\right)$	(79)
l a	(80)
	d $-\frac{1}{b}\left(\mathcal{E}_{a}^{1}+\mathcal{E}_{d}^{1}\right)$ $-\frac{1}{b}\left(\mathcal{E}_{a}^{1}+\mathcal{E}_{d}^{1}\right)$ 1 a

 $\tan 2 \varphi = \frac{\frac{1}{\sqrt{3}} \left(\mathcal{E}_{c}^{1} - \mathcal{E}_{b}^{1} \right)}{\frac{1}{2} \left(\mathcal{E}_{a}^{1} - \mathcal{E}_{d}^{1} \right)}$

$$\boldsymbol{\epsilon}_{1} \text{ or } \boldsymbol{\epsilon}_{2} = (1 - \frac{1}{b}) \frac{\boldsymbol{\epsilon}_{a}^{1} + \boldsymbol{\epsilon}_{d}^{1}}{2} \neq (1 + \frac{1}{b}) \sqrt{\left(\frac{\boldsymbol{\epsilon}_{a}^{1} - \boldsymbol{\epsilon}_{d}^{1}}{2}\right)^{2} + \left(\frac{\boldsymbol{\epsilon}_{c}^{1} - \boldsymbol{\epsilon}_{b}^{\prime}}{\sqrt{3}}\right)^{2}}$$

(81)

(82)

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ROSETTE ANALYSIS

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ROSETTE ANALYSIS

Experiment No. 26 - Strain Gage Rosettes

Object: To illustrate the use of Strain Gage Rosettes for determining the magnitudes of the principal stresses and the directions of their axes under biaxial conditions.

Problem: By strain measurement, to determine the stresses set up in a thin walled cylinder due to an internal pressure of 1500 lbs/ sq. in,

Several gage arrangements have been set up with different axes of reference. All arrangements of strain gages should indicate the same results which should agree with theoretical calculations.

./sq.in.

.,

Specimen: Steel cylinder closed at both ends

Outside Diameter	4.50"
Wall Thickness	0,14"
Length	30"

Material Properties

Ultimate Strength	60,000	lbs
Yield Strength	35,000	11
Modulus of Elasticity	30,000,000	-11
Poisson's Ratio	0.3	





Diagram of Gage Orientation

Gages are mounted in pairs diametrically opposite each other on the cylinder; for example, 1 is opposite 11, 2 is opposite 12, etc.

Resistance of all gages is nominally 120 ohms. Gage Factors are as follows:

ROSETTE ANALYSIS

Experiment No, 26 - Strain Gage Rosettes (Continued)

	Gage Factor
Axial & Circumferential Gages: 1, 11, 2, 12	2,03
Rectangular Rosettes: 7, 8, 9, 17, 18, 19	2,03
Tee-Delta Rosette: 3, 4, 5, 6: 13, 14, 15,	16 2.01

(Note that the $T-\Delta$ Rosette can be used as a Δ Rosette by omitting observations on gages 3 & 13

Equipment:

- 1 Switching Unit
- 1 Baldwin Portable Strain Indicator
- 1 Oil Reservoir & Pump with Pressure Gage

Results Wanted:

1. Determination of the principal stresses, $\sigma_1 \& \sigma_2$, and the directions of the corresponding axes from strains measured

(a) With axial & circumferential gages

- (b) With Rectangular rosettes
- (c) With $T = \Delta$ (or Δ) rosettes

2. Comparison with theoretical calculations

Procedure:

- 1. Take zero readings on all strain gages.
- 2. Apply pressure to the cylinder in increments of 200 lbs./sq.in. up to a maximum of 1600 lbs./sq.in. and take readings on all gages after each pressure in-crement.
- 3. Release pressure to zero and check zero readings on all gages.

NOTE: Since time is limited it is suggested that you take readings either on a few gages at all pressure levels or all gages at a few pressure levels and refer to the accompaying table (See Page 644) for the remainder of the required observations.

 Plot pressure vs. indicated strain for each gage. Curves for one rosette can be arranged together on a single graph sheet.

ROSETTE ANALYSI

Chapter XXIII

Experiment No. 26 - Strain Gage Rosettes (Continued)

Procedure: (Continued)

- Average the slopes of plots of item 4 for diametrically 5。 opposite gages and determine the strain on each gage for a pressure increment of 1500 lbs./sq.in.
- 6. Neglecting transverse effects in the strain gages, calculate the magnitudes of the principal stresses and determine the directions of the corresponding axes for each of the three gage arrangements
 - (a) by analytical means
 - (b) by graphical means
- 7. Check the results of item 6 by making the necessary theoretical calculations for the noop stress and the longitudinal stress.

Hoop Stress (psi) = Pressure (psi) x Radius (in) Wall Thickness (in)

Longitudinal Stress = $\frac{1}{2}$ Hoop Stress

8. If the Transverse Sensitivity factor, K, for the axial and circumferential gages is 0,02, and the "b" factor for Rectangular and T- Δ Rosottes is 55, how much error is introduced by neglecting the transverse effects?



SCHEMATIC DIAGRAM OF APPARATUS

		GAGE NO.		х х		PRESSURI	IN P.S.I	• -			
		undi no.	0	200	400	600	800	1000	1200	1400	1600
		ł	Ū		STR	AIN IN MICH	O-INCHES	PFR INCH			
(bourt t	\sim	1	0	74	139	260	341	422	492	580	670
	eq	2	0	20	5)	74	110	118	140	162 ·	189
	nu	3	0	49	113	175	232	282	350	398	455
	ti	4	0	48	111	170	2 26	276	3 40 .	375	440
mt	5	5	0	21	52	81	110	133	164 v	189	219
	<u> </u>	6	0	75	174	261	350	430	525	602	698
	.w	7	0	29	.51	80	105	130	160	180	210
¥.	E	8	0	70	149	222	292	360	432	500	575
₹	E E	9	0	81	174	262	349	425	515	593	682
빈	SO	_					•		•		
	~	11	0.	80	171	260	340	422	510	592	680
S	E	12	0	20	49	71	92	115	140	160	183
Ř.	GA	13	0	50	111	170	214	270	322	379	428
	z	14	0	51	115	170	217	270	329	382	430
·	[A]	15	0	21	52	80	109	130	155	180	202
	E.	16	C	75	171	260	330	410	488	560	640
		17	0	21	52	82	110	135	160	183	212
		18	0	59	155	230	290	360	425	498	562
	3	19	С	71 [`]	171	2 50	312	392	462	540	611
н	e e										
H					Zero s	hift after	experimen	t less tha	n 2 /~."/"		
X	ne l	<i>,</i>	•					₹.		· • .	
24	Ĕ			Equipment:	20 Sta	tion Switch	ning and B	alancing U	nit Baldwi	n No. 5009	-3
t.	1		• •		Baldwi	n Type L-S	train Indi	cator No.	H-80797		
a p	ě				Common	Zero Sett	ing at eac	h Gage: 0	-8-1000		
g	<u>a</u>										

REDUCED DATA for EXPERIMENT No. 26

Chapter

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centro de educación continua división de estudios superiores facultad de ingeniería, unam



ANALISIS EXPERIMENTAL DE ESFUERZOS

Chapter XXII

SOME EXAMPLES

 \mathbf{OF}

DYNAMIC STRAIN MEASUREMENT

DR. LUIS FERRER ARGOITE

DR. PORFIRIO BALLESTEROS BAROCIO

ING. ALFREDO OLIVARES PONCE

primer piso.

Outline

Introduction 1,

Chapter XXII

2. Steady State Dynamic Test with Strain Gages - Experiment No. 20

- (a) Statement of the Problem
- (b) Specifications of System Components
- (c) Theoretical Solution
- (d) Instruments and Equipment
- (e) Design of the Strain Gage System
 - Measuring System Input Requirements
 - Maximum Strain Gage Sensitivity
 - Circuit Design
 - Circuit Properties
 - Sensitivity Maximum Output Non-Linearity
 - Amplifier Specifications
 - Comparison with Available Amplifier
- (f) Calibration
- (g) Experimental Procedure

з. Unsteady State Low Frequency Dynamic Measurements - Experiment No. 21

- (a) Experimental Procedure
- (b) Qualitative Analysis of the Transient Phenomenon.
- (c) Specifications of System Components
- (d) Theoretical Solutions
- (c) Instrument Characteristics

Transients of Short Duration - Impact - Experiment No. 22

- (a) General Remarks
- (b) The Problem
- (c) Experiment
- (d) Information
- (c) Calibration of CRO X Axis in Terms of Time(f) Determination of the Striking Velocity
- (g) Triggering the CRO Internally Externally
- (h) Qualitative Study

1. Introduction

Three experiments have been designed as samples of some of the techniques available for dynamic strain gage studies.

(1) A steady state vibration phenomenon where, with fairly simple equipment, it is possible to obtain good results.

(2) A non-steady state, or transient, vibration problem where the main phenomena occur at frequencies which permit the use of a papertype recorder without the necessity of resorting to oscillographicphotographic methods.

(3) A transient problem the duration of which is so short, that oscillographic-photographic methods are a necessity.

2. Steady State Dynamic Test with Strain Gages - Experiment No. 20

(a) Statement of the Problem

A freely vibrating beam supported at its nodes is to be investigated. The stress distribution along the upper surface is to be determined at a given amplitude of vibration, by two methods:

> (1) Direct strain measurement, to be interpreted in terms of stress, by locating six strain gages along the beam as shown in the diagram.

The amplitude of vibration will be measured with an optical micrometer at the center of the vibrating bar,

(2) Analytically determined values of stress along the beam divided by the amplitude of vibration at the center of the beam can be determined from theoretical considerations.

The two methods are to be compared.

(b) Specification of System Components

			•
Beam:	L	length of beam	37 3/16 inches
	t	thickness of beam	3/4 inch
	b	width of beam	2.00 inches
	P	density of beam material (steel)	0,286 lbs/ins ³
	E	Young's modulus of beam material	30×10^6 lbs/ins ²
	đ	distance from center of beam to nodes of	
•		vibration	(0.276L) = 10.25 ins,

endurance limit of beam material

23,000 psi

f natural frequency of beam vibration

$$\frac{20.21 \text{ t}}{L^2} \sqrt{\frac{E}{\rho}} = 112.8 \text{ cyc/sec}$$

(c) Theoretical Solution

ຕຼ

A	fundamental	constant	1,1532
в	fundamental	constant.	0.1532
m	fundamental	constant	4.7300
	1		

a amplitude of vibration at center of beam in inches

x distance along beam from center, in inches

 $\sigma_{\mathbf{x}}$ stress at any point x along the beam

supported at its nodes of vibration, vibrated at its natural frequency.

$$\mathbf{O}_{\mathbf{X}}^{\bullet} = \mathbf{a} \in \frac{\mathbf{t}}{2} \quad \frac{\mathbf{m}^2}{\mathbf{L}^2} \quad \mathbf{A} \cos \frac{\mathbf{m}\mathbf{X}}{\mathbf{L}} + \mathbf{B} \cosh \frac{\mathbf{m}\mathbf{X}}{\mathbf{L}}$$

and for this beam:

(alue of x (inches)	0	3	6	9
(alue of $\sigma_{x/a}$ (lbs/ins ³)	238,500	224,500	189,000	134,000
<u>م</u>	12 75,400	15 28,100	(18-19/32) 0	. N. 1

(d) Instruments and Equipment

Amplitude Measurement Cathetometer, continuous range of 10 cm. 0.01 mm smallest scale division

Strain Gages

Type SR-4 C-1 Resistance Rg = 500 ohms Gage Factor (GF) = 3.23 Maximum Current Rating 30 milliamperes (continuous) Location: at 0, 3, 6, 9, 12, 15 inches from center

Vibration Exciter

Rayflex Fatigue Machine, description attached.

Available Amplifier

Gain (in linear range) Linear Range G 26

0.05 volts input maximum

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Chapter XXII

Lower Frequency Cut-Off Upper Frequency Cut-Off Input Impedance Output Impedance f₁ 2 cps f₂ 7000 cps 0.5 μF, 1M Ω less than 100,000

0,01 rms volts/ins

100,000 cycles/second

2 cycles/second

2 M 2 50 pm F

Type 208B

4 inches

Measuring Instrument:

DuMont Cathode Ray Oscillograph Maximum Sensitivity along Y-axis Useful screen diameter Lower frequency limit Upper frequency limit Input impedance

Calibration:

Type Calibration resistor Switch Parallel resistance 125,000 ohms 1/60 second period (square wave)



DISTANCE ALONG BEAM FROM CENTER IN INCHES

.

Chapter XXII

DYNAMIC STRAIN MEASUREMENT

Chapter XXII

DETERMINATION OF YOUNG'S MODULUS

The principle of free vibration lends itself to the accurate determination of Young's Modulus. For this purpose, the natural period of vibration or frequency must be measured to an accuracy of 0.1%. This is readily done as stated above, the measurement being made at low amplitudes of vibration, well below the fatigue limit. From this natural frequency, the dimensions and the weight of the specimen, the modulus may be calculated (see formulae, page 4).

MAGNAFLUX TEST

The Magnaflux test for discontinuities in steel or iron has been found useful in conjunction with fatigue investigations. Incipient failures may be located and studied in relation to surface conditions or local metallurgical factors before the spread of the crack has proceeded beyond a few thousandths of an inch. Coils for Magnaflux testing are supplied with the machine, and a limited license will be granted to customers who are not already licensees of the Magnaflux Corporation.

Reference: Rate of Growth of Fatigue Cracks

Journal of Applied Mechanics, Mar. '36, Vol. 3, No. 1

STROBOSCOPE ATTACHMENT

A stroboscopic device is supplied. This permits "slow motion" observation of the specimen; the growth of the failure crack being readily followed visually.

DETERMINATION OF STRESS

The stress applied to a specimen of uniform section is readily obtained from a knowledge of the maximum deflection at the center of the specimen, its dimensions, and Young's Modulus for the particular material being tested. The maximum deflection or amplitude may beread on a meter mounted on the control panel. This instrument is fitted with an arbitrary scale, the actual amplitude in thousandths of an inch being supplied by a calibration curve.

An optical method of changing the amplitude is also provided.

STRESS CALCULATIONS

Theory: The equation of motion for a uniform free bar vibrating in its first mode is:

$$y = a \left(A \cos m \sum_{L} - B \cosh m \sum_{L} \right) \cos \omega t$$

where $w = 2\pi f = \frac{m K}{L^2} \sqrt{\frac{Eg}{a}}$
 $A, B, and m are fundamental constants. $A = 1.1532$ $B = 0.1532$ $m = 4.7300$$

The bending moment may be derived thus:

$$M = EI \frac{\delta^2 v}{\delta x^2} = EIa \frac{m^2}{L^2} \left(A \cos m \frac{X}{L} + B \cosh m \frac{X}{L} \right) \cos \omega$$

The deflection and bending moment curves are shown in the figure. The deflection is zero at the nodes,

where $\frac{X}{L} = 0.2758$ and the bending moment is a maxi-

mum at the mic point of the specimen.

The notation is as follows:

- S Maximum Stress (Lbs., In.²)
- y Deflection from Mean Position (In.)
- Distance from Mid-Point of Specimen (In.)
- L Length (In.)
- d Diameter (In.)
- M Bending Moment (In. Lbs.)







Crack shown by Magnaflux Powder

Magnetizing Coils

Energized from Rayflex

- Ε Young's Modulus (Lbs. In.2)
- Density (Lbs. In.")
- Frequency of Vibration (Cycles Sec.)
- Moment of Inertia of Cross Section (In.4)
- Radius of Gyration of Cross Section (In.") κ
- Thickness (In.)
- Acceleration of Gravity (In. sec.3) q
- Amplitude of Vibration, one-half Total Travel at Mid-Point of Specimen (In.)

PRACTICAL FORMULAE

The following practical formulae are derived from the above equations.



TESTING OF NON-MAGNETIC MATERIALS

Non-magnetic materials may be tested by simply fastening soft iron sleeves to the ends of the specimen. A set of standard sleeves for round specimens will be supplied with the Rayflex. In testing a specimen loaded with these sleeves or armatures, the above standard formulae do not apply directly. Means for calculating stress under these conditions will also be supplied with the Rayllex.

(Courtesy of Baldwin-Lima-Hamilton Corporation)

SPECIAL TESTS

The Rayflex is admirably suited to tests on welded sections and, of course, non-uniform sections and threaded couplings may be tested on a comparative basis and in somé cases stress can be computed from the theory of elasticity.

MAINTENANCE

Extreme precautions have been taken to make the Rayflex a tool for fatigue tasting and not a "gadget" requiring tinkering or service to make it work. The tubes used are available at any standard radio supply house and suitable instructions will be furnished so that any competent radio service man can handle tube replacement and repairs.



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Figure 2

DYNAMIC STRAIN MEASUREMENT

(e) Design of the Strain Gage System

General

In order to combine most of the preceding chapters into one focal problem, the design of this system will be presented in detail as a sample,

Measuring System Input Requirements

It is usually necessary to start at one end of the measuring system, and unless one has the choice of several measuring instruments, that portion of the system serves as a satisfactory point of departure.

Since the endurance limit of the bar material is about 23,000 psi., and since the bar is not to be destroyed, a maximum operating stress of 20,000 psi., is arbitrarily assigned to the bar. Thus the peak to peak stress variations during the experiment will be in the vicinity of 40,000 psi. For best results, these 40,000 psi are to occupy the full 4 inches of the CRO screen. At maximum sensitivity, the CRO requires 0.010 volts rms at the Y-input terminals per inch deflection on the screen. The minimum input sensitivity to the measuring instrument, in terms of micro-volts per micro-inch-per-inch strain will be:

4(inches on screen) 40,000 (psi stress)	x	0,01 (volts rms) 1 (inch on screen)	х	$\sqrt{2}$ (volts peak) 1 (volt rms)	
	x	<u>30 x 10⁶ (psi stress</u> 1 (inch/inch strain)	2	χ.	

= 42.2 micro-volts per micro-inch per inch strain in the bar.

= 1,414 micro-volts per psi stress in the bar,

Corollary

If a strain gage circuit can be designed with this output sensitivity, then an amplifier will not be needed. Can such a circuit be designed?

Maximum Strain Gage Sensitivity

The maximum strain gage sensitivity in terms of S_s in micro-volts per volt output from the circuit per micro-inch per inch strain has been shown to be a property only of the strain gage used and independent of the circuit configuration (so long as it is passive) or of any supply voltages used.

S_{Smax} = (Gage Resistance)(Gage Factor)(Maximum Current Capacity)

In this case it is assumed that there is no choice in gage type available, but that the gages specified must be used:

 $S_{S_{max}} = 500 \times 3,23 \times \frac{30}{1000} = 48,45$ micro-volts per microinch per inch strain,

Corollary

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If the output from the actual strain gage circuit to be designed can be made to be:

 $\frac{42,42 \times 100}{48,45}$ = 87,7% of maximum sensitivity

no amplifier will be needed.

Circuit Design.

on

The design chart on page 119 may be used both for a Potentiometric Circuit and for a Wheatstone Bridge, so that at this point a design can be made without as yet specifying the type of circuit to be finally employed.

On the chart draw the horizontal line $E_{max} = \frac{500 \times 30}{1000}$

= I_{max} , R_g = 15 volts Find the horizontal line S_r = 87,7% of $\frac{s}{(GF)}$ = 13,16

Now find that value of a for which the line of E = f(a, V) intersecting the E = 15 volt line and the line of $S_r = f(a, V)$ intersecting the 13.16 volt line belongs to the same value of V.

For the limited choices available on the graph the solution is;

V = 150 volts

9

By solving numerically from the corresponding relationships

$$S_r = E \frac{a}{1+a}$$

$$V = E (1+a)$$

$$e \text{ finds } 13.16 = 15 \left(\frac{a}{1+a}\right)$$

V = 15(1 + a) or

a = 7.07V = 121.1 volts hence $R_{b} = 3535 \Omega_{b}$

Corollary

Chapter XXII

and

Through proper choice of ballast resistance and supply voltage, a system has been designed which does not need a pre-amplifier between the circuit and the CRO, but which demands operation of the CRO at maximum sensitivity. Furthermore, it turns out that there is no voltage source above 45 volts available so that the "ideal" circuit cannot be used.

Redesign of Circuit

With V = 45 volts, in order to have 30 milliamperes through the gage, the ballast resistor must be $R_b = 1000$ ohms and the sensitivities from page 119 will be, for the value of a = 2:

 $S_{r} = \sqrt[V]{\frac{8}{(1+a)}} \xrightarrow{\frac{1}{2}} 45 \times \frac{2}{(1+2)^{2}} = 10 \text{ micro-volts/micro$ $ohm per ohm}$ $S_{g} = S_{r}(GF) = 10 \times 3,23 = 32,3 \text{ micro-volts/micro-inch/$ $inch}$

Circuit efficiency = $\frac{8}{1+e}$ = 66 2/3%

Choice of Type of Circuit

Since the phenomenon does not contain any static stresses, a Wheatstone bridge circuit would unnecessarily complicate matters. The extra resistors and zero-balancing devices would be cumbersome, A Potentiometric circuit is called for in this case. The circuit values:



Chapter XXII <u>DYNAMIC STRAIN MEASUREMENT</u> Circuit Properties <u>Sensitivity</u> $S_g = \frac{V}{(GF)} \frac{A}{(1 + a)^2} = 32.3$ volts/ μ inch/inch <u>Maximum Output at 20,000 psi</u> $\Delta E/20,000 = \frac{S_g \times Q'}{E} = \frac{32.3 \times 20,000}{30 \times 10^6} = 0.0216$ volts <u>Non-Linearity at 20,000 psi</u> $n = \frac{1}{1 + \frac{a+1}{\Delta R/R}} = \frac{1}{1 + \frac{2+1}{\Delta R/R}} = 0.072\%$ $= \frac{0.072}{100} \times 0.216 = 15.5$ micro-volts

Measuring Instrument Reading Accuracy

Assuming the four inches on the CRO can be read to 0.05 inches, the equivalent input to the CRO is:

0.05 inches x 0.010 volts/inch x 1.414 volts peak/volt rms = 0.707 mV

Amplifier Specifications

Since an amplifier will be needed, the specifications should be drawn up:

Gain: The minimum gain must be:

Linear Input Region: The minimum specifications should read:

0.072% deviation from linearity at 21.5 millivolts input

in order to mate with the circuit output and linearity. The CRO, however, can be read to only 1-1/2% approximately, such that a revised specification may be:

1-1/2% deviation from linearity at 21,6 millivolts input,

Noise Level: This figure is dictated, either by the circuit nonlinearity, since it does not make sense to have a much lower noise level than the linearity-limit of the system,

(This limit would be 15,5 micro-volts)

or, the limit could be the CRO readability, 0.05 inches on the CRO at maximum sensitivity correspond to 0.707 millivolts input to the CRO which corresponds to 0.707 millivolts input to the amplifier, G

This limit would be $\frac{0.707}{G}$ millivolts

The larger limit should prevail in the suplifier chosen,

Frequency Response: The use of the Potentiometric Circuit determines that the amplifier shall have a lower frequency limit.

Signal frequency: 112.8 cycles theoretically Calibration frequency: 1/60 second square wave.

- f to be at least 6 cps., such that the fundamental of the square wave is fairly well in the "flat region."
- f to be at least 6000 cps., if it is desired to pass that component in the square wave whose frequency is 100 times the fundamental. This upper limit must be set by some rule of thumb as regards the number of harmonics of the fundamentals to be passed.

Since these frequency limits contain the expected signal frequency and any normal deviation from it, they may stand as specifications for the amplifier needed.

Input Impedance: In order not to interfere with the measurements, the input impedance should be at least 100 times the gage resistance:

Imput impedance of amplifier greater than 50,000 ohms,

Output Impedance: In this case the output impedance should be much lower than the CRO input impedance which is 50,000 ohms.

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Comparison with Available Amplifier

·	Desired	Available	Corment
Gain	1,3	26	ok
Lower frequency	6 сря	1.5 cps	ok
Upper frequency	6000 cps	7000 cps	ok
Input impedance	50,000 ohms	10^6 ohms	ok
Noise level	27.2 u-volts	<u>بهم</u> جور دین	check
Output impedance			check
Linear Input Region	21,6 mv, 1-1/2%	50 mv	no percentage deviation figure given, Should be checked.

The phase characteristics can only be assumed to be satisfactory. A good assumption is that the phase lag is constant between the upper and lower frequency limits.

Conclusion

The amplifier will be used with the circuit as finally designed. If the calibration is performed with the amplifier in the circuit, exact fulfillment of all the characteristics is not really necessary. The effect of too high an amplifier output impedance, for example, would be accounted for in the calibration proceedings.

(f) Calibration

Since it has been decided to operate the bar at no more than 40,000 psi peak-to-peak stress, and since there are 4 inches available on the CRO screen, a convenient calibration figure would seem to be 10,000 psi/inch. The calibration resistor necessary to simulate the application of 40,000 psi stress to the bar beneath one of the gages would be:

 $R_{c} = \left[\frac{1}{\epsilon (GF)} - 1\right] R_{g} = \left[\frac{30 \times 10^{6}}{40,000 \times 3,23} - 1\right] 500 = 116,000 \text{ ohms}$

The only resistor available, however, in that order of magnitude has a resistance of 125,000 ohms, which will give equivalent stress of:

$$= \frac{E}{G_{\circ}F_{\circ}} \times \left[\frac{R_{g}}{R_{g} + R_{c}} \right] = \frac{30 \times 10^{6}}{3_{\circ}23} \left[\frac{500}{125,500} \right] = 37,100 \text{ psi stress},$$

Hence, if the total amplitude of the square wave which results from the periodic switching into and out of the circuit of the calibration

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resistor, is made to occupy 3.71 inches on the CRO screen, the calibration conditions will correspond to 10,000 psi stress per inch deflection on the CRO screen.

It is to be noted that direct calibration in stress is possible only because there is a uni-axial stress field and stress and strain are related directly through Young's Modulus.

(g) Experimental Procedure

Strain Measurement

(1) Calibrate the screen of the CRO using the equivalent strain method and a 125,000 ohm calibrating resistor. The resulting signal will represent a stress of:

$$\vec{O} = \frac{E}{(GF)} \circ \frac{R}{R_c + R_g} = 37,100 \text{ psi}$$

on the CRO screen. If the Y-gain adjustment on the CRO is set such that this signal occupies 3,71 inches on the screen of the CRO along the Y-axis, the calibration constant for the system is a convenient:

10,000 psi stress/inch deflection on the screen

- (2) Adjust the Rayflex machine such that the beam vibrating with an approximate stress amplitude of 20,000 psi zeroto peak for the center gage, No. 1. (The maximum stress in the beam of 20,000 psi is then below the endurance limit of the beam material of about 23,000 psi. This condition is desirable since the specimen is not to be destroyed.)
- (3) By means of the switching arrangement, read the stress amplitudes for all six gages without changing the Y-axis setting on the CRO control panel. The readings should be taken in as short a period of time as possible so that it may be assumed that the beam is vibrating at a constant amplitude for all readings.

Amplitude Measurement

- (1) Focus the Cathetometer on one of the punch marks in the center section of the beam, while the beam is at rest.
- (2) As the beam vibrates, this punch mark will appear as a line whose length is to be measured with the Cathetometer.

The length of this line is the double amplitude of vibration of the beam,

(3) The amplitude reading should be performed simultaneously with the direct stress reading such that the results may be compared as having been obtained under the same conditions.

3. Unsteady State Low Frequency Dynamic Measurements - Experiment No. 21 Purpose

To demonstrate the use and limitations of a recorder for the study

of vibrations.

(a) Experimental Procedure

A cantilever beam with two pairs of strain gages mounted as shown in the diagram is to be subjected to various conditions.

- (1) An original deflection at the free end, which is suddenly released to permit the beam to vibrate freely,
- (2) A concentrated load is applied to the free end, which is given an initial deflection and then suddenly released to permit the beam to vibrate freely.
- (3) A concentrated load is suddenly applied to the free end, being permitted to fall through zero distance onto the beam.
- (4) Taps with the steel hammer at various locations along the beam.
- (5) Taps with the steel hammer at a location 0.78L from the clamped end of the beam. (L is the beam length).

Recordings will be made of all five conditions, and these records will be examined for:

Conditions

1

Experimental Results Desired

The frequency of the first mode of vibration and the time constant of decay of this vibration.

2

The frequency of the first mode of vibration and the time constant of decay of this vibration.

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3

Δ

5

DYNAMIC STRAIN MEASUREMENT

Verify that this condition of dynamic loading produces an initial deflection (or strain) which is twice the final value,

The frequency of the second mode of vibration of the beam, Also ascertain the non-reliability of the recorder for frequencies above about 40 cycles per second, by observing the same phenomenon on the recorder and on the screen of a Cathode Ray Tube.

Notice the absence of the second mode of vibration because the beam is excited at the node of vibration of the second mode.

Note that the frequency of vibration remains constant and independent of the amplitude of vibration.

Methods of Calculation of Desired Results

Frequencies

The recordings obtained show periodic pips along a line at the bottom of the record. These pips are 1 second apart and provide a convenient time scale, such that one must merely count the number of cycles of vibration occuring in any given time interval in order to determine the frequency of vibration in cycles per second.

The first, second, and third modes of vibration will be evidenced in the following type of record, and it is possible to distinguish between them as shown:

2nd MODE t MODE 3rd MODE

Time Constants

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To a very good approximation, the rate of decay of the vibration may be expressed by a function:

Decay Få	ctor: e ^{-t/T}
where	e is the base of the natural logarithm (2.71828). t is the time in seconds T is the Time Constant of Decay
att =	0 the decay factor is 1
at t 🗯	T the decay factor is $1/e = 0.3670$
att =	2T the decay factor is $1/(e^2) = 0.1353$

One may therefore determine T by ascertaining the time in seconds, in which the amplitude of the vibration has decreased to 36.7% of its initial value.



(b) Qualitative Analysis of the Transient Phenomenon

The theoretical analysis of the freely vibrating cantilever beem becomes extremely complicated when the initial transient phenomena are taken into account. Since the initial transient is of short duration, an exceedingly good approximate theory exists as a tool of analysis, A qualitative analysis of the cause of these transients, however, is indicated.

When the beam is released from its static constraint (the initial end deflection), the effective loading on the beam is changed from a concentrated end load to a distributed dynamic load. This change in loading condition is accompanied by a change in shape of the deflection curve.

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Since these changes cannot occur in zero time, a transient period of several cycles of vibration is needed before the beam settles down to its normal free vibration for which the theoretical equations are derived.

Furthermore, the initial deflection condition of the beam corresponds to its static deflection curve. This curve may be regarded as a superposition of the deflection curves for all the modes of vibration of the beam in proportion to the intensities with which they exist. Thus, roughly, the static curve may be said to be composed of a positive deflection of 103% of the first mode, plus a negative deflection of 3% of the second mode, adding up to 100% of the static deflection curve.



It stands to reason, therefore, that during the initial few cycles of vibration, several modes will be present until all but the first mode have decayed. This decay takes place rapidly because the initial amplitudes of all higher modes of vibration are exceedingly small compared to that of the first mode. A check on this explanation may be obtained by exciting the bar at the node of vibration of the second mode (Condition No, 5). The resulting record should show the absence of the second mode of vibration,

It also becomes apparent that if only the higher modes of vibration are of interest, the beam must be excited at locations where the initial amplitude of the first mode is small, whereas the amplitudes of the higher modes are at their maximum.



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(c) Specifications of System Components

Symbols	Items	Units	Numerical Values
L	Length of the Beam	(ins)	20,45
b	Width of the Beam	(ins)	1
h	Thickness of the Beam	(ins)	0.060
I	Moment of Inertia of Beam Section b.h. ³ /12	(ins ⁴)	18 x 10 ⁻⁶
E	Modulus of Elasticity of the Beam	(lbs/ins ²)	30×10^6
P	Density of Beam Material	(lbs/ins ³)	0,283
λ	Weight of Beam per Unit Length	(lbs/ins)	0.017
w	Total Weight of Beam	(1bs)	0.344
g	Gravity Constant	(ins/sec ²)	386.
t	Time	(sec)	
£	Frequency	(cycles/sec))
ď	Initial Eud Deflection of Beam	(ins)	
W	Concentrated End Load Applied to the Beam	(1bs)	0,1
c,	Constants obtained as solution to (cos Ci.cosh C ₁ + 1) = 0 See below	Â	
ī	Subscript to Denote Modes of Vibratic 1, 2, 3, 4, 5, 6	on	• •
	Strain Gage Type		A~7
·	Gage Factor		1,93
	Gage Resistance	(ohms)	120,
	Node of Vibration of Second Mode (from Clamped End)		0.78 x L
	Circuit Type 2 act:	lve gages	Potentiometric
	Supply Voltage	(volts)	6

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(d) Theoretical Solution

(1) Theoretical Solution for Freely Vibrating Cantilever Beam

$$f_{i} = \frac{C_{i}}{2\pi L^{2}} \sqrt{\frac{E_{o}I_{o}g}{\lambda}} cps$$

 where
 Mode of Vibration
 1
 2
 3
 4
 5
 6

 Value of C1
 3,515
 22.04
 61.7
 120.9
 200
 298.6

 Value of f. in cps
 4.77
 28.6
 81.8
 164.2
 272
 408

$$f_{1} = \frac{\sqrt{3}}{2\pi L^{2}} \sqrt{\frac{E.I.g.L}{\frac{33}{140} w + W}} = 3.03 \text{ cps}^{*}$$

(e) Instrument Characteristics

The operating manuals for the Recorder will be available at test location. From them, obtain the recorder characteristics

Type of System

Null Balance, Unbalance or both? Carrier System or D.C.? If Carrier System, what type carrier function? If Carrier System, is it phase-sensitive?

System Characteristics

Sensitivity, maximum and minimum in term of millimeters pen deflection per micro-inch per inch strain in a single gage.

Frequency response, upper and lower limits

Noise level in equivalent strain

Imput impedance

Linear Input Region in terms of strain

Zero shift

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Calibration Conditions

Type of System: Equivalent strain, equivalent bridge output, parallel resistance?

Transducer Source Impedance Limits: explanation /

Range Extenders: use and manipulation

Zero-Suppression: use and manipulation.

Gage Factor Dial: use and interpretation

Circuit

Bridge or Potentiometric

Supply Voltage

Initial Balancing Means Available and Their Range

General Comments Which May be of Interest

Types of Transducers Accommodated

Anything Else Which Seems Appropriate

Note

If all these characteristics are not to be found in the instruction books, then either the manufacturer has published an incomplete set of characteristics, or the user desires information not really necessary. Comment on the availability of the information, its relative importance, and give a short description of the instrument.

DYNAMIC STRAIN MEASUREMENT

1 A A 1 ï -1 1 ____ .1...1. 1 1 1 FIG. II !__ 4 4 4 4 2 4 anti. tr ίij ¶∦ I ----·(+) · 1 MMMMMMMM ~

DYNAMIC STRAIN MEASUREMENT









4. Transients of Short Duration --- Impact - Experiment No. 22

(a) General Remarks

The problem of impact has two major aspects:

- (1) When considered as that of maximum and most efficient energy transfer from one struck body to another, such as occurs in pile drivers or air-hammers for example. The problem there is to transfer the energy from the hammer to the pile to the ground without excessive energy dissipation in the pile.
- (2) When considered from the point of view of design where it is desired to determine the stress values due to impact, or optimum damping and redesign methods to lower peak stress values.

The proposition is rendered the more difficult since theoretical solutions to impact problems, although frequently available, are complex and difficult to carry to completion; furthermore, experimental methods of investigation must contend with the extremely short periods of time during which the entire phenomenon occurs. Work has been done, and is continuing, employing photoelastic techniques. Other investigators have used the electric resistance strain gage and its fore-runner, the carbon ESS strip for investigations of impact problems. References to some previous work may be found in this section.

(b) The Problem

To determine the amplitudes and the rate of repetition of a stress wave set up by the impact of two freely swinging bars; correlation between some experimentally determined quantities with some physical characteristics of the system.

(c) Experiment

Obtain a photograph of part of the initial wave and two or three subsequent reflections, using the internal trigger mechanism of the CRO.

Calibrate the screen of the CRO in terms of stress or strain along the Y-axis, and time along the X-axis.

Check the time between peaks of successive reflections determined experimentally with theoretical values calculated from the information given.

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(d) Information

Test Bar

Length: Diameter: Radius at struck end: Radius at free end: Material: Young's Modulus: Poisson's Ratio: Speed of Sound in Medium: Supports:

Striking Bar

Length; Diameter: Radius at Striking End; Radius at Free End; Material: Properties; Supports;

Distance Dropped: Repeatability of Distance Dropped: 24 inches 1.062 inches very large very large steel 30 x 10 psi approx. 0.265 201,800 ins/sec at room temp. at 2 locations by flexible strings.

24 inches 0.627 inches 1.0 inches very large steel exact props, unknown at 2 locations by steel rods on ball bearings as shown 5 to 10 inches

.

Transducer

Type:

Style: Resistance: Gage Factor: Location: assured by an Ames Dial Gage which determines initial position to 0,001 inches

Electric resistance bonded strain gage Baldwin SR-4, C-8 515 ± 3 ohms 3.0 ± 2% Three gages 120° apart-four from struck end of test bar, mounted axially.

Measuring Equipment

"Ellis Strain Gage Unit" used as a 2 stage amplifier DuMont Cathode Ray Oscilloscope Type 304-H long persistance screen Polaroid Camera Attachment for CRO.

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Characteristic of interest for these instruments may be obtained from the instruction booklets available at the test location.

Strain Gage Circuit

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Type: Ballast Resistor

Gage Resistance: Supply Volgage:

Potentiometric

- 7,500 ohm wire-wound precision non-inductive resistors.
 3 series gages - 515 ohms ea.
- 3 series adding 45-volt dry cells.

Strain Calibration

Type: Method: Calibration Resistor:

Switch

Time Axis Calibration

Mothod: Type: Apparent strain Entire System 5 Mogohus rated. To be accurately measured on a Wheatstone Bridge provided.

60 cycle buzzer contactor

See next few pages, Using an oscillator as standard

Velocity Determination of Dropping Bar

Type: Methods: Phototube: Series Resistor: Supply Voltage; Light Source:

Width of test strip:

Experimental and/or theoretical See next pages RCA 934 10 Megohm precision resistor 2 series adding 45 v. dry cells 6 - volt automobile headlight No. 1503 with lens system 0.75 inches.

(e) Calibration of CRO Screen X-Axis in Terms of Time

Method

One simple method of calibrating the X-axis of the CRO screen in terms of time is to apply a sinusoidal signal of known frequency to the Y-input Terminals of the CRO. Chapter XXII

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The distance between peaks along the X-axis of the CRO screen corresponds to a time interval of 1/(frequency of input signal) in seconds. The screen may thus be calibrated in terms of second per inch along its X-axis.

It is to be noted that the frequency-adjustment dials on the CRO must not be touched between the experiment itself and the calibration of the screen;

(f) Determination of the Striking Velocity of the Impinging Bar

Theoretical

The striking velocity of the impinging bar is given by: $V = \sqrt{2}$, g.h. where h is the height of drop of the bar and g is gravity acceleration.

Experimental.

The experimental method available involves the mounting of a strip of known width near the striking end of the bar. As a bar drops, a photocell arrangement is interrupted by the strip. An oscillographic record of the time of passage of the test strip through the photocell arrangement, coupled with the known width of the strip permits calculation of the velocity of the bar at the photocell location. The photocell must therefore be located such that the test strip passes through it only an instant before impact occurs.



(g) Triggering the CRO

With an open-shutter camera attached to the CRO, it becomes necessary to trigger the CRO beam at an instant such that the part of the wave to be photographed appears on the screen.

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Several such triggering devices exist, three of which will be mentioned here:

(1) Internal Trigger Mechanism of the CRO

The DuMont 304-H possesses an internal triggering mechanism which is actuated by the incoming signal to be measured. As soon as that signal reaches a predetermined amplitude (adjustable on the SYNCH control), the beam commences one traverse of the screen, displaying during that time, whatever phenomenon is applied to the input terminals. Since the time of traverse of the beam across the screen is variable (by means of the FREQUENCY controls), this trigger is convenient on occasion. It possesses one drawback, however, and that is the following: there is a time delay between the instant the desired signal arrives at the CRO and the instant the beam commences its traverse of the screen. Usually, this delay of some 30 micro-seconds is not serious. In this case, however, 20 micro-seconds corresponds to almost one-half of the first compressive wave which travels past the gage locations. The photographs on the following pages show this fact. Hence, if it is desired to obtain only the latter half of the first wave, and several of the subsequently reflected waves, this method is quite adequate.

(2) External Triggering Mechanism

If the complete first wave is desired, a mechanism must be found which emits an electrical signal at some short, adjustable time prior to impact. This signal enters the CRO at the EXTERNAL SYNCH binding post and starts the beam on its traverse.

a) One simple method is to use the instant of impact itself to trigger the CRO. Active terminals may be connected one each to each bar. At the moment of impact, the bars make contact, and the resulting electrical signal may be used to trigger the CRO. The duration of that trigger will be the time of contact between the bars. This method, however, does not give an adjustable trigger in terms of time.

b) Another method available here is the photocell arrangement, Instead of using it for velocity measurement, the electrical signal emitted by the photocell circuit may be used to trigger the CRO. By appropriate placement of the photocell, a controllable amount of time elapses between CRO triggering and time of impact. Thus the initial wave may be photographed. The only drawback here is that a second trigger signal is emitted when the beam bounces back from impact.



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(h) Qualitative Study of the Impact Phenomenon

Impact studies are complex even in the simplest theoretical cases. It is possible, however, with some imagination and physical reasoning, to study the phenomena qualitatively.

When impact occurs between two horizontally moving bars, stress waves are set up in both bars at the point of contact. These stress waves travel along the respective bars, much like a worm crawling along the ground. The velocity of propagation of these waves is equal to the velocity of sound in the medium in which they travel.

Referring to the diagrams on the following pages, the sequence of events may roughly be described as follows:

(1) Impact occurs sending compressive stress waves down both bars. When each wave reaches the end of its bar, it is reflected according to the boundary conditions existing at that end in the bar. Since the boundary conditions in this problem are "free-free bars," hence zerostress at the free ends, the compressive wave arriving at such a termination is reflected as a tensile wave. Hence after the first reflected wave in the struck bar has passed the gage location, zero stress exists beneath the gage, (Refer to Nos, on the following pages). Furthermore, the two bars exhibit slightly different properties, such that the two waves travelling in the bars do not do so at the same velocity, the reflected wave in the struck bar reaching the point of contact slightly before the corresponding wave in the striking bar.

(2) The condition of zero stress prevails in the struck bar after the first wave has been reflected. Since the bars are still in contact, the striking bar, (which is still under a compressive stress at the point of contact because its reflected wave has not yet reached that point), shares some of its stress with the struck bar producing a new compressive wave which travels down the struck bar (See Nos. 2 on the following pages) and a corresponding tensile wave in the striking bar.

(3) The reflected wave from the free end of the striking bar now reaches the point of contact a very short time after the phenomena in No. 2 have occurred. Its arrival leaves the end of the striking bar with a condition of tensile stress, which is shared with the struck bar, setting up a tensile wave (See No. 3) in the struck bar.

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SAMPLE RESULTS

STRAIN vs. TIME AT GAGE LOCATION



10,000 CPS TIME AXIS CALIERATION



4.97 MEGHOM SHUNT RESISTOR STRAIN CALIBRATION



EXPERIMENTAL DATA:

h

Rb	7,500 ohms
Rg	three 500 ohm gages in
v	135 volts
h	height of drop: 5,75"

s in series

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DYNAMIC STRAIN MEASUREMENT

COMPLETE IMPACT PHENOMENA

USING EXTERNAL PHOTOCELL TRIGGER

STRAIN WAVE

TIME BASE











50,000 cycles/sec



20,000 cycles/sec



100 cycles/sec



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(4) The duration of contact is over as soon as the reflected wave from the free end of the striking bar reaches the point of contact. The bars part company and a new set of boundary conditions must be satisfied: zero stress at the point which was the point of contact. In order to satisfy that new condition, a compression wave (See No. 4) starts from the ex-point-of-contact in the struck bar, leaving behind it a state of zero stress in the bar.

(5) Three separate waves are now left bouncing back and forth in the struck bar. They arose under conditions Nos. 2, 3 and 4, and they have different stress amplitudes and are delayed relative to one another in time. This triplet gives rise to successively smaller pulse shapes which are reflected from the free ends of the bars until they are completely dissipated and the struck bar is again in a condition of rest.

The next page shows these steps in terms of stress along the bar. The page following shows the stress vs, time relationship corresponding to that at the gage location. The actual phenomenon in the bar will not exhibit sharp square edges as a simple theory might predict, and the rounding-off effect is shown. It will be noted that this roughly predicted curve shape corresponds in general to the one actually obtained.

It is to be noted that the distance between successive peaks in the reflected waves after impact, should correspond to the amount of time it takes a wave travelling with the speed of sound in steel to travel twice the total length of the bar.

Further more, the duration of the initial wave is:

2 x (distance from the gage location to the free end of the bar) speed of sound in the bar material

Thus an experimental check can be made with theoretically calculated values.

DYNAMIC STRAIN MEASUREMENT



STRESS ALONG BARS DURING CONTACT TIME

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ANALISIS EXPERIMENTAL DE ESFUERZOS

ANALISIS DIMENSIONAL

NOVIEMBRE 1978.

Palacio de Minería Calle de Tacuba 5, primer piso México 1, D. F. Tel.: 521-40-20

5 Líneas

d

DIMENSIONAL ANALYSIS

TABLE 12.1. DIMENSIONS OF ENTITIES

Length, L	ŧ <i>T</i>
Area, A	17.21
Volume, V	[7,3]
Time, <i>t</i>	ן כין (ידי)
Force, <i>F</i> , <i>P</i>	14 [35572-2]
Mass, m	136121 * [14]
Specific weight, y.	[.)/ [3// -9/97~41
Mass density, o	[<i>3112 *</i>] *]
Angle, 0, o, etc.	(0772-1) (1)
Pressure and stress, p, σ .	[1] 1][]
Velocity, y.	
Acceleration. a.	121 ·]
Angular velocity, ω	, <i>L2 I</i> − †] [<i>T</i> = 1]
Angular negeleration.	(T)-21
Energy, work, T. W	: 4 * 5 4 * 5 ans as
Momentum: 907.	MI27-1
*Power. <i>P</i> .	31127~1j
Moment of a force M	
Moment of inertia of an area I	ML*T=*j
Moment of inertia of a mass. I	12*) 17721
Modulus of clasticity, E.	11 L-177-91
Strain, e	1) 1)
Poisson's ratio. v.	11
	41

Dimension of $\mu_1 = [L]^2 [L^2]^3 [MLT^{-2}]^2 [ML^{-1}T^{-2}] = [M^3 L^p T^{-6}]$ Dimension of $\mu_2 = [L^2]^2 [1^2]^3 = [L^4]$ Dimension of $\mu_3 = [L^2] [L]^{-2} = 1$ Dimension of $\mu_4 = [MLT^{-2}]^{-1} [ML^{-1}T^{-2}] [L^2] = 1$

In general, the dimensions of a product of powers

will be

or

 $[L]^{*_1}[L^2]^{*_1}[1]^{*_1}[MLT^{-2}]^{*_1}[ML^{-1}T^{-2}]^{*_1}$

 $\mu = l^{k_1} A^{k_2} \epsilon^{k_3} F^{k_4} E^{k_4}$

$[M]^{k_*+k_*}[L]^{k_1+2k_*+k_*-k_*}[T^i]^{-2k_*-2k_*}$

Products of powers like μ_3 and μ_4 , whose exponents of M, I, and T all vanish, are called dimensionless products of powers. Evidently the product μ will be dimensionless if and only if the exponents k_1 , k_2 , k_3 , k_4 , and k_5 satisfy all three of the following equations:

$$k_{4} + k_{5} = 0$$

$$k_{1} + 2k_{2} + k_{4} - k_{5} = 0$$

$$-2k_{4} - 2k_{5} = 0$$
(12.1)

CHAPTER 12

DIMENSIONAL ANALYSIS

12.1. Introduction. This chapter can be developed in an autonomous way without using the methods of analysis introduced in the theory of elasticity. It is also true that, although dimensional analysis will help in a better understanding of some problems in theory of elasticity, the latter can be completely developed without using any of the dimensional-analysis approaches. As a matter of fact, the organized approach to dimensional analysis is very recent, whereas the theory of elasticity is an old science. In stress analysis, the main application of dimensional analysis will be found in the design of models.

A knowledge of dimensional analysis is necessary for the proper design of models and the correct interpretation of the test results obtained from them.

12.2. Dimensions of Physical Quantities. In mechanics, the fundamental dimensions are usually taken as mass, length, and time, denoted, respectively, by M, L, and T. The dimensions of other physical quantities follow from their definitions or from physical laws. For example, the dimension of velocity, LT^{-1} , follows from its definition, quotient of length by time. Acceleration is defined as the quotient of velocity by time and has the dimension LT^{-2} . From Newton's law, force equals the product of mass and acceleration; it follows that force has the dimension MLT^{-2} . The dimensions of various physical quantities commonly encountered in mechanics are given in Table 12.1. Note that strain, angle, and Poisson's ratio are dimensionless.

12.3. Dimensionless Products. Given the five variables, length l, area A, strain ϵ , force F, and modulus of elasticity E, it may be observed that there are an infinite number of products of powers of these five variables. Examples are $\mu_1 = l^2 A^3 F^2 E$, $\mu_2 = A^2 \epsilon^{\frac{1}{2}}$, $\mu_3 = A l^{-2}$, $\mu_4 = F^{-1} E A$. Here the exponents may be either an integer or a fraction, and positive, zero, or negative. The dimensions of products of powers are calculated by replacing each variable by its corresponding dimensions and computing the resulting exponents of M, L, and T. Thus we replace l by [L], A by $[L]^2$, ϵ by [1], F by $[MLT^{-2}]$, E by $[ML^{-1}T^{-2}]$ and obtain (L^T)

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There are an infinite number of combinations of the exponents k_1 , k_2 , k_3 , k_4 , and k_5 which satisfy the above condition so that the number of dimensionless products of powers which can be formed out of the five variables l, A, ϵ , F, and E is infinite. Examples are $\pi_1 = Al^{-2}$, $\pi_2 = F^{-1}El^2$, $\pi_3 = F^{-1}EA$, $\pi_4 = A^2l^{-4}$, and $\pi_5 = \epsilon^{-1}$. Here π denotes a dimensionless product of powers and has no connection whatsoever with the value 3.1416. In this chapter, μ will denote a product of powers of variables, whether dimensionless or not. The use of π will be reserved to designate a dimensionless product of powers of variables, and the shortened term dimensionless product will be used for this.

Forming some products of powers of the dimensionless products, it can be noticed that

$\pi_3 = \pi_1 \pi_2$

$\pi_4 = \pi_1^2$

so that π_3 and π_4 can be expressed as products of powers of π_1 and π_2 . This suggests the following definition:

A set of *independent* dimensionless products of given variables is one in which none of these products can be expressed as a product of powers of other dimensionless products in the set. Here again, the exponents of the powers may be integers or fractions, positive, zero, or negative.

For example, π_1 and π_2 form a set of independent dimensionless products, π_2 and π_3 form another set of independent dimensionless products, π_2 , π_3 , and π_5 form still another set of independent dimensionless products, and many more sets of independent dimensionless products can be formed out of the infinite number of dimensionless products. Evidently if, in a set of dimensionless products, only one of them contains a particular variable, then this dimensionless product will be an independent one. The simplest way to construct a set of independent dimensionless products is therefore to make one variable appear exclusively in one dimensionless product, another variable to appear exclusively in another dimensionless product, etc.

For example, in the set of independent dimensionless products composed of π_1 , π_3 , and π_5 , *l* appears exclusively in π_1 , *F* appears exclusively in π_3 , and ϵ appears exclusively in π_5 .

12.4. Matrices and Determinants. Dimensional analysis is based on a theorem demonstrated first by Buckingham and known sometimes as the π theorem. To understand this theorem, some knowledge is required of the elementary properties of matrices. These will be given below.

A rectangular array of numbers is called a matrix. If the number of columns equals the number of rows, the matrix is called a square matrix, of order n. If there are n rows and m columns $(n \neq m)$, the matrix is said to be of $c \rightarrow n \times m$. Associated with every square matrix of order

n is a number called the determinant of order n. The determinants obtained after crossing out certain rows or columns or both from a matrix are called the "determinants of the matrix." Tables 12.2 and 12.3 five an example of a matrix and one of its third-order determinants

TABLE	12.2. Exa	MPLE OF A	MATRIX
a_1	a2	a3	 a.
bı	b2	bi	b.
с,	C2	C 3	C.

TABLE 12.3. A THIRD-ORDER DETERMINANT OF THE MATRIX OF TABLE 12.2

a 1	42	a.
<i>b</i> 1	b 8	b.
C1	C 2	C4

Determinants can be evaluated by the methods commonly used in algebra. For example, the value of the determinant of Table 12.3 is $a_1b_3c_4 + a_3b_4c_1 + a_4b_1c_3 - a_1b_4c_3 - a_3b_1c_4 - a_4b_3c_4$. It occasionally happens that all determinants above a certain order taken from a matrix have the value zero. The following definition is employed in algebra:

If a matrix contains a nonzero determinant of order r, and if all determinants of order greater than r that the matrix contains have the value zero, the rank of the matrix is said to be r.

12.5. Complete Set of Dimensionless Products. The concept of a complete set of dimensionless products is essential in dimensional analysis. The following is the definition of a complete set of dimensionless products:

A set of dimensionless products of given variables is complete if each product in the set is independent of the others in the set, and every dimensionless product of the variables is a product of powers of dimensionless products in the set. In other words, a complete set of dimensionless products is a set of independent dimensionless products with the additional property that every possible dimensionless product of the variables may be expressed as a product of powers of the dimensionless products in the set. For example, π_1 and π_2 have been shown to be independent of tach other and form a set of independent dimensionless products. Also, π_3 and π_4 have been shown to be expressible as products of powers of π_1 and π_2 . Now if it can be shown furthermore that any dimensionless product $\pi = l^{k_1} A^{k_2} \epsilon^{k_3} P^{k_4} E^{k_4}$ is expressible as a product of powers of π_1 and π_2 , then π_1 and π_2 will form a complete set. Similarly π_2 and π_3 will form a complete set if they meet the above conditions for a complete set.

After dealing with the previous example the general case will be discussed next. Let us consider the n variables whose dimensions are given in Table 12.4. The rectangular array of numbers a_i , b_i , giving the

TA	BLE 12	.4. Λ	DIMENS	IONAL M	ATRIX
		<i>x</i> ₁	<i>x</i> ₂	•••	x _n
	M	<i>a</i> 1	a2	•••	an
,	L	bı	b 1	•••	b _n
	Т	C1	C2 .	•••	C _n

dimensions of the variables x_1, x_2, \ldots, x_n corresponding to the fundamental units in the first column is called the dimensional matrix of these variables. Evidently the product $x_1^{k_1}x_2^{k_2}\cdots x_n^{k_n}$ will be dimensionless if and only if the exponents k_1, k_2, \ldots, k_n satisfy all three of the following equations:

> $a_{1}k_{1} + a_{2}k_{2} + \cdots + a_{n}k_{n} = 0$ $b_{1}k_{1} + b_{2}k_{2} + \cdots + b_{n}k_{n} = 0$ $c_{1}k_{1} + c_{2}k_{2} + \cdots + c_{n}k_{n} = 0$ (12.2)

By the theory of algebra it can be shown[†] that (1) Eqs. (12.2) possess exactly n - r linearly independent solutions in which r is the rank of the dimensional matrix given in Table 12.4 and (2) any solution (k_1, k_2, \dots, k_n) is a linear combination of these n - r linearly independent solutions. Since each solution (k_1, k_2, \dots, k_n) represents a dimensionless product, property (1) is equivalent to stating that these n - r dimensionless products are independent of each other and property (2) is equivalent to stating that all other dimensionless products may be expressed as a product of powers of these n - r dimensionless products. Hence the following important theorem on dimensional analysis:

The number of dimensionless products in a complete set is equal to the total number of variables minus the rank of their dimensional matrix.

It should be pointed out that there is an infinite number of complete sets. By accumulating any n - r independent dimensionless products, a complete set is obtained.

Returning to the example given earlier in this chapter, we have the five variables l, A, ϵ, F , and E. Their dimensions are given in Table 12.5.

TABLE 12.5. THE DIMENSIONAL MATRIX OF THE FIVE VARIABLES l, A, ϵ, F , and E

	l	A ·	e	F	E
М	0	0	0	1	.1
L	1	2	0	1.	-1
T	0	ο.	0	-2	-2

†See any standard text on theory of equations, for instance, L. W. Griffiths, "Introduction to the Theory of Equations," chap. 7, John Wiley & Sons, Inc., New York, 1947.

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It can be shown by evaluation that all determinants of the third order taken from the matrix of Table 12.5 are zero and at least one of the secondorder determinants is not zero. Therefore the rank of the dimensional matrix is 2. Hence there are only 5 - 2, or 3, dimensionless products in the complete set. Accordingly, $\pi_1 = Al^{-2}$, $\pi_2 = F^{-1}El^2$, $\pi_5 = \epsilon^{-1}$ constitutes a complete set of dimensionless products of the variables l, A, ϵ, F , and E. It should be noted that any three independent dimensionless products here will form a complete set.

12.6. Dimensional Homogeneity. An equation will be said to be dimensionally homogeneous if the form of the equation does not depend on the units of measurement. For example, the equation of the falling body $(h = \frac{1}{2}gt^2)$ is valid whether length is measured in feet, meters, or inches and whether time is measured in hours, years, or seconds, provided g is measured in the same units of length and time as h and t. Therefore, by definition, the equation is dimensionally homogeneous. If the value g = 32.2 ft/sec² is substituted in the equation, there results $h = 16.1t^2$. This equation applies only if length is measured in feet and time is measured in seconds and is not dimensionally homogeneous.

The application of dimensional analysis to physical problems is based on the hypothesis that the solution of physical problems is always expressible by means of a dimensionally homogeneous equation in terms of specified variables. This hypothesis is justified by the fact that the fundamental equations of mechanics are dimensionally homogeneous and that relationships that may be deduced from these equations are consequently dimensionally homogeneous.

We quote, without proof, a fundamental theorem on dimensional analysis called Buckingham's theorem:

If an equation is dimensionally homogeneous, it can be reduced to a relationship among a complete set of dimensionless products.

12.7. Elastic Structures Statically Loaded. All the above applies to any physical phenomenon. In the following, an application will be developed to the case of statically loaded elastic structures. The material of the structure can be completely defined by the modulus of elasticity. Eand Poisson's ratio ν as shown in the chapter on the theory of elasticity. The geometry of the structure can be defined by one length l and the ratios r_1, r'_1, r''_1, \ldots of all other lengths to l. The loads can be divided into five categories.

1. Concentrated loads acting on a point can be specified by one of them, P, and the ratios r_2, r'_2, r''_2, \ldots of the others to P. P will have the dimension of a force.

†For the proof of this theorem, see Henry L. Langhaar, "Dimensional Analysis and Theory of Models," chap. 4, John Wiley & Sons, Inc., New York, 1951.

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2. Loads distributed on a line can be specified by one of them, Q, and the ratios r_3 , r'_3 , r''_3 , ... of all others to Q. Q will have the dimension of a force per unit length.

3. Loads distributed on a surface can be specified by one of them, R, and the ratios r_4 , r'_4 , r''_4 , ... of all others to R. R will have the dimension of a force per unit area.

4. Loads distributed in a volume can be specified by one of them, S, and the ratios r_5, r'_5, r''_5, \ldots of all others to S. S will have the dimension of a force per unit volume. Body forces such as the dead weight of structures and seismic loads belong to this category.

5. Prescribed boundary displacements can be specified by one of them, U, and the ratios r_6 , r'_6 , r'_6' , ... of all others to U. U will have the dimension of a length.

The directions of the loads can be specified by θ , θ' , θ'' , The formula for the stress at a point whose coordinates are x, y, z, will be

$$\sigma = f_1(x, y, 2, E, \nu; l, r_1, r'_1, \cdots; P, r_2, r'_2, \cdots; Q, r_3, r'_3, \cdots; R, r_4, r'_4, \cdots;$$
(12.3)
$$S, r_5, r'_5, \cdots; U, r_6, r'_6, \cdots; \theta, \theta', \theta'', \cdots)$$

assuming isotropy and homogeneity and Hooke's law. The dimensional matrix of the above variables is

TABLE 12.6 DIMENSIONAL MATRIX OF	VARIABLES OF ELASTIC STRUCTURES
----------------------------------	---------------------------------

		σ	/	x	· y		z	E	7	v		l		P	Q		R	\$	s 	<u>U</u>
M L T		$ 1 \\ -1 \\ -2 $		0: 1 0	0 1 0		0 1 0	1	- I - 2	0 0 0))).	0 1 0		1 1 -2	1 0 -	2	1 - 1 - 2) -	 -2 -2	0 1 0
r 1	r'_1		r ₂	r'2	•••	r3	r'_{i}	••••	r4,	r'i		rb	r'5	·	<i>r</i> 6	r's	•••	θ	θ'	
0 0 0	0 0 0	· 	0 0 0	0 0 - 0	 	0 0 0	0 0 0	· · · · · · · ·	0 0 0	0		0 0 0	0 0 0		0 0 0	0 0 0	•••	0 0. 0	0 0 0	

Since all the third-order determinants taken from the above matrix are zero, and at least one of the second-order determinants is not zero, the rank of the matrix is 2. The number of independent dimensionless products necessary to form a complete set of dimensionless products is therefore two less than the number of variables. The following constitutes a complete set of dimensionless products:

$$\frac{\sigma}{E}, \frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, \frac{P}{El^2}, \frac{Q}{El}, \frac{R}{E}, \frac{Sl}{E}, \frac{U}{l}, r_1, r'_1, \cdots,$$

$$r_2, r'_2, \cdots, r_4, r'_4, \cdots, r_5, r'_5, \cdots, r_6, r'_6, \cdots, \theta, \theta'$$

By Buckingham's theorem, Eq. (12.3) is reducible to the following form:

$$\frac{\sigma}{E} = f_2 \left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, \frac{P}{El^2}, \frac{Q}{L'l}, \frac{R}{E}, \frac{Sl}{E}, \frac{U}{l}, \frac{T}{l}, \frac{$$

In experimental stress analysis, it is often impracticable to perform tests on the real structure or prototype. In such cases, a model of the real structure is built, usually at a reduced scale and often of a different material. Tests are performed on the model, and the stresses and strains in the model are determined. The stresses and strains in the real structure can then be obtained if the relations between the stresses and strains in the model and the prototype are known. This relation can be established by dimensional analysis and will now be shown. Equation (12.4) is explied to both model and prototype. Although the form of the function f_2 is unknown, it is the same for both. If we make a model such that the numerical values of all the dimensionless products $x/l, y/l, z/l, \nu, \ldots$ at the right-hand side of Eq. (12.4) are equal to those of the prototype, respectively, then the numerical value of σ/E for the model will also be equal to that of the prototype. If the subscript *m* is used for the model and *p* for the prototype, then

or

The true stress at any point x, y, z in the prototype would then be equal to the stress at the similarly situated point in the model multiplied by the ratio between the modulus of elasticity of prototype to that of model.

 $\sigma_{p} = \frac{E_{p}}{E_{m}} \sigma_{m}$

 $\frac{\sigma_{p}}{E_{p}} = \frac{\sigma_{m}}{E_{m}}$

Making x/l, y/l, z/l the same for both model and prototype means that the stress is to be taken at similarly situated points in the model and prototype. Making r_1, r'_1, \ldots the same for both model and prototype means geometric similarity for the model and prototype. Making r_2 , $r'_2, \ldots; r_3, r'_3, \ldots; r_4, r'_1, \ldots; r_5, r'_5, \ldots; r_6, r'_6, \ldots; \theta, \theta', \ldots$ the same means similarity of load distribution. If the stresses do depend on ν , then the model material should have the same Poisson's ratio as the prototype. Making P/El^2 . Q/El, R/E, Sl/E, U/l the me for both TNT.

means

$$\frac{P_{m}}{P_{p}} = \frac{E_{m}}{E_{p}} \left(\frac{l_{m}}{l_{p}}\right)^{2}$$
$$\frac{Q_{m}}{Q_{p}} = \frac{E_{m}}{E_{p}} \frac{l_{m}}{l_{p}}$$
$$\frac{R_{m}}{R_{p}} = \frac{E_{m}}{E_{p}}$$
$$\frac{S_{m}}{S_{p}} = \frac{E_{m}}{E_{p}} \frac{l_{p}}{l_{m}}$$
$$\frac{U_{m}}{U_{p}} = \frac{l_{m}}{l_{p}}$$

The loads must therefore be scaled down according to these rules.

Similar analyses can be carried out for the displacement w and the strain ϵ at any point x, y, z, of the structure. Thus

$$\frac{w}{l} = f_3\left(\frac{x}{l}, \frac{y}{l'}, \frac{z}{l'}, \frac{P}{El^2}, \dots\right)$$
$$\epsilon = f_4\left(\frac{x}{l'}, \frac{y}{l'}, \frac{z}{l'}, \frac{P}{El^2}, \dots\right)$$

For a model which has all its values of x/l, y/l, z/l, v, P/El^2 , ... equal to that of the prototype,

$$\frac{w_m}{w_p} = \frac{l_m}{l_p}$$

$$\epsilon_m = \epsilon_n$$

The deformations have not been assumed small. The above applies to all structures made of materials obeying Hooke's law and stressed below its proportional limit. Very flexible steel springs, thin plates transversely loaded to large deflection, and other structures where the stresses, strains, displacements, and redundant reactions are in general not proportional to the loads can therefore also be analyzed by the above procedure.

12.8. Linear Structures. From the theory of elasticity, we know that, for stiff structures where the deformations do not affect the action of the loads, the stresses, strains, displacements, and redundant reactions are

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always linear functions of the loads. This knowledge makes the following \mathbb{T} simplification of Eq. (12.4) possible:

$$\frac{\sigma}{E} = \frac{P}{El^2} g_1 \left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_1, r'_1, \dots, r_2, r'_2, \dots, \theta, \theta', \dots \right)
+ \frac{Q}{El} g_2 \left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_1, r'_1, \dots, r_2, r'_2, \dots, \theta, \theta', \dots \right)
+ \frac{R}{E'} g_3 \left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_1, r'_1, \dots, r_2, r'_2, \dots, \theta, \theta', \dots \right)
+ \frac{Sl}{E} g_4 \left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_1, r'_1, \dots, r_2, r'_2, \dots, \theta, \theta', \dots \right)
+ \frac{U}{l} g_6 \left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_1, r'_1, \dots, r_2, r'_2, \dots, \theta, \theta', \dots \right)$$
(12.5)

Similar expressions exist for w/l and ϵ . If we make x/l, y/l, z/l, ν , r'_1 , r'_1 , ..., r_2 , r'_2 , ..., r_3 , r'_3 , ..., r_4 , r'_4 , ..., r_5 , r'_5 , ..., r_6 , r'_6 , ..., θ , θ' , ... the same for model and prototype, then

 $\frac{\sigma}{E} = C_1 \frac{P}{El^2} + C_2 \frac{Q}{El} + C_3 \frac{R}{E} + C_4 \frac{Sl}{E} + C_5 \frac{U}{l}$

where the constants C_1, C_2, \ldots, C_5 are independent of the loads P, Q, R, S, U and are the same for model and prototype. By running five separate tests on the model, each test using only one among the five types of loads P, Q, R, S, U, the values of these constants C_1, C_2, \ldots, C_5 can be determined for any point whose stress is required.

Similar constants for the strain ϵ and displacement w/l can be determined in the same manner. This reasoning will be applied to two concrete cases in the following examples.

Example 1. Let us consider a thick plate with a hole (Fig. 12.1), under a uniformly distributed load R_p at its two ends. Let the modulus of elasticity and Poisson's ratio of the material of the plate be E_p and ν_p . respectively. The problem is to design a model to study the stress distribution of this thick plate.

By Eq. (12.5), the stresses σ_{p} in the prototype at any point A_{p} whose coordinates are x, y, z are given by

$$\frac{\sigma_{P}}{E_{P}} = \frac{R_{P}}{E_{P}} g_{3}\left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_{1}, r_{1}', r_{1}'\right)$$

$$\sigma_{P} = R_{P} g_{3}\left(\frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \nu, r_{1}, r_{1}', r_{1}'\right)$$
(12.6)

or

Consider a model which is geometrically similar to the prototype so



FIG. 12.1. Thick plate with a hole, under a uniformly distributed load.

that r_1 , r'_1 , r''_1 are the same for the model and prototype. Let the model be made of a material having the same Poisson's ratio as that of the prototype. Under a uniformly distributed load R_m , the stresses in the model at a similarly situated point A_m will be given by

$$\sigma_{m} = R_{m} g_{3} \left(\frac{x}{l'} \frac{y}{l'} \frac{z}{l'}, \nu, r_{1}, r_{1}', r_{1}'' \right)$$
(12.7)

where g_3 will have the same value as in Eq. (12.6). Equation (12.6) is divided by Eq. (12.7) to obtain

$$\frac{\sigma_p}{\sigma_m} = \frac{R_p}{R_m} \tag{12.8}$$

The stresses in the prototype and in the geometrically similar model at similarly situated points are therefore in the same proportion as the intensity of the uniformly distributed load. The materials of the prototype and the model must have the same Poisson's ratio but not necessarily the same modulus of elasticity. The length scale factor of the model does not appear in Eq. (12.8), so that the model can be made one-tenth or five times as large as the prototype and Eq. (12.8) still holds.

If the plate is thin, from the theory of elasticity we have the additional knowledge that the plane-stress solution is applicable. This means that

for this case both the thickness of the plate and Poisson's ratio will not enter the solution for stresses. For such a prototype the model must be geometrically similar to the prototype in the direction of its width and length. It can be a thin plate of any thickness which is small compared with the diameter of the hole, made of any elastic material. The relation between the stresses in the model and the prototype will still be given by Eq. (12.8). Here again, the length scale factor of the model does not enter Eq. (12.8). The model can be half or twice the size of the prototype and Eq. (12.8) always holds.

Example 2. Let us consider a thick cylinder with an eccentric hole, loaded as shown in Fig. 12.2. By Eq. (12.5) the stresses σ_p at any point A_p whose coordinates are x, y, z are given by





Construct a model geometrically similar to the given cylinder, and made of a material whose Poisson's ratio is the same as that of the prototype. Then, at a similarly located point A_m in the model, the stresses under similarly distributed loads P_m and R_m will be

$$\frac{\sigma_m}{E_m} = \frac{P_m}{E_m l_m^2} g_1 \left(\frac{x}{l'}, \frac{y}{l'}, \frac{z}{l'}, \frac{y}{l'}, r_1, r_1', r_1'' \right) + \frac{R_m}{E_m} g_3 \left(\frac{x}{l'}, \frac{y}{l'}, \frac{z}{l'}, \frac{z}{l'}, r_1, r_1', r_1'' \right)$$
(12.10)

where g_1 and g_3 have the same values as in Eq. (12.9).

To get σ_{p} from the observed σ_{m} in the model, either one of the two following methods can be used.

Method 1. The principle of superposition will be used. The portion of the stress $(\sigma_p)_1$ due to P_p alone will be determined separately from the portion of the stress $(\sigma_p)_2$ due to R_p alone. Then the true stress σ_p due to P_p and R_p will be obtained as the sum of $(\sigma_p)_1$ and $(\sigma_p)_2$. Two separate

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tests must therefore be conducted, one employing P_m only on the model, and the other employing R_m only on the model. The values of $(\sigma_p)_1$ and $(\sigma_p)_2$ are obtained from these two tests separately by the method shown in Example 1.

Method 2. The ratio of P/l^2 to R will be made the same in model as in prototype, so that

$$\frac{P_{p}}{l_{p}^{2}} = R_{p} \frac{P_{m}}{R_{m} l_{m}^{2}}$$
(12.11)

By Eqs. (12.9), (12.11),

$$\sigma_{p} = \frac{P_{p}}{l_{p}^{2}} g_{1} + R_{p} g_{3}$$

$$= R_{p} \frac{P_{m}}{R_{m} l_{m}^{2}} g_{1} + R_{p} g_{3}$$

$$= \frac{R_{p}}{R_{m}} \left[\frac{P_{m}}{l_{m}^{2}} g_{1} + R_{m} g_{3} \right]$$
(12.12)

Therefore by Eqs. (12.10) and (12.12),

$$\sigma_p = \frac{R_p}{R_m} \sigma_m \tag{12.13}$$

Given any combination of P_p and R_p , it is sufficient to load the specimen in such a way that Eq. (12.11) is fulfilled, and the stresses in the prototype σ_p can be calculated from the observed stress σ_m in the model. In this method only one test needs to be conducted. But the stresses obtained will be only those corresponding to the given combination of P_p and R_p . To obtain the stresses of a different combination of P_p and R_p , a second test must be performed in a similar manner. After the stresses corresponding to any two different combinations of P_p and R_p are obtained, the stresses due to a load of P_p or R_p alone can be computed by solving two simultaneous equations. The stresses corresponding to any other combinations of P_p and R_p can then be obtained by superposition.

It should be pointed out that no restrictions are imposed on the value of the modulus of elasticity E_m of the material of the model. The stresses are independent of the modulus of elasticity. The strains in the prototype ϵ_p are always calculated from the stresses and will of course depend on E_p .

12.9. Composite Structures. Where the structure is composed of two or more materials whose moduli of elasticity and Poisson's ratios are $E, E_1, E_2, \ldots; \nu, \nu_1, \nu_2, \ldots$ respectively, the additional dimensionless products $E_1/E, E_2/E, \ldots; \nu, \nu_1, \nu_2, \ldots$ would appear, and these must be the same for model and prototype. Often Poisson's ratio does not affect appreciably the stresses sought and can therefore be omitted. For example, the model of a reinforced-concrete structure may be made of materials having the same ratio of moduli as between steel and concrete but with Poisson's ratios different from steel and concrete.

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12.10. Application of the Method to a Specific Stress-analysis Proven. Suppose it is desired to determine experimentally stresses and strains set up by shock waves impinging upon obstructions embedded in a wavepropagating medium. Since full-scale tests are expensive, the possibility of experimentally studying the problem by means of scaled-down models might be considered. For example, the stresses could be determined photoelastically, and a purely optical approach might be used to obtain displacements and hence strains. By means of the methods of dimensional analysis discussed in this chapter, the feasibility of using such experimental methods to study this problem will be investigated. It is cautioned, however, that this discussion should be looked upon as only an example illustrating the use of the methods of this chapter; and while a set of scale laws are derived which must necessarily be adhered to in conducting the experiment, there is no reason to believe that these laws represent a sufficient set of conditions to be met. For a new problem such as this which is gone into for the first time, a simplified approach is useful as a preliminary feasibility study; but it may be found that additional variables over the ones selected have influence on the problem.

The variables involved in specifying the phenomena are contained in some function

$$\sigma = F(x, y, z, E, E_0, \epsilon, \nu, \nu_0, \rho, \rho_0 t; l, r_1, r'_1, \dots; P, r_2, r'_2, \dots;$$

$$Q, r_3, r'_3, \dots; R, r_4, r'_4, \dots; S, r_5, r'_5, \dots; U, r_6, r'_6, \dots; \theta, \theta', \theta'', \dots)$$
(12.14)

which gives the stress at the point x, y, z. Symbols which appear here and were not present in the previous examples are those arising from the dynamic nature of the problem, viz., mass density ρ and time *l*. The terms E_0 , ν_0 , ρ_0 refer to to the obstructions, while E, ϵ , ν , ρ refer to the wave-transmitting medium. The remainder of the variables apply throughout both.

The following simplification and assumptions are made: By the introduction of E and ν it is implicitly assumed that the phenomenon occurs entirely within the elastic range. This is not quite true in the case of many photoelastic materials. In most plastics, for example, the modulus of elasticity E has been found to vary with strain rate. If this effect is very pronounced, the problem becomes much more complicated. It will nevertheless be supposed in this illustrative example that E and ν are constants and that this approximation will lead to sufficiently accurate results.

It will be further assumed that no damping occurs, i.e., that there is

no wave attenuation resulting from internal friction, or, as it is often called, "hysteresis damping." Damping is present to some extent in all materials, but in this example it will be neglected.

Isotropy and homogeneity are, of course, also assumed. The terms S, r_5, r'_5, \cdots can be excluded if body forces are neglected. In many applications, obstructions can be considered to be acted upon by a plane-strain shock wave (i.e., one for which the strain perpendicular to the direction of its travel is zero). This suggests using for the model wave-transmitting medium a slab of photoelastic material (see Fig. 12.3). Knowing the stress-time shape of the shock wave can be applied to one end of the model stress- (or displacement-) time wave can be applied to one end of the model



Fig. 12.3. Possible laboratory method for determining stresses around and displacements of obstructions partially or fully embedded in an elastic medium.

medium, and the resulting stresses and displacements around the obstructions can be determined by photoelasticity and optical techniques as schematically indicated in the figure. By so formulating the problem, the variables $P, r_2, r'_2, \ldots; Q, r_3, r'_3, \ldots; R, r_4, r'_4, \ldots; r_6, r'_6, \ldots;$ $\theta, \theta', \theta'', \ldots$ can be omitted in Eq. (12.14), leaving simply the displacement U = U(t), which represents the plane motion of particles in the medium immediately in front of the obstruction. Equation (12.14) thus simplifies to

$$\mathbf{r} = F[x, y, z, E, E_0, \epsilon, \nu, \nu_0, \rho, \rho_0; t; l, r_1, r'_1, \dots; U(t)]$$
(12.15)

1 -

Examination of the dimensional matrix of these variables will show that at least one third-order determinant is not zero[†], so that the rank of the

tOne nonzero determinant is that corresponding to the three variables σ , ρ , l; that is,

$$\begin{vmatrix} 1 & 1 & 0 \\ -1 & -3 & 0 \\ -2 & 0 & 1 \end{vmatrix} = -2$$

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matrix is 3. The number of independent dimensionless products necessary to form a complete set of dimensionless products is therefore three less than the number of variables. One of the ways of writing the complete set is

$$\frac{\sigma}{E\epsilon}, \frac{x}{l}, \frac{y}{l}, \frac{z}{l}, \frac{E_0}{E}, \epsilon, \nu, \nu_0, \frac{\rho l^2}{E l^2}, \frac{\rho_0}{\rho}, r_1, r_1', \dots, \frac{U}{l\epsilon}$$
(12.16)

If the value of each of these groups is made the same for the model and prototype, then, by Buckingham's theorem, the law [Eq. (12.15)] governing the phenomena will hold for both. Making x/l, y/l, z/l, r_1 , r'_1 , ... equal for both means that the model will be geometrically similar to the prototype and that the stresses occurring in the model will occur in the prototype at geometrically similar locations. Using subscripts m and p to denote model and prototype, respectively, and introducing the scale factors

$$K_{\sigma} = \frac{\sigma_{p}}{\sigma_{m}} \qquad K_{R} = \frac{E_{p}}{E_{m}} \qquad K_{*} = \frac{\epsilon}{\epsilon_{*}}$$

the condition of equality between model and prototype of the first dimensionless product can be written

$$K_{\sigma} = K_E K_{\sigma}$$

This can be done for all the dimensionless groups, with the results

 $K_{\sigma} = K_{\kappa}K, \qquad K_{\kappa} = K_{\kappa}, \qquad K_{\star} = 1 \qquad K_{\star} = K, \qquad K_{\star} = 1$ $K_{\rho}K_{1}^{2} = K_{\kappa}K_{1}^{2} \qquad K_{\rho} = K_{\rho}, \qquad K_{U} = K_{1}K,$

If the test is kept within the linear range of elasticity, the requirement $K_{\bullet} = 1$ need not be met. This is because a deviation from this requirement corresponds only to an equal deviation in K_{\bullet} and K_{U} , which in turn merely implies a higher or lower stress and displacement level.

The requirement that $K_{\star} = K_{\star} = 1$ means that Poisson's ratio for both model and prototype obstruction and wave-transmitting medium must be equal. Quite probably it will not be possible to adhere to the requirement, and it must be neglected.

A final simplification: if E_0 is much larger than E (that is, the observetions can be assumed to be rigid compared with the wave-transmitting medium), E_0 can be dropped from the analysis. The final set of scale-law equations is then

K. =	$K_{E}K_{\bullet}$	(12.17a)
		(14.174)

$$K_{\rho}K_{i}^{2} = K_{B}K_{i}^{2} \tag{12.17b}$$

$$K_{\rho} = K_{\rho_{\sigma}} \tag{12.17c}$$

$$K_{\star} = K_{\star}K_{\star} \tag{12.17d}$$

$$K_{\bullet}$$
 = arbitrary but below elastic limit (12.17e)

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There are many possible ways of combining the variables to obtain a complete set of dimensionless products such as given in (12.16); however, the one chosen leads to a form of Eqs. (12.17) which admits a direct physical interpretation. Thus, Eq. (12.17a) is representative of the stressstrain relations [see Eqs. (4.17)], and Eq. (12.17b) corresponds to the wave equation in mechanics.[†] The third equation simply states that the ratio of densities of obstruction to wave-propagating medium must be the same for both model and prototype, and Eq. (12.17d) expresses the straindisplacement relations of the theory of elasticity [Eqs. (2.11) and (2.13)]. Other scale factors can be derived from those in Eq. (12.17) viz

Other scale factors can be derived from those in Eq. (12.17),	V14
Wave-velocity scale factor $= K_i/K_i$	(12.18a)
Wave-acceleration scale factor $= K_i/K_i^2$	(12.18b)
Particle velocity scale factor $= K_u/K_t = K_t K_t/K_t$	(12.18c)
Particle acceleration scale factor = $K_U/K_t^2 = K_t K_t/K_t^2$	(12.18d)
The basic design equation for setting up the experiment is Eq.	(12.17b).

To illustrate, suppose the values

$$E_{p} = 55,000 \text{ psi}$$
$$\rho_{p} = 90 \text{ lb/ft}^{3}$$

are assumed for soil; and

$$E_m = 18 \text{ psi}$$

 $\rho_m = 62 \text{ lb/ft}$

are taken for the chosen photoelastic model material; then by Eq. (12.17b)

$$\frac{K_i}{K_i} = \sqrt{\frac{55,000/18}{90/62}} \cong 46$$

This means that, for a wave traveling 1,700 fps in the soil, the model wave velocity will be 1,700/46 = 37 fps. The above also establishes the ratio of the scales for length and time. If a convenient length scale is 150, the time scale will be approximately 3. The acceleration scale will correspondingly be, by Eq. (12.18b),

$$\frac{K_{t}}{K_{t}^{2}} = \frac{150}{9} = 16.7$$

From Eqs. (12.18c), (12.18d), particle velocities and accelerations will, on the other hand, be $K_t K_t / K_t = 46K_t$ and $K_t K_t / K_t^2 = 16.7K_t$, respectively, which indicates that these are proportional to the strain scale factor, whatever its value is chosen to be.

†A simplified form of which is, for example, that the velocity v of a wave propagating in a long slender elastic bar having density ρ and modulus of E is expressed by: $v = \sqrt{E/\rho}$.

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12.11. Structural Similarity. If the fundamental equations governing the phenomena are known, the scale-factor laws may be derived directly from these equations without utilizing the methods of dimensional and, srs. Thus in the example mentioned in Sec. 12.10 we might expect that the stress-strain relations, the strain-displacement relations, and the wave equations of mechanics are known to apply. By writing these equations in their most general form for both the model and the prototype, and introducing the scale factors, Eqs. (12.17) will result directly.

In order that the reader may understand these concepts, he is advised to pursue the following simple examples which illustrate the use of structural similarity in the derivation of the basic scale-factor laws in each particular problem.

Straight Member under Axial Load. One of the simplest problems which may be solved by the principles of structural similarity is that of a straight tension member under a unidimensional uniformly distributed axial load. Such a member of rectangular cross section is shown in Fig. 12.4. Here





it may seem that the dimensions of a geometrically similar model are given by $l_m = \lambda l_{\nu}$, $a_m = \lambda a_{\nu}$, and $b_m = \lambda b_{\nu}$, where λ is a given constant factor. The cross-sectional area of the prototype is given by

(12.19)

 $A_{\mathfrak{p}} = a_{\mathfrak{p}} \times b_{\mathfrak{p}}$

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The area in the model will be given by

$$A_{m} = \lambda^{2} \times A_{p} \qquad (12.20)$$

Similarly it is seen that

$$V_{\rm m} = \lambda^3 \times V_{\rm p} \tag{12.21}$$

where V_m and V_p represent the volumes of the model and prototype respectively.

If the stresses are defined as total force across any cross section divided by cross-sectional area, i.e., $\sigma_p = R_p/A_p$ and $\sigma_m = R_m/A_m$, it may be seen, using Eq. (12.20), that

$$\sigma_m = \frac{R_m}{\lambda^2 A_p} \tag{12.22}$$

If the requirement that the stresses in the model and in the prototype be the same is to be satisfied, it is necessary that the load on the model satisfy the relation

$$R_m = \lambda^2 R_p \tag{12.23}$$

If the requirement that the load on the model and on the prototype be the same is to be satisfied, it is necessary that the stress in the model satisfy the following relation:

$$\sigma_m = \frac{\sigma_p}{\lambda^2} \tag{12.24}$$

At this point it may be observed that the elastic constants E and ν do not influence the scaling laws of either the model stresses or model loads. Assuming that the elastic constants of the mode and the prototype are different, it is necessary that the scale-factor laws for the model strains contain one of these constants, viz., Young's modulus, E. Thus, we have

$$\epsilon_p = \frac{\sigma_p}{E_p} = \frac{R_p}{A_p E_p} \tag{12.25}$$

$$\epsilon_m = \frac{\sigma_m}{E_m} = \frac{R_m}{\lambda^2 A_p E_m}$$
(12.26)

From (12.26) it is easily seen that the requirement that the strains in the model and in the prototype be the same implies either that $E_m = E_p$ and $R_m = \lambda^2 R_p$ or that $E_m \neq E_p$ and

$$R_m = \frac{\lambda^2 E_m}{E_p} R_p \tag{12.27}$$

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The requirement that the loads on the model and on the prototype be the same implies that

$$_{m} = \frac{E_{p}}{\lambda^{2} E_{m}} \epsilon_{p} \qquad (12.23)$$

It should be observed from Eq. (12.22) that, regardless of the geometric shape of the cross section, if $A_m = A_p/K$,

$$= K\sigma_{p} \qquad (12.29)$$

provided that the loads are the same. It should also be pointed out that Eqs. (12.25) and (12.26), relating the strains in the model to the strains in the prototype, will be valid regardless of the shape of the cross section. That is, if

$$A_{m} = \lambda^{2} A_{p}$$

whatever the shape of A_m and A_p , the strains in the model will still be related to the strains in the prototype and Eqs. (12.27) and (12.28) will still be valid. Another important result shown by these considerations is that the modulus of elasticity may be determined from specimens of any cross section.

The total displacement of any specimen is given by

$$\Delta l = l\epsilon \tag{12.30}$$

Thus the total displacements in the model and in the prototype are given respectively as

$$l_m = l_m \epsilon_m \tag{12.31}$$

 $\Delta l_{\mathbf{p}} = l_{\mathbf{p}} \epsilon_{\mathbf{p}} \tag{12.32}$

Substituting (12.26) into (12.31), we obtain

$$\Delta l_m = \frac{R_m l_m}{\lambda^2 \Lambda_\nu E_m} \tag{12.33}$$

If $\Delta l_p = \Delta l_m$, then it follows from (12.32) and (12.33) that

$$\frac{R_p}{E_p} = \frac{l_m}{\lambda^2 l_p} \frac{R_m}{E_m}$$
(12.34)

Then Eq. (12.34) must be the scale-factor law relating the model loads and modulus of elasticity to the prototype loads and modulus of elasticity when it is desired that displacements in the model and in the prototype be the same. It can be seen from (12.34) that if $E_m = E_p$, then

$$R_{\rm m} = \lambda^2 R_{\rm p} l_{\rm p} / l_{\rm m} \tag{12.35}$$

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If, on the other hand, the loads on the model and prototype are the same. i.e., $R_m = R_p$, then it follows from (12.25), (12.26), (12.31), and (12.32) that the scale-factor law relating the total displacement and modulus of elasticity of the model to the total displacement and modulus of elasticity of the prototype is given by

$$\Delta l_m = \frac{l_m}{l_p} \frac{E_p}{\lambda^2 E_m} \Delta l_p \tag{12.36}$$

Uniformly Loaded, Simply Supported Beam. The second example of interest is the problem of the uniformly loaded, simply supported beam. Figure 12.5 illustrates such a beam. If it were desirable to study the mechanical behavior of such a beam by means of a model, it would be



FIG. 12.5. Simply supported beam under uniformly distributed load.

necessary to determine the scale-factor laws relating the deflections and stresses in such a model to the stresses and deflections in the prototype.

The length, depth, and width of the model are assumed to be given respectively as $l_m = \lambda l_p$, $2c_m = 2\lambda c_p$, and $b_m = \lambda b_p$. The coordinate system is defined in Fig. 12.5. If we define a value C as

$$C = \frac{I}{c} \tag{12.37}$$

where I is the moment of inertia of the cross section of any beam and 2c is the depth of that beam, then we have from the properties of geometrical similarity that

$$I_m = \lambda^4 I_p \tag{12.38}$$

$$C_{m} = \lambda^{3} C_{p} \tag{12.39}$$

From elementary strength of materials the deflection at any point on this beam, the elastic moment, and the longitudinal normal stress are given respectively by:

$$y = \frac{Qx}{24EI} \left(-l^3 + 2lx^2 - x^3 \right)$$
 (12.40a)

$$M = \frac{Qx}{2} (l - x)$$
 (12.40b)

$$=\frac{M}{C}=\frac{Qx}{2C}\left(l-x\right) \tag{12.40c}$$

DIMENSIONAL ANALYSIS

Substituting into Eqs. (12.40) the geometrical dimensions and constants of the prototype and model, we arrive at the relations

$$y_{p} = \frac{Q_{\mu}x_{p}}{24E_{p}I_{p}} \left(-l_{p}^{3} + 2l_{\mu}x_{p}^{2} - x_{p}^{3}\right)$$
(12.41a)

$$y_{m} = \frac{Q_{m}x_{m}}{24E_{m}I_{m}} \left(-l_{m}^{3} + 2l_{m}x_{m}^{2} - x_{m}^{3}\right)$$
(12.41b)

$$M_{p} = \frac{Q_{p} x_{p}}{2} (l_{p} - x_{p}) \qquad (12.41c)$$

$$M_{m} = \frac{Q_{m}x_{m}}{2}(l_{m} - x_{m})$$
 (12.41d)

$$\sigma_{p} = \frac{M_{p}}{C_{p}} = \frac{Q_{p} x_{p}}{2C_{p}} (l_{p} - x_{p}) \qquad (12.41e)$$

$$\sigma_m = \frac{M_m}{\ell'_m} = \frac{Q_m x_m}{2\ell'_m} (l_m - x_m)$$
(12.41f)

Substituting the geometrical dimensions of the model in terms of the geometrical dimensions of the prototype into Eq. (12.41b), (12.41d), and (1241f) and using the relations (12.41a), (12.41c), and (12.41e), we get

U

$$m = \frac{Q_m}{Q_p} \frac{E_p}{E_m} y_p \qquad (12.42a)$$

$$M_{m} = \frac{Q_{m}}{Q_{p}} \lambda^{2} M_{p} \qquad (12.42b)$$

$$\sigma_m = \frac{Q_m}{Q_p} \frac{\sigma_p}{\lambda} \tag{12.42c}$$

From Eqs. (12.42) we see that, if $E_m = E_p$ and $Q_m = Q_p$, the deflections of the model and prototype are the same. It should be pointed out at this time that because Q_m and Q_p are defined as loads per unit length, if the length is doubled the total load will be doubled but the deflections will remain the same.

It is observed from Eqs. (12.41) and (12.42) that if $\sigma_m = \sigma_p$, the resulting scale factor laws will be

$$Q_m = \lambda Q_p \tag{12.43a}$$

 $M_{m} = \lambda^{3} M_{p} \qquad (12.43b)$

$$y_{m} = \lambda \frac{E_{p}}{E_{m}} y_{p} \qquad (12.43c)$$

Cantilever Beam under Concentrated Load. Another example similar to the last one is the problem of the cantilever beam under a concentrated

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end load. Fig. 12.6 shows such a beam of length l under load P. The maximum deflection y_{max} is found from elementary strength theory considerations to be given by:



FIG. 12.6. Cantilever beam under concentrated load at the end.

If a model were constructed geometrically similar to the prototype, its length would be given as $l_m = \lambda l_p$ and the moment of inertia I_m would be given as $I_m = \lambda^4 I_p$. As is easily seen, the equations for the maximum deflection in the prototype and model are then given respectively as

$$y_{p \max} = \frac{P_{p}l_{p}^{3}}{3E_{p}I_{p}}$$
(12.45a)
$$y_{m \max} = \frac{P_{m}l_{m}^{3}}{3E_{m}I_{m}}$$
(12.45b)

By substituting into (12.45b) the geometrical dimensions of the model in terms of those of the prototype, we obtain the scale-factor law for the maximum deflections,

$$y_{m \max} = \frac{P_m}{P_p} \frac{E_p}{E_m} \frac{(y_{p \max})}{\lambda}$$
(12.46)

From Eq. (12.46) it can be seen that one way to have $y_{m \max} = y_{p \max}$ is to make $E_p = E_m$ and $P_m = \lambda P_p$.

Thus if we construct a model whose dimensions are, say, one-half of those of the prototype and which is made of the same material, and load them in a manner such that $P_m = \frac{1}{2}P_p$, we will observe that the bar AB as shown in Fig. 12.7 will remain horizontal after deflection of the two cantilever beams (See Fig. 12.7).

Heavy Beam Simply Supported. The last example is the problem of the simply supported beam under its own weight. Fig. 12.8 illustrates this beam in its undeflected and deflected positions. Although this beam may be considered for structural purposes as a special case of the simply supported beam under a uniform load, it is also of interest to obtain scale-



F16. 12.7. Cantilever beams assembly applying the scaling law $y_{musx} =$ The bar AB should remain horizontal if $E_p = E_m$ and $P_m = \lambda P_p$.



Fig. 12.8. Simply supported beam under its own weight.

factor laws relating the densities and other physical constants of the model to the corresponding quantities in the prototype. Let γ_m and γ_p be the densities of the model and the prototype respectively.

From Eq. (12.43a) and the fact that

$$Q_m = \gamma_m A_m = \gamma_m (\lambda^2 A_n)$$

we conclude that to have $y_m = y_p$, the scale-factor law relating the density of the model to the density of the prototype must be given by

$$\frac{E_m}{\lambda^2 E_p} \gamma_p \tag{12.47}$$

If $E_m = E_p$, the scale-factor law reduces to

$$=\frac{1}{\lambda^2}\gamma_p \qquad (12.47a)$$

If it were desirable to have $\sigma_m = \sigma_p$, then the scale-factor law relating the densities is given by

γm

Υm

$$=\frac{1}{\lambda}\gamma_{\mu} \tag{12.48}$$

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and as a result the relation between the deflections is given by

$$y_m = \lambda \frac{E_p}{E_m} y_r \tag{12.49}$$

If the models were made of the same material, then it is easily seen that the scale-factor laws for the stresses, deflections, and moments would be given respectively by

$$\sigma_m = \lambda \sigma_p \qquad (12.50a)$$

$$y_m = \lambda^2 y_p \qquad (12.50b)$$

$$M_{m} = \lambda^{4} M_{p} \qquad (12.50c)$$

Use of Two Scale Factors. Sometimes it becomes convenient to have two factors: one (call it λ) for the longitudinal dimensions, and the second (call it η) for transversal dimensions. Thus the dimensions and mechanical constants of a beam might be $l_m = \lambda l_p$, $x_m = \lambda x_p$, $A_m = \eta^2 A_p$, $I_m = \eta^4 I_p$, $C_m = \eta^2 C_p$. In the first example above for the simply supported beam under uniform loading the equation relating the deflections becomes, using these quantities,

$$y_{m} = \frac{Q_{m}\lambda^{4}x_{p}}{2!E_{m}\eta^{4}I_{p}}\left(-l_{p}^{3}+2l_{p}x_{p}^{2}-x_{p}^{3}\right)$$
(12.51)

It is obvious that the equation relating the bending moments is identical to Eq. (12.42b). However, the equation relating the stresses becomes

$$\sigma_m = \frac{Q_m}{Q_p} \frac{\lambda^2}{\eta^3} \sigma_p \qquad (12.52)$$

Therefore the scale-factor law relating the loads necessary to make $\sigma_p = \sigma_m$ is given by

$$Q_{\rm m} = \frac{\eta^3}{\lambda^2} Q_{\rm p} \tag{12.53}$$

The scale-factor law relating the deflections is then given by

$$y_m = \frac{E_p}{E_m} \frac{\lambda^2}{\eta} y_p \tag{12.54}$$

PART 3

GRID METHODS



Centro de educación continua división de estudios superiores facultad de ingeniería, unam



ANALISIS EXPERIMENTAL DE ESFUERZOS

METODO DE GRID

DR. LUIS FERRER ARGOTE

NOVIEMBRE, 1978.

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GRID METHODS

Lirge deformations. An example of ink lines drawn on a Lucite sheet, to study its formability properties, is shown in Fig. 13.1. Using vacuum, a sphere was produced in the center of the sheet, and the amount of permanent strain introduced was determined by comparing the grid on the spherical part to the grid on the undeformed sheet.

d: Rubber Threads. For soft porous materials, thin rubber threads of about 0.00S in. in diameter can be firmly glued on the specimen by latex. The threads have a very low modulus of elasticity so that their effect on the rigidity of the specimen is negligible. Because threads are manufactured by the extrusion process, they have uniform thickness and straight sides.

e. Photogrid. A fine grid can be printed on the surface of the model by photographic means. The surface is first cleaned and lightly roughened by rubbing with fine pumice. It is then coated with a thin layer of highcontrast light-sensitive emulsion. Many types of emulsions are satisfactory for this work, for instance, those used by Brewer and Glasscot or by Miller.[‡] Generally four or five thin layers are sprayed at about 1-min intervals to allow the layers to dry. The model should be kept out of the light between sprayings and under subdued light during sprayings. Provision should often be made for fume removal. After drying, a master negative is placed in close contact with the model. Exposure to an intensive light source is made. To secure maximum clarity of the lines, a vacuum prihting frame is preferred. The development of the exposed emulsion then follows the procedure set down for the particular emulsion used.

To make the master negative, a plate glass is first coated with wax. A fine grid is ruled on the plate glass. These lines are etched and filled with lead sulfide. The master negative is then obtained from the master grid by contact printing. In this way master negatives of 100 lines per inch with a maximum of ± 1 per cent deviation from the nominal spacing of 0.01 in. may be obtained. This deviation becomes negligible only for large strains involving 50 per cent or more elongation or shortening. For such cases, measurements need be made only on the spacings under maximum load, and no measurements are made on the initial spacings under zero load, because the nominal spacing can be taken as the initial spacings.

An example of a photogrid on an aluminum sheet is shown on Fig. 13.2. f. Embedded Rubber Threads. The grid method can also be used in conjunction with soft transparent plastics. For this application the grid network is constructed of thin rubber threads which are fastened to

[†]G. A. Brewer, and R. B. Glassco, Determination of Strain Distribution by the Photogrid Process, J. Acronaut. Sci., vol. 9, no. 1, pp. 1-7, November, 1941.

¹J. A. Miller, Improved Photogrid Techniques for Determination of Strain over Short Gage Lengths, *Proc. Soc. Exptl. Stress Anal.*, vol. 10, no. 1, pp. 29-34, 1952.

CHAPTER 13

GRID METHODS

13.1. Introduction. The first simple idea that comes to mind for the detection of surface strains in a model is to put a grid on its surface and observe the distortions of the grid as the load is put on. For rectangular grids, if the initial and final spacing of the grid lines as well as the change in length of one of the diagonals of the elementary squares are measured, the principal strains and principal directions can be calculated easily by the rosette formula. For other types of grid geometries, for instance, polar grids, similar measurements can be made and the strains determined. There are various methods of putting the grid on the specimen and of measuring the distortion of the grid under load. The methods of putting on the grid will be discussed first.

13.2. Methods of Putting on Grids. a. Hand Scratching. For plates made of relatively soft, transparent materials like plastics, grid lines can be hand-scratched on the front face by a sharp razor blade guided by a straightedge. For these thin scratches to show, the light source should come from behind the specimen. The scratches will then appear as thin, dark lines against a light background. Filling the scratches with ink will also increase the contrast. This method is the simplest and the least expensive, but the grid lines cannot be spaced with precision.

Circular scratches can be obtained by using a compass with a sharpened point. The scratches obtained in this way, however, are not so thin as those obtained using razor blades.

b. Machine Scribing. Grid lines can be scratched on the surface of the model by machine scribing. The lines obtained are well defined and evenly spaced.

c. Ink Drawing. For rubber models which cannot take scratches, the grid lines may be drawn in ink by hand. In measuring the spacing between two lines, the centers of these lines must be estimated. Since the error of this estimate increases with increasing thickness of the lines, the accuracy of this method will be higher with thin lines. An alternative is to try to draw relatively thick lines but with sharply defined edges. Measurements are then made from the edges rather than from the center of the lines.

Grid lines can also be drawn in ink on transparent plastics to study



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FIG. 13.1. Grid lines drawn in ink used to study formability properties of transparent plastics. The sketch shows a central cross section.



F10. 13.2 Photogrid applied to the surface of an aluminum Alclad 24-S0 sheet. The photograph at right shows the distortion produced by forming. (Brewer and Glassco.)

the edges of a mold. The soft plastic is then cast around the network. The properties and the manufacturing details of a typical soft material used can be found elsewhere.[†] In this manner, the grid can be located at any desired position in the model. In cases where the grid is cemented to the surface of the model, the light transmitted through the model is distorted somewhat, since the latex emulsion builds up around the threads, and the light rays are refracted by this uneven surface. When the grid is embedded in the model this difficulty is not encountered. Fig. 13.3a shows a photograph of a mold with the rubber thread grid in place prior to pouring. As can be seen from this photograph, the grid can be placed at any desired distance from the surface of the model, and the grid lines . can be easily spaced at intervals as close as $\frac{1}{16}$ in. Fig. 13.3b shows a cured sheet of the plastic with the embedded grid in place. Fig. 13.3c shows a typical model machined from a sheet of the material. Sheets of the material can be cast, in any desired size and thickness.

This method can be used in three-dimensional, dynamic, and plastic deformation studies.

13.3. Methods of Measurement of Grids. There are two common methods for the measurement of the distortions of the grid lines.

1. For strains that remain after the load is removed, a micrometer microscope can be used to measure the spacings of the grid lines directly on the specimen both before and after the loading, or only after the loading if the original spacing is accurately known. For elastic strains the dis-

†A. J. Durelli and W. F. Riley, Developments in the Grid Method of Experimental Stress Analysis, Proc. Soc. Exptl. Stress Anal., vol. 14, no. 2, pp. 91-100, 1957.



FIG. 13.3. A series of photographs showing various stages in the preparation of a photoelastic model with an embedded grid. (a) A mold with the rubber thread grid in place prior to casting. (b) A sheet of cured plastic with the embedded grid. (c) A model machined from the sheet.

tortions of the grid will be gone after the load is removed so that this method cannot be used. If the strains at only a few points are needed, measurements directly on the specimen can be made by the microscope while the load is on. Where a large number of measurements is to be made, these measurements become difficult to conduct and the method given below may be used.

2. Two pictures of the specimens are taken, one at zero load and the other at maximum load. These will furnish a permanent record of the distortion of the grid, which can later be examined at ease. - Measurements on the spacings of grid lines are made on these two pictures instead of on the specimen. Two important sources of error in this method must be carefully guarded against. First, photographic paper usually shrinks with time. Measurements on the same print on different days often show discrepancies of the order of the strains due to the stresses. Glass plates, though more expensive, are therefore preferred. Second, often owing to slack motions in loading mechanisms, the specimen may move a little during the loading process. Since the camera is usually unaffected by the loading, there will be a relative motion between specimen and camera caused by the loading. The component of this relative motion in the plane of the specimen does not change the distance between the specimen and camera so that the size of the image formed on the plate will not be changed. But the component in the direction of the camera will change the size of the image and often cause a serious error in the computed strain. For instance, let P_1Q_1 represent an object placed at a distance d from the center of the lens (Fig. 13.4). Let $P'Q'_1$ be its image formed on the photographic plate at a distance d' away from the center of the lens. Let the object be displaced to its new position P_2Q_2 without



Fig. 13.4. Error introduced in photographic strain measurements due to movement. of specimen.

changing its length. Then the new image will be represented by $P'Q'_2$. Using the properties of similar triangles, we have

$$\frac{l}{r} = \frac{h}{d} \tag{13.1}$$

$$\frac{l+\Delta l}{d'} = \frac{h}{d-\Delta d}$$
(13.2)

Taking the difference of the above two equations, we have

$$\frac{\Delta l}{d'} = \frac{h}{d} \frac{\Delta d}{d - \Delta d} \tag{13.3}$$

By Eqs. (13.1) and (13.3) we obtain the apparent strain ϵ_{ap} due to the movement of the specimen,

$$\epsilon_{ap} = \frac{\Delta l}{l} = \frac{\Delta d}{d - \Delta d} \tag{13.4}$$

At each point in the specimen this apparent strain is the same in all directions; hence it is a hydrostatic strain. In general, the amount of displacement in the direction of the camera may be different at different points so that this hydrostatic strain may vary from point to point in the specimen and is not necessarily homogeneous. An idea of the magnitude of the error involved in experiments using flexible loading mechanisms

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having slack motions can be obtained from this numerical example. Let d = 10 in. and $\Delta d = 0.01$ in.; then, by Eq. (13.4), $\epsilon_{ep} = 0.001$, which may be larger than the strains caused by the loading. Such small movements of the specimen will not throw the image out of focus so that the presence of the error cannot be detected through inspection of the image to check whether it becomes blurred or not. Since the slack motion of most loading mechanisms will have taken place by the time a small load is on, it is advisable to use a fraction of the maximum load, say, one-fifth, as the initial load, to take two pictures, one at this load and one at the maximum load, and to measure the change of strain due to the increase of load. Where portions of the specimen have zero or known strains under load, these can be used to compute the motion of the specimen. Usually the hydrostatic apparent strain does not vary appreciably from point to point so that it can be taken as the same for all points and a single correction applied to all the measured strains.

13.4. Determination of Stress Concentrations by Fischer's Method. Suppose we have a number of points A_0, A_1, \ldots, A_n on a straight line parallel to the X axis (Fig. 13.5). Let X_0, X_1, \ldots, X_n be the X coordinates of these points before the body undergoes deformation. After deformation,



Fig. 13.5. Fischer's method of determination of stress concentrations. After deformation, A_0A_n is displaced to $A_0A_n^{\prime}$.

suppose these points move to their new positions A'_0, A'_1, \ldots, A'_n . Let X'_0, X'_1, \ldots, X'_n be the X coordinates of these new positions. By definition, the displacements in the X direction, denoted by u, are $X'_0 - X_0, X'_1 - X_1, \ldots, X'_n - X_n$ for the points A_0, A_1, \ldots, A_n , respectively. If we plot these displacements against the X coordinates of the undeformed positions

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of the points, we obtain a number of points a_0, a_1, \ldots, a_n (Fig. 13.6). If we pass a smooth curve through these points, then the slope of the curve, du/dx, will give the strain in the X direction, ϵ_x . This method of plotting the ux curve and obtaining ϵ_x from its slope was due to Fischer.† It has several advantages over the usual method of calculating the strains. (1) A point which deviates excessively from the smooth curve can be



FIG. 13.6. Fischer's method of determination of stress concentrations. The slope of the curve at each point gives the strain at that point.

discovered immediately from a glance at this ux curve. Measurements on this point can be carefully checked again to detect a probable mistake, or, if that is not possible, the point is discarded. (2) In the usual method, the average strain in the interval A_1A_2 is computed by the formula $\epsilon_x = \Delta l/l$ or

$$=\frac{(x_2'-x_1')-(x_2-x_1)}{x_2-x_1}$$

This corresponds to the slope $\tan \alpha$ of the chord a_1a_2 in Fig. 13.6. Similarly the average strain in the interval A_0A_1 is given by the usual method as the slope of the chord a_0a_1 . The strain ϵ_a at A_1 is then taken as the mean

†G. Fischer, "Versuche uber die Wirkung von Kerben an elastische beanspruchten Biegestaben," dissertation T. H. Anchen, 1932, VDI Verlag G.m.b.h., Düsseldorf, 1932. slope of the chords a_0a_1 and a_1a_2 . This mean is close to the slope of the tangent at a_1 , so that here the accuracy of the usual method, though not so good as Fischer's method, is almost as good. At or near a stress concentration (for instance, A_3), however, the average of the two slopes of the chords a_2a_3 and a_3a_4 is much lower than the slope of the tangent through a_3 . The ordinary method therefore misses the peak strain, whereas Fischer's method does not. For the determination of stress concentration, Fischer's method is therefore always preferred.

13.5. Determination of the Distribution of Stresses in a Plate with a Circular Hole, under Unidimensional Load by the Rubber-model Method. The problem of the hole in a plate under tension was investigated by the rubber-model method. A rubber sheet 36 in. in length, 12 in. in width, and $\frac{1}{4}$ in. in thickness was used (Fig. 13.7). A circular hole 1 in. in diam-



FIG. 13.7. Test setup for rubber sheet (36 by 12 by $\frac{1}{2}$ in. with a 1-in. hole stretched in its plane). The grid is drawn with India ink. The sheet rests on ball bearings to decrease friction.

eter was drilled in its center, and a constant deformation was applied to the sheet by means of a turnbuckle. When the sheet was hung vertically, it was found that the dead weight of the loading jig and rubber sheet produced enough strains to distort the circular hole. To avoid this, the sheet was therefore placed in a horizontal position. To avoid friction, the sheet was supported on ball bearings, as shown in Fig. 13.8. On the rubber sheet, a fine grid was drawn with India ink (Fig. 13.9). Both polar and cartesian-coordinate systems were used. The distance between lines varied from 1/32 to $\frac{1}{2}$ in.

Photographs of the sheet were taken for a small initial load and for increasing amounts of load. The camera setup is shown in Fig. 13.10. The photograph of the grid at about 10 per cent longitudinal deformation is shown in Fig. 13.11. Photographic plates and not films were used.

The first obvious feature of the photographs is that the drawn circles become ellipses after deformation. The circle on the longitudinal axis



FIG. 13.8. Ball bearings used to support the rubber sheet loaded horizontally.

of the sheet away from the hole and the two ends elongates longitudinally and contracts transversely. With the micrometer microscope, it is easy to measure on the two photographic plates the lengths of the longitudinal and transversal diameter before and after deformation. Dividing the change in length by the original length, the two principal strains are obtained. The ratio between them is Poisson's ratio, since the transversal stress is negligible there.

It is also obvious that, although the directions of the axes of the ellipse on the longitudinal axis of the plate remain longitudinal and transversal, the axes of the other ellipses shifted. The directions of these axes are the directions of the principal strains and stresses.

Superimposing the original circle on the deformed ellipse, as shown in Fig. 13.11, the strains in all directions become apparent. These strains are proportional to the distance between the circle and ellipse. (The circles should be small for this to be true.)

The hole in the plate becomes elliptical; its axes coincide with the axis of the plate. In the polar-coordinate system radial lines diverge prominently at the boundary near the transversal axis and converge at the boundary near the longitudinal axis, making it easy to understand the two fundamental facts produced by the hole:

1. There is an extra elongation at the boundary on the transversal axis (stress-concentration phenomenon).


FIG. 13.9. Grid system used in the rubber-sheet test.

2. There is a contraction at the boundary on the longitudinal axis. Since at free boundaries the state of stress is unidimensional, this contraction demonstrates the existence of a compressive stress.

The longitudinal and transversal strains on the transversal axis through



FIG. 13.10. Camera arrangement in the rubber-sheet test.

the center of the hole are obtained by micrometer-microscope measurements on the two photographs, one at a small initial load and the other at about 10 per cent longitudinal deformation. Fischer's method was used. The uniform longitudinal strain at the portion of the plate midway between the hole and the clamped ends is also measured. These measured strains are translated into stresses by the stress-strain relations. The ratios of the stresses on the transversal axis to the stress in the uniform field are computed, plotted, and compared with Howland's theoretical values (Fig. 13.12). The agreement is fair. It was found that the stress-strain relationship for the particular rubber used (Hevea natural rubber 28.5%, fillers 56.3%, vulcanizer 8.6%, sulfur 3.1%, oils 3.5%) is practically straight for strains not larger than 10 per cent. The modulus of elasticity was therefore assumed to be constant. Its value did not enter the final result because only the stress ratios, not stresses, were calculated. Poisson's ratio of the rubber was assumed to be 0.32 in the computations. A point ($r = 2.12a; \theta = 28^{\circ}17'$) was arbitrarily selected for the termina-



FIG. 13.11. Rubber sheet under about 10 per cent elongation.

tion of stresses from measured strains. Three strains were measured (longitudinally, transversally, and at 45°), and the principal stresses and principal directions were calculated by the rosette formula and the stress-strain relations (Fig. 13.13). Here also, the check with values obtained by Kirsch's formula is fair.



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FIG. 13.12. Distribution of stress on the transversal axis of a plate with a circular hole, under a unidimensional uniformly distributed load. (Comparison of theory and rubber-model measurements.) Poisson's ratio of rubber is taken as 0.32.



FIG. 13.13. Theoretical and experimental determination of stress and strain at any point on a plate with a circular hole, under unidimensional uniformly distributed load.

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13.6. Determination of the Stress-Strain Relations of a Rubberlike Material. The rubber-thread method was used to determine the stressstrain relations of a rocket propellant. The thread used has a diameter of 0.008 in., and was glued on the specimen by latex. A series of motion pictures were taken on the specimen as it was loaded to failure.

Measurements were made on these pictures by means of a comparator and the stress-strain curve plotted. Owing to the large deformations involved, true stress and natural strain were used. Figure 13.14 shows pictures of the specimen before loading, during loading, and after failure. The straight rubber threads become wavy under loading. This strongly indicates that the material is not homogeneous.



FIG. 13.14. Rubber-thread grid cemented to a rubberlike-material, tensile specimen. The photograph at the left shows the unloaded specimen. The photograph at the right shows the specimen after failure. The photograph in the middle shows nonhomogeneous strain produced by heterogeneity in the material.

13.7. Grids for Point Location. Sometimes in experimental stress analysis, in particular in connection with photoelasticity and the brittlecoating method, it is found convenient to have a grid on the specimen to help in the location of points. When the specimens are of complicated shape, this is often a necessity. The grids are then used, not to measure strains, but to allow a precise location of the points where strains or stresses are determined, and they often coincide with a coordinated system, either cartesian or polar. For photoelastic applications these grids are often scribed on the surface of the plastic specimen. For brittle-coating applications the grids are usually drawn with Dykem Steel Blue. An example of grids on brittle-coating specimens is shown in Figs. 17.2 and 17.3 of the chapter on applications of brittle coating. An example of grids on photoelas precimens is shown in Fig. 13.15.



FIG. 13.15. Grid scribed on a photoelastic specimen to allow a precise location of the points where stresses are determined. The grid lines were scratched on a plastic model by means of a sharp-point steel scriber.

13.8. Determination of the Distribution of Strains in a Disk under Diametral Compression. To use the embedded-rubber-thread technique, a sheet of plastic was molded about a grid of rubber threads, and then cured for two days. A disk was then machined from the sheet and placed in a loading frame. Since the plastic had photoelastic properties the disk and loading frame were placed in a field of circularly polarized light. Fringe patterns and the grid network were photographed simultaneously. These data are illustrated in Fig. 13.16, which shows (a) a light-field photograph before the load was applied, (b) a loaded photograph α 1 distor-



FIG. 13.16. A series of photographs showing complete photoelastic-and grid displacement data. (a) A light-field photograph before the load was applied. The fringe at the point of support is due to the dead weight of the disk. (b) A photograph of the grid displacements after the load was applied with the polariscope elements removed. (c) A photograph of the light-field isochromatics and grid displacements. (d) A photograph of the dark-field isochromatics and grid displacements. The black circles in (a), (b), and (c) are a reference sphere used to compensate for film shrinkage. Data obtained from the grids are sufficient to solve the elastic problem.

tions only, (c) light-field isochromatics and grid distortions, and (d) dark-field isochromatics and grid distortions. Only Figs. 13.16a and b are needed for the grid analysis. These two photographs give all values of strain and by use of E and ν all values of stress. However Figs. 13.16c and d will be used for comparison.

An enlarged view of the isochromatic pattern and the grid distortions in the neighborhood of the load are shown in Fig. 13.17.

A fixed reference should always be placed in the field of the photographs to compensate for possible errors which could be introduced by film shrinkage. In this study a small sphere was used, as seen in Fig. 13.16.

The photographs of the disk were taken on a diffused-light polariscope, and both a measuring microscope and an optical comparator were used to make the grid measurements. It is believed that the optical measurements of grid displacements are accurate to ± 0.0002 in.



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FIG. 13.17. An enlarged view of the photoelastic isochromatics and grid displacements in the neighborhood of the point of application of the load.

In order to compare the photoelastic results with the strain measurements determined from the grid displacements, the following relationship was derived. From the plane-stress equations in Exercise 6.3,

$$\epsilon_1 = \frac{1}{E} (\sigma_1 - \nu \sigma_2) \qquad \epsilon_2 = \frac{1}{E} (\sigma_2 - \nu \sigma_1)$$

The difference in principal strain is then found to be

 $\epsilon_1 - \epsilon_2 = \frac{1+\nu}{E} (\sigma_1 - \sigma_2)$

The ratio of principal stress difference to principal strain difference is ithus a constant.

$$\frac{\sigma_1-\sigma_2}{\epsilon_1-\epsilon_2}=\frac{E}{1+\nu}$$

The difference in principal stress was computed for the horizontal and vertical diameters of the disk using the photoelastic isochromatics and the fringe value for the material of 0.54 psi in./fringe. The two principal strains were determined for the two diameters from the grid displacements by Fischer's method. The strain difference was then computed and plotted. The results of these calculations are presented in the form of the curves shown in Figs. 13.18 and 13.19. A comparison between the photoelastic and grid network results is shown in Tables 13.1 and 13.2.

TABLE 13.1. HORIZONTAL DIAMETER

Position	σ ₁ — σ ₂ psi	$\epsilon_1 - \epsilon_2$	$\sigma_1 - \sigma_2$
			$\epsilon_1 - \epsilon_2$ psi
0.1D -	3.26	0.0052	(10+
0.2D	7 80	0.0003	0121
0.3D	12 40	0.0183	426
0.40	13.40	0.0320	419
0.40	18.55	0.0433	427
0.51)	20.55	0.0490	419

TABLE 13.2. VERTICAL DIAMETER

Position	$\sigma_1 - \sigma_2$ psi	$\epsilon_1 - \epsilon_2$	$\frac{\sigma_1 - \sigma_2}{\epsilon_1 - \epsilon_2}$ psi
0.1D 0.2D 0.3D 0.4D 0.5D	39.70 29.80 24.60 21.60 20.55	0.090 0.069 0.058 0.052 0.049	441 429 424 415

†Not used for the statistical measures.

From the data of Tables 13.1 and 13.2, statistical measures of the quan-

- tity $\frac{\sigma_1 \sigma_2}{\epsilon_1 \epsilon_2}$ were calculated as indicated below:
 - a. Mean = 424.3
 - b. Standard deviation = 7.76
 - c. Coefficient of variation = 1.83

The results presented in Tables 13.1 and 13.2 show that the strain measurements correlate very well with the photoclastic results. Except in the region of very low strains near the boundary of the disk and in the region of high strain gradient near the point of application of the load,



FIG. 13.18. Photoclastic and grid measurement results for the horizontal diameter of the disk.





the coefficient of variation is less than 2.00. The value of $E/(1 + \nu)$ computed independently was found to be 420. This comparimized vorably with the mean of the disk results, 424.3.

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In addition to the comparisons of Tables 13.1 and 13.2, a static equilibrium check was conducted by determining the distributions of σ_{ν} across the horizontal diameter from the measured strains and the elastic constants of the material. The total normal force across the diameter checked to within 2.5 per cent of the applied load.

The usefulness of the method is limited to cases in which large deformations of the plastic do not produce appreciable changes in the boundary conditions. It is obvious in Fig. 13.17 that the distribution of stress at the zone of contact is very different from the corresponding distribution produced by a load concentrated at a point. This limitation is also encountered in other methods of stress analysis such as the "freezing" technique in three-dimensional photoelasticity.



Points on the	Distance measured from point 0, in.		
tangent to the hole	Plate not loaded	Plate loaded	
0	0	0.	
1 •	0.018	0.027	
2	0.034	0.053	
3	0.057	0.089	
4	0.073	0.116	
5	0.098	0.158	
6 ·	0.111	0.181	
7	0.136	0.222	
8	0.162	0.261	

Fig. 13.20. Use of Fischer's method to determine the stress concentration at the boundary of a hole.

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EXERCISE

Determine the average strains in the eight intervals on the line AB (Fig. 13.20). From these average strains compute the strains at the seven interior points 1, 2, ..., 7. Determine the strains at these seven interior points again by Fischer's method, and calculate the per cent difference between the results obtained from these two methods. Determine the strains a third time using Fischer's method; however, in addition, take advantage of the symmetry in respect to the transversal axis.

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